

# OCP NIC 3.0 Design Specification

Version 0.99

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# 1 Overview

## 1.1 License

As of January 23<sup>rd</sup>, 2018, the following persons or entities have made this Specification available under the Open Compute Project Hardware License (Permissive) Version 1.0 (OCPHL-P)

• OCP NIC Subgroup

An electronic copy of the OCPHL-P is available at:

https://www.opencompute.org/documents/ocphl-permissive-v10

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# 1.2 Acknowledgements

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The OCP NIC Subgroup would like to acknowledge the following member companies for their contributions to the OCP NIC 3.0 specification:

Table 1: Acknowledgements – By Company

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Netronome Systems, Inc.

Quanta Computer Inc.

TE Connectivity Corporation

Keysight Technologies University of New Hampshire InterOperability Lab



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#### 1.3.1 Trademarks

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PCIe® and PCI Express® are the registered trademarks of PCI-SIG



# 1.4 Acronyms

For the purposes of the OCP NIC 3.0 specification, the following acronyms apply:

Table 2: Acronyms

| Acronym | Definition                                          |  |  |
|---------|-----------------------------------------------------|--|--|
| AIC     | Add-in Card                                         |  |  |
| ASIC    | Application Specific Integrated Circuit             |  |  |
| BGA     | Ball Grid Array                                     |  |  |
| BMC     | Baseboard Management Controller                     |  |  |
| BOM     | Bill of Materials                                   |  |  |
| CAD     | Computer Aided Design                               |  |  |
| СВВ     | Compliance Base Board                               |  |  |
| CEM     | Card Electromechanical                              |  |  |
| CFD     | Computational Fluid Dynamics                        |  |  |
| CFM     | Cubic Feet per Minute                               |  |  |
| CLB     | Compliance Load Board                               |  |  |
| CTD     | Chain of Trust for Detection                        |  |  |
| CTF     | Critical to Function                                |  |  |
| CTU     | Chain of Trust for Update                           |  |  |
| DMTF    | Distributed Management Task Force                   |  |  |
| DRAM    | Dynamic Random Access Memory                        |  |  |
| EDSFF   | Enterprise and Datacenter SSD Form Factor           |  |  |
| EMI     | Electro Magnetic Interference                       |  |  |
| ESD     | Electrostatic Discharge                             |  |  |
| EU      | European Union                                      |  |  |
| FCC     | Federal Communications Commission                   |  |  |
| FRU     | Field Replaceable Unit                              |  |  |
| I/O     | Input / Output                                      |  |  |
| I2C     | Inter-Integrated Circuit - two wire serial protocol |  |  |
| IEC     | International Electrotechnical Commission           |  |  |
| IPC     | Institute for Printed Circuits                      |  |  |
| IPMI    | Intelligent Platform Management Interface           |  |  |
| ISO     | International Organization for Standardization      |  |  |
| LED     | Light Emitting Diode                                |  |  |
| LFF     | Large Form Factor                                   |  |  |
| LFM     | Linear Feet per Minute                              |  |  |
| MAC     | Media Access Control                                |  |  |
| MC      | Management Controller                               |  |  |
| МСТР    | Management Component Transport Protocol             |  |  |
| ME      | Management Entity                                   |  |  |
| MSA     | Multi-source Agreement                              |  |  |
| NC      | No Connect                                          |  |  |
| NC-SI   | Network Controller Sideband Interface               |  |  |
| NEBS    | Network Equipment Building-System                   |  |  |
| NIC     | Network Interface Card                              |  |  |
| OCP     | Open Compute Project                                |  |  |

| ODM   | Original Design Manufacturer                                           |  |  |  |
|-------|------------------------------------------------------------------------|--|--|--|
| OEM   | Original Equipment Manufacturer                                        |  |  |  |
| PBA   | Printed Board Assembly                                                 |  |  |  |
| PCB   |                                                                        |  |  |  |
| PCI™  | Printed Circuit Board                                                  |  |  |  |
|       | Peripheral Component Interconnect                                      |  |  |  |
| PCIe® | PCI Express®                                                           |  |  |  |
| PDR   | Platform Descriptor Record                                             |  |  |  |
| PLDM  | Platform Level Data Model                                              |  |  |  |
| QSFP  | Quad Small Form Factor Pluggable                                       |  |  |  |
| QZ    | Quiet Zone                                                             |  |  |  |
| RA    | Right Angle                                                            |  |  |  |
| RBT   | RMII Based Transport                                                   |  |  |  |
| REACH | Registration, Evaluation, Authorization and Restriction of Chemicals   |  |  |  |
| RFU   | Reserved Future Use                                                    |  |  |  |
| RJ45  | Registered Jack 45 (IEC 60603-7 8P8C connector)                        |  |  |  |
| RoHS  | Restriction of Hazardous Substances Directive                          |  |  |  |
| RSVD  | Reserved                                                               |  |  |  |
| RTU   | Root of Trust for Update                                               |  |  |  |
| SFF   | Small Form Factor                                                      |  |  |  |
| SFP   | Small Form Factor Pluggable                                            |  |  |  |
| SMBus | System Management Bus                                                  |  |  |  |
| SMT   | Surface Mount Technology                                               |  |  |  |
| TBD   | To be Determined                                                       |  |  |  |
| TDP   | Thermal Design Power                                                   |  |  |  |
| UART  | Universal Asynchronous Receiver-Transmitter                            |  |  |  |
|       | Unique Device Identifier for each SMBus device. Refer to the SMBus 2.0 |  |  |  |
| UDID  | specification for the field definition.                                |  |  |  |
| UEFI  | Unified Extensible Firmware Interface                                  |  |  |  |
| USB   | Universal Serial Bus                                                   |  |  |  |
| VDM   | Vendor Defined Messages                                                |  |  |  |
| WEEE  | WEEE Waste Electrical and Electronic Equipment                         |  |  |  |

# 1.5 Background

The OCP NIC 3.0 specification is a follow-on to the OCP Mezz 2.0 rev 1.00 design specification. The OCP NIC 3.0 specification supports two basic card sizes: Small Form Factor (SFF), and Large Form Factor (LFF). The SFF allows for up to 16 PCIe® lanes on the card edge while the LFF supports up to 32 PCIe lanes. Compared to the OCP Mezz Card 2.0 Design Specification, the updated OCP NIC 3.0 specification provides a broader solution space for the NIC and system vendors to support the following use case scenarios:

- NICs with a higher Thermal Design Power (TDP)
- Power delivery supports up to 80 W to a single connector (SFF) card, and up to 150 W to a dual connector (LFF) card
  - Note: Baseboard vendors need to evaluate if there is sufficient airflow to thermally cool the OCP NIC 3.0 card. Refer to Section 6 for additional details.
- Supports up to PCIe Gen 4 (16 GT/s) on the baseboard and OCP NIC 3.0 card
  - Connector is electrically compatible with PCIe Gen 5 (32 GT/s)
- Support for up to 32 lanes of PCle per OCP NIC 3.0 card
- Support for single host, multi-root complex, and multi-host environments
- Supports a greater board area for more complex OCP NIC 3.0 card designs
- Support for Smart NIC implementations with on-board DRAM and accelerators
- Simplification of FRU installation and removal while reducing overall down time

A representative SFF OCP NIC 3.0 card is shown in Figure 1 and a representative LFF is shown in Figure 2.

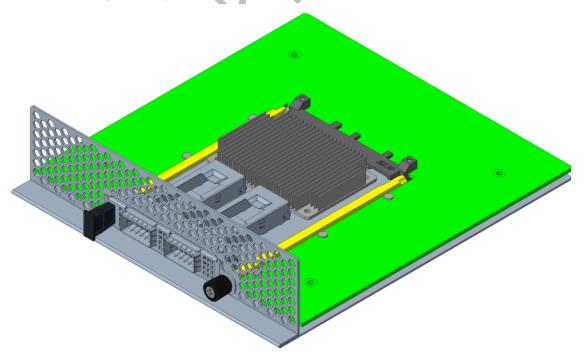


Figure 1: Representative SFF OCP NIC 3.0 Card with Dual QSFP Ports

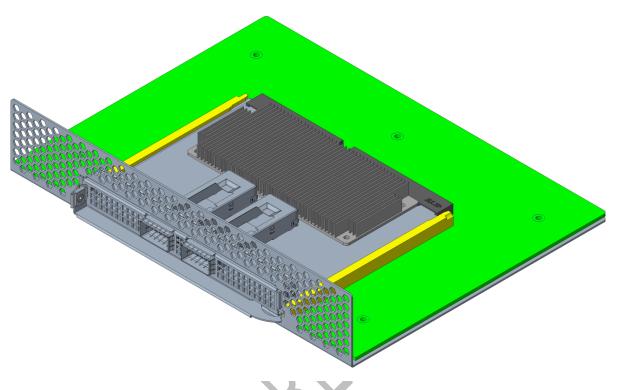


Figure 2: Representative LFF OCP NIC 3.0 Card with Dual QSFP Ports and on-board DRAM

In order to achieve the features outlined in this specification, OCP NIC 3.0 compliant cards are not backwards compatible with OCP Mezz 2.0 cards.

This specification is created under OCP Server workgroup – OCP NIC subgroup. An electronic copy of this specification can be found on the Open Compute Project and the OCP Marketplace websites:

http://www.opencompute.org/wiki/Server/Mezz#Specifications and Designs

https://www.opencompute.org/contributions?query=OCP%20NIC%203.0

#### 1.6 Overview

#### 1.6.1 Mechanical Form Factor Overview

The OCP NIC 3.0 specification defines a third generation mechanical form factor that allows for interoperability between compliant baseboards and OCP NIC 3.0 cards.

OCP NIC 3.0 cards have two form factors – SFF and LFF. These cards are shown in Figure 3 below. The components shown in the figures are for illustrative purposes. The SFF uses one connector (Primary Connector) on the baseboard. The LFF uses one or two connectors (Primary Connector only or both the Primary and Secondary Connectors) on the baseboard.

Both the Primary and Secondary Connectors and card edge gold fingers are defined in and compliant to SFF-TA-1002. The Primary Connector is the "4C+" variant, the Secondary Connector is the "4C" version. On the OCP NIC 3.0 card side, the card edge is implemented with gold fingers. The SFF gold finger area only occupies the Primary Connector area for up to 16 PCIe lanes. The LFF gold finger area may occupy both the Primary and Secondary Connectors for up to 32 PCIe lanes, or optionally just the Primary Connector for up to 16 PCIe lane implementations.

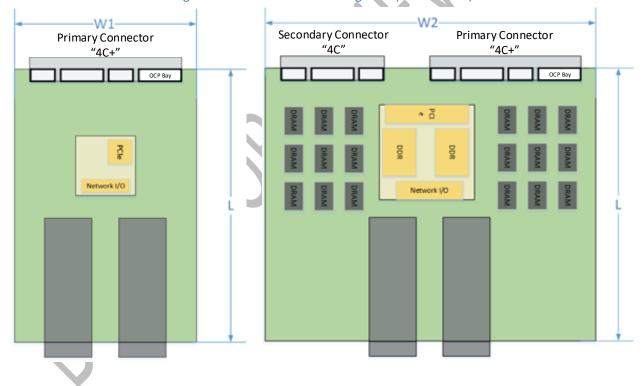


Figure 3: SFF and LFF Block Diagrams (not to scale)

The two form factor dimensions are shown in Table 3.

| Form   | Width    | Depth   | Primary   | Secondary | Typical Use Case               |
|--------|----------|---------|-----------|-----------|--------------------------------|
| Factor |          |         | Connector | Connector |                                |
| SFF    | W1 = 76  | L = 115 | "4C+"     | N/A       | Low profile and NIC with a     |
|        | mm       | mm      | 168 pins  |           | similar profile as an OCP NIC  |
|        |          |         |           |           | 2.0 card; up to 16 PCIe lanes. |
| LFF    | W2 = 139 | L = 115 | "4C+"     | "4C"      | Larger PCB width to support    |
|        | mm       | mm      | 168 pins  | 140 pins  | additional NICs; up to 32 PCIe |
|        |          |         |           |           | lanes.                         |

Table 3: OCP 3.0 Form Factor Dimensions

The OCP NIC 3.0 design allows downward compatibility between the two card sizes. Table 4 shows the compatibility between the baseboard and NIC combinations. A SFF baseboard slot may only accept a SFF sized NIC. A LFF baseboard slot may accept a SFF or LFF NIC.

| Tuble 4. Busebourd to der Twe Form Fuetor Combutationty Chart |                                 |                     |  |  |  |
|---------------------------------------------------------------|---------------------------------|---------------------|--|--|--|
| Baseboard                                                     | NIC Size / Supported PCIe Width |                     |  |  |  |
| Slot Size                                                     | SFF                             | LFF                 |  |  |  |
| SFF                                                           | Up to 16 PCIe lanes             | Not Supported       |  |  |  |
| LFF                                                           | Up to 16 PCIe lanes             | Up to 32 PCIe lanes |  |  |  |

Table 4: Baseboard to OCP NIC Form Factor Compatibility Chart

There are two baseboard connector mounting options available for system designers: straddle mount and right angle (RA). The straddle mount connector option allows the OCP NIC and baseboard to exist in a co-planer position. To achieve this, a cutout exists on the baseboard and is defined in this specification. Alternatively, the right angle option allows the OCP NIC to be installed on top of the baseboard. A baseboard cutout is not required for the right angle connector. The right angle option allows the baseboard to use this area for additional routing or backside component placement. The straddle mount and right angle connectors are shown in Section 3.2.

For both the baseboard and OCP NIC 3.0 card, this specification defines the component and routing keep out areas. Refer to Section 2.5 for details.

Both the straddle mount and right angle implementations shall accept the same OCP NIC 3.0 card and shall be supported in the baseboard chassis regardless of the baseboard connector selection (right angle or straddle mount) so long as the baseboard slot and OCP NIC 3.0 card sizes are a supported combination as shown in Table 4.

This specification defines the form factor at the OCP NIC 3.0 card level, including the front panel, latching mechanism and card guide features.

More details about the card form factor is shown in Section 2.

#### 1.6.2 Electrical Overview

This specification defines the electrical interface between baseboard and the OCP NIC 3.0 card. The electrical interface is implemented with a right angle or straddle mount connector on baseboard and gold finger on the OCP NIC 3.0 card. As previously noted in the mechanical overview, each card may implement a Primary Connector or Primary + Secondary Connector. Cards using only the Primary Connector are suitable for both the SFF and LFF and may support up to 16 lanes of PCIe. The Secondary Connector, when used in conjunction with the Primary Connector, allows LFF implementations and may support up to 32 lanes of PCIe.

## 1.6.2.1 Primary Connector

The Primary Connector provides all OCP specific management functions as well as up to 16 lanes of PCIe between the OCP NIC and the system motherboard.

#### **Management Function Overview (OCP Bay):**

- DMTF DSP0222 compliant Network Controller Sideband Interface (NC-SI) RMII Based Transport (RBT) Physical Interface
- Power management and status reporting
  - o Power Brake for emergency power reduction
  - State change control
- Control / status serial bus
  - NIC-to-Host status
    - Port LED Link/Activity
    - Environmental Indicators
  - Host-to-NIC configuration Information
- Multi-host PCIe support signals (2x PCIe resets, 2x reference clocks)
  - The OCP bay provides PERST2#, PERST3#, REFCLK2 and REFCLK3. This enables support for up to four hosts when used in conjunction with PERST0#, PERST1#, REFCLK0 and REFCLK1 in the Primary 4C region.
- PCIe Wake signal

See Section 3.4 for a complete list of pin and function descriptions for the OCP Bay portion of the Primary Connector. The OCP Bay pins are prefixed with "OCP\_" in the pin location column.

# **Interface Overview (4C Connector):**

- 16x differential transmit/receive pairs
  - Up to PCle Gen 4 (16 GT/s) support
    - Connector is electrically compatible with PCIe Gen 5 (32 GT/s)
- 2x 100 MHz differential reference clocks
- Control signals
  - 2x PCIe Resets
  - Link Bifurcation Control
  - Card power disable/enable
- SMBus 2.0
- USB 2.0 interface

- Power
  - o +12V\_EDGE
  - +3.3V\_EDGE
  - o Power distribution between the aux and main power domains is up to the baseboard vendor

See Section 3.4 for a complete list of pin and function descriptions for the 4C+ connector.

#### 1.6.2.2 Secondary Connector

The Secondary Connector provides an additional 16 lanes of PCIe and their respective control signals.

# **Interface Overview (4C Connector):**

- 16x differential transmit/receive pairs
  - O Up to PCle Gen 4 (16 GT/s) support
    - Connector is electrically compatible with PCIe Gen 5 (32 GT/s)
- 2x 100 MHz differential reference clocks
- Control signals
  - o 2x PCIe Resets
  - Link Bifurcation Control
  - Card power disable/enable
- SMBus 2.0
- UART (transmit and receive)
- Power
  - o +12V EDGE
  - +3.3V\_EDGE
  - o Power distribution between the aux and main power domains is up to the baseboard vendor

See Section 3.4 for a complete list of pin and function descriptions for the 4C connector.

#### 1.7 Non-NIC Use Cases

The OCP NIC 3.0 specification is mainly targeted for Network Interface Card applications. It is possible to use the same OCP NIC 3.0 card form factor, baseboard interface and mechanical design to enable non-NIC use cases. These non-NIC use cases use the same baseboard/OCP NIC 3.0 card interface as defined in Section 3. The non-NIC use cases are not covered in the current revision of the OCP NIC 3.0 specification. Example non-NIC use cases implement various external I/O interfaces and are shown in Table 5.

Table 5: Example Non-NIC Use Cases

| Example Use Case        | Card External I/O Interface(s)                                  |
|-------------------------|-----------------------------------------------------------------|
| PCIe Retimer Card       | PCle                                                            |
| Accelerator Card        | N/A                                                             |
| NVMe Card               | N/A                                                             |
| Storage HBA / RAID Card | I/O Interface to be determined in future specification release. |

## 2 Mechanical Card Form Factor

# 2.1 Form Factor Options

OCP NIC 3.0 provides two fundamental form factor options: a SFF (76 mm x 115 mm) and a LFF (139 mm x 115 mm).

These form factors support a Primary Connector and optionally, a Secondary Connector. The Primary Connector is defined to be a SFF-TA-1002 compliant 4C+ connector. The 4C+ connector is a 4C complaint implementation plus a 28-pin "OCP bay" for OCP NIC 3.0 specific pins. The Secondary Connector is the 4C connector as defined in SFF-TA-1002. The 4C specification supports up to 32 differential pairs for a x16 PCIe connection per connector. For host platforms, the 28-pin OCP bay is required for all Primary Connector implementations.

The SFF uses the Primary 4C+ connector to provide up to a x16 PCle interface to the host. The additional 28-pin OCP bay carries sideband management interfaces as well as OCP NIC 3.0 specific control signals for multi-host PCle support. The SFF card provides sufficient faceplate area to accommodate up to 2x QSFP modules, 4x SFP modules, or 4x RJ45 for BASE-T operation. The SFF supports up to 80 W of delivered power to the card edge. An example SFF is shown in Figure 1.

The LFF uses the Primary 4C+ connector to provide the same functionality as the SFF along with an additional Secondary 4C connector to provide up to a x32 PCIe interface. The LFF Card may utilize both the Primary and Secondary Connectors, or just the Primary Connector for lower PCIe lane count applications. Table 6 summarizes the LFF permutations. The LFF supports higher power envelopes and provides additional board area for more complex designs. The LFF supports up to 150 W of delivered power to the card edge across the two connectors. An example LFF is shown in Figure 2.

For LFF Cards, implementations may use both the Primary and Secondary Connector (as shown in Figure 4), or may use the Primary Connector only (as shown in Figure 5) for the card edge gold fingers.

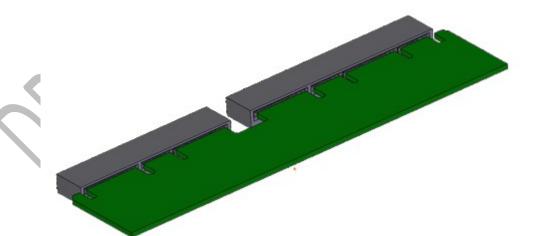


Figure 4: Primary Connector (4C+) and Secondary Connector (4C) (LFF) OCP NIC 3.0 Cards

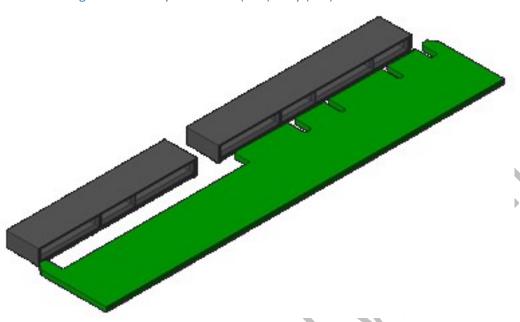


Figure 5: Primary Connector (4C+) Only (LFF) OCP NIC 3.0 Cards

For both form factors, an OCP NIC 3.0 card may optionally implement a subset of pins to support less than a x16 PCIe connection. This may be implemented using a 2C+ card edge per SFF-TA-1002. The baseboard Primary Connector shall use a 4C+ in all cases. Figure 6 illustrates the supported 4C+ and 2C+ card edge configurations on a 4C+ Primary Connector.

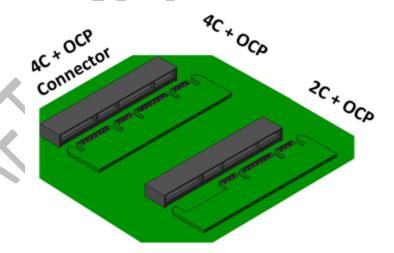


Figure 6: Primary Connector (4C+) with 4C and 2C (SFF) OCP NIC 3.0 Cards

Table 6 summarizes the supported card form factors. SFF cards support the Primary Connector and up to 16 PCIe lanes. LFF cards support implementations with both the Primary and Secondary Connectors and up to 32 PCIe lanes, or a Primary Connector only implementation with up to 16 PCIe lanes.

OCP NIC 3.0 Card **Baseboard Primary Baseboard Secondary** Size and PCIe Lane Connector (4C) Connector (4C+) Count x16 PCle x16 PCle OCP Bay SFF (x8) Not used with SFF 2C+ Card Edge x8 (Lanes 7:0) PCIe OCP Bay SFF (x16) Not used with SFF 4C+ Card Edge x16 (Lanes 15:0) PCIe OCP Bay Not used with LFF 2C+ Card Edge LFF (x8) x8 (Lanes 7:0) PCIe OCP Bay Not used with LFF 4C+ Card Edge x16 (Lanes 15:0) PCIe OCP Bay LFF (x16) LFF (x32) x16 (Lanes 31:16) PCIe x16 (Lanes 15:0) PCIe OCP Bay

Table 6: OCP NIC 3.0 Card Definitions

All mechanical board assemblies shall meet the safety requirements described in Section 7.1.3.

#### 2.1.1 SFF Faceplate Configurations

The SFF configuration views are shown below. Three different faceplates are available for the SFF – a pull tab, ejector latch and an internal lock version are available. The same SFF OCP NIC 3.0 PBA assembly accepts all three faceplates types and may be interchanged depending on the end application. The drawings shown in Figure 7 below illustrate a representative front, side and top views of the SFF.

Where space is permitted on the faceplate, square vents sized to a maximum of 3.0 mm x 3.0 mm must be added to help optimize airflow while maintaining the integrity of the faceplate structure. EMI considerations should also be taken into account during the design process. Refer to the images shown in Figure 8 for example square vent configurations depending on the line side I/O connectors.

Depending on the OCP NIC 3.0 card implementation, I/O connectors may be placed anywhere within the allowable connector keep in regions as defined by the SFF PBA mechanical drawings and faceplate drawings of Section 2.5.1.

The OCP NIC 3.0 outline provides an optional feature to lock the card into the chassis. This is accomplished with two notches – one on each side of the card guide rail. A baseboard may choose to use one or both notches for the internal locking mechanism. The OCP NIC 3.0 outline provides a notch location on both guide rails to provide flexible configurations to baseboard vendors. If a locking feature is implemented on the baseboard, the OCP NIC 3.0 card may only be inserted or removed after actuating the internal locking mechanism. These retention notches are compatible with all chassis implementations. Please refer to the SFF dimensions in Section 2.5.1 for details. The internal locking mechanism is not available on LFF cards.

Note: The OCP NIC 3.0 card supplier shall add port identification on the faceplate assembly that meet their manufacturing and customer requirements.

All of the OCP NIC 3.0 CAD files are available for download and use on the OCP NIC 3.0 Wiki site: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>

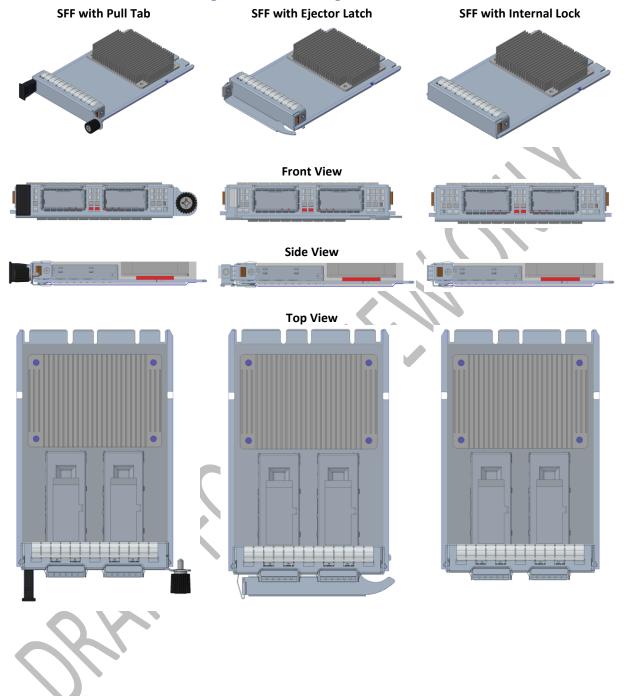


Figure 7: SFF NIC Configuration Views

Figure 8 illustrates example SFF 3D views for the supported line side I/O implementations. The line side I/O implementations are discussed in Section 2.2.

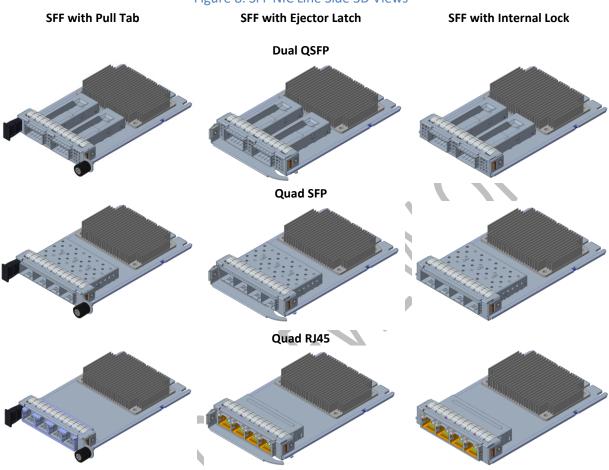


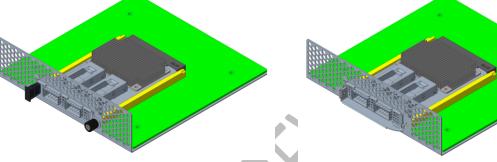
Figure 8: SFF NIC Line Side 3D Views

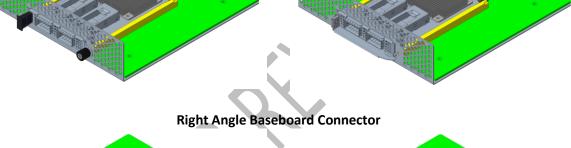
Figure 9 illustrates example SFF 3D views of the pull tab and ejector latch assemblies mounted in a chassis utilizing a straddle mount connector and a right-angle connector. The baseboard connector options are discussed in Section 3.2. The SFF OCP NIC 3.0 card is identical for both chassis connector options.

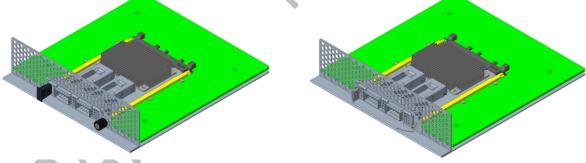
The OCP NIC 3.0 card provides a notch on each side of the card rail edge. This feature is used in conjunction with a baseboard's internal locking mechanism to prevent card insertion and removal. The internal locking mechanism is a baseboard vendor's optional feature and is not shown in the views below.

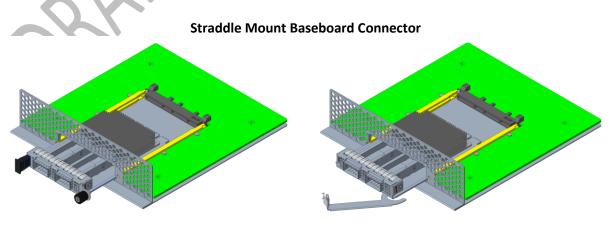
On the internal lock variation only, a 5.4 Kg force with a 1 second ramp may be applied to the heatsink during NIC ejection. The mechanical and thermal solution shall be implemented such that the thermal performance is maintained for 10 force cycles (i.e., the NIC still passes all functional tests). If there exists a minimum of (10 mm x 10 mm x 10 mm) of space behind the line side connectors, then each connector shall be able to sustain the same 5.4 Kg force with a 1 second ramp.

Figure 9: SFF NIC Chassis Mounted 3D Views **SFF with Pull Tab SFF with Ejector Latch** Right Angle vs Straddle Mount Chassis Configuration









#### NIC Insertion / Removal (Shown with a Straddle Mount Connector)

#### 2.1.2 LFF Faceplate Configurations

The LFF configuration views are shown below. A single faceplate implementation is available for the LFF — with a single ejector latch. The long ejector is the default configuration, however, a short ejector version is available for non-shadowed front I/O configurations and is being considered for future development. Similar to the SFF, if additional LFF faceplate implementations become available, the same LFF OCP NIC 3.0 PBA assembly shall be able to accept new faceplate types and may be interchanged depending on the end application. The drawings shown in Figure 10 below illustrate a representative front, side and top views of the LFF.

Where space is permitted on the faceplate, square vents sized to a maximum of 3.0 mm x 3.0 mm must be added to help optimize airflow while maintaining the integrity of the faceplate structure. EMI considerations should also be taken into account during the design process. Refer to the images shown in Figure 11 for example square vent configurations depending on the line side I/O connectors.

Depending on the OCP NIC 3.0 card implementation, I/O connectors may be placed anywhere within the allowable connector keep in regions as defined by the PBA mechanical drawings and faceplate drawings of Section 2.5

Note: The OCP NIC 3.0 card supplier shall add port identification on the faceplate assembly that meet their manufacturing and customer requirements.

All of the OCP NIC 3.0 CAD files are available for download and use on the OCP NIC 3.0 Wiki site: http://www.opencompute.org/wiki/Server/Mezz



LFF with Ejector Latch **Front View** Side View **Top View** 

Figure 10: LFF NIC Configuration Views

Figure 11 illustrates example LFF 3D views for the supported line side I/O implementations. The line side I/O implementations are discussed in Section 2.2.

**LFF with Long Ejector Latch LFF with Short Ejector Latch Non-Shadowed Configuration Shadowed Configuration Dual QSFP Quad SFP** Under development. Quad RJ45 Under development.

Figure 11: LFF NIC Line Side 3D Views

Figure 12 illustrates example LFF 3D views of the ejector latch assembly mounted in a chassis utilizing a straddle mount connector and a right angle connector. The baseboard connector options are discussed in Section 3.2. The LFF OCP NIC 3.0 card is identical for both chassis connector options.

**Right Angle Baseboard Connector Straddle Mount Baseboard Connector** NIC Installed in Baseboard with Right Angle **NIC Installed in Baseboard with Straddle Mount** 

NIC Insertion / Removal (As shown with a Straddle Mount Connector)

Figure 12: LFF NIC Chassis Mounted 3D Views

# 2.2 Line Side I/O Implementations

At the time of this writing, the SFF and LFF implementations have been optimized to support the standard line side I/O implementations shown in Table 7. OCP NIC 3.0 cards may implement a subset of line side connectors and shall stay within the allowed I/O area as depicted in Section 2.4.3 for SFF and Section 2.4.4 for LFF.

| Form Factor | Max Topology Connector Count |
|-------------|------------------------------|
| SFF         | 2x QSFP+/QSFP28              |
| SFF         | 4x SFP+/SFP28                |
| SFF         | 4x RJ45                      |
| LFF         | 2x QSFP+/QSFP28              |
| LFF         | 4x SFP+/SFP28                |
| LFF         | 4x RJ45                      |

Table 7: OCP NIC 3.0 Line Side I/O Implementations

**Note:** For brevity, references to QSFP+, and QSFP28 shall be referred to as QSFP for the remainder of this document. Similarly, references to SFP+, and SFP28 shall be referred to as SFP.

The following specifications may be used to cross reference the associated line side I/O form-factor and module management specifications. This is not an exhaustive list. Refer to Table 3-1 in SFF-8024 – SFF Cross Reference to Industry Products for additional details.

| Form Factor | Pluggable Form-Factor Specification | Common Management Specification |
|-------------|-------------------------------------|---------------------------------|
| SFP         | INF-8074 (MSA)                      | SFF-8472                        |
| SFP+        | SFF-8084                            | SFF-8472                        |
| SFP28       | SFF-8402                            | SFF-8472                        |
| QSFP        | INF-8438 (MSA)                      | SFF-8636                        |
| QSFP+       | SFF-8436                            | SFF-8636                        |
| QSFP28      | SFF-8665                            | SFF-8636                        |

Table 8: Line Side I/O Cross Reference to Industry Standards

SFP and QSFP cables come in passive and active variants. An active cable contains equalization or optical transceiver components. For cards that support active cables, appropriate thermal considerations shall made per Section 6. A passive direct-attach, or RJ45 cable are purely passive elements.

Additional combinations and connector types (such as SFP-DD and QSFP-DD) are permissible as I/O form factor technologies and thermal capabilities evolve.

# 2.3 Top Level Assembly (SFF and LFF)

The images in Figure 13 illustrate the exploded top level assemblies for both the SFF and the LFF.

SFF with Ejector Latch

SFF with Ejector Latch

SFF with Internal Lock

LFF with Ejector Latch

Figure 13: PBA Exploded Views (SFF and LFF)

Diagram callouts #8, and #11 through #15 are installed at the NIC assembly level:

Item #8 and #11 – Wave washer and bushing are part of the ejector latch mechanism.

Item #12 & #13 – Screws used to attach the faceplate assembly to the OCP NIC 3.0 PBA.

Item #14 – 2x SMT nuts installed on to the PBA assembly using the reflow process.

Item #15 – Insulator is located on the secondary side and is installed on the PBA prior to the faceplate.

# 2.4 Faceplate Subassembly (SFF and LFF)

The following section define the generic SFF and LFF faceplates.

## 2.4.1 Faceplate Subassembly – Exploded View

The images in Figure 14 illustrate the three faceplates subassemblies as exploded views. The bill of materials is shown in Section 2.4.2.

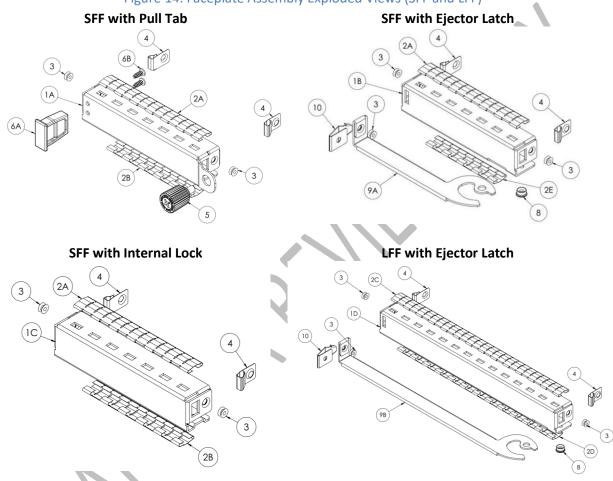


Figure 14: Faceplate Assembly Exploded Views (SFF and LFF)

#### 2.4.2 Faceplate Subassembly – Bill of Materials (BOM)

Table 9 shows the bill of materials for the SFF and LFF assemblies. Item number call outs align with the SFF and LFF numbering of Figure 14.

Note: Dimensionally identical equivalent parts and equivalent materials may be substituted in the assembly. Substituted parts and materials shall meet or exceed the tolerances and requirements specified by the supplier part numbers of Table 9. Refer to the 3D CAD files for hardware specifics not covered by this table.

Table 9: Bill of Materials for the SFF and LFF Faceplate Assemblies

| Item<br># | Item description | Part Number / Drawing                                                                                     | Supplier                                  |
|-----------|------------------|-----------------------------------------------------------------------------------------------------------|-------------------------------------------|
| 1A        | Faceplate        | See Section 2.4.3:                                                                                        | Custom                                    |
| 1B        |                  | 1A NIC_OCPv3_SFF_Faceplate_Pulltab_20190303.pdf                                                           |                                           |
| 1C        |                  | 1B NIC OCPv3 SFF Faceplate Latch 20190719.pdf                                                             |                                           |
| 1D        |                  | 1C NIC_OCPv3_SFF_Faceplate_IntLatch_20190303.pdf                                                          |                                           |
|           |                  | See Section 2.4.4:  1D NIC_OCPv3_LFF_Faceplate_Latch_20190719.pdf                                         | 1                                         |
| 2A        | Top and Bottom   | 2A LT18CJ1921 – 13 fingers (Laird)                                                                        | Laird,                                    |
| 2B        | EMI Fingers      | TF187VE32F11-2.41-08 (Tech-Etch)                                                                          | Tech-ETCH                                 |
| 2C        |                  | 2B LT18CJ1920 – 11 fingers (Laird)                                                                        |                                           |
| 2D        |                  | TF187VE32F11-2.04-08 (Tech-Etch)                                                                          |                                           |
| 2E        |                  | 2C LT18CJ1923 – 27 fingers (Laird)                                                                        |                                           |
|           |                  | TF187VE32F11-5.03-08 (Tech-Etch)                                                                          |                                           |
|           |                  | 2D LT18CJ1922 – 25 fingers (Laird)                                                                        |                                           |
|           |                  | TF187VE32F11-4.66-08 (Tech-Etch)                                                                          |                                           |
|           |                  | 2E LT18CJ4430 – 9 fingers (Laird)                                                                         |                                           |
|           |                  | TF187VE32F11-1.67-08 (Tech-Etch)                                                                          |                                           |
|           |                  | 11 107 V2521 11 1107 00 (Team 21011)                                                                      |                                           |
| 3         | Rivet            | 1-AC-2424-01                                                                                              | Dong Guan KSETT<br>Hardware<br>Technology |
| 4         | Side EMI Fingers | LT18DP1911                                                                                                | Laird                                     |
| 5         | Thumbscrew       | 4C-99-343-K081                                                                                            | Southco, Inc.                             |
| 6A        | Pull tab w/2x    | CN-99-459                                                                                                 | Southco, Inc.                             |
| 6B        | screws           |                                                                                                           | ,                                         |
| 8         | Clinch Nut       | See Section 2.4.8 and drawing                                                                             | Custom                                    |
|           |                  | NIC_OCPv3_ClinchNut_20190719.pdf                                                                          |                                           |
| 9A        | Ejector Handle   | SFF Ejector: See Section 2.4.5 and drawing                                                                | Custom                                    |
| 9B        |                  | 9A NIC_OCPv3_EjectorHandle_Short_20190719.pdf  Note: The SFF ejector is also used on the LFF non-shadowed |                                           |
|           | N                | I/O faceplate configuration.                                                                              |                                           |
|           | OB               | LFF Ejector: See Section 2.4.6 & Drawing  9B NIC_OCPv3_EjectorHandle_Long_20190719.pdf                    |                                           |
| 10        | Ejector Lock     | See Section 2.4.7 and drawing NIC_OCPv3_EjectorLock_20190719.pdf                                          | Custom                                    |
| 11        | N/A              | Item no longer used for drawing call out.                                                                 | N/A                                       |
| 12*       | Screw for        | Phillips screw: ICMMBS200403N                                                                             | WUJIANG Screw                             |
|           | securing         | Torx screw: ITMMAE200402X                                                                                 | Tech Precision                            |
|           | faceplate to NIC |                                                                                                           | Industry                                  |
| 13*       | Screw for        | Phillips screw: FCMMQ200503N                                                                              | WUJIANG Screw                             |
|           | attaching        | Torx screw: FTMMC200502X                                                                                  | Tech Precision                            |
|           | faceplate and    |                                                                                                           | Industry                                  |
|           | ejector to NIC   |                                                                                                           |                                           |

| 14  | SMT nut (on NIC) | 82-950-22-010-05-RL                                            | Fivetech        |
|-----|------------------|----------------------------------------------------------------|-----------------|
|     |                  |                                                                | Technology Inc. |
| 15A | Insulator        | Refer to Section 2.7 for the SFF (15A) and LFF (15B) insulator | Custom          |
| 15B |                  | mechanical requirements                                        |                 |

Note: \* Phillips and Torx screws are allowed. Head types should not be mixed on the same assembly.



#### 2.4.3 SFF Generic I/O Faceplate

Figure 15 shows the standard SFF I/O bracket with a thumbscrew and pull tab assembly.

Figure 15: SFF Generic I/O Faceplate with Pulltab Version (2D View)

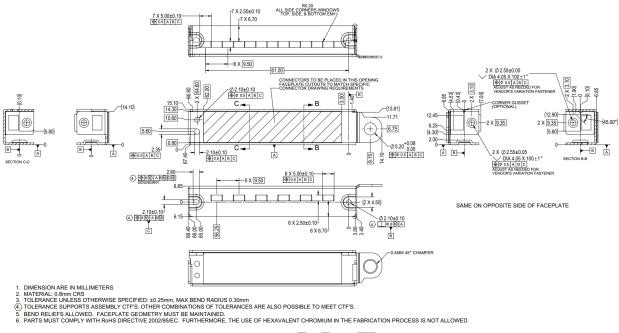
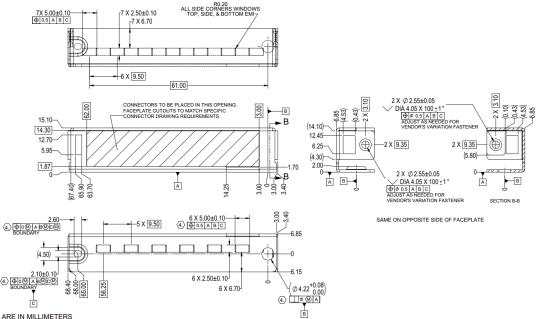


Figure 16: SFF Generic I/O Faceplate iector Version (2D View)



- DIMENSION ARE IN MILLIMETERS MATERIAL: 0.8mm CRS
- TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.25mm, MAX BEND RADIUS 0.30mm
- TOLERANCE SUPPORTS ASSEMBLY CTF'S. OTHER COMBINATIONS OF TOLERANCES ARE ALSO POSSIBLE TO MEET CTF'S.
- BEND RELIEFS ALLOWED. FACEPLATE GEOMETRY MUST BE MAINTAINED.
  PARTS MUST COMPLY WITH RoHS DIRECTIVE 2002/95/EC. FURTHERMORE, THE USE OF HEXAVALENT CHROMIUM IN THE FABRICATION PROCESS IS NOT ALLOWED.

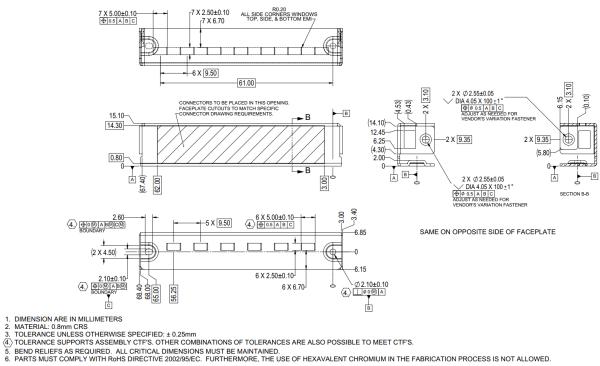
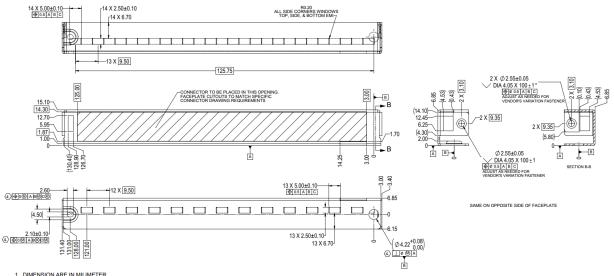


Figure 17: SFF Generic I/O Faceplate – Internal Lock Version (2D View)

#### LFF Generic I/O Faceplate 2.4.4

Figure 18: LFF Generic I/O Faceplate – Ejector Version (2D View)



- 1. DIMENSION ARE IN MILIMETER
  2. MATERIAL: 0.8mm CRS
  3. TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.25mm, MAX BEND RADIUS 0.30mm
  (4) TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.25mm, MAX BEND RADIUS 0.30mm
  (4) TOLERANCE SUPPORTS ASSEMBLY CTFS. OTHER COMBINATIONS OF TOLERANCES ARE ALSO POSSIBLE TO MEET CTFS.
  5. BEND RELIEFS ALLOWED. FACEPLATE GEOMETER MUST BE MAINTAINED. ANY DEVIATIONS MUST BE APPROVED.
  6. PARTS MUST COMPLY WITH ROHS DIRECTIVE 2002/95/EC. FURTHERMORE, THE USE OF HEXAVALENT CHROMIUM IN THE FABRICATION PROCESS IS NOT ALLOWED.

#### 2.4.5 **Ejector Lever (SFF)**

This section defines the SFF lever dimensions. Note: this SFF ejector lever is also used on the nonshadowed LFF faceplate configuration.

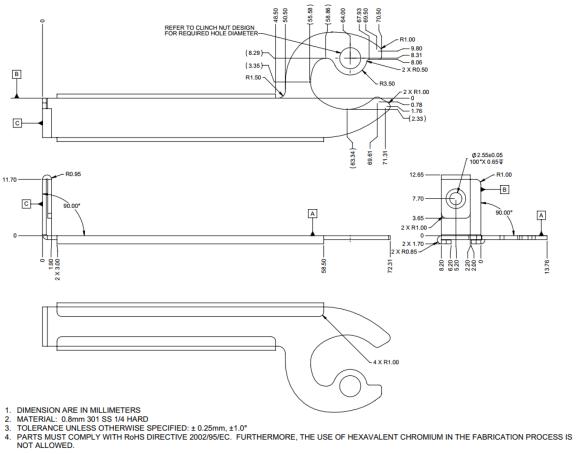
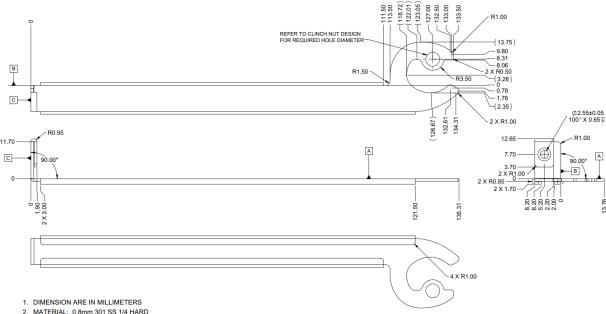


Figure 19: SFF I/O Faceplate – Ejector Lever (2D View)

## 2.4.6 Ejector Levers (LFF)

This section defines the LFF ejector lever dimensions.

Figure 20: LFF I/O Faceplate – Ejector Lever (2D View)



- MATERIAL: 0.8 mm 301 SS 1/4 HARD
  TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.25 mm, ±1.0°
  PARTS MUST COMPLY WITH ROHS DIRECTIVE 2002/95/EC. FURTHERMORE, THE USE OF HEXAVALENT CHROMIUM IN THE FABRICATION PROCESS IS NOT ALLOWED.

## 2.4.7 Ejector Lock (SFF and LFF)

The SFF and LFF ejector uses a locking mechanism at the end of the handle to retain the lever position. This is shown in Figure 21.

Ø2.55±0.05 - 8.00 - 7.03 - 5.32 С - 2.68 C В В

Figure 21: Ejector Lock

- DIMENSION ARE IN MILLIMETERS
  MATERIAL: 0.3mm 301 SS 1/2 HARD
  TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.25mm, ±1.0°
  PARTS MUST COMPLY WITH RoHS DIRECTIVE 2002/95/EC. FURTHERMORE, THE USE OF HEXAVALENT CHROMIUM IN THE FABRICATION PROCESS IS NOT ALLOWED.

#### 2.4.8 Clinch Nut (SFF and LFF)

The SFF and LFF card ejector handle uses a clinch nut as a spacer and rotation anchor. The clinch nut binds the ejector handle to the faceplate. Two clinch nut options are available to accommodate supplier manufacturing processes. These are shown in Figure 22 and Figure 23.

Figure 22: Clinch Nut Option A **CLINCH NUT** LATCH'S LEVER HOLE LATCH'S ASSEMBLY REQUIREMENT ( Ø4.40) Ø2.40 Ø3.78 0.89 DIMENSION ARE IN MILLIMETERS
 MATERIAL: 300 SERIES STAINLESS STEEL
 FINISHING: PASSIVATION
 NON-HEAT TREATMENT Ø3.90 . NON-HEAT I TRAITMENT TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.10mm, ±1.0° REFERENCE PART: PEM DSOS-M3-6.35 PARTS MUST COMPLY WITH ROHS DIRECTIVE 2002/95/EC. FURTHERMORE, THE USE OF HEXAVALENT CHROMIUM IN THE FABRICATION PROCESS IS SECTION C-C SCALE 20:1 Figure 23: Clinch Nut Option B **CLINCH NUT** LATCH'S LEVER HOLE & CHAMFER LATCH'S ASSEMBLY REQUIREMENT the same Ø4.20±0.05 Ø3.80±0.05 . DIMENSION ARE IN MILLIMETERS
. MATERIAL: 300 SERIES STAINLESS STEEL
. FINISHING: PASSIVATION
. NON-HEAT TREATMENT
. TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.10mm, ±1.0° SECTION E-E SCALE 20:1 REFERENCE PART: PEM DSOS-M3-6.35
PARTS MUST COMPLY WITH ROHS DIRECTIVE 2002/95/EC. FURTHERMORE,
THE USE OF HEXAVALENT CHROMIUM IN THE FABRICATION PROCESS IS
NOT ALLOWED.

## 2.5 Card Keep Out Zones

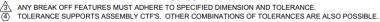
## 2.5.1 SFF Keep Out Zones

Figure 24: SFF Keep Out Zone - Top View CONNECTOR KEEP IN ZONE REPRESENT MAXIMUM CONNECTOR'S BODYKEEP IN. NOT INCLUDING EMI SPRING FINGERS. COMPONENT AND TRACE FREE AREA, TOP & BOTTOM LAYERS, TRACE PERMITTED ON INTERNAL LAYERS UP TO 1MM MAX FROM PCB EDGE SMT COMPONENT IS PERMITTED IN THIS AREA WHERE CONNECTOR IS NOT OCCUPIED. CONNECTOR PROTRUSION 
CONNECTOR
PROTRUSION FROM PCB EL
R145 5.0±0.5

SFP 4.5±0.5 FROM PCB EDGE - 115.00 -2 X 109.76 103.00 2.75 7.00 G REFERENCE SFF-TA-1002 CONNECTOR SPEC - € of DATUM - H (63.475) ⊕ 0.15 D G H 3 76.00 65.00 59.10 of DATUM - F C 2.75 H COMPONENT KEEP IN 2 X Ø5.50 PLATED PAD — FOR GROUNDING COMPONENT AND TRACE FREE AREA, TOP & BOTTOM LAYERS, TRACE PERMITTED ON INTERNAL LAYERS UP TO 1MM MAX FROM PCB EDGE— 2 X Ø 3.20<sup>+0.08</sup> PTH – (4) • Ø 0.15 • D H G



- NOTES:
  1. UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS
  2. TOLERANCE UNLESS OTHERWISE SPECIFIED: ±0.13, ±1°



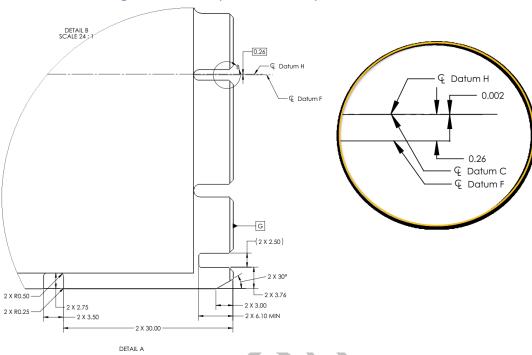
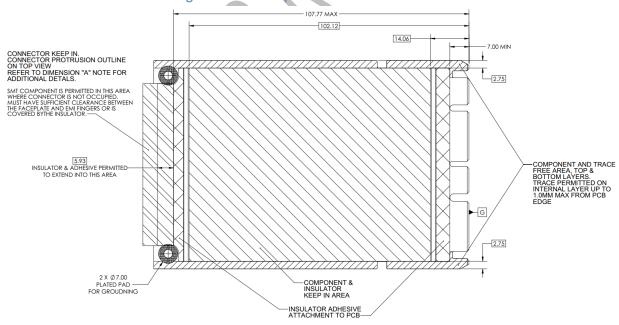


Figure 25: SFF Keep Out Zone - Top View - Detail A





NOTES: 1. UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS 2. TOLERANCE UNLESS OTHERWISE SPECIFIED:  $\pm0.13$ ,  $\pm1.0^{\circ}$ 

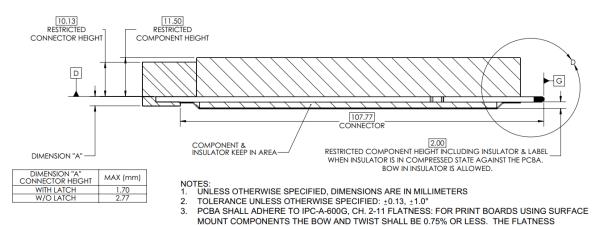


Figure 27: SFF Keep Out Zone – Side View

**Note:** The area defined by DIMENSION "A" is between the faceplate and the primary side of the board. Grounded through-hole mounting pins are permitted but should avoid making contact with the latching mechanism and EMI fingers. Signal pins are not permitted in this area.

MEASUREMENT IS DEFINED ACCORDING TO IPC-TM-650 2.4.22

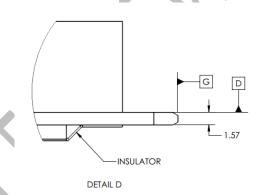
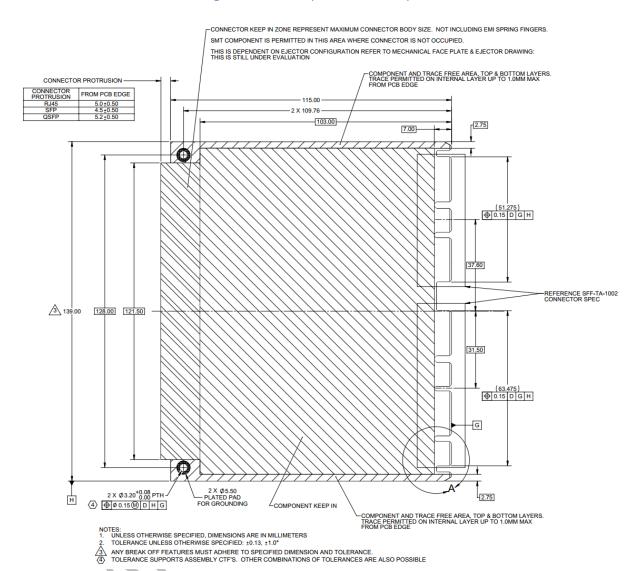


Figure 28: SFF Keep Out Zone - Side View - Detail D

## 2.5.2 LFF Keep Out Zones

Figure 29: LFF Keep Out Zone – Top View



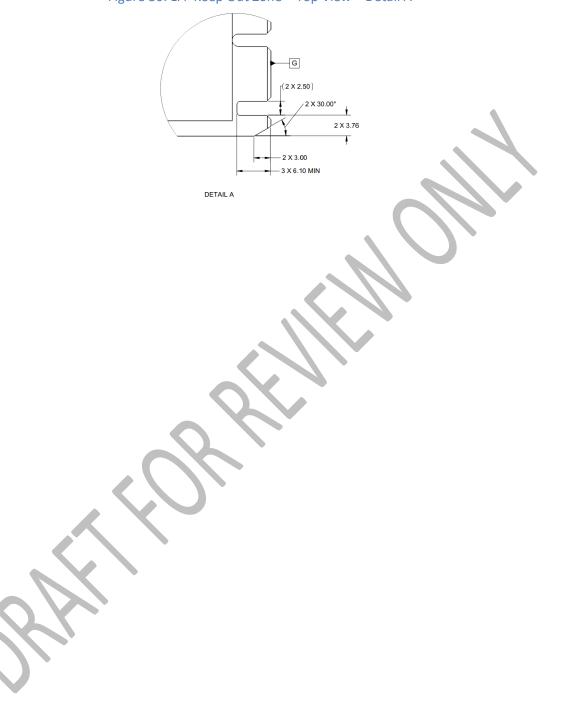


Figure 30: LFF Keep Out Zone – Top View – Detail A

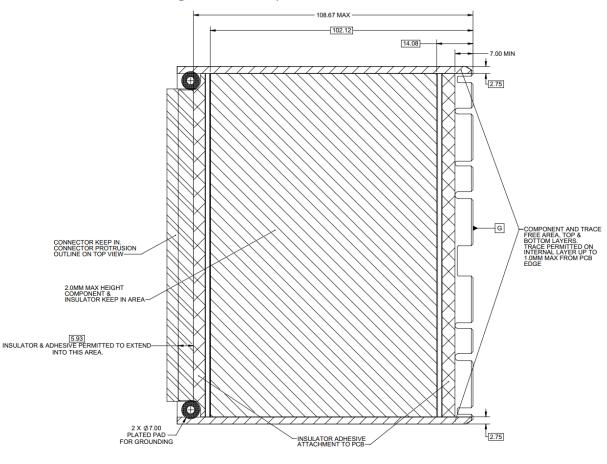
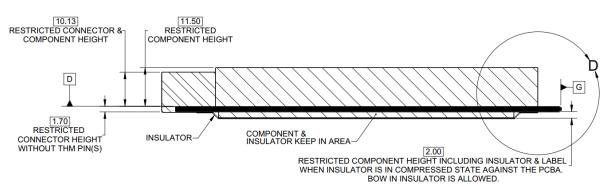


Figure 31: LFF Keep Out Zone - Bottom View

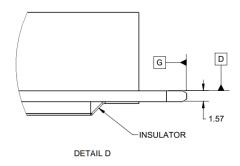
NOTES:
1. UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS
2. TOLERANCE UNLESS OTHERWISE SPECIFIED: ±0.13, ±1.0°





- NOTES:
  1. UNLESS OTHERWISE SPECIFIED, DIMENSIONS ARE IN MILLIMETERS
- TOLERANCE UNLESS OTHERWISE SPECIFIED: ±0.13, ±1.0°
- PCBA SHALL ADHERE TO IPC-A-600G, CH. 2-11 FLATNESS: FOR PRINT BOARDS USING SURFACE MOUNT COMPONENTS THE BOW AND TWIST SHALL BE 0.75% OR LESS. THE FLATNESS MEASUREMENT IS DEFINED ACCORDING TO IPC-TM-650 2.4.22

Figure 33: LFF Keep Out Zone – Side View – Detail D



# 2.6 Baseboard Keep Out Zones

Refer to the 3D CAD files for the baseboard keep out zones for both the SFF and LFF designs. The 3D CAD files are available for download on the OCP NIC 3.0 Wiki:

http://www.opencompute.org/wiki/Server/Mezz



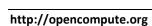
## 2.7 Insulation Requirements

All OCP NIC 3.0 cards shall implement an insulator to prevent the bottom side card components from shorting out to the baseboard chassis. The recommended insulator thickness is 0.25 mm and shall reside within the following mechanical envelope for the SFF and LFF. An alternate insulator thickness of 0.127 mm is permitted. The total stack up height of the secondary side components, insulator and the labels shall not exceed the 2 mm keep-in dimension as shown in Section 2.7.1 and 2.7.2.

A maximum of four circular holes with a 4 mm maximum diameter are permitted for access to mechanical retention components. Any components exposed by these holes must be non-conductive.

#### 2.7.1 SFF Insulator

Figure 34: SFF Bottom Side Insulator (3D View)



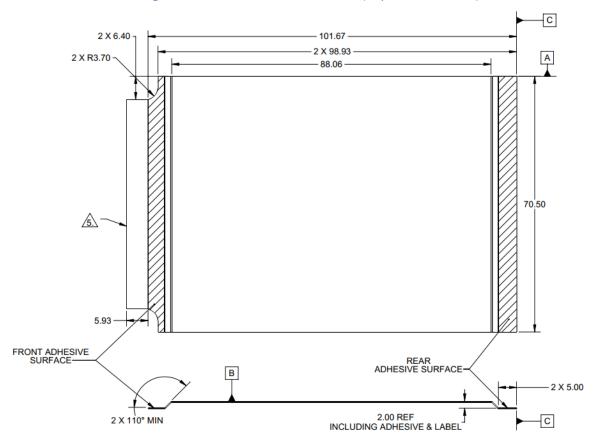


Figure 35: SFF Bottom Side Insulator (Top and Side View)

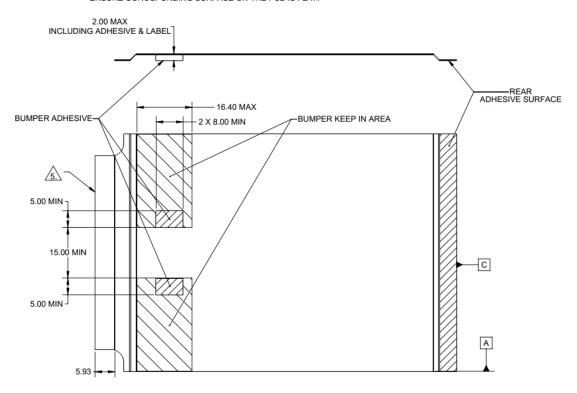
- DIMENSIONS ARE IN MILLIMETERS
  MATERIAL:

  1. FORMEX GK-10BK or FORMEX N3 (HALOGEN FREE, BLACK OR NATURAL), 0.25mm THICKNESS
  2. FORMEX GK-5BK (HALOGEN FREE, BLACK), 0.127mm THICKNESS
  MATERIAL SHALL CONFORM TO 94VTM-0
  ADHESIVE 3M 467MP 0.05mm THICKNESS

- FRONT EDGE OF INSULATOR AND ADHESIVE MAY EXTEND TO 107.60MM IF NECESSARY TO PROTECT LEDS ON SECONDARY SIDE OF PCBA.
- TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.30mm, ±1.0°

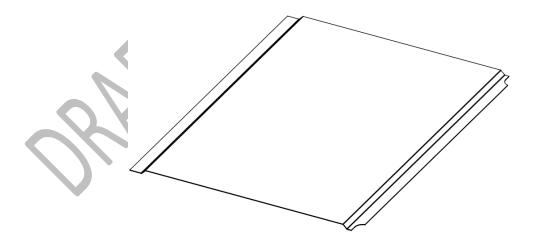
Figure 36: SFF Bottom Side Insulator (alternate) (Top and Side View)

ALTERNATE OPTION USING BUMPER & ADHESIVE FOR ATTACHING THE INSULATOR TO PCB INSTEAD OF USING FRONT ADHESIVE SURFACE. ENSURE COROSPONDING SURFACE ON THE PCB IS FLAT.



## 2.7.2 LFF Insulator

Figure 37: LFF Bottom Side Insulator (3D View)



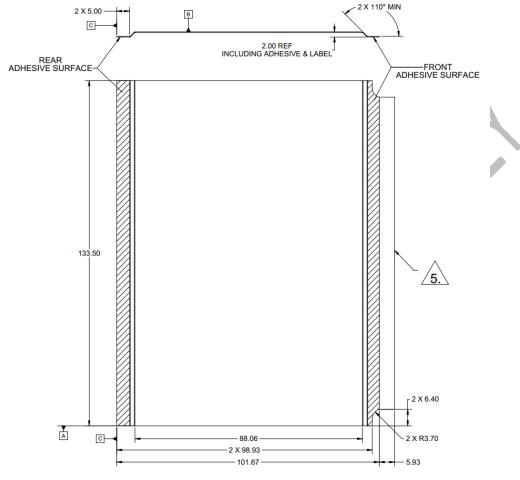


Figure 38: LFF Bottom Side Insulator (Top and Side View)

- DIMENSION ARE IN MILLIMETERS
  MATERIAL: FORMEX GK-10BK, FORMEX N3 (HALOGEN FREE, BLACK OR NATURAL), 0.25mm THICKNESS
  MATERIAL SHALL CONFORM TO 94VTM-0
  ADHESIVE 3M 467MP 0.05mm THICKNESS

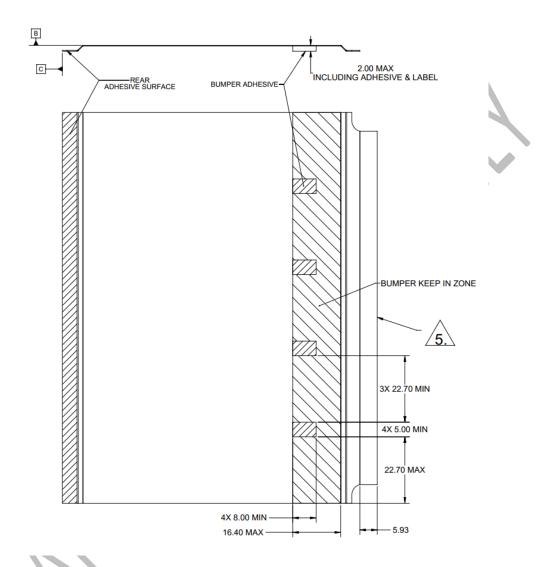
- 4. ADHESIVE 3M 467MP 0.05mm THICKNESS

  FRONT EDGE OF INSULATOR AND ADHESIVE MAY EXTEND TO 107.60MM IF NECESSARY TO PROTECT LEDS ON SECONDARY SIDE OF PCBA.

  6. TOLERANCE UNLESS OTHERWISE SPECIFIED: ± 0.30mm, ±1.0°

Figure 39: LFF Bottom Side Insulator (alternate) (Top and Side View)

ALTERNATE OPTION USING BUMPER & ADHESIVE FOR ATTACHING THE INSULATOR TO PCB INSTEAD OF USING FRONT ADHESIVE SURFACE. ENSURE CORROSPONDING SURFACE ON PCB IS FLAT



## 2.8 Critical-to-Function (CTF) Dimensions (SFF and LFF)

## 2.8.1 CTF Tolerances

The following CTF tolerances are used in this section and are the same for both the SFF and LFF.

Table 10: CTF Default Tolerances (SFF and LFF OCP NIC 3.0)

| CTF DEFAULT TOLERANCES    |                             |  |
|---------------------------|-----------------------------|--|
| DIMENSION RANGE TOLERANCE |                             |  |
|                           | TWO PLACE<br>DECIMALS: X.XX |  |
| LINEAR:                   | ± 0.30                      |  |
| ANGULAR:                  | ± 1.00 DEGREES              |  |
| HOLE DIAMETER:            | ± 0.13                      |  |

#### 2.8.2 SFF Pull Tab CTF Dimensions

The following dimensions are considered critical-to-function (CTF) for each SFF OCP NIC 3.0 card with a pull tab and thumbscrew. The CTF default tolerances are shown in Section 2.8.1.

Figure 40: SFF OCP NIC 3.0 Card with Pull Tab CTF Dimensions (Top View)

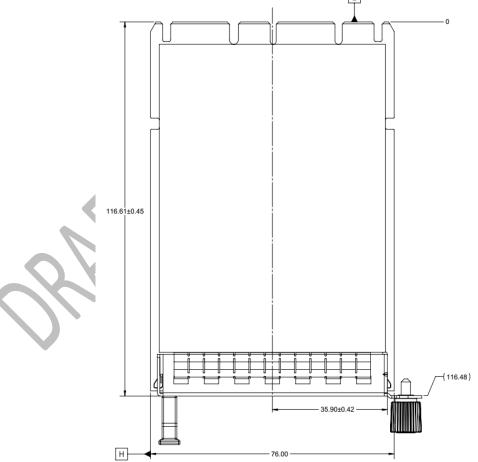


Figure 41: SFF OCP NIC 3.0 Card with Pull Tab CTF Dimensions (Front View)

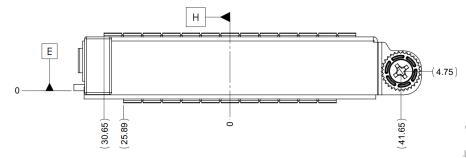
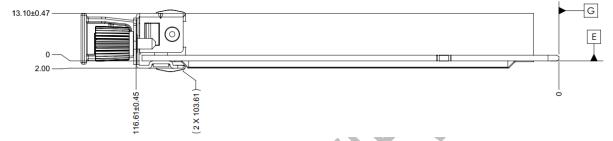


Figure 42: SFF OCP NIC 3.0 Card with Pull Tab CTF Dimensions (Side View)



## 2.8.3 SFF Ejector Latch CTF Dimensions

The following dimensions are considered critical-to-function (CTF) for each SFF OCP NIC 3.0 card with an ejector latch. The CTF default tolerances are shown in Section 2.8.1.

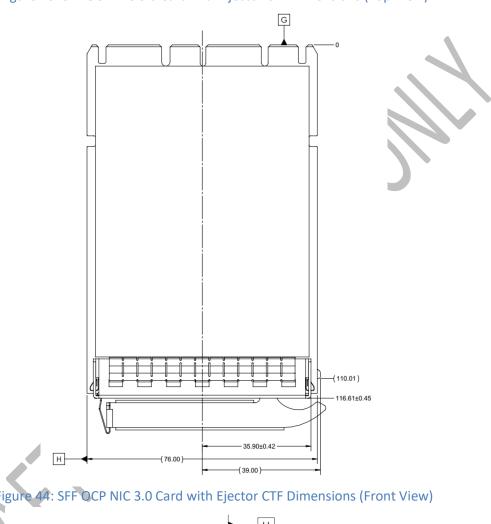
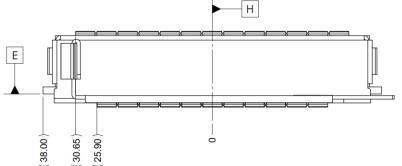


Figure 43: SFF OCP NIC 3.0 Card with Ejector CTF Dimensions (Top View)





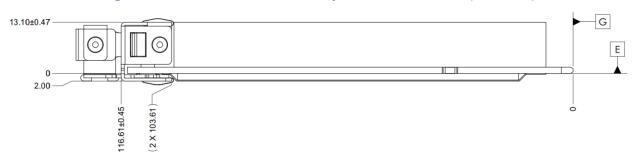


Figure 45: SFF OCP NIC 3.0 Card with Ejector CTF Dimensions (Side View)

#### 2.8.4 SFF Internal Lock CTF Dimensions

The following dimensions are considered critical-to-function (CTF) for each SFF OCP NIC 3.0 card with an internal lock. The CTF default tolerances are shown in Section 2.8.1.

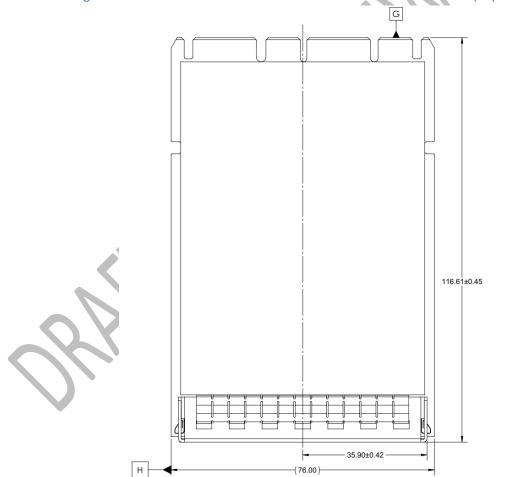


Figure 46: SFF OCP NIC 3.0 Card with Internal Lock CTF Dimensions (Top View)

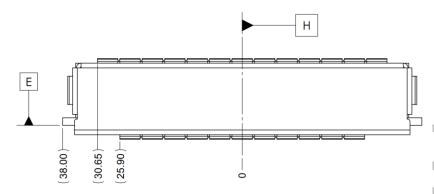


Figure 47: SFF OCP NIC 3.0 Card with Internal Lock CTF Dimensions (Front View)





#### 2.8.5 SFF Baseboard CTF Dimensions

The following dimensions are considered critical-to-function (CTF) for each SFF baseboard chassis. The CTF default tolerances are shown in Section 2.8.1.

Note: The SFF baseboard CTF dimensions are applicable to both the right angle and straddle mount connector configurations. The faceplate opening relative to the baseboard changes due to the connector vertical offset, but all CTF dimensions remain identical.

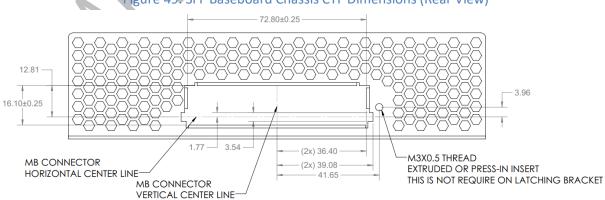


Figure 49 SFF Baseboard Chassis CTF Dimensions (Rear View)

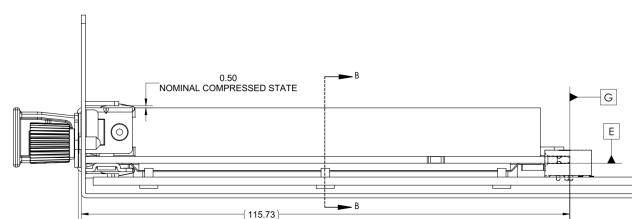


Figure 50: SFF Baseboard Chassis to Card Thumb Screw CTF Dimensions (Side View)

Figure 51: SFF Baseboard Chassis to Ejector lever Card CTF Dimensions (Side View)

<del>(</del> 116.48 )

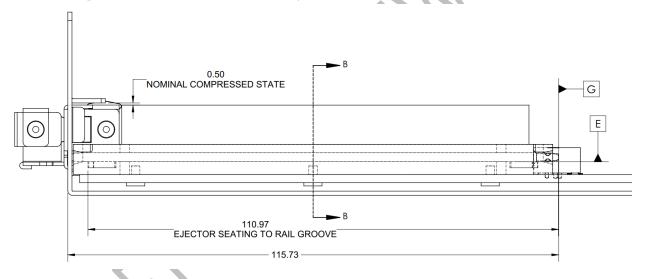


Figure 52: SFF Baseboard Chassis CTF Dimensions (Rear Rail Guide View)

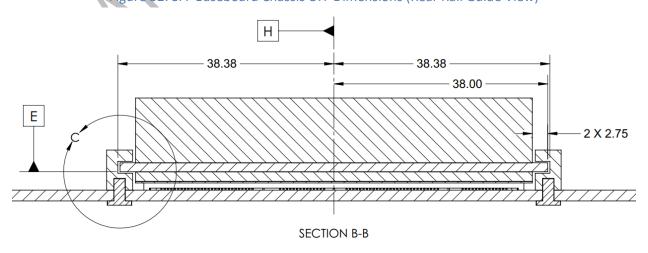
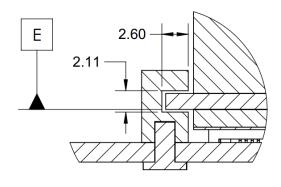
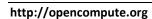


Figure 53: SFF Baseboard Chassis CTF Dimensions (Rail Guide Detail) – Detail C



**DETAIL C** 

The right angle and straddle mount card guides are identical between the SFF and LFF cards. The card guide model is included in the 3D CAD packages and may be downloaded from the OCP NIC 3.0 Wiki site: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>.



## 2.8.6 LFF Ejector Latch CTF Dimensions

The following dimensions are considered critical-to-function (CTF) for each LFF OCP NIC 3.0 card. The CTF default tolerances are shown in Section 2.8.1.

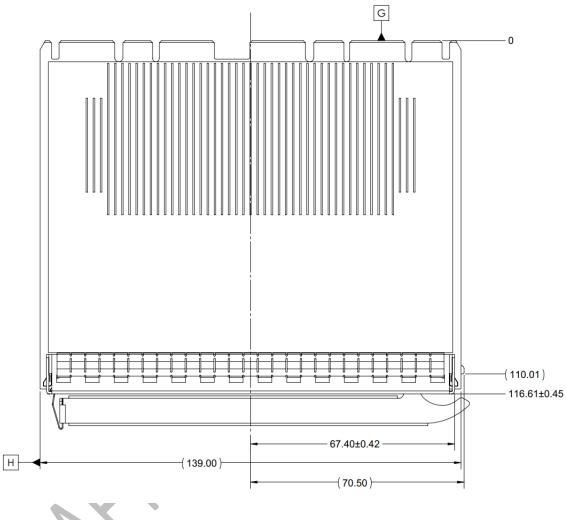
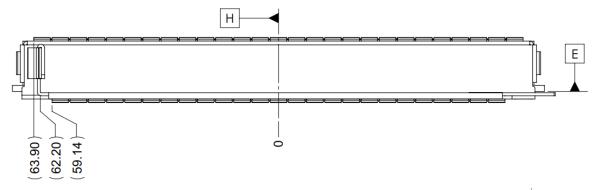


Figure 54: LFF OCP NIC 3.0 Card with Ejector CTF Dimensions (Top View)





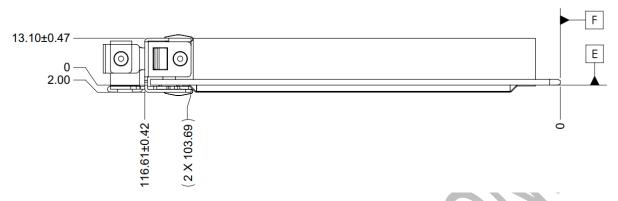


Figure 56: LFF OCP NIC 3.0 Card with Ejector CTF Dimensions (Side View)

#### 2.8.7 LFF Baseboard CTF Dimensions

The following dimensions are considered critical-to-function (CTF) for each LFF baseboard chassis. The CTF default tolerances are shown in Section 2.8.1.

Note: The LFF baseboard CTF dimensions are applicable to both the right angle and straddle mount connector configurations. The faceplate opening relative to the baseboard changes due to the connector vertical offset, but all CTF dimensions remain identical.

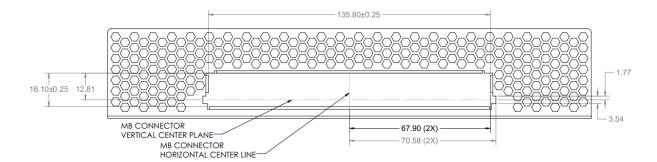


Figure 57: LFF Baseboard Chassis CTF Dimensions (Rear View)

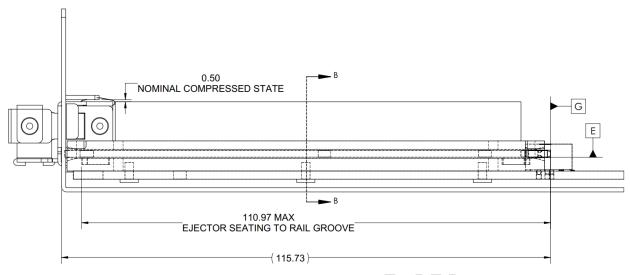
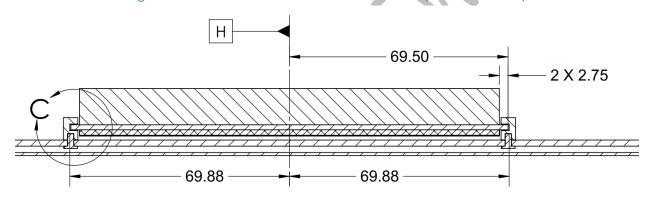
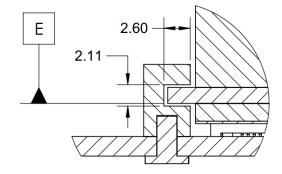


Figure 58: LFF Baseboard Chassis CTF Dimensions (Side View)

Figure 59: LFF Baseboard Chassis CTF Dimensions (Rail Guide View)



\_SECTION B-B Figure 60: LFF Baseboard Chassis CTF Dimensions (Rail Guide – Detail C)



**DETAIL C** 

The right angle and straddle mount card guides are identical between the SFF and LFF. The card guide models are included in the 3D CAD packages and may be downloaded from the OCP NIC 3.0 Wiki site: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>.



## 2.9 Labeling Requirements

OCP NIC 3.0 cards shall implement all (or a subset of) label items listed below as required by each customer. All labels shall be placed on the exposed face of the insulator and within their designated zones. All labels shall be placed within the insulator edge and insulator bend lines to prevent labels from peeling or interfering with the faceplate, chassis card guides and card gold finger edge.

The insulator shall be divided into three different zones:

- **Regulatory Zone** Used for all regulatory markings and filing numbers
- Customer Zone Used for manufacturer markings or any ODM specific labels
- OCP NIC 3.0 Zone Used for MAC addresses, part number labels and optionally the board serial number label if there are no manufacturer requirements to place it on the primary side

#### Notes:

- Some NIC vendor(s) may require serial number labels to be placed on the primary side of the PBA. This is permitted but it is up to the NIC vendor(s) to find the appropriate location(s) to affix the label. If a label is to be adhered to the PCB, then the label must be ESD safe as defined by ANSI/ESD S541-2008 (between 10<sup>4</sup> and 10<sup>11</sup> Ohms).
- Regulatory marks may be printed on the insulator or affixed via a label
- Each zone size shall be adjustable to accommodate each vendor's labeling requirements
- All labels shall be oriented and readable in the same direction. The readable direction should be with the line side I/O interfaces facing "up"
- Additional labels may be placed on the primary side or on the PCB itself. This is up to the NIC vendor(s) to find the appropriate location(s)

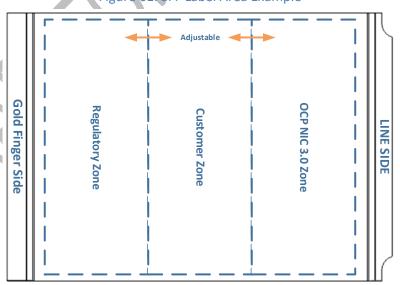


Figure 61: SFF Label Area Example

#### 2.9.1 General Guidelines for Label Contents

Each board shall have a unique label for identification. The label information shall be both in human readable and machine readable formats (linear or 2D data matrix). The labels may include:

- Serial number
- Part Number
- MAC Address
- Manufacturing Date
- Manufacturing Site Information

#### **Barcode Requirements**

- Linear Barcodes
- Code 93, Code 128 Auto or Code 128 Subset B
- Minimum narrow bar width X ≥5 mil (0.127 mm)
- 2D data matrix
- Data matrix shall use ECC200 error correction
- Minimum cell size X ≥10 mil (0.254 mm)
- All linear barcode and data matrix labels shall meet the contrast and print growth requirements per ISO/IEC 16022
- All linear barcode and data matrix labels shall have a quality level C or higher per ISO/IER 15415
- All linear barcode and data matrix labels shall define a minimum Quiet Zone (QZ) to ensure the label is correctly registered by the scanner per ISO/IEC 15415
- Linear barcode labels shall use a QZ that is 10 times the width of the narrowest bar or 1/8<sup>th</sup> inch, whichever is greater
- Data matrix labels shall have a Quiet Zone (QZ) that is at least one module (in the X-dimension) around the perimeter of the data matrix
- Multiple Serial Numbers, MAC address may exist in one 2D data matrix, each separated by a comma

#### Human Readable Font

- Arial or printer font equivalent
- Minimum 5 point font size. 3 point font is acceptable when using 600 DPI printers
- Text must be easily legible under normal lighting 6-to-8 inches away

The label size and typeface may vary based on each vendor and/or customer's label content and requirements.

#### 2.9.2 MAC Address Labeling Requirements

For an OCP NIC 3.0 card with *m* line side interfaces and *n* RBT management interfaces, the MAC address label shall list the MAC addresses in sequential order starting with line side port 1 to port *m* followed by the controller #0 MAC address to controller *n*. For cards that support multi-host configurations, the label shall associate each MAC address with a host number. The examples below show the MAC addresses presented as a single column, for labels with many MAC addresses, the label may also be formatted in multiple columns for greater readability. Labels may optionally use ellipses for the human readable text to individually indicate a range of Port and ME MAC addresses. In all cases, the 2D data matrix shall include all the card assigned MAC addresses.

## 2.9.2.1 MAC Address Label Example 1 – Quad Port with Single Host, Single Managed Controller

As an example, the label content of a quad SFP OCP NIC 3.0 card with a single management MAC address shall be constructed to show human readable data per the Label Data column of Table 11. The constructed label is shown in Figure 62. For each human readable line, there is a MAC prefix "Px:" for a line side Port, or "MEx:" for a managed controller instance, followed by the MAC address. The port/controller association for each row is shown in the far right column.

| Table 11: MAC Address | Label Example 1 | <ul> <li>Quad Port with</li> </ul> | Single Host, Singl | e Managed Controller |
|-----------------------|-----------------|------------------------------------|--------------------|----------------------|
|                       |                 |                                    |                    |                      |

| Label Data             | MAC Prefix | MAC Address       | Association   |
|------------------------|------------|-------------------|---------------|
| P1: AA:BB:CC:DD:EE:F0  | P1:        | AA:BB:CC:DD:EE:F0 | Port 1        |
| P2: AA:BB:CC:DD:EE:F1  | P2:        | AA:BB:CC:DD:EE:F1 | Port 2        |
| P3: AA:BB:CC:DD:EE:F2  | P3:        | AA:BB:CC:DD:EE:F2 | Port 3        |
| P4: AA:BB:CC:DD:EE:F3  | P4:        | AA:BB:CC:DD:EE:F3 | Port 4        |
| ME1: AA:BB:CC:DD:EE:F4 | ME1:       | AA:BB:CC:DD:EE:F4 | Controller #0 |

Figure 62: MAC Address Label Example 1 – Quad Port with Single Host, Single Managed Controller



P1: AA:BB:CC:DD:EE:F0 P2: AA:BB:CC:DD:EE:F1 P3: AA:BB:CC:DD:EE:F2 P4: AA:BB:CC:DD:EE:F3 ME1: AA:BB:CC:DD:EE:F4

#### 2.9.2.2 MAC Address Label Example 2 – Octal Port with Single Host, Dual Managed Controllers

As a second example, the label content of an octal port (2xQSFP with "breakout" support) OCP NIC 3.0 card with two managed silicon instances is constructed per Table 12. The constructed label is shown in Figure 63. The MAC address label shall also list the four MAC addresses associated with QSFP lanes [1:4] for QSFP connectors that allow "breakout" modes. The Host-MAC address presentation may also be formatted horizontally for easier readability.

Table 12: MAC Address Label Example 2 – Octal Port with Single Host, Dual Managed Controller

| Label Data             | MAC Prefix | MAC Address       | Association   |
|------------------------|------------|-------------------|---------------|
| P1: AA:BB:CC:DD:EE:F0  | P1:        | AA:BB:CC:DD:EE:F0 | QSFP1, Port 1 |
| P2: AA:BB:CC:DD:EE:F1  | P2:        | AA:BB:CC:DD:EE:F1 | QSFP1, Port 2 |
| P3: AA:BB:CC:DD:EE:F2  | P3:        | AA:BB:CC:DD:EE:F2 | QSFP1, Port 3 |
| P4: AA:BB:CC:DD:EE:F3  | P4:        | AA:BB:CC:DD:EE:F3 | QSFP1, Port 4 |
| P5: AA:BB:CC:DD:EE:F4  | P5:        | AA:BB:CC:DD:EE:F4 | QSFP2, Port 5 |
| P6: AA:BB:CC:DD:EE:F5  | P6:        | AA:BB:CC:DD:EE:F5 | QSFP2, Port 6 |
| P7: AA:BB:CC:DD:EE:F6  | P7:        | AA:BB:CC:DD:EE:F6 | QSFP2, Port 7 |
| P8: AA:BB:CC:DD:EE:F7  | P8:        | AA:BB:CC:DD:EE:F7 | QSFP2, Port 8 |
| ME1: AA:BB:CC:DD:EE:F8 | ME1:       | AA:BB:CC:DD:EE:F8 | Controller #0 |
| ME2: AA:BB:CC:DD:EE:F9 | ME2:       | AA:BB:CC:DD:EE:F9 | Controller #1 |

Figure 63: MAC Address Label Example 2 – Octal Port with Single Host, Dual Managed Controller



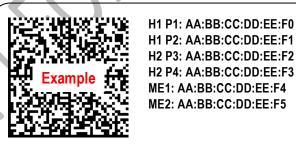
#### 2.9.2.3 MAC Address Label Example 3 – Quad Port with Dual Hosts, Dual Managed Controllers

For multi-host implementations, each MAC address shall be prefixed with the host association "Hx" prior to the port number, where x represents the host number. An example of this is shown in Table 13 and Figure 64.

Table 13: MAC Address Label Example 3 – Quad Port with Dual Hosts, Dual Managed Controller

| Label Data             | Host | MAC Prefix | MAC Address       | Association   |
|------------------------|------|------------|-------------------|---------------|
| P1: AA:BB:CC:DD:EE:F0  | H1   | P1:        | AA:BB:CC:DD:EE:F0 | Port 1        |
| P2: AA:BB:CC:DD:EE:F1  | H1   | P2:        | AA:BB:CC:DD:EE:F1 | Port 2        |
| P3: AA:BB:CC:DD:EE:F2  | H2   | P3:        | AA:BB:CC:DD:EE:F2 | Port 3        |
| P4: AA:BB:CC:DD:EE:F3  | H2   | P4:        | AA:BB:CC:DD:EE:F3 | Port 4        |
| ME1: AA:BB:CC:DD:EE:F4 | n/a  | ME1:       | AA:BB:CC:DD:EE:F4 | Controller #0 |
| ME2: AA:BB:CC:DD:EE:F5 | n/a  | ME2:       | AA:BB:CC:DD:EE:F5 | Controller #1 |

Figure 64: MAC Address Label Example 3 – Quad Port with Dual Hosts, Dual Managed Controllers



#### 2.9.2.4 MAC Address Label Example 4 – Singe Port with Quad Host, Single Managed Controller

The following example shows a single port device with quad hosts. To conserve space on the MAC address label, this example only shows the MAC addresses for Port 1 through Port 4. The MAC address for each managed host is Px+1. This is shown in Table 14 and Figure 65.

Table 14: MAC Address Label Example 4 – Single Port with Quad Host, Single Managed Controller

| Label Data             | Host | MAC Prefix | MAC Address       | Association |
|------------------------|------|------------|-------------------|-------------|
| P1: AA:BB:CC:DD:EE:F0  | H1   | P1:        | AA:BB:CC:DD:EE:F0 | Port 1      |
| ME1: AA:BB:CC:DD:EE:F1 | ME1  | P1:        | AA:BB:CC:DD:EE:F1 | Port 1      |
| P2: AA:BB:CC:DD:EE:F2  | H2   | P1:        | AA:BB:CC:DD:EE:F2 | Port 1      |
| ME2: AA:BB:CC:DD:EE:F3 | ME2  | P1:        | AA:BB:CC:DD:EE:F3 | Port 1      |
| P3: AA:BB:CC:DD:EE:F4  | H3   | P1:        | AA:BB:CC:DD:EE:F4 | Port 1      |
| ME3: AA:BB:CC:DD:EE:F5 | ME3  | P1:        | AA:BB:CC:DD:EE:F5 | Port 1      |
| P4: AA:BB:CC:DD:EE:F6  | H4   | P1:        | AA:BB:CC:DD:EE:F6 | Port 1      |
| ME4: AA:BB:CC:DD:EE:F7 | ME4  | P1:        | AA:BB:CC:DD:EE:F7 | Port 1      |

Figure 65: MAC Address Label Example 4 – Single Port with Quad Host, Single Managed Controller



H1 P1: AA:BB:CC:DD:EE:F0 H2 P1: AA:BB:CC:DD:EE:F2 H3 P1: AA:BB:CC:DD:EE:F4 H4 P1: AA:BB:CC:DD:EE:F6

Table 15: MAC Address Label Example 5 – Octal Port with Single Host, Octal Managed Controller

| Label Data             | MAC Prefix | MAC Address       | Association |
|------------------------|------------|-------------------|-------------|
| P1: AA:BB:CC:DD:EE:F0  | P1:        | AA:BB:CC:DD:EE:F0 | Port 1      |
| P8: AA:BB:CC:DD:EE:F7  | P8:        | AA:BB:CC:DD:EE:F1 | Port 8      |
| ME1: AA:BB:CC:DD:EE:F8 | ME1:       | AA:BB:CC:DD:EE:F8 | P1          |
| ME8: AA:BB:CC:DD:EE:FF | ME8:       | AA:BB:CC:DD:EE:FF | P8          |

Figure 66: MAC Address Label Example 5 – Octal Port with Single Host, Octal Managed Controller



P1: AA:BB:CC:DD:EE:F0

P8: AA:BB:CC:DD:EE:F7

ME1: AA:BB:CC:DD:EE:F8

...

ME8: AA:BB:CC:DD:EE:FF

Figure 66 illustrates the use of ellipses in the human readable text to individually indicate a range of Port and Management MAC addresses. In this example, the 2D data matrix shall contain all 16 MAC addresses.

## **2.10 Mechanical CAD Package Examples**

Typical OCP NIC 3.0 implementation examples are included in the 3D CAD package. The purpose of these examples is to demonstrate the implementation feasibility. Additional use cases beyond the implementation examples are possible as long they adhere to the OCP NIC 3.0 specification.

**Note:** For brevity, references to QSFP+, and QSFP28 shall be referred to as QSFP in this document. Similarly, references to SFP+, and SFP28 shall be referred to as SFP.

The 3D CAD files may be obtained from the OCP NIC 3.0 Wiki: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>

Table 16: NIC Implementation Examples and 3D CAD

| Implementation Example     | 3D CAD File name              |
|----------------------------|-------------------------------|
| SFF Single/Dual QSFP ports | 01_nic_v3_sff2q_1tab_asm.stp  |
|                            | 01_nic_v3_sff2q_latch_asm.stp |
| SFF Single/Dual SFP ports  | N/A                           |
| SFF Quad SFP ports         | 01_nic_v3_sff4s_1tab_asm.stp  |
|                            | 01_nic_v3_sff4s_latch_asm.stp |
| SFF Quad 10GBASE-T ports   | 01_nic_v3_sff4r_1tab_asm.stp  |
|                            | 01_nic_v3_sff4r_latch_asm.stp |
| LFF Single/Dual QSFP ports | 01_nic_v3_lff2q_asm.stp       |
| LFF Single/Dual SFP ports  | N/A                           |
| LFF Quad SFP ports         | 01_nic_v3_lff4s_asm.stp       |
| LFF Quad 10GBASE-T ports   | 01_nic_v3_lff4r_asm.stp       |

# 3 Electrical Interface Definition – Card Edge and Baseboard

## 3.1 Card Edge Gold Finger Requirements

The OCP NIC 3.0 cards are compliant to the SFF-TA-1002 specification with respect to the gold fingers and connectors.

SFF cards fit in the Primary Connector. Primary Connector compliant cards are 76 mm x 115 mm and may implement the full 168-pins. The Primary Connector cards may optionally implement a subset of gold finger pins if there is a reduced PCle width requirement (such as 1 x8 and below). In this case, the card edge gold finger may implement a 2C+ design. The overall board thickness is 1.57 mm. The gold finger dimensions for the Primary Connector compliant cards are shown below.

LFF cards support up to a x32 PCIe implementation and may use both the Primary 4C+and Secondary 4C Connectors. LFF cards may implement a reduced PCIe lane count and optionally implement only the Primary Connector.

Note: The "B" pins on the connector are associated with the top side of the OCP NIC 3.0 card. The "A" pins on the connector are associated with the bottom side of the OCP NIC 3.0 card. The A and B side pins are physically on top of each other with zero x-axis offset.

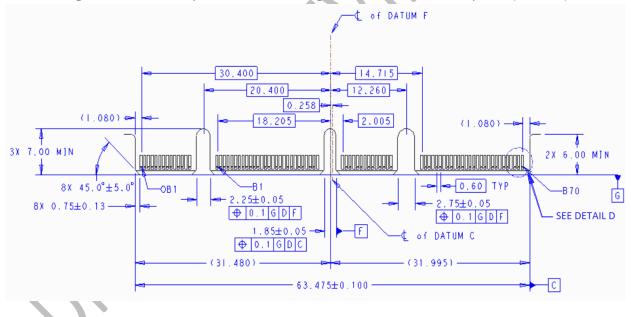


Figure 67: SFF Primary Connector Gold Finger Dimensions – x16 – Top Side ("B" Pins)

Figure 68: SFF Primary Connector Card Profile Dimensions

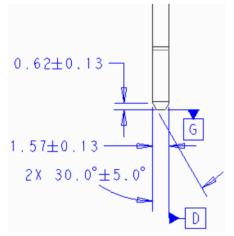
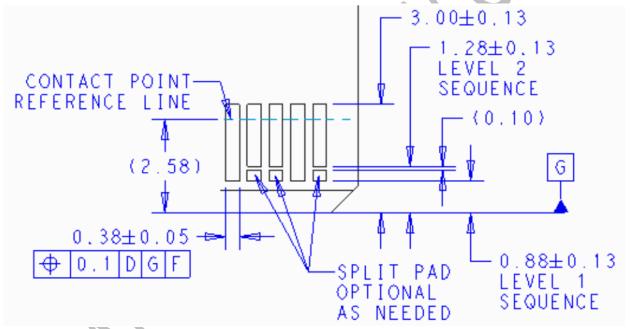


Figure 69: SFF Primary Conector Gold Finger Detail D



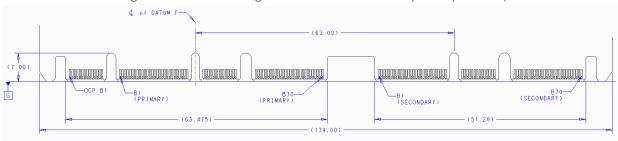
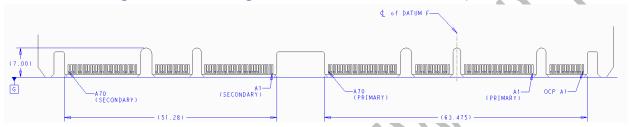


Figure 70: LFF Gold Finger Dimensions – x32 – Top Side ("B" Pins)





# 3.1.1 Gold Finger Mating Sequence

Per the SFF-TA-1002 specification, the Primary and Secondary Connectors are protocol agnostic and are optimized for high speed differential pairs. For use in the OCP NIC 3.0 application, some pin locations are used for single ended control nets or power and would benefit from a shorter pin length for staggering. As such, the required OCP NIC 3.0 card gold finger staging is shown in Table 17 and Table 18 for a two stage, first-mate, last-break functionality. The two-stage finger length is a normative requirement for the OCP NIC 3.0 card. The host connectors have a single stage mating and do not implement different pin lengths.

The AIC Plug (Free) side refers to the OCP NIC 3.0 card gold fingers; the receptacle (Fixed) side refers to the physical connector on the host platform. This table is based on the SFF-TA-1002 Table A-1 with modifications for OCP NIC 3.0. Refer to the mechanical drawings for pin the first-mate and second-mate lengths.

Note: Pin names in Table 17 and Table 18 are used for first mate/second mate reference only. Full pin definitions are described in Sections 3.3 and 3.4.

| Side B  |                      |                      | Side A     |         |                            |                      |         |
|---------|----------------------|----------------------|------------|---------|----------------------------|----------------------|---------|
|         | Gold Finger Side     | (Free)               | Receptacle |         | Gold Finger Side (Free) Re |                      |         |
|         | 2 <sup>nd</sup> Mate | 1 <sup>st</sup> Mate | (Fixed)    |         | 2 <sup>nd</sup> Mate       | 1 <sup>st</sup> Mate | (Fixed) |
| OCP B1  | NIC_PWR_GOOD         |                      |            | OCP A1  | PERST2#                    |                      |         |
| OCP B2  | MAIN_PWR_EN          |                      |            | OCP A2  | PERST3#                    |                      |         |
| OCP B3  | LD#                  |                      |            | OCP A3  | WAKE#                      |                      |         |
| OCP B4  | DATA_IN              |                      |            | OCP A4  | RBT_ARB_IN                 |                      |         |
| OCP B5  | DATA_OUT             |                      |            | OCP A5  | RBT_ARB_OUT                |                      |         |
| OCP B6  | CLK                  |                      |            | OCP A6  | SLOT_ID1                   |                      |         |
| OCP B7  | SLOT_ID0             |                      |            | OCP A7  | RBT_TX_EN                  |                      |         |
| OCP B8  | RBT_RXD1             |                      |            | OCP A8  | RBT_TXD1                   |                      |         |
| OCP B9  | RBT_RXD0             |                      |            | OCP A9  | RBT_TXD0                   |                      |         |
| OCP B10 | GND                  |                      |            | OCP A10 | GND                        |                      |         |
| OCP B11 | REFCLKn2             |                      |            | OCP A11 | REFCLKn3                   |                      |         |
| OCP B12 | REFCLKp2             |                      |            | OCP A12 | REFCLKp3                   |                      |         |

Table 17: Contact Mating Positions for the Primary Connector

| OCP B13    | GND           | OCP            | A13 GND       |  |
|------------|---------------|----------------|---------------|--|
| OCP B13    | RBT_CRS_DV    | OCP            |               |  |
| OCF B14    | KB1_CK3_DV    | Mechanical Key |               |  |
| B1         | +12V_EDGE     | A1             | GND           |  |
| B2         | +12V EDGE     | A2             | GND           |  |
| B3         | +12V EDGE     | A3             | GND           |  |
| B4         | +12V EDGE     | A4             | GND           |  |
| B5         | +12V EDGE     | A5             | GND           |  |
| B6         | +12V EDGE     | A6             | GND           |  |
| B7         | BIFO#         | A7             | SMCLK         |  |
| B8         | BIF1#         | A8             | SMDAT         |  |
| В9         | BIF2#         | A9             | SMRST#        |  |
| B10        | PERSTO#       | A10            | PRSNTA#       |  |
| B11        | +3.3V_EDGE    | A11            | PERST1#       |  |
| B12        | AUX_PWR_EN    | A12            | PRSNTB2#      |  |
| B13        | GND           | A13            | GND           |  |
| B14        | REFCLKn0      | A14            | REFCLKn1      |  |
| B15        | REFCLKp0      | A15            | REFCLKp1      |  |
| B16        | GND           | A16            | GND           |  |
| B17        | PETn0         | A17            | PERn0         |  |
| B18        | PETp0         | A18            |               |  |
| B19        | GND           | A19            | GND           |  |
| B20        | PETn1         | A20            | PERn1         |  |
| B21        | PETp1         | A21            | PERp1         |  |
| B22        | GND           | A22            | GND           |  |
| B23        | PETn2         | A23            | PERn2         |  |
| B24        | PETp2         | A24            |               |  |
| B25        | GND           | A25            | GND           |  |
| B26        | PET-3         | A26            |               |  |
| B27<br>B28 | PETp3 GND     | A27<br>A28     |               |  |
| B28        | GND           | Mechanical Key |               |  |
| B29        | GND           | A29            |               |  |
| B30        | PETn4         | A30            |               |  |
| B31        | PETp4         | A31            | PERp4         |  |
| B32        | GND           | A32            |               |  |
| B33        | PETn5         | A33            |               |  |
| B34        | PETp5         | A34            |               |  |
| B35        | GND           | A35            | GND           |  |
| B36        | PETn6         | A36            | PERn6         |  |
| B37        | PETp6         | A37            | PERp6         |  |
| B38        | GND           | A38            | GND           |  |
| B39        | PETn7         | A39            | PERn7         |  |
| B40        | PETp7         | A40            | PERp7         |  |
| B41        | GND           | A41            | GND           |  |
| B42        | PRSNTB0#      | A42            | PRSNTB1#      |  |
|            |               | Mechanical Key |               |  |
| B43        | GND           | A43            | GND           |  |
| B44        | PETn8         | A44            |               |  |
| B45        | PETp8         | A45            | PERp8         |  |
| B46        | GND           | A46            |               |  |
| B47        | PETn9         | A47            | PERn9         |  |
| B48        | TEIPS         | A48            |               |  |
| B49        | GND<br>PETn10 | A49            | GND<br>PERA10 |  |
| B50        |               | A50            |               |  |
| B51<br>B52 | PETp10<br>GND | A51<br>A52     |               |  |
| B52<br>B53 | PETn11        | A52<br>A53     |               |  |
| B53        | PETp11        | A53<br>A54     |               |  |
| B55        | GND           | A55            |               |  |
| B56        | PETn12        | A56            |               |  |
| B57        | PETp12        | A57            |               |  |
| B58        | GND           | A58            |               |  |
| B59        | PETn13        | A59            | PERn13        |  |
| B60        | PETp13        | A60            |               |  |
| B61        | GND           | A61            |               |  |
| B62        | PETn14        | A62            |               |  |
| B63        | PETp14        | A63            |               |  |
| B64        | GND           | A64            |               |  |
| B65        | PETn15        | A65            | PERn15        |  |
| B66        | PETp15        | A66            | PERp15        |  |
|            |               |                |               |  |

| B67 | GND       |  | A67 | GND      |  |
|-----|-----------|--|-----|----------|--|
| B68 | RFU1, N/C |  | A68 | USB_DATn |  |
| B69 | RFU2, N/C |  | A69 | USB_DATp |  |
| B70 | PRSNTB3#  |  | A70 | PWRBRK0# |  |

# Table 18: Contact Mating Positions for the Secondary Connector

|            | Sid                    | e 18: Contact N<br>le B | 710-61115 1-031 | nons for the c |                      | le A                 |            |
|------------|------------------------|-------------------------|-----------------|----------------|----------------------|----------------------|------------|
|            | Gold Finger Sid        |                         | Receptacle      |                | Gold Finger Si       |                      | Receptacle |
|            | 2 <sup>nd</sup> Mate   | 1 <sup>st</sup> Mate    | (Fixed)         |                | 2 <sup>nd</sup> Mate | 1st Mate             | (Fixed)    |
| D1         |                        | 15 Mate                 | (Fixeu)         | A.1            |                      | 1 <sup>st</sup> Mate | (Fixeu)    |
| B1<br>B2   | +12V_EDGE<br>+12V_EDGE |                         |                 | A1<br>A2       | GND<br>GND           | •                    |            |
| B3         | +12V_EDGE<br>+12V_EDGE |                         |                 | A3             | GND                  |                      |            |
| B4         | +12V_EDGE<br>+12V EDGE |                         |                 | A4             | GND                  |                      |            |
| B5         | +12V_EDGE              |                         |                 | A5             | GND                  |                      |            |
| B6         | +12V_EDGE              |                         |                 | A6             | GND                  |                      |            |
| B7         | BIFO#                  |                         |                 | A7             | SMCLK                |                      |            |
| B8         | BIF1#                  |                         |                 | A8             | SMDAT                |                      |            |
| B9         | BIF2#                  |                         |                 | A9             | SMRST#               |                      |            |
| B10        | PERST4#                |                         |                 | A10            | PRSNTA#              |                      |            |
| B11        | +3.3V_EDGE             |                         |                 | A11            | PERST5#              |                      |            |
| B12        | AUX_PWR_EN             |                         |                 | A12            | PRSNTB2#             |                      |            |
| B13        | GND                    |                         |                 | A13            | GND                  |                      |            |
| B14        | REFCLKn4               |                         |                 | A14            | REFCLKn5             |                      |            |
| B15        | REFCLKp4               |                         |                 | A15            | REFCLKp5             |                      |            |
| B16        | GND                    |                         |                 | A16            | GND                  |                      |            |
| B17        | PETn16                 |                         |                 | A17            | PERn16               |                      |            |
| B18        | PETp16                 |                         |                 | A18            | PERp16               |                      |            |
| B19        | GND                    |                         |                 | A19            | GND                  |                      |            |
| B20        | PETn17                 |                         |                 | A20            | PERn17               |                      |            |
| B21        | PETp17                 |                         |                 | A21            | PERp17               |                      |            |
| B22        | GND                    |                         |                 | A22            | GND                  |                      |            |
| B23        | PETn18                 |                         |                 | A23            | PERn18               |                      |            |
| B24        | PETp18                 |                         |                 | A24            | PERp18               |                      |            |
| B25        | GND<br>DET 10          |                         |                 | A25            | GND                  |                      |            |
| B26        | PETn19                 |                         |                 | A26<br>A27     | PERn19               |                      |            |
| B27<br>B28 | PETp19<br>GND          |                         |                 | A27            | PERp19<br>GND        |                      |            |
| D20        | GND                    |                         | Mad             | chanical Key   | GND                  |                      |            |
| B29        | GND                    |                         | IVIE            | A29            | GND                  |                      |            |
| B30        | PETn20                 |                         |                 | A30            | PERn20               |                      |            |
| B31        | PETp20                 |                         |                 | A31            | PERp20               |                      |            |
| B32        | GND                    |                         |                 | A32            | GND                  |                      |            |
| B33        | PETn21                 |                         |                 | A33            | PERn21               |                      |            |
| B34        | PETp21                 |                         |                 | A34            | PERp21               |                      |            |
| B35        | GND                    |                         |                 | A35            | GND                  |                      |            |
| B36        | PETn22                 |                         |                 | A36            | PERn22               |                      |            |
| B37        | PETp22                 |                         |                 | A37            | PERp22               |                      |            |
| B38        | GND                    |                         |                 | A38            | GND                  |                      |            |
| B39        | PETn23                 |                         |                 | A39            | PERn23               |                      |            |
| B40        | PETp23                 |                         |                 | A40            | PERp23               |                      |            |
| B41        | GND                    |                         |                 | A41            | GND                  |                      |            |
| B42        | PRSNTBO#               |                         |                 | A42            | PRSNTB1#             | <u> </u>             |            |
|            |                        |                         | Med             | chanical Key   |                      |                      |            |
| B43        | GND                    |                         |                 | A43            | GND                  |                      |            |
| B44        | PETn24                 |                         |                 | A44            | PERn24               |                      |            |
| B45        | PETp24                 |                         |                 | A45            | PERp24               |                      |            |
| B46        | GND                    |                         |                 | A46            | GND                  |                      |            |
| B47        | PETn25                 |                         |                 | A47            | PERn25               |                      |            |
| B48        | PETp25                 |                         |                 | A48            | PERp25               |                      |            |
| B49<br>B50 | GND<br>PETn26          |                         |                 | A49<br>A50     | GND<br>DEPn26        |                      |            |
|            |                        |                         |                 | 1              | PERn26               |                      |            |
| B51<br>B52 | PETp26<br>GND          |                         |                 | A51<br>A52     | PERp26<br>GND        |                      |            |
| B52<br>B53 | PETn27                 |                         |                 | A52<br>A53     | PERn27               |                      |            |
| B54        | PETp27                 |                         |                 | A54            | PERII27<br>PERp27    |                      |            |
| B55        | GND                    |                         |                 | A55            | GND                  |                      |            |
| B56        | PETn28                 |                         |                 | A56            | PERn28               |                      |            |
| B57        | PETp28                 |                         |                 | A57            | PERp28               |                      |            |
| B58        | GND                    |                         |                 | A58            | GND                  |                      |            |
|            |                        |                         |                 |                |                      |                      |            |



# **3.2** Baseboard Connector Requirements

The OCP NIC 3.0 connectors are compliant to the 4C+ and 4C connectors as defined in the SFF-TA-1002 specification for a right angle or straddle mount form factor. The Primary Connector is a 4C+ implementation with 168-pins. The Secondary Connector is a 4C implementation with 140-pins. Both the Primary and Secondary Connectors includes support for up to 32 differential pairs to support a x16 PCIe connection. Each connector also provides 6 pins of +12V\_EDGE, and 1 pin of +3.3V\_EDGE for power. This implementation is common between both the Primary and Secondary Connectors. In addition, the 4C+ implementation of the Primary Connector has a 28-pin OCP Bay used for management and support for up to a 4 x2 and 4 x4 multi-host configuration on the Primary Connector. The Primary and Secondary Connector drawings are shown below.

All diagram units are in mm unless otherwise noted.

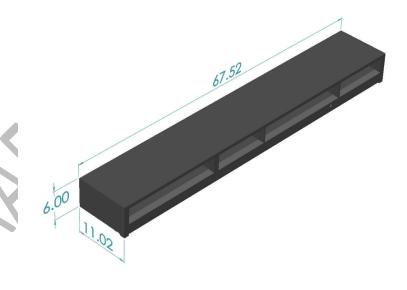
# **3.2.1** Right Angle Connector

The following offset and height options are available for the right angle Primary and Secondary Connectors.

|                          | 0        |                               |             |
|--------------------------|----------|-------------------------------|-------------|
| Name                     | Pins     | Style and Baseboard Thickness | Offset (mm) |
| Primary Connector – 4C+  | 168 pins | Right Angle                   | 4.05 mm     |
| Secondary Connector – 4C | 140 pins | Right Angle                   | 4.05 mm     |

Table 19: Right Angle Connector Options





55.32

Figure 73: 140-pin Base Board Secondary Connector – Right Angle

### 3.2.2 Right Angle Offset

The OCP NIC 3.0 right angle connectors have a 4.05 mm offset from the baseboard. This is shown in Figure 74.

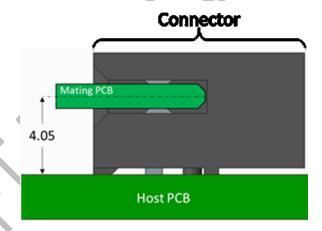


Figure 74: OCP NIC 3.0 Card and Host Offset for Right Angle Connectors

# 3.2.3 Straddle Mount Connector

The following offset and height options are available for the straddle mount Primary and Secondary Connectors.

**Style and Baseboard Thickness** Offset (mm) Name Pins Primary Connector - 4C+ 168 pins Straddle Mount for 0.062" Coplanar (0 mm) Primary Connector - 4C+ 168 pins Straddle Mount for 0.076" -0.3 mm Primary Connector – 4C+ 168 pins Straddle Mount for 0.093" Coplanar (0 mm) Secondary Connector – 4C 140 pins Straddle Mount for 0.062" Coplanar (0 mm) Secondary Connector – 4C 140 pins Straddle Mount for 0.076" -0.3 mm Secondary Connector – 4C 140 pins Straddle Mount for 0.093" Coplanar (0 mm)

Table 20: Straddle Mount Connector Options

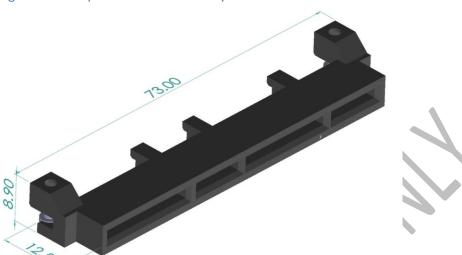
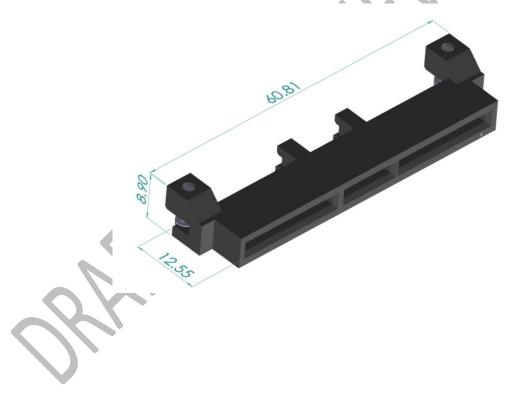


Figure 75: 168-pin Base Board Primary Connector – Straddle Mount

Figure 76: 140-pin Base Board Secondary Connector – Straddle Mount



#### 3.2.4 Straddle Mount Offset and PCB Thickness Options

The OCP NIC 3.0 straddle mount connectors have three baseboard PCB thicknesses they can accept. The available options are shown in Figure 77. The thicknesses are 0.062'', 0.076'', and 0.093''. These PCBs must be controlled to a thickness of  $\pm 10\%$ . These are available for both the Primary and Secondary Connector locations. At the time of this writing, the most commonly used part is expected to be the 0.076'' baseboard thickness.

Connector

Mating PCB

Host PCB

Host PCB Thickness

A

B

C

.062" (1.57mm)

.076" (1.93mm)

.093" (2.36mm)

Figure 77: OCP NIC 3.0 Card and Baseboard PCB Thickness Options for Straddle Mount Connectors

The connectors are capable of being used coplanar as shown in Figure 78. Additionally, the connectors are also capable of having a 0.3 mm offset from the centerline of the host board as shown in Figure 79.

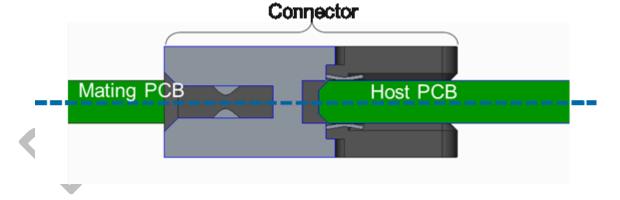
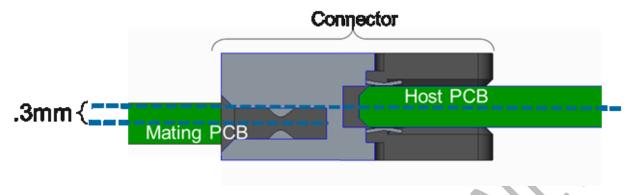


Figure 78: 0 mm Offset (Coplanar) for 0.062" Thick Baseboards

Figure 79: 0.3 mm Offset for 0.076" Thick Baseboards



#### 3.2.5 LFF Connector Locations

In order to support the LFF, systems must locate the Primary and Secondary Connectors per the mechanical drawing shown in Figure 80 and Figure 81.

Figure 80: Primary and Secondary Connector Locations for LFF Support with Right Angle Connectors

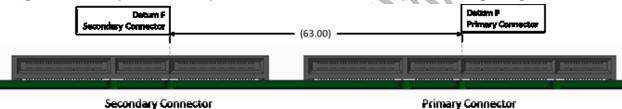
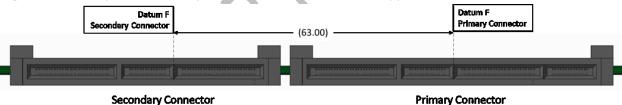


Figure 81: Primary and Secondary Connector Locations for LFF Support with Straddle Mount Connectors



#### 3.3 Pin Definition

The pin definitions of an OCP NIC 3.0 card with up to a x32 PCIe interface are shown in Table 21 and Table 22. All signal directions are shown from the perspective of the baseboard.

A baseboard system may provide a combination of Primary Connectors only, or Primary and Secondary Connectors to support multiple sizes of OCP NIC 3.0 cards. Both connectors share common functionality with power, SMBus 2.0, x16 PCle and bifurcation control. The Primary Connector 4C+ definition has an additional OCP Bay (pins OCP\_A[1:14], OCP\_B[1:14]) with additional REFCLKs for supporting up to four PCle hosts, NC-SI over RBT connectivity and a Scan Chain for information exchange between the host and card. The NIC is required to implement the Scan Chain, while the baseboard may choose to optionally implement it. Depending on the baseboard form factor, multiple OCP NIC 3.0 compliant cards may be designed into the system.

The Primary and Secondary Connectors pins are shown in Section 3.4. The OCP Bay pins on the Primary Connector only are explicitly called out with the "OCP\_" prefix in the pin location column.

Cards or systems that do not require the use of a PCIe x16 connection may optionally implement a subset of electrical connections as applicable to the design. For example, a x8 (or smaller) card using the first 8 PCIe lanes that is compliant with the Primary Connector pinout. Refer to Sections 3.1 and 3.2 for mechanical details. For these cases, the Primary Connector matches the 2C dimensions as defined in SFF-TA-1002.

In all cases, the physical baseboard connectors shall support x16 PCIe widths and must be implemented with the Primary (4C+) and Secondary (4C) connectors.

### **3.3.1** Primary Connector

Table 21: Primary Connector Pin Definition (x16) (4C+)

|         | Side B       | Side A      |         |                                                                     |                                                                    |
|---------|--------------|-------------|---------|---------------------------------------------------------------------|--------------------------------------------------------------------|
| OCP_B1  | NIC_PWR_GOOD | PERST2#     | OCP_A1  | P                                                                   | P                                                                  |
| OCP_B2  | MAIN_PWR_EN  | PERST3#     | OCP_A2  | Ť                                                                   | rim                                                                |
| OCP_B3  | LD#          | WAKE#       | OCP_A3  | an                                                                  | ıar,                                                               |
| OCP_B4  | DATA_IN      | RBT_ARB_IN  | OCP_A4  | Š.                                                                  | / Cc                                                               |
| OCP_B5  | DATA_OUT     | RBT_ARB_OUT | OCP_A5  | ğ                                                                   | nn                                                                 |
| OCP_B6  | CLK          | SLOT_ID1    | OCP_A6  | Primary Connector (4C+, x16, 168-pin OCP NIC 3.0 card with OCP Bay) | Primary Connector (2C+, x8, 112-pin OCP NIC 3.0 card with OCP bay) |
| OCP_B7  | SLOT_ID0     | RBT_TX_EN   | OCP_A7  | 9                                                                   | or (                                                               |
| OCP_B8  | RBT_RXD1     | RBT_TXD1    | OCP_A8  | (4C                                                                 | [2C                                                                |
| OCP_B9  | RBT_RXD0     | RBT_TXD0    | OCP_A9  | ,†<br>×                                                             | +, ×                                                               |
| OCP_B10 | GND          | GND         | OCP_A10 | 16,                                                                 | 8, 1                                                               |
| OCP_B11 | REFCLKn2     | REFCLKn3    | OCP_A11 | 16                                                                  | 112                                                                |
| OCP_B12 | REFCLKp2     | REFCLKp3    | OCP_A12 | 8- <del>p</del>                                                     | -pi                                                                |
| OCP_B13 | GND          | GND         | OCP_A13 | ij                                                                  | O L                                                                |
| OCP_B14 | RBT_CRS_DV   | RBT_CLK_IN  | OCP_A14 | Ç                                                                   | CP                                                                 |
|         | Mechan       | nical Key   |         | ž                                                                   | NIC                                                                |
| B1      | +12V_EDGE    | GND         | A1      | IC 3                                                                | 3.0                                                                |
| B2      | +12V_EDGE    | GND         | A2      | 0.0                                                                 | ၁ င                                                                |
| В3      | +12V_EDGE    | GND         | A3      | Carc                                                                | ard                                                                |
| B4      | +12V_EDGE    | GND         | A4      | ₹                                                                   | <b>v</b> it                                                        |
| B5      | +12V_EDGE    | GND         | A5      | ₹                                                                   | ήC                                                                 |
| B6      | +12V_EDGE    | GND         | A6      | 00                                                                  | СР                                                                 |
| B7      | BIFO#        | SMCLK       | A7      | PΒ                                                                  | ba                                                                 |
| B8      | BIF1#        | SMDAT       | A8      | ay)                                                                 | <b>خ</b>                                                           |
| B9      | BIF2#        | SMRST#      | A9      |                                                                     |                                                                    |
| B10     | PERSTO#      | PRSNTA#     | A10     |                                                                     |                                                                    |
| B11     | +3.3V_EDGE   | PERST1#     | A11     |                                                                     |                                                                    |
| B12     | AUX_PWR_EN   | PRSNTB2#    | A12     |                                                                     |                                                                    |
| B13     | GND          | GND         | A13     |                                                                     |                                                                    |
| B14     | REFCLKn0     | REFCLKn1    | A14     |                                                                     |                                                                    |
| B15     | REFCLKp0     | REFCLKp1    | A15     |                                                                     |                                                                    |
| B16     | GND          | GND         | A16     |                                                                     |                                                                    |
| B17     | PETn0        | PERn0       | A17     |                                                                     |                                                                    |
| B18     | PETp0        | PERp0       | A18     |                                                                     |                                                                    |
| B19     | GND          | GND         | A19     |                                                                     |                                                                    |
| B20     | PETn1        | PERn1       | A20     |                                                                     |                                                                    |
| B21     | PETp1        | PERp1       | A21     |                                                                     |                                                                    |
| B22     | GND          | GND         | A22     |                                                                     |                                                                    |

| B23         PETn2         PERn2         A23           B24         PETp2         PERp2         A24           B25         GND         GND         A25           B26         PETn3         PERn3         A26           B27         PETp3         PERn3         A27           B28         GND         GND         A28           Mechanical Key           B29         GND         GND         A29           B30         PETn4         PERn4         A30           B311         PETp4         PERn4         A31           B32         GND         GND         A32           B33         PETn5         PERn5         A33           B34         PETp5         PERp5         A34           B35         GND         GND         A36           B37         PETp6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A40           B41         GND         GND         A41           B42         PSNTB0#         PRNTB1#                |   |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|
| B25         GND         GND         A25           B26         PETn3         PERn3         A26           B27         PETp3         PERp3         A27           B28         GND         GND         A28           Mechanical Key           B29         GND         GND         A29           B30         PETn4         PERp4         A30           B31         PETp4         PERp4         A31           B32         GND         GND         A32           B33         PETn5         PERn5         A33           B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERn7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key                                | ı |
| B26         PETn3         PERp3         A26           B27         PETp3         PERp3         A27           B28         GND         GND         A28           Mechanical Key           B29         GND         GND         A29           B30         PETn4         PERn4         A30           B31         PETp4         PERp4         A31           B31         PETp4         PERp4         A31           B32         GND         GND         A32           B33         PETn5         PERn5         A33           B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETn6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           B43         GND         GND                   | 1 |
| B27         PETp3         PERp3         A27           B28         GND         GND         A28           Mechanical Key           B30         PETn4         PERp4         A30           B31         PETp4         PERp4         A31           B32         GND         GND         A31           B33         PETp5         PERp5         A34           B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETp6         PERp6         A37           B38         GND         GND         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETp7         PERp7         A40           B                                                                                                                                                                                                                                                                                                                         | İ |
| Mechanical Key                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | Ì |
| Mechanical Key                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | İ |
| B29         GND         GND         A29           B30         PET14         PER04         A30           B31         PETp4         PER04         A31           B32         GND         GND         A32           B33         PET05         PER05         A33           B34         PET05         PER05         A34           B35         GND         GND         A35           B36         PET06         PER06         A36           B37         PET06         PER06         A37           B38         GND         GND         A38           B39         PET07         PER07         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           PRSNTB0#         PRSNTB1#         A42           B43         GND         GND         A43           B44         PET08         PER08         A44           B45         PET08         PER08         A44           B45         PET08         PER08         A45           B46         GND         GND         A46           B47         PET09<     | Ì |
| B30         PETn4         PERp4         A30           B31         PETp4         PERp4         A31           B32         GND         GND         A32           B33         PETn5         PERn5         A34           B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A48           B49         GND         GND               | 1 |
| B31         PETp4         PERp4         A31           B32         GND         GND         A32           B33         PETn5         PERn5         A33           B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERn8         A45           B46         GND         GND         A46           B47         PETn9         PERp9         A48           B49         GND         GND         A50           B51         PETp10         PERn10             | İ |
| B32         GND         GND         A32           B33         PETn5         PERn5         A33           B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERn8         A45           B46         GND         GND         A46           B47         PETn9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10 <td></td> |   |
| B33         PETN5         PERN5         A33           B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERN8         A44           B45         PETp8         PERN8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A50           B51         PETp10         PERp10<        |   |
| B34         PETp5         PERp5         A34           B35         GND         GND         A35           B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND <td></td> |   |
| B35         GND         GND         A35           B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           Mechanical Key           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A48           B49         GND         GND         A49           B50         PETn10         PERp10         A51           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53                                           |   |
| B36         PETn6         PERn6         A36           B37         PETp6         PERp6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           Mech                                                                                                                                             |   |
| B37         PETP6         PERP6         A37           B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A50           B51         PETp10         PERp10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERp1        |   |
| B38         GND         GND         A38           B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A50           B51         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERp12         A56           B57         PETp12         PER        |   |
| B39         PETn7         PERn7         A39           B40         PETp7         PERp7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         <    | 1 |
| B40         PETP7         PERP7         A40           B41         GND         GND         A41           B42         PRSNTB0#         PRSNTB1#         A42           Mechanical Key           B43         GND         GND         A43           B44         PETN8         PERN8         A44           B45         PETP8         PERP8         A45           B46         GND         GND         A46           B47         PETN9         PERN9         A47           B48         PETP9         PERP9         A48           B49         GND         GND         A50           B51         PETN10         PERN10         A51           B52         GND         GND         A52           B53         PETN11         PERN11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                               |   |
| B41         GND         GND         A41           B42         PRSNTB0#         PPSNTB1#         A42           Mechanical Key           Mechanical Key           B43         GND         A43           B44         PETN8         PERN8         A44           B44         PETP8         PERN8         A44           B46         GND         A45           B46         GND         A46           B47         PETn9         PERN9         A47           B48         PETp9         PERP9         A48           B49         GND         A49           B50         PETn10         PERN10         A50           B51         PETp10         PERP10         A51           B52         GND         A52           B53         PETn11         PERP11         A54           B55                                                                                                                                                                                                                                                                                            | ı |
| Mechanical Key           Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A50           B51         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                  | Ì |
| Mechanical Key           B43         GND         GND         A43           B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                           | İ |
| B43       GND       GND       A43         B44       PETn8       PERn8       A44         B45       PETp8       PERp8       A45         B46       GND       GND       A46         B47       PETn9       PERn9       A47         B48       PETp9       PERp9       A48         B49       GND       GND       A49         B50       PETn10       PERn10       A50         B51       PETp10       PERp10       A51         B52       GND       GND       A52         B53       PETn11       PERn11       A53         B54       PETp11       PERp11       A54         B55       GND       GND       A55         B56       PETn12       PERn12       A56         B57       PETp12       PERp12       A57         B58       GND       GND       A58                                                                                                                                                                                                                                                                                                                  | 1 |
| B44         PETn8         PERn8         A44           B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                      | Ì |
| B45         PETp8         PERp8         A45           B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                            | İ |
| B46         GND         GND         A46           B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                  | İ |
| B47         PETn9         PERn9         A47           B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                    | İ |
| B48         PETp9         PERp9         A48           B49         GND         GND         A49           B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                          | Ì |
| B49       GND       GND       A49         B50       PETn10       PERn10       A50         B51       PETp10       PERp10       A51         B52       GND       GND       A52         B53       PETn11       PERn11       A53         B54       PETp11       PERp11       A54         B55       GND       GND       A55         B56       PETn12       PERn12       A56         B57       PETp12       PERp12       A57         B58       GND       GND       A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | İ |
| B50         PETn10         PERn10         A50           B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | İ |
| B51         PETp10         PERp10         A51           B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | İ |
| B52         GND         GND         A52           B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | İ |
| B53         PETn11         PERn11         A53           B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | Ì |
| B54         PETp11         PERp11         A54           B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | İ |
| B55         GND         GND         A55           B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | Ì |
| B56         PETn12         PERn12         A56           B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | İ |
| B57         PETp12         PERp12         A57           B58         GND         GND         A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | İ |
| B58 GND GND A58                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | İ |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | İ |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Ì |
| B59 PETn13 PERn13 A59                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | İ |
| B60 PETp13 PERp13 A60                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | İ |
| B61 GND GND A61                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Ì |
| B62 PETn14 PERn14 A62                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | İ |
| B63 PETp14 PERp14 A63                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | 1 |
| B64 GND GND A64                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | 1 |
| B65 PETn15 PERn15 A65                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | 1 |
| B66 PETp15 PERp15 A66                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | i |
| B67 GND GND A67                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | i |
| B68 RFU1, N/C USB_DATn A68                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | 1 |
| B69         RFU2, N/C         USB_DATp         A69                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | 1 |
| B70 PRSNTB3# PWRBRK0# A70                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |   |

# **3.3.2** Secondary Connector

Table 22: Secondary Connector Pin Definition (x16) (4C)

|     |            | y connector Pin Definition (x16) | (40) | Ī                                                       |
|-----|------------|----------------------------------|------|---------------------------------------------------------|
|     | Side B     | Side A                           |      |                                                         |
| B1  | +12V_EDGE  | GND                              | A1   | Se                                                      |
| B2  | +12V_EDGE  | GND                              | A2   | COI                                                     |
| B3  | +12V_EDGE  | GND                              | A3   | nda                                                     |
| B4  | +12V_EDGE  | GND                              | A4   | Ţ                                                       |
| B5  | +12V_EDGE  | GND                              | A5   | Cor                                                     |
| B6  | +12V_EDGE  | GND                              | A6   | Secondary Connector (4C, x16, 140-pin OCP NIC 3.0 card) |
| B7  | BIFO#      | SMCLK                            | A7   | cto                                                     |
| B8  | BIF1#      | SMDAT                            | A8   | r (4                                                    |
| B9  | BIF2#      | SMRST#                           | A9   | i,                                                      |
| B10 | PERST4#    | PRSNTA#                          | A10  | <b>x1</b> 6                                             |
| B11 | +3.3V_EDGE | PERST5#                          | A11  | , 1,                                                    |
| B12 | AUX_PWR_EN | PRSNTB2#                         | A12  | <b>1</b> 0-                                             |
| B13 | GND        | GND                              | A13  | pin                                                     |
| B14 | REFCLKn4   | REFCLKn5                         | A14  | 00                                                      |
| B15 | REFCLKp4   | REFCLKp5                         | A15  | P                                                       |
| B16 | GND        | GND                              | A16  | JIC                                                     |
| B17 | PETn16     | PERn16                           | A17  | 3.0                                                     |
| B18 | PETp16     | PERp16                           | A18  | са                                                      |
| B19 | GND        | GND                              | A19  | rd)                                                     |
| B20 | PETn17     | PERn17                           | A20  |                                                         |
| B21 | PETp17     | PERp17                           | A21  |                                                         |
| B22 | GND        | GND                              | A22  |                                                         |
| B23 | PETn18     | PERn18                           | A23  |                                                         |
| B24 | PETp18     | PERp18                           | A24  |                                                         |
| B25 | GND        | GND                              | A25  |                                                         |
| B26 | PETn19     | PERn19                           | A26  |                                                         |
| B27 | PETp19     | PERp19                           | A27  |                                                         |
| B28 | GND        | GND                              | A28  |                                                         |
|     | Mechan     | ical Key                         |      |                                                         |
| B29 | GND        | GND                              | A29  |                                                         |
| B30 | PETn20     | PERn20                           | A30  |                                                         |
| B31 | PETp20     | PERp20                           | A31  |                                                         |
| B32 | GND        | GND                              | A32  |                                                         |
| B33 | PETn21     | PERn21                           | A33  |                                                         |
| B34 | PETp21     | PERp21                           | A34  |                                                         |
| B35 | GND        | GND                              | A35  |                                                         |
| B36 | PETn22     | PERn22                           | A36  |                                                         |
| B37 | PETp22     | PERp22                           | A37  |                                                         |
| B38 | GND        | GND                              | A38  |                                                         |
| B39 | PETn23     | PERn23                           | A39  |                                                         |
| B40 | PETp23     | PERp23                           | A40  |                                                         |
| B41 | GND        | GND                              | A41  |                                                         |
| B42 | PRSNTB0#   | PRSNTB1#                         | A42  |                                                         |
|     | Mechan     |                                  |      |                                                         |
| B43 | GND        | GND                              | A43  |                                                         |
| B44 | PETn24     | PERn24                           | A44  |                                                         |
| B45 | PETp24     | PERp24                           | A45  |                                                         |
| B46 | GND        | GND                              | A46  |                                                         |
| B47 | PETn25     | PERn25                           | A47  |                                                         |
| B48 | PETp25     | PERp25                           | A48  |                                                         |
| B49 | GND        | GND                              | A49  |                                                         |
| 5.5 | GIID       | 5110                             |      |                                                         |

| B50 | PETn26    | PERn26   | A50 |  |
|-----|-----------|----------|-----|--|
| B51 | PETp26    | PERp26   | A51 |  |
| B52 | GND       | GND      | A52 |  |
| B53 | PETn27    | PERn27   | A53 |  |
| B54 | PETp27    | PERp27   | A54 |  |
| B55 | GND       | GND      | A55 |  |
| B56 | PETn28    | PERn28   | A56 |  |
| B57 | PETp28    | PERp28   | A57 |  |
| B58 | GND       | GND      | A58 |  |
| B59 | PETn29    | PERn29   | A59 |  |
| B60 | PETp29    | PERp29   | A60 |  |
| B61 | GND       | GND      | A61 |  |
| B62 | PETn30    | PERn30   | A62 |  |
| B63 | PETp30    | PERp30   | A63 |  |
| B64 | GND       | GND      | A64 |  |
| B65 | PETn31    | PERn31   | A65 |  |
| B66 | PETp31    | PERp31   | A66 |  |
| B67 | GND       | GND      | A67 |  |
| B68 | RFU3, N/C | UART_RX  | A68 |  |
| B69 | RFU4, N/C | UART_TX  | A69 |  |
| B70 | PRSNTB3#  | PWRBRK1# | A70 |  |
|     |           |          |     |  |

# 3.4 Signal Descriptions

The pins shown in this section are common for both the Primary and Secondary Connectors unless otherwise noted. Pins that exist only for the Primary Connector OCP Bay are explicitly called out in the pin location column with the prefix "OCP\_xxx". USB is only defined on the Primary Connector. UART is only defined on the secondary connector. All pin directions are from the perspective of the baseboard.

Note: The OCP NIC 3.0 card shall implement protection methods to prevent leakage or low impedance paths between the  $V_{AUX}$  and  $V_{MAIN}$  power domains in the event that a powered-down NIC is physically present in a powered-up baseboard. This specification provides example isolation implementations in the signal description text and appropriate figures. OCP NIC 3.0 implementers may choose to do a different implementation as long as the isolation requirements are met and the same result is achieved.

### 3.4.1 PCle Interface Pins

This section provides the pin assignments for the PCIe interface signals. The PCIe signals have unique names on the Primary and Secondary connector. The Primary Connector uses the REFCLK[0:3], TX/RX[0:15], PERST[0:3] indices. The Secondary Connector uses the REFCLK[4:5], TX/RX[16:31] and PERST[4:5] indices. Where applicable, the Primary/Secondary connector naming convention is shown as a pair. The AC/DC specifications are defined in the PCIe CEM Specification, Rev 4.0. Example connection diagrams for are shown in Section 3.6.

| Signal Name<br>(Primary /<br>Secondary) | Pin # | Baseboard<br>Direction | Signal Description |
|-----------------------------------------|-------|------------------------|--------------------|
| REFCLKn0/REFCLKn4                       | B14   | Output                 |                    |
| REFCLKp0/REFCLKp4                       | B15   |                        |                    |

Table 23: Pin Descriptions – PCle

| REFCLKn1/REFCLKn5 | A14                | Output | PCIe compliant differential reference clocks.                                                                                                                                                                                                                                                       |
|-------------------|--------------------|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| REFCLKp1/REFCLKp5 | A15                | Catpat | 100MHz reference clocks are used for the OCP NIC                                                                                                                                                                                                                                                    |
| REFCLKn2          | OCP_B11<br>OCP_B12 | Output | 3.0 card PCIe core logic.                                                                                                                                                                                                                                                                           |
| REFCLKp2 REFCLKn3 | _                  | Outout | REFCLKO is always available to all OCP NIC 3.0 cards.                                                                                                                                                                                                                                               |
| REFCLKD3          | OCP_A11<br>OCP_A12 | Output | The card should not assume REFCLK1, REFCLK2 or REFCLK3 are available until the bifurcation                                                                                                                                                                                                          |
| ·                 | _                  |        | negotiation process is complete.                                                                                                                                                                                                                                                                    |
|                   |                    |        | For baseboards, the REFCLKO, REFCLK1, REFCLK2 and REFCLK3 signals shall be available at the Primary Connector for supported designs. REFCLK2 and REFCLK3 are only available on the Primary connector in the OCP Bay. REFCLK4 and REFCLK5 are available on the Secondary connector.                  |
|                   |                    |        | <ul> <li>REFCLKO is required for all designs.</li> </ul>                                                                                                                                                                                                                                            |
|                   |                    |        | REFCLK1, REFCLK2 and REFCLK3 are                                                                                                                                                                                                                                                                    |
|                   |                    |        | required for designs that support 2 $xn$ , and 4 $xn$ bifurcation implementations.                                                                                                                                                                                                                  |
|                   |                    |        | For baseboard implementations that use REFCLK[1:3], the baseboard should disable the appropriate REFCLKs not used by the OCP NIC 3.0 card.                                                                                                                                                          |
|                   |                    | 34     | The baseboard shall not advertise the corresponding bifurcation modes if REFCLK[1:3] are not implemented.                                                                                                                                                                                           |
|                   |                    |        | REFCLK4 and REFCLK5 are only available on the Secondary Connector and are not defined for use this specification release.                                                                                                                                                                           |
| US I              |                    |        | For OCP NIC 3.0 cards, the required REFCLKs shall be connected per the endpoint datasheet. Unused REFCLKs on the OCP NIC 3.0 card shall be left as a no connect.                                                                                                                                    |
|                   |                    |        | <b>Note:</b> For cards that only support 1 x16, REFCLKO is used. For cards that support 2 x8, REFCLKO is used for the first eight PCIe lanes, and REFCLK1 is used for the second eight PCIe lanes. REFCLK2 and REFCLK3 are only used for cards that only support a four link PCIe bifurcation mode. |

| PETNO / PETN16 B17 Output PETD0 / PETP16 B18 Connector), and differential pairs [0:15] (Primary Connector), and differential pairs [16:31] PETN1 / PETN17 B20 Output (Secondary Connector). These pins are connected from the baseboard transmitter differential pairs to the receiver differential pairs on the OCP NIC 3.0 card.  PETD2 / PETD18 B24 Output PETD3 / PETD19 B26 Output PETD3 / PETD19 B27 Capacity value shall use the C <sub>TX</sub> parameter value specified in the PCle Base Specification Rev 4.0 Section 8.3.9.  PETN6 / PETN21 B34 Output PETD7 / PETD2 B37 Output PETD7 / PETD2 B37 Output PETD8 / PETD2 B37 PETD9 PETD93 B40 PETD8 / PETD2 B45 PETD9 / PETD25 B48 PETD9 / PETD25 B48 PETD10 / PETD26 B51 Output PETD10 / PETD26 B51 PETD11 / PETD27 B54 PETD11 / PETD27 B54 PETD11 / PETD28 B56 PETD11 / PETD28 B57 PETD11 / PETD29 B60 PETD14 / PETD30 B63 PETD14 / PETD30 B63 PETD15 / PETD31 B66 PETD16 / PETD31 B66 PETD16 / PETD31 B66 PETD17 / PETD31 B66 PETD17 / PETD31 B66 PETD17 / PERD31 B66 PERD17 / PERD31 B66 PERD17 / PERD31 B66 PERD17 / PERD31 B66 PERD17 / PERD31 B66 PERD17 / PERD31 B66 PERD31 / PERD31 A22 Input PERD31 PERD31 A23 Input PERD31 PERD32 A23 Input PERD32 PERD33 PERD34 A23 Input PERD34 PERD34 PERD35 on the PERD35 PERD35 on the PERD35 PERD35 on the PERD35 PERD35 on the PERD35 PERD35 PERD35 PERD35 PETD35 PETD31 B66 PERD36 PERD36 A32 Input PERD37 PERD37 PERD37 A23 Input PERD37 PERD38 PERD37 PERD37 PERD37 PERD37 PERD37 PERD37 PERD37 PERD37 PERD37 PERD37 PERD38 PETD37 PERD39 PERD37 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 PERD39 |                |     |        | Refer to Section 2.1 in the PCIe CEM Specification, Rev 4.0 for electrical details. |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|-----|--------|-------------------------------------------------------------------------------------|
| PETPO / PETP16 B18 Connector), and differential pairs [16:31] PETN1 / PETN17 B21 FTRN17 B20 Output (Secondary Connector). These pins are connected from the baseboard transmitter differential pairs to the receiver differential pairs on the OCP NIC 3.0 card.  PETN3 / PETN18 B24 Cord.  PETN3 / PETN19 B26 Output PETN4 / PETN20 B30 Output PETN4 / PETN20 B31 Output PETN5 / PETN21 B33 Output PETN6 / PETN21 B34 Output PETN6 / PETN22 B36 Output PETN6 / PETN22 B37 Output PETN7 / PETN23 B39 Output PETN8 / PETN24 B44 Output PETN8 / PETN24 B44 Output PETN8 / PETN24 B45 PETN18 / PETN25 B47 Output PETN9 / PETN25 B48 PETN18 / PETN26 B50 Output PETN10 / PETN26 B50 Output PETN10 / PETN26 B50 Output PETN10 / PETN26 B50 Output PETN10 / PETN27 B53 Output PETN10 / PETN28 B50 Output PETN11 / PETN27 B53 PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN11 / PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN29 B50 Output PETN           |                |     |        |                                                                                     |
| PETN1 / PETN17 B21 Cutput PETD1 / PETD17 B21 Cutput PETD1 / PETD18 B23 Output ETD12 / PETD18 B24 Card.  PETD3 / PETD19 B26 Output PETD3 / PETD19 B27 Cutput PETD3 / PETD19 B27 Cutput PETD3 / PETD19 B27 Cutput PETD3 / PETD19 B27 Cutput PETD3 / PETD19 B27 Cutput PETD3 / PETD19 B27 Cutput PETD3 / PETD19 B27 Cutput PETD3 / PETD19 B27 Cutput PETD3 / PETD12 B33 Cutput Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9.  PETD6 / PETD22 B36 Output PETD6 PETD22 B37 PETD12 B39 Cutput PETD6 / PETD23 B40 PETD6 / PETD23 B40 PETD6 / PETD24 B45 PETD9 / PETD25 B48 PETD9 / PETD25 B48 PETD10 / PETD25 B48 PETD10 / PETD25 B48 PETD10 / PETD25 B48 PETD10 / PETD26 B51 PETD11 / PETD27 B54 PETD11 / PETD27 B54 PETD11 / PETD28 B56 PETD11 / PETD28 B56 PETD11 / PETD29 B60 PETD11 / PETD29 B60 PETD12 / PETD29 B60 PETD13 / PETD29 B60 PETD13 / PETD29 B60 PETD13 / PETD29 B60 PETD13 / PETD29 B60 PETD13 / PETD30 B63 PETD15 / PETD31 B66 PETD15 / PETD31 B66 PETD15 / PETD31 B66 PERD16 / PERD16 A17 Input Receiver differential pairs [0:15] (Primary Connector), These pins are connected from the OCP NIC 3.0 cards the required PET[0:15] are assigned to the Secondary Connector.  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | PETn0 / PETn16 | B17 | Output | Transmitter differential pairs [0:15] (Primary                                      |
| PETD1 / PETD17 B21 from the baseboard transmitter differential pairs to the PETD2 / PETD18 B24 card.  PETD2 / PETD18 B24 b24 card.  PETD3 / PETD19 B26 Output PETD3 / PETD19 B27 The PCIe transmit pins shall be AC coupled on the baseboard with capacitors. The AC coupling capacitor value shall use the CTIX parameter value specified in the PCIe Base Specification Rev 4.0 Section 8.3.9.  PETD6 / PETD21 B34 Output PETD6 / PETD22 B37 For baseboards, the PET[0:15] signals are required at the Primary Connector for a SFF slot. PET[0:15] and PET[16:31] are required for a LFF slot. PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected to the endpoint datasheet.  PETD1 / PETD2 B34 Output PETD1 / PETD25 B48 PETD1 / PETD26 B51 Output PETD1 / PETD27 B54 PETD1 / PETD28 B56 Output PETD1 / PETD29 B50 Output PETD1 / PETD29 B50 Output PETD1 / PETD29 B50 Output PETD1 / PETD29 B50 Output PETD1 / PETD29 B60 PETD1 / PETD29 B60 PETD1 / PETD3 B62 PETD1 / PETD3 B63 PETD1 / PETD3 B63 PETD3 / PETD3 B66 PETD1 / PETD3 B63 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PETD3 B66 PETD1 / PET           | PETp0 / PETp16 | B18 |        | Connector), and differential pairs [16:31]                                          |
| PETn2 / PETn18                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | PETn1 / PETn17 | B20 | Output | · · · · · · · · · · · · · · · · · · ·                                               |
| PETD2 / PETD18 B24 Card.  PETD3 / PETD19 B27 The PCle transmit pins shall be AC coupled on the baseboard with capacitors. The AC coupling capacitor value shall use the C <sub>TX</sub> parameter value specified in the PCle Base Specification Rev 4.0 Section 8.3.9.  PETD5 / PETD21 B34 Output Section 8.3.9.  PETD6 / PETD22 B37 PETD21 B34 PETD6 / PETD22 B37 PETD13 B39 Output Section 8.3.9.  PETD7 / PETD23 B40 PETD24 B45 PETD24 B45 PETD24 B45 PETD24 B45 PETD25 B47 PETD19 / PETD25 B47 PETD10 / PETD25 B48 PETD10 / PETD25 B48 PETD10 / PETD26 B51 PETD11 / PETD26 B51 PETD11 / PETD26 B51 PETD11 / PETD27 B54 PETD11 / PETD28 B56 PETD12 / PETD29 B50 PETD13 / PETD29 B50 PETD13 / PETD29 B50 PETD13 / PETD29 B60 PETD14 / PETD30 B63 PETD14 / PETD30 B63 PETD15 / PETD31 B66 PETD15 / PETD31 B66 PERD16 / PERD16 A18 PERD17 / PERD17 A21 PERD17 PERD17 A21 PERD17 PERD17 A21 PERD17 PERD17 A21 PERD17 PERD17 A21 PERD17 PERD17 A21 PERD17 PERD17 A21 PERD17 PERD17 A21 PERD17 PERD18 PERD17 PERD17 A21 PERD17 PERD18 PERD19 PERD18 PERD19 PERD18 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PERD19 PER | PETp1 / PETp17 | B21 |        |                                                                                     |
| PETn3 / PETn19                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | PETn2 / PETn18 | B23 | Output | the receiver differential pairs on the OCP NIC 3.0                                  |
| PETp3 / PETp19B27The PCle transmit pins shall be AC coupled on the baseboard with capacitors. The AC coupling capacitors value shall use the C <sub>TX</sub> parameter value specified in the PCle Base Specification Rev 4.0 Section 8.3.9.PETp4 / PETp21B33Output Specified in the PCle Base Specification Rev 4.0 Section 8.3.9.PETp5 / PETp21B36Output Specified in the PCle Base Specification Rev 4.0 Section 8.3.9.PETp6 / PETp22B37For baseboards, the PET[0:15] signals are required at the Primary Connector for a SFF slot. PET[0:15] and PET[16:31] are required for a LFF slot.PETn8 / PETn24B44Output PETp8 / PETp24For SFF OCP NIC 3.0 cards, the required PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected per the endpoint datasheet.PETn10 / PETp26B51Output PETp10 / PETp26PET011 / PETp27PET011 / PETp27PET011 / PETp27PETn11 / PETn27B53Output PETp11 / PETp28PET011 / PETp28PET011 / PETp28PET011 / PETp28PET011 / PETp29PET012 / PETp38PET012 / PETp39PET013 / PETp39PET013 / PETp39PEG0PEG014 / PETp30PEG02 / PETp31 / PETp31PEG02 / PETp31 / PETp31PEG03 / PETp31 / PETp31PEG03 / PETp31 / PETp31PEG03 / PETp31 / PETp31PEG03 / PETp31 / PETp31PEG03 / PETp31 / PETp31 / PETp31PEG03 / PETp31 / PETp31 / PETp31PEG03 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PETp31 / PET                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |                | B24 |        | card.                                                                               |
| PETn4 / PETn20 B31 Output petrb4 / PETp20 B31 Output petrb5 / PETp21 B33 Output petrb6 / PETp21 B34 Output petrb6 / PETp22 B36 Output petrb7 / PETp22 B37 Output petrb7 / PETp23 B40 Output petrb8 / PETp24 B45 PETp24 B45 PETp3 / PETp25 PETp24 B45 PETp9 / PETp25 B47 Output petrb9 / PETp26 B51 Output petrb1 / PETp3 / PETp3 B54 PETp10 / PETp26 B51 Output petrb1 / PETp10 / PETp26 B51 Output petrb1 / PETp10 / PETp27 B54 PETp11 / PETp27 B54 PETp11 / PETp27 B54 PETp11 / PETp27 B54 PETp12 / PETp28 B57 PETp11 / PETp28 B56 PETp12 / PETp29 B60 PETp13 / PETp29 B60 PETp13 / PETp29 B60 PETp14 / PETp30 B63 PETp14 / PETp30 B63 PETp15 / PETp31 B66 PERn0 / PERn16 A17 Input Receiver differential pairs [0:15] (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential pairs [16:31] PETp15 / PETp31 B66 PERn1 / PERp17 A21 PETp17 Netp19 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18 PETp18            | · ·            |     | Output |                                                                                     |
| PETp4 / PETp20 B31                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                | •   |        |                                                                                     |
| PETN5 / PETN21 B33 Output PETN6 / PETN22 B36 Output PETN6 / PETN22 B37 Output PETN6 / PETN23 B39 PETP7 / PETN23 B40 Output PETN8 / PETN24 B45 Output PETN8 / PETN24 B45 Output PETN9 / PETN25 B47 Output PETN10 / PETN25 B48 Output PETN10 / PETN26 B50 Output PETN10 / PETN26 B51 Output PETN11 / PETN27 B53 PETP11 / PETN27 B54 PETN12 / PETN28 B56 PETN12 / PETN29 B59 Output PETN11 / PETN29 B59 Output PETN12 / PETN29 B50 Output PETN13 / PETN29 B50 Output PETN13 / PETN29 B50 Output PETN14 / PETN30 B63 PETN15 / PETN31 B66 PERN0 / PERN16 A18 PERN17 A20 Input PERN17 / PERN17 A21 Input PERN17 / PERN17 A21 Input PERN17 / PERN17 A21 Input Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9. Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9. Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9. Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9. Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9. Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9. Specified in the PCIe Base Specification Rev 4.0 Section 8.3.9.  PETN16 / PETN123 B39 Output B40 PETM16:31] are required for a LFF slot.  For SFF OCP NIC 3.0 cards, the required PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connected per the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector, and PET[16:31] are assigned to the Secondary Connector.  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PETN15 / PETN31 B66 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Output B65 Outpu           | •              |     | Output |                                                                                     |
| PETn5 / PETp21 B34 Output PETn6 / PETn22 B37 Output PETn7 / PETn23 B39 Output PETp7 / PETp23 B40 Output PETp8 / PETp24 B45 PETp24 B45 PETn9 / PETp25 B47 Output PETp9 / PETp25 B48 Output PETn10 / PETp25 B50 Output PETn10 / PETp26 B51 Output PETn11 / PETp27 B54 Output PETn11 / PETp27 B54 PETp11 PETp27 B54 PETp11 / PETp28 B57 PETp12 PETp28 B57 PETn13 / PETp29 B60 PETp13 PETp29 B60 PETn14 / PETp30 B63 PETp14 PETp30 B63 PETp15 / PETp31 B66 PERn0 / PERn16 A18 PERn17 PERn17 A20 Input PERn1 / PERn17 A21 Input Receiver differential pairs [0:15] (Primary Connected primary Connector). These pins are connected from the OCP NIC 3.0 card s, the required PET[0:15] and PET[0:15] and PET[0:15] and PET[0:15] are detailed at the Primary Connector for a SFF slot. PET[0:15] and PET[0:15] are detailed at the Primary Connector of a SFF slot. PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected per the endpoint datasheet.  PETn11 / PETn27 B54 PETp11 PETp27 B54 PETp11 PETp28 B56 Output B60 PETp12 / PETp28 B57 PETp13 PETp29 B60 PETp13 / PETp29 B60 PETp15 / PETp30 B63 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PETp15 / PETp31 B6           |                | •   |        | ·                                                                                   |
| PETN6 / PETN22 B36 Output PETN7 / PETN23 B39 B40 Output PETN8 / PETN24 B45 PETN9 / PETN25 B47 PETN9 / PETN25 B48 B50 Output PETN10 / PETN25 B48 B50 Output PETN10 / PETN26 B51 Output PETN11 / PETN27 B53 PETN11 / PETN27 B54 PETN11 / PETN27 B54 PETN12 / PETN28 B56 PETN12 / PETN28 B57 PETN13 / PETN29 B60 PETN13 / PETN29 B60 PETN13 / PETN29 B60 PETN14 / PETN30 B63 PETN15 / PETN31 B66 PETN15 / PETN31 B66 PERN0 / PERN16 A18 PERN17 PERN17 A20 Input PERN17 PERN17 A21 Input Secondary Connector). These pins are connected from the OCP NIC 3.0 cards, the required PET[0:15] and PET[0:15] and PET[0:15] are required for a LFF slot.  For baseboards, the PET[0:15] signals are required at the Primary Connector for a SFF slot. PET[0:15] and PET[0:15] are according to the Petnary Petn A18 PETN13 / PETN25 PETN13 PETN25 PETN31 PETN30 B63 PETN15 / PETN31 PETN30 B63 PETN15 / PETN31 PETN31 B66 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PETN30 PET           | <u> </u>       |     | Output |                                                                                     |
| PETP6 / PETP22 B37 For baseboards, the PET[0:15] signals are required at the Primary Connector for a SFF slot. PET[0:15] and PET[16:31] are required for a LFF slot.  PETN8 / PETN24 B44 Output PETP924 B45 For SFF OCP NIC 3.0 cards, the required PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected be endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected per the endpoint datasheet.  PETN10 / PETP26 B51 Output PETP11 / PETP27 B53 Output PETP11 / PETP27 B54 For LFF implementations, PET[0:15] are assigned to the Primary Connector, and PET[16:31] are assigned to the Secondary Connector.  PETN12 / PETN28 B56 Output PETP13 / PETP29 B60 PETN14 / PETN30 B63 PETN15 / PETN31 B65 Output PETP14 / PETN31 B66 PETN15 / PETN31 B66 PETN15 / PETN31 B66 PETN15 / PETN31 B66 PETN16 A18 PETN17 A20 Input Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential pairs [16:31] (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |                |     |        | Section 8.3.9.                                                                      |
| PETN7 / PETN23 B39 B40 Output at the Primary Connector for a SFF slot. PET[0:15] and PET[16:31] are required for a LFF slot.  PETN8 / PETN24 B44 Output PETN25 B47 Output PETN12 / PETN25 B48 Output PETN10 / PETN26 B51 Output PETN11 / PETN27 B53 Output PETN11 / PETN27 B54 PETN12 / PETN28 B56 Output PETN12 / PETN28 B57 Output PETN13 / PETN29 B60 PETN13 / PETN29 B60 PETN14 / PETN30 B63 PETN15 / PETN31 B65 Output PETN15 / PETN31 B66 PERN0 / PERN16 A18 PERN17 PERN17 A20 Input PERN17 PERN17 A21 Input PERN17 PERN17 A21 Input PERN17 PERN17 A21 Input PERN17 PERN17 A21 Input PERN17 PERN17 A21 Input PERN18 PETN18 PETN18 PETN18 PETN18 PETN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PERN19 PE           | · ·            |     | Output | For hardboards, the DET[0,15] signals are required                                  |
| PETP7 / PETp23 B40 and PET[16:31] are required for a LFF slot.  PETN8 / PETN24 B45 Output PETp8 / PETp24 B45 Output PETp9 / PETp25 B48 Output PETp10 / PETp25 B51 Output PETp10 / PETp26 B51 Output PETp11 / PETp27 B53 Output PETp11 / PETp27 B54 PETp12 / PETp28 B57 Output PETp12 / PETp28 B57 Output PETp13 / PETp29 B60 PETp13 / PETp29 B60 PETp14 / PETp30 B63 PETp15 / PETp31 B66 PETp15 / PETp31 B66 PERp0 / PERp16 A18 PERp1 / PERp17 A21 Input Receiver differential pairs [16:31] (Secondary Connector). These pins are connected from the OCP NIC 3.0 cards, the required PET Slot.  POUR NIC 3.0 cards, the required PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected per the endpoint datasheet.  Por LFF implementations, PET[0:15] are assigned to the Primary Connector, and PET[16:31] are assigned to the Secondary Connector.  PETn13 / PETn29 B59 Output Refer to Section 6.1 in the PCle CEM Specification, Rev 4.0 for details.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                | •   | -      |                                                                                     |
| PETN8 / PETN24 B44 PETp8 / PETp24 B45 PETp9 / PETp25 B47 PETp9 / PETp25 B48 PETp10 / PETp25 B48 PETp10 / PETp26 B51 PETn11 / PETp27 B54 PETp11 / PETp27 B54 PETp12 / PETp28 B56 PETp12 / PETp28 B57 PETp13 / PETp29 B60 PETp13 / PETp29 B60 PETp14 / PETp30 B63 PETp14 / PETp30 B63 PETp15 / PETp31 B66 PERp0 / PERp16 A18 PERp1 / PERp17 A20 Input PERp17 A21 PETp17 PERp17 A21 PETp17 PERp17 A21 PETp17 PERp17 PERp17 A21 PETp17 PERp17 PERp17 PERp17 A21 PETp18 PETp18 PETp18 PETp19 PERp17 A21 PETp19 PETp18 PETp19 PERp17 A21 PETp19 PERp17 A21 PETp19 PERp17 A21 PETp19 PERp17 A21 PETp19 PETp19 PERp17 A21 PETp19 PERp17 A21 PETp19 PERp17 A21 PETp19 PERp17 A21 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp1           | •              |     | Output | ,                                                                                   |
| PETP8 / PETP24 B45 For SFF OCP NIC 3.0 cards, the required PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected per the endpoint datasheet.  PETN10 / PETP26 B51 Output PETP11 / PETP27 B54 PETP11 / PETP27 B55 Output PETP12 / PETP28 B57 PETP12 / PETP28 B57 PETP13 / PETP29 B60 PETP13 / PETP29 B60 PETP14 / PETP30 B63 PETP14 / PETP30 B63 PETP15 / PETP31 B66 PERP15 / PETP31 B66 PERP0 / PERP16 A18 PERP0 / PERP16 A18 PERP17 A21 PERP17 A21 PETP18 PETP18 PERP17 A21 PETP18 PETP18 PETP18 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PETP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PETP19 PETP19 PERP19 PERP19 PERP19 PERP19 PERP19 PETP19 PERP19 PETP19 PERP19 PERP19 PERP19 PERP19 PETP19 PERP19 PETP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PERP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PETP19 PE           |                | +   |        | and terpio.sij dre required for a firt slot.                                        |
| PETn9 / PETn25 PETn9 / PETn25 PETn9 / PETp25 B48 PETn10 / PETn26 PETn10 / PETn26 PETp10 / PETp26 PETp10 / PETp26 PETp10 / PETp26 PETp11 / PETp27 PETp11 / PETp27 PETp11 / PETp27 PETn12 / PETp28 PETp12 / PETp28 PETp12 / PETp28 PETp13 / PETp29 PETp13 / PETp29 PETp13 / PETp29 PETp14 / PETp30 PETp15 / PETp31 PETp15 / PETp31 PETp0 / PERp16 PERn0 / PERp16 A17 PERn17 / PERn17 PERn17 / PERn17 PERn17 / PERn17 PERn17 / PERn17 PERn17 / PERn17 PERn17 / PERn17 PERn17 / PERn17 PERn17 / PERn17 A20 Input Signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connection, the appropriate PET[0:15] signals shall be connected per the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector, and PET[16:31] are assigned to the Secondary Connector.  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PETn15 / PETn31 PETp15 / PETp31 PERn17 / PERn17 A20 Input PERn1 / PERn17 A21 Input Signals shall be connected to the endpoint silicon. For silicon that uses less than a x16 connected to the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector, and PET[16:31] are assigned to the Secondary Connector.  PETp14 / PETp28 B50 Output Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 PETp15 / PETp31 P           | •              |     | Output | For SEE OCP NIC 3.0 cards, the required PET[0:15]                                   |
| PETn9 / PETn25 B48  PETn10 / PETn26 B50 Output appropriate PET[0:15] signals shall be connected per the endpoint datasheet.  PETn11 / PETn27 B53 Output per the endpoint datasheet.  PETn12 / PETn28 B56 Output per the endpoint datasheet.  PETn12 / PETn28 B56 Output per the endpoint datasheet.  PETn13 / PETn28 B56 Output per the endpoint datasheet.  PETn14 / PETn28 B57 Output per the endpoint datasheet.  PETn15 / PETn29 B59 Output per the endpoint datasheet.  PETn16 / PETn29 B59 Output per the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector, and PET[16:31] are assigned to the Secondary Connector.  PETn14 / PETn29 B60 PETn15 / PETn30 B63 Output per the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector.  Refer to Section 6.1 in the PCle CEM Specification, Rev 4.0 for details.  PETn15 / PETn31 B66 Output per the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector.  Refer to Section 6.1 in the PCle CEM Specification, Rev 4.0 for details.  PETn15 / PETn31 B66 Output per the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector.  Refer to Section 6.1 in the PCle CEM Specification, Rev 4.0 for details.  PETn15 / PETn31 B66 Output per the endpoint datasheet.  For LFF implementations, PET[0:15] are assigned to the Primary Connector.  Refer to Section 6.1 in the PCle CEM Specification, Rev 4.0 for details.  PETn15 / PETn31 B66 Output per the endpoint datasheet.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |                |     |        |                                                                                     |
| PETn10 / PETn26 B50 Output per the endpoint datasheet.  PETn11 / PETn27 B53 Output PETn11 / PETn27 B54 PETn12 / PETn28 B56 Output PETn12 / PETn28 B57 PETn13 / PETn29 B60 PETn13 / PETn29 B60 PETn14 / PETn30 B63 PETn15 / PETn31 B65 Output PETn15 / PETn31 B66 PERn0 / PERn16 A17 Input PERn0 / PERn17 A20 Input PERn17 PERn17 A20 Input PERn17 PERn17 A21 Input PERn17 PERn17 A21 Input PERn17 PERn17 A21 Input PERn17 PERn17 A21 Input PERn17 Input PERn17 PERn17 A21 Input PERn17 Input PERn18 Input PETn18 Input PETn18 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 Input PERn19 In           | · ·            |     | Output | ,                                                                                   |
| PETN10 / PETN26 B51 per the endpoint datasheet.  PETN11 / PETN27 B53 Output PETN12 / PETN27 B54 PETN12 / PETN28 B56 Output PETN13 / PETN29 B59 Output PETN13 / PETN29 B60 PETN14 / PETN30 B62 Output PETN14 / PETN30 B63 PETN15 / PETN31 B65 Output PETN15 / PETN31 B66 PERN0 / PERN16 A17 Input PERN17 A20 Input PERN1 / PERN17 PERN17 A21 Input PERN17 PERN17 A21 Input PETN13 Input PERN1 / PERN1 / PERN17 A21 Input PETN13 Input PERN1 / PERN17 A21 Input PERN1 / PERN17 A21 Input PETN13 / PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN13 PETN1           |                |     | 0.1.   | ·                                                                                   |
| PETn11 / PETn27                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | •              |     | Output | , , , , , , , , , , , , , , , , , , , ,                                             |
| PETp11 / PETp27 B54 Output B56 PETp12 / PETp28 B57 Output PETp13 / PETp29 B60 PETp14 / PETp30 B63 PETp14 / PETp31 B66 PERn0 / PERp16 A17 PERp0 / PERp16 A18 PERp1 / PERp17 A21 PETp17 A21 PETp18 PETp18 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp19 PETp1           |                |     | Outout | , '                                                                                 |
| PETN12 / PETN28 B56 B57 Output assigned to the Secondary Connector.  PETN13 / PETN29 B59 Output PETN13 / PETN29 B60 PETN14 / PETN30 B62 Output PETN15 / PETN31 B65 PETN15 / PETN31 B66 PERN0 / PERN16 A17 Input PERN17 A20 Input PERN17 PERN17 A21 Input Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |                |     | Output | For LFF implementations, PET[0:15] are assigned to                                  |
| PETp12 / PETp28 B57 PETn13 / PETn29 B59 PETp13 / PETp29 B60 PETn14 / PETn30 B62 PETp14 / PETp30 B63 PETn15 / PETn31 B65 PERn0 / PERp16 A17 PERp0 / PERp16 A18 PERn1 / PERn17 A20 PERp1 / PERp17 A21  PETp15 / PETp17 A21  PETp15 / PETp17 A21  PERp1 / PERp17 A21  PERp1 / PERp17  PERp1 / PERp17  PERp1 / PERp17  PERp1 / PERp17  PERp1 / PERp17  PERp1 / PERp17  PESp1 / PERp17  PESp1 / PERp17  PESp1 / PERp17  PESp1 / PERp17  PESp1 / PERp17  PESp1 / PERp17  PUtput Perp16 Perp17  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PERp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PERp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PERp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PERp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PERp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PETp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PETp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  PERp1 / PETp18  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |                |     | Output |                                                                                     |
| PETn13 / PETn29 B59 B60 PETn13 / PETp29 B60 PETn14 / PETn30 B62 Output PETp14 / PETp30 B63 PETn15 / PETn31 B65 PETp15 / PETp31 B66 PERn0 / PERn16 A17 Input PERp0 / PERp16 A18 PERn1 / PERn17 A20 Input PERp1 / PERp17 A21 PERp17 A21 Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  Refer to Section 6.1 in the PCIe CEM Specification, Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Secondarium (Secondarium Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum Permanum P           | · ·            | ľ.  | Output | assigned to the Secondary Connector.                                                |
| PETp13 / PETp29 B60  PETn14 / PETn30 B62 PETp14 / PETp30 B63 PETn15 / PETn31 B65 PERn0 / PERn16 A17 PERp0 / PERp16 A18 PERn1 / PERn17 A20 PERp1 / PERp17 A21  Refer to Section 6.1 in the PCle CEM Specification, Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |                |     | Output |                                                                                     |
| PETn14 / PETn30 B63 PETn15 / PETn31 B65 Output PETp15 / PETp31 B66 PERn0 / PERn16 A17 Input PERp0 / PERp16 A18 PERn1 / PERn17 A20 Input PERp1 / PERp17 A21 PERp17 A21 Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.  Rev 4.0 for details.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |                |     | Output | Refer to Section 6.1 in the PCIe CEM Specification,                                 |
| PETp14 / PETp30 B63  PETn15 / PETn31 B65 Output PETp15 / PETp31 B66  PERn0 / PERn16 A17 Input Receiver differential pairs [0:15] (Primary Connector), and differential pairs [16:31] PERn1 / PERn17 A20 Input (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                |     | Output | Rev 4.0 for details.                                                                |
| PETn15 / PETn31 B65 Output PETp15 / PETp31 B66  PERn0 / PERn16 A17 Input Receiver differential pairs [0:15] (Primary Connector), and differential pairs [16:31] PERn1 / PERn17 A20 Input (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |                |     | Output |                                                                                     |
| PETp15 / PETp31 B66  PERn0 / PERn16 A17 Input Receiver differential pairs [0:15] (Primary Connector), and differential pairs [16:31]  PERn1 / PERn17 A20 Input (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                |     | Output |                                                                                     |
| PERn0 / PERn16 A17 Input Receiver differential pairs [0:15] (Primary Connector), and differential pairs [16:31] PERn1 / PERn17 A20 Input (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |                |     | σαιραί |                                                                                     |
| PERp0 / PERp16 A18 Connector), and differential pairs [16:31] PERn1 / PERn17 A20 Input (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |                | •   | Innut  | Receiver differential pairs [0:15] (Primary                                         |
| PERn1 / PERn17 A20 Input (Secondary Connector). These pins are connected from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |                |     | прис   | ,                                                                                   |
| PERp1 / PERp17 A21 from the OCP NIC 3.0 card transmitter differential                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                |     | Input  | ,                                                                                   |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | -              |     |        | ' '                                                                                 |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | PERn2 / PERn18 | A23 | Input  | pairs to the receiver differential pairs on the                                     |
| PERp2 / PERp18 A24 baseboard.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            | -              |     |        | , ·                                                                                 |

|                   | ı      |        |                                                               |
|-------------------|--------|--------|---------------------------------------------------------------|
| PERn3 / PERn19    | A26    | Input  |                                                               |
| PERp3 / PERp19    | A27    |        | The PCIe receive pins shall be AC coupled on the              |
| PERn4 / PERn20    | A30    | Input  | OCP NIC 3.0 card with capacitors. The AC coupling             |
| PERp4 / PERp20    | A31    |        | capacitor value shall use the C <sub>TX</sub> parameter value |
| PERn5 / PERn21    | A33    | Input  | specified in the PCIe Base Specification Rev 4.0              |
| PERp5 / PERp21    | A34    |        | Section 8.3.9.                                                |
| PERn6 / PERn22    | A36    | Input  |                                                               |
| PERp6 / PERp22    | A37    |        | For baseboards, the PER[0:15] signals are required            |
| PERn7 / PERn23    | A39    | Input  | at the Primary Connector for a SFF slot. PER[0:15]            |
| PERp7 / PERp23    | A40    |        | and PER[16:31] are required for a LFF slot.                   |
| PERn8 / PERn24    | A44    | Input  |                                                               |
| PERp8 / PERp24    | A45    |        | For SFF OCP NIC 3.0 cards, the required PER[0:15]             |
| PERn9 / PERn25    | A47    | Input  | signals shall be connected to the endpoint silicon.           |
| PERp9 / PERp25    | A48    |        | For silicon that uses less than a x16 connection, the         |
| PERn10 / PERn26   | A50    | Input  | appropriate PER[0:15] signals shall be connected              |
| PERp10 / PERp26   | A51    | •      | per the endpoint datasheet.                                   |
| PERn11 / PERn27   | A53    | Input  |                                                               |
| PERp11 / PERp27   | A54    | •      | For LFF implementations, PER[0:15] are assigned to            |
| PERn12 / PERn28   | A56    | Input  | the Primary Connector, and PER[16:31] are                     |
| PERp12 / PERp28   | A57    | •      | assigned to the Secondary Connector.                          |
| PERn13 / PERn29   | A59    | Input  |                                                               |
| PERp13 / PERp29   | A60    | ·      | Refer to Section 6.1 in the PCIe CEM Specification,           |
| PERn14 / PERn30   | A62    | Input  | Rev 4.0 for details.                                          |
| PERp14 / PERp30   | A63    |        |                                                               |
| PERn15 / PERn31   | A65    | Input  |                                                               |
| PERp15 / PERp31   | A66    |        |                                                               |
| PERSTO# / PERST4# | B10    | Output | PCIe Reset #[0:5]. Active low.                                |
| PERST1# / PERST5# | A11    |        |                                                               |
| PERST2#           | OCP A1 |        | When PERSTn# is deasserted, the signal shall                  |
| PERST3#           | OCP_A2 |        | indicate the power state is already in Main Power             |
|                   | C - X  |        | Mode and is within tolerance and stable for the               |
|                   |        |        | OCP NIC 3.0 card to bring up the PCIe link.                   |
|                   |        |        |                                                               |
|                   |        |        | PERST# shall be deasserted at least 1s after the              |
|                   |        |        | NIC_PWR_GOOD assertion to Main Power Mode.                    |
|                   |        |        | This ensures the card power rails are within the              |
|                   |        |        | operating limits. This value is longer than the               |
|                   |        |        | minimum value specified in the PCIe CEM                       |
|                   |        |        | Specification. The PCIe REFCLKs shall also become             |
|                   |        |        | stable within this period of time.                            |
|                   |        |        | ·                                                             |
|                   |        |        | PERST[0:5]# shall be asserted low on the baseboard            |
|                   |        |        | until the platform is ready to deassert reset.                |
|                   |        |        |                                                               |
|                   |        |        | For baseboards that support bifurcation, the                  |
|                   |        |        | PERST[0:3]# signals are required at the Primary               |

|       |        |           | Connector, PERST[4:5]# are required at the Secondary Connector.                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|-------|--------|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|       |        |           | For OCP NIC 3.0 cards, the required PERST[0:5]# signals shall be connected to the endpoint silicon. Unused PERST[0:5]# signals shall be left as a no connect.                                                                                                                                                                                                                                                                                                                                      |
|       |        |           | <b>Note:</b> For cards that only support 1 x16, PERSTO# is used. For cards that support 2 x8, PERSTO# is used for the first eight PCIe lanes, and PERST1# is used for the second eight PCIe lanes. PERST2# and PERST3# are only used for cards that support a four link PCIe bifurcation mode.                                                                                                                                                                                                     |
|       |        |           | PERSTO# is always available to all OCP NIC 3.0 cards. The card should not assume PERST[1:5]#are available until the bifurcation negotiation process is complete.                                                                                                                                                                                                                                                                                                                                   |
|       |        |           | Refer to Section 2.2 in the PCIe CEM Specification, Rev 4.0 for details.                                                                                                                                                                                                                                                                                                                                                                                                                           |
| WAKE# | OCP_A3 | Input, OD | WAKE#. Open drain. Active low.                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|       |        | 9/        | This signal shall be driven by the OCP NIC 3.0 card to notify the baseboard to restore PCle link. For OCP NIC 3.0 cards that support multiple WAKE# signals, their respective WAKE# pins may be tied together as the signal is open-drain to form a wired-OR. For multi-homed host configurations, the WAKE# signal assertion shall wake all nodes.                                                                                                                                                |
|       |        |           | For baseboards, this signal shall be pulled up to +3.3V_EDGE on the baseboard with a 10 kOhm resistor. This signals shall be connected to the system WAKE# signal.                                                                                                                                                                                                                                                                                                                                 |
|       |        |           | For OCP NIC 3.0 cards, this signal shall be connected between the endpoint silicon WAKE# pin(s) and the card edge through an isolation buffer. The WAKE# signal shall not assert until the PCIe card is in the D3 state according to the PCIe CEM specification to prevent false WAKE# events. For OCP NIC 3.0, the WAKE# pin shall be buffered or otherwise isolated from the host until the aux voltage source is present. Examples of this are shown in Section 3.5.5 by gating via an on-board |
|       |        |           | shown in Section 3.5.5 by gating via an on-board "AUX_PWR_GOOD" signal to indicate all the NIC                                                                                                                                                                                                                                                                                                                                                                                                     |

|                        |     |            | ALIV a success as its same stable. The BOLL CEAA                                                                                                                                                                                                                                                                                                                 |
|------------------------|-----|------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                        |     |            | AUX power rails are stable. The PCIe CEM specification also shows an example in the WAKE# signal section.                                                                                                                                                                                                                                                        |
|                        |     |            | This pin shall be left as a no connect if WAKE# is not supported by the silicon.                                                                                                                                                                                                                                                                                 |
|                        |     |            | Refer to Section 2.3 in the PCIe CEM Specification, Rev 4.0 for details.                                                                                                                                                                                                                                                                                         |
| PWRBRK0# /<br>PWRBRK1# | A70 | Output, OD | Power Brake. Active low, open drain.  This signal shall be pulled up to +3.3V_EDGE on the OCP NIC 3.0 card with 95 kOhm or larger resistance.  A baseboard that supports this function must                                                                                                                                                                      |
|                        |     |            | provide a stronger pull up on PWRBRK#. A baseboard pull up value between 4.7 kOhm and 10 kOhm is recommended. The pull up shall meet the T <sub>PWRBRK</sub> timing parameter as shown in the PCIe CEM Specification.                                                                                                                                            |
|                        |     |            | When this signal is driven low by the baseboard, the Emergency Power Reduction State is requested. The OCP NIC 3.0 card shall move to a lower power consumption state.                                                                                                                                                                                           |
|                        | . < | 38         | For baseboards, the PWRBRKO# pin shall be implemented and available on the Primary Connector for SFF slots. In addition, the PWRBRK1# pin shall be implemented on the Secondary connector for LFF slots.                                                                                                                                                         |
| ORI                    |     |            | For OCP NIC 3.0 cards, the PWRBRK[0:1]# pin usage is optional. If used, the PWRBRKO# on the Primary Connector should be connected to the network silicon to enable reduced power state. If not used, the PWRBRKO# signals shall be left as a no connect. PWRBRK1# on the Secondary Connector is reserved for future use cases and shall be left as a no connect. |
|                        |     |            | Note: The PWRBRK[0:1]# pins are only available for OCP NIC 3.0 cards that implement a SFF 4C+ edge connector or a LFF. For SFF cards that implement at 2C+ edge connection, the PWRBRK[0:1]# functionality is not available.                                                                                                                                     |

#### 3.4.2 PCIe Present and Bifurcation Control Pins

This section provides the pin assignments for the PCIe present and bifurcation control signals. The AC/DC specifications are defined in Section 3.11. Example connection diagrams are shown in Figure 82 and Figure 83.

The PRSNTA#/PRSNTB[0:3]# state shall be used to determine if a card has been physically plugged in. The BIF[0:2]# pins shall be asserted by the baseboard along with the rising edge of AUX\_PWR\_EN. The BIF[0:2]# pins shall be latched by the OCP NIC 3.0 card when AUX\_PWR\_EN=1 and NIC\_PWR\_GOOD=1 to ensure the correct values are detected by the OCP NIC 3.0 card. Changing the pin states after this timing window is not allowed. Refer to the AC timing diagram in Section 3.11 for details.

PRSNTB[0:3]# pins are available to each connector and are independent of each other. For the SFF, the baseboard shall only read the Primary Connector PRSNTB[0:3]# to determine the card type. For the LFF, the baseboard shall read both the Primary and Secondary connector PRSNTB[0:3]# pins to determine the card type. The card type matrix is discussed in Section 3.5.

Table 24: Pin Descriptions – PCIe Present and Bifurcation Control Pins

| Signal Name | Pin # | Baseboard | Signal Description                                                                                                                                                                                                                                                 |
|-------------|-------|-----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|             |       | Direction |                                                                                                                                                                                                                                                                    |
| PRSNTA#     | A10   | Output    | Present A is used for OCP NIC 3.0 card presence and PCIe capabilities detection.  For baseboards, this pin shall be directly connected to GND.                                                                                                                     |
|             |       |           | For OCP NIC 3.0 cards, this pin shall be directly connected to the PRSNTB[3:0]# pins.                                                                                                                                                                              |
| PRSNTB0#    | B42   | Input     | Present B [0:3]# are used for OCP NIC 3.0 card                                                                                                                                                                                                                     |
| PRSNTB1#    | A42   |           | presence and PCIe capabilities detection.                                                                                                                                                                                                                          |
| PRSNTB2#    | A12   |           |                                                                                                                                                                                                                                                                    |
| PRSNTB3#    | B70   |           | For baseboards, these pins shall be connected to the I/O hub and pulled up to +3.3V_EDGE using 1 kOhm resistors.                                                                                                                                                   |
| B           |       |           | For OCP NIC 3.0 cards, these pins shall be strapped to PRSNTA# per the encoding definitions described in Section 3.5.                                                                                                                                              |
|             |       |           | Note: PRSNTB3# is located at the bottom of the 4C connector and is only applicable for OCP NIC 3.0 cards with a PCIe width of x16 (or greater). OCP NIC 3.0 cards that implement a 2C card edge do not use the PRSNTB3# pin for capabilities or present detection. |
| BIFO#       | В7    | Output    | Bifurcation [0:2]# pins allow the baseboard to force                                                                                                                                                                                                               |
| BIF1#       | B8    |           | configure the OCP NIC 3.0 card bifurcation.                                                                                                                                                                                                                        |
| BIF2#       | B9    |           |                                                                                                                                                                                                                                                                    |

For baseboards, the BIF[0:2]# these pins shall be driven from the baseboard I/O hub on the rising edge of AUX\_PWR\_EN. This allows the baseboard to force the OCP NIC 3.0 card bifurcation. The baseboard may optionally pull the BIF[0:2]# signals to AUX\_PWR\_EN or to ground per the definitions described in Section 3.5 if no dynamic bifurcation configuration is required. The BIF[0:2]# pins shall be low until AUX\_PWR\_EN is asserted.

For baseboards that allow dynamic bifurcation, the BIF[0:2] pins are driven low prior to AUX\_PWR\_EN. The state of the BIF[0:2] pins are driven with the rising edge of AUX\_PWR\_EN when bifurcation is requested. Refer to Figure 82 for an example configuration.

For baseboards with static bifurcation, the BIF pins that are intended to be a logical '1' shall be connected to a pull up to AUX\_PWR\_EN. BIF pins that are a logical '0' may be directly tied to ground. Refer to Figure 83 for an example configuration.

For OCP NIC 3.0 cards, these signals shall connect to the endpoint bifurcation pins if it is supported. The BIF[0:2]# signals shall be left as no connects if end point bifurcation is not supported. The value of the BIF[2:0]# pins are latched by the OCP NIC 3.0 card upon entering the AUX power mode state (when AUX PWR EN=1 and NIC PWR GOOD=1).

Note: the required combinatorial logic output for endpoint bifurcation is dependent on the specific silicon and is not defined in this specification.

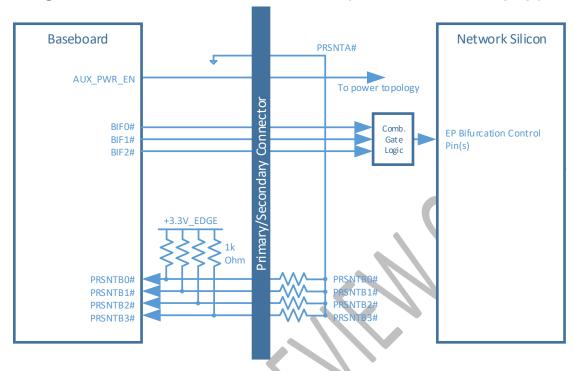
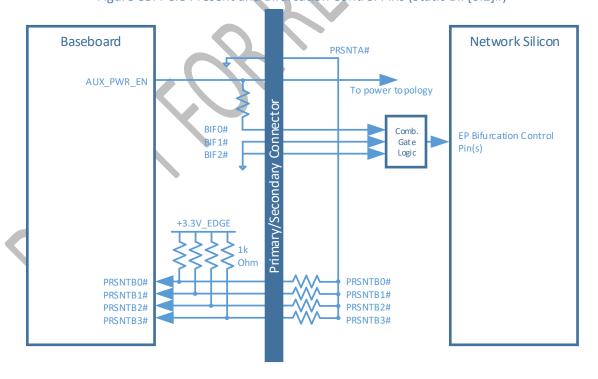


Figure 82: PCIe Present and Bifurcation Control Pins (Baseboard Controlled BIF[0:2]#)





1

#### 3.4.3 SMBus Interface Pins

This section provides the pin assignments for the SMBus interface signals. The AC/DC specifications are defined in the SMBus 2.0 specification. The SMBus interface is pinned out on the Primary and Secondary Connectors. For SFF and LFF OCP NIC 3.0 card implementations, FRU and MCTP over SMBus transactions shall use the Primary Connector only. SMBus on the Secondary Connector may be a separate bus and is reserved for a future use case. An example connection diagram is shown in Figure 84.

Table 25: Pin Descriptions – SMBus

| Signal Name | Pin # | Baseboard             | Signal Description                                                                                                                                                                                                                                                                                                                                              |
|-------------|-------|-----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|             |       | Direction             |                                                                                                                                                                                                                                                                                                                                                                 |
| SMCLK       | A7    | Output, OD            | SMBus clock. Open drain, pulled up to +3.3V_EDGE on the baseboard.                                                                                                                                                                                                                                                                                              |
|             |       |                       | For baseboards, the SMCLK from the platform SMBus master shall be connected to the connector.                                                                                                                                                                                                                                                                   |
|             |       |                       | For OCP NIC 3.0 cards, the SMCLK from the endpoint silicon shall be connected to the card edge gold fingers.                                                                                                                                                                                                                                                    |
| SMDAT       | A8    | Input /<br>Output, OD | SMBus Data. Open drain, pulled up to +3.3V_EDGE on the baseboard.                                                                                                                                                                                                                                                                                               |
|             |       |                       | For baseboards, the SMDAT from the platform SMBus master shall be connected to the connector.                                                                                                                                                                                                                                                                   |
|             |       |                       | For OCP NIC 3.0 cards, the SMDAT from the endpoint silicon shall be connected to the card edge gold fingers.                                                                                                                                                                                                                                                    |
| SMRST#      | A9    | Output, OD            | SMBus reset. Open drain.                                                                                                                                                                                                                                                                                                                                        |
|             |       |                       | For baseboards, this pin shall be pulled up to +3.3V_EDGE. The SMRST pin may be used to reset optional downstream SMBus devices (such as temperature sensors). The SMRST# implementation shall be mandatory for baseboard implementations.                                                                                                                      |
|             |       |                       | For OCP NIC 3.0 cards, SMRST# is optional and is dependent on the OCP NIC 3.0 card implementation. If used, the SMRST# is on the +3.3V_EDGE power domain. Isolation logic may be required if the target device(s) exist on a different power domain to prevent a leakage path. The SMRST# signal shall be left as a no connect if it is not used on the OCP NIC |
|             |       |                       | left as a no connect if it is not used on the OCP NIC 3.0 card.                                                                                                                                                                                                                                                                                                 |

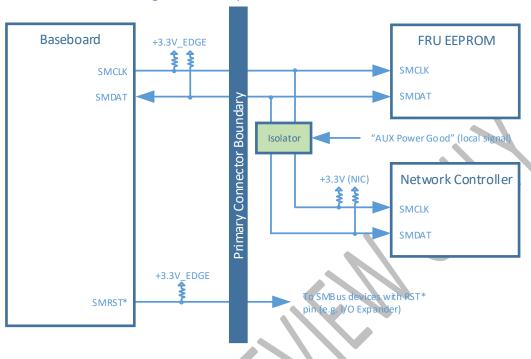


Figure 84: Example SMBus Connections

#### 3.4.4 NC-SI over RBT Interface Pins

This section provides the pin assignments for the NC-SI over RBT interface signals on the Primary Connector OCP bay. The AC/DC specifications for NC-SI over RBT are defined in the DMTF DSP0222 NC-SI specification. Example connection diagrams are shown in Figure 85 and Figure 86.

Note: The RBT pins must provide the ability to be isolated on the baseboard side when AUX\_PWR\_EN=0 or when (AUX\_PWR\_EN=1 and NIC\_PWR\_GOOD=0). The RBT pins shall remain isolated until the power state machine has transitioned to AUX power mode or to Main Power Mode along with a valid indication of NIC\_PWR\_GOOD. This prevents a leakage path through unpowered silicon. The RBT REF\_CLK must also be disabled until AUX\_PWR\_EN=1 and NIC\_PWR\_GOOD=1. Example buffering implementations are shown in Figure 85 and Figure 86. The isolator shall be controlled on the baseboard with a signal called RBT\_ISOLATE#.

RBT reference clock buffers are permitted on the OCP NIC for multi-endpoint implementations if the NIC timing budget is not violated. Refer to the signal integrity requirements in Section 5.1 for timing budget details.

Command-based (software) arbitration is also permissible per DSP0222. Baseboards may choose to use the Select Package and Deselect Package commands to allow a network controller to transmit on the shared bus when more than one device is present.

Table 26: Pin Descriptions – NC-SI over RBT

| Signal Name | Pin # | Baseboard | Signal Description |
|-------------|-------|-----------|--------------------|
|             |       | Direction |                    |

| RBT_REF_CLK          | OCP_A14          | Output | Reference clock input. Synchronous clock reference for receive, transmit and control interface. The clock shall have a typical frequency of 50MHz ±50 ppm.                                                                                                                             |
|----------------------|------------------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                      |                  |        | For baseboards, this pin shall be connected between the baseboard NC-SI over RBT PHY and the Primary Connector OCP bay. The RBT_REF_CLK shall not be driven until the card has transitioned into AUX Power Mode. The RBT_REF_CLK shall be continuous once it has started.              |
|                      |                  |        | If the baseboard does not support NC-SI over RBT, then this pin shall be terminated to ground through a 100 kOhm pull down resistor.                                                                                                                                                   |
|                      |                  |        | For OCP NIC 3.0 cards, this pin shall be connected between the card gold finger and the endpoint silicon. This pin shall be left as a no connect if NC-SI over RBT is not supported.                                                                                                   |
| RBT_CRS_DV           | OCP_B14          | Input  | Carrier sense/receive data valid. This signal is used to indicate to the baseboard that the carrier sense/receive data is valid.                                                                                                                                                       |
|                      |                  |        | For baseboards, this pin shall be connected between the baseboard NC-SI over RBT PHY and the connector. This signal requires a 100 kOhm pull down resistor on the baseboard between the BMC and the RBT isolator to prevent the signal from floating when no card is installed.        |
|                      |                  |        | If the baseboard does not support NC-SI over RBT, then this pin shall be terminated to ground through a 100 kOhm pull down resistor.                                                                                                                                                   |
| AR                   |                  |        | For OCP NIC 3.0 cards, this pin shall be connected between the card gold finger and the endpoint silicon. This pin shall be left as a no connect if NC-SI over RBT is not supported.                                                                                                   |
| RBT_RXD0<br>RBT_RXD1 | OCP_B9<br>OCP_B8 | Input  | Receive data. Data signals from the network controller to the BMC.                                                                                                                                                                                                                     |
|                      |                  |        | For baseboards, this pin shall be connected between the baseboard NC-SI over RBT PHY and the connector. This signal requires a 100 kOhm pull down resistor to GND on the baseboard between the BMC and the RBT isolator to prevent the signal from floating when no card is installed. |

|                      |                  | 1      | T                                                                                                                                                                                                                                                                                                                      |
|----------------------|------------------|--------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                      |                  |        | If the baseboard does not support NC-SI over RBT, then this pin shall be terminated to GND through a 100 kOhm pull down.                                                                                                                                                                                               |
|                      |                  |        | For OCP NIC 3.0 cards, this pin shall be connected between the card gold fingers and the RBT_RXD[0:1] pins on endpoint silicon. This pin shall be left as a no connect if NC-SI over RBT is not supported.                                                                                                             |
| RBT_TX_EN            | OCP_A7           | Output | Transmit enable.                                                                                                                                                                                                                                                                                                       |
|                      |                  |        | For baseboards, this pin shall be connected between the baseboard NC-SI over RBT PHY and the connector. This signal requires a 100 kOhm pull down resistor to ground on the baseboard between the RBT isolator and the OCP connector to prevent the card-side signals from floating when the RBT signals are isolated. |
|                      |                  |        | If the baseboard does not support NC-SI over RBT, then this pin shall be terminated to ground through a 100 kOhm pull down.                                                                                                                                                                                            |
|                      |                  |        | For OCP NIC 3.0 cards, this pin shall be connected between the card gold finger and the endpoint silicon. This pin shall be left as a no connect if NC-SI over RBT is not supported.                                                                                                                                   |
| RBT_TXD0<br>RBT_TXD1 | OCP_A9<br>OCP_A8 | Output | Transmit data. Data signals from the BMC to the network controller.                                                                                                                                                                                                                                                    |
|                      |                  |        | For baseboards, this pin shall be connected between the baseboard NC-SI over RBT PHY and the connector. This signal requires a 100 kOhm pull down resistor to GND on the baseboard between the RBT isolator and the OCP connector to prevent the card-side signals from floating when the RBT signals are isolated.    |
|                      |                  |        | If the baseboard does not support NC-SI over RBT, then this pin shall be terminated to GND through a 100 kOhm pull down.                                                                                                                                                                                               |
|                      |                  |        | Note: Some BMC vendors use the RBT_TXD[0:1] pins as hardware configuration straps. A 4.7 kOhm to 10 kOhm pull up/pull down resistor is permitted between the BMC and the RBT isolator for this purpose. The resulting network will not violate the NC-SI V <sub>IHMIN</sub> of 2.0V.                                   |
|                      |                  |        |                                                                                                                                                                                                                                                                                                                        |

|             | 1      | T       |                                                                                                          |
|-------------|--------|---------|----------------------------------------------------------------------------------------------------------|
|             |        |         | For OCP NIC 3.0 cards, this pin shall be connected                                                       |
|             |        |         | between the card gold fingers and the RBT_TXD[0:1]                                                       |
|             |        |         | pins on the endpoint silicon. This pin shall be left as a                                                |
|             |        |         | no connect if NC-SI over RBT is not supported.                                                           |
| RBT_ARB_OUT | OCP_A5 | Output  | NC-SI hardware arbitration output.                                                                       |
|             |        |         |                                                                                                          |
|             |        |         | If the baseboard supports multiple OCP NIC 3.0 cards                                                     |
|             |        |         | connected to the same RBT interface, it shall                                                            |
|             |        |         | implement logic that connects the RBT_ARB_OUT pin                                                        |
|             |        |         | of the first populated OCP NIC 3.0 card to its                                                           |
|             |        |         | RBT_ARB_IN pin if it is the only card present or to the RBT_ARB_IN pin of the next populated card and so |
|             |        |         | on sequentially for all cards on the specified RBT bus                                                   |
|             |        |         | to ensure the arbitration ring is complete. This logic                                                   |
|             |        |         | shall bypass slots that are not populated, powered                                                       |
|             |        |         | off, or in ID mode. A two OCP NIC 3.0 card example                                                       |
|             |        |         | using an analog mux is shown in Figure 86.                                                               |
|             |        |         | asing an analog man is shown in rightic oo.                                                              |
|             |        |         | If the baseboard does not support NC-SI over RBT or                                                      |
|             |        |         | implements only one OCP NIC 3.0 interface, this                                                          |
|             |        |         | signal shall be directly connected to the RBT_ARB_IN                                                     |
|             |        |         | pin to complete the hardware arbitration ring on the                                                     |
|             |        |         | OCP NIC 3.0 card.                                                                                        |
|             |        |         |                                                                                                          |
|             |        |         | For OCP NIC 3.0 cards that support hardware                                                              |
|             |        |         | arbitration, this pin shall be connected between the                                                     |
|             |        |         | card gold finger and the RBT_ARB_IN pin on the                                                           |
|             |        |         | endpoint silicon. If the card implements two                                                             |
|             |        |         | controllers, both must be connected internally to                                                        |
|             |        |         | complete the ring, see Figure 86. If hardware                                                            |
|             |        |         | arbitration is not supported, then this pin shall be                                                     |
|             |        |         | directly connected to the card edge RBT_ARB_IN pin.                                                      |
|             |        |         | This allows the hardware arbitration signals to pass                                                     |
| DDT ADD IN  | OCD 44 | la a de | through in a multi-Primary Connector baseboard.                                                          |
| RBT_ARB_IN  | OCP_A4 | Input   | NC-SI hardware arbitration input.                                                                        |
| - 17 K      |        |         | If the baseboard supports multiple OCP NIC 3.0 cards                                                     |
|             |        |         | connected to the same RBT interface, it shall                                                            |
|             |        |         | implement logic that connects the RBT_ARB_IN pin                                                         |
|             |        |         | of the first populated OCP NIC 3.0 card to its                                                           |
|             |        |         | RBT_ARB_OUT pin if it is the only card present or to                                                     |
|             |        |         | the RBT_ARB_OUT pin of the next populated card                                                           |
|             |        |         | and so on sequentially for all cards on the specified                                                    |
|             |        |         | RBT bus to ensure the arbitration ring is complete.                                                      |
|             |        |         | This logic shall bypass slots that are not populated,                                                    |
|             |        |         | powered off, or in ID mode. A two OCP NIC 3.0 card                                                       |
|             |        |         | example using an analog mux is shown in Figure 86.                                                       |
|             |        |         |                                                                                                          |

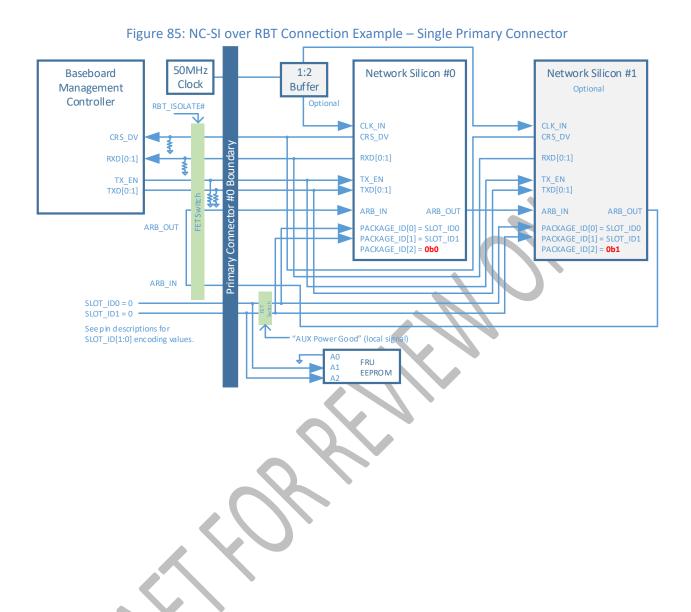
| SLOT_ID0 | OCP_B7 | Output | If the baseboard of implements only of signal shall be directly arbitration ring or a point arbitration, this point arbitration, this point arbitration, this point arbitration is illustration is not a complete the ring arbitration is not a directly connected pin. This allows the pass through in a baseboard. | one OCP NIC 3.0 in ectly connected to a to complete the a the OCP NIC 3.0 ards that support in shall be connected the RBT_ARB_C and the RBT_ARB_C ard implements be connected, see Figure 86. If supported, then the to the card edge are hardware arbitr multi-Primary Cor | hterface, this the hardware card.  hardware ted between the DUT pin on the ents two dinternally to hardware his pin shall be RBT_ARB_OUT ation signals to |
|----------|--------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| SLOT_ID1 | OCP_A6 |        | For baseboards, t<br>connected to GNI<br>to +3.3V_EDGE th                                                                                                                                                                                                                                                            | he SLOT_ID[1:0] p<br>O through a 100 O<br>rough a 4.7 kOhm<br>are based on the f                                                                                                                                                                                            | hm pull down or                                                                                                                                           |
|          |        |        | (Decimal)                                                                                                                                                                                                                                                                                                            | OCP_A6                                                                                                                                                                                                                                                                      | OCP_B7                                                                                                                                                    |
|          |        |        | 0                                                                                                                                                                                                                                                                                                                    | 0                                                                                                                                                                                                                                                                           | 0                                                                                                                                                         |
|          |        |        | 1                                                                                                                                                                                                                                                                                                                    | 0                                                                                                                                                                                                                                                                           | 1                                                                                                                                                         |
|          |        |        | 2                                                                                                                                                                                                                                                                                                                    | 1                                                                                                                                                                                                                                                                           | 0                                                                                                                                                         |
|          |        |        | 3                                                                                                                                                                                                                                                                                                                    | 1                                                                                                                                                                                                                                                                           | 1                                                                                                                                                         |
|          |        |        | from floating prio<br>good."  For OCP NIC 3.0 c<br>to the endpoint d<br>ID[0]. SLOT_ID1 sl                                                                                                                                                                                                                           | BT Package ID and CP NIC 3.0 card. The III implement weat 47 kOhm) to prevent to the local siliconards, SLOT_ID0 should be associated                                                                                                                                       | the FRU EEPROM ne OCP NIC 3.0 nk pull up or pull ent the silicon pins on "Aux power all be connected ated with Package                                    |

For OCP NIC 3.0 cards with multiple endpoint devices, Package ID[2] shall be used to identify a second physical RBT capable controller on the same physical card.

For Package ID addressing, the SLOT\_ID[1:0] pins shall be buffered on NIC side with a FET switch (or a similar implementation) to prevent a leakage path when the OCP NIC 3.0 card is in ID mode. The SLOT\_ID[1:0] buffers shall isolate the signals to the network silicon until an "Aux Power Good" is generated locally from the NIC. This indication shall be generated from an on-board voltage monitor or similar logic. OCP NIC 3.0 designers may omit isolation logic for the Package ID addressing if the target silicon properly isolates the signals when it is unpowered.

For FRU EEPROM addressing, the SLOT\_ID0 pin shall be directly connected to the EEPROM A1 address pin; SLOT\_ID1 shall be connected to the EEPROM A2 address pin. No isolation shall be used for the FRU EEPROM connections.

For endpoint devices without NC-SI over RBT support, these pins shall only be connected to the FRU EEPROM as previously described.



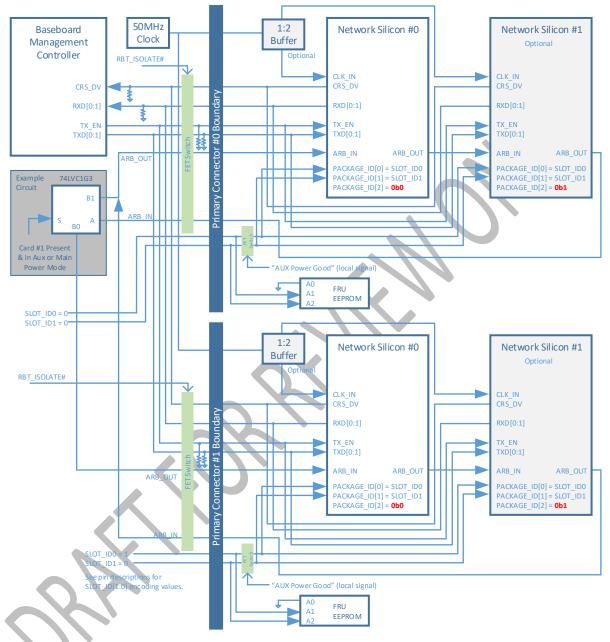


Figure 86: NC-SI over RBT Connection Example – Dual Primary Connectors

**Note 1:** For baseboard designs with a single Primary Connector, connect ARB\_IN to ARB\_OUT to complete the NC-SI hardware arbitration ring. For designs with multiple Primary Connectors, connect ARB\_IN and ARB\_OUT to an analog mux to complete the NC-SI arbitration ring based on the number of cards installed in the system. An example dual Primary Connector implementation is shown in Figure 86.

**Note 2:** For baseboard implementations having two or more RBT busses, the baseboard hardware arbitration rings shall remain within their respective bus and shall not cross RBT bus domains.

**Note 3:** The baseboard implementation shall maintain the arbitration ring integrity when there exists one or more cards that are not present, plugged in but are powered off, or in ID Mode.

**Note 4:** For OCP NIC 3.0 cards with two discrete endpoint silicon, the Package ID[2] bit shall be statically set based on the silicon instance. For example, the figure above shows Network Silicon #0 and Network Silicon #1. Network Silicon #0 has Package ID[2] = 0b0, Network Silicon #1 has Package ID[2] = 0b1.

**Note 5:** Designs that implement a clock fan out buffer will affect the RBT timing budget. Careful analysis of the timing budget is required. Refer to Section 5.1 for RBT signal integrity and timing budget considerations.

#### 3.4.5 Scan Chain Pins

This section provides the pin assignments for the Scan Chain interface signals on the Primary Connector OCP Bay. The scan chain is a point-to-point bus on a per OCP slot basis. The scan chain consists of two unidirectional busses, a common clock and a common load signal. The DATA\_OUT signal serially shifts control signals from the baseboard to the OCP NIC 3.0 card. The DATA\_IN signal serially shifts bits from the OCP NIC 3.0 card to the baseboard. The DATA\_OUT and DATA\_IN chains are independent of each other. The scan chain CLK is driven from the baseboard. The LD pin, when asserted by the baseboard, allows loading of the data on to the shift registers. An example timing diagram is shown in Figure 87. An example connection diagram is shown in Figure 88.

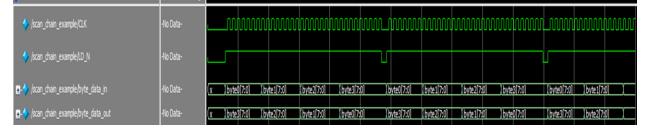
**Note:** The DATA\_OUT chain is provisioned, but is not used on OCP NIC 3.0 cards for this revision of the specification.

| Signal Name | Pin #  | Baseboard | Signal Description                                                                                                                                                                                                                                                        |
|-------------|--------|-----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|             |        | Direction |                                                                                                                                                                                                                                                                           |
| CLK         | OCP_B6 | Output    | Scan clock. The CLK is an output pin from the                                                                                                                                                                                                                             |
|             |        |           | baseboard to the OCP NIC 3.0 card. The CLK may run up to 12.5MHz.                                                                                                                                                                                                         |
|             |        |           | For baseboard implementations, the CLK pin shall be connected to the Primary Connector. The CLK pin shall be tied directly to GND if the scan chain is not used.                                                                                                          |
|             |        |           | For NIC implementations, the CLK pin shall be connected to Shift Registers 0 & 1, and optionally connected to Shift Registers 2 & 3 (if implemented) as defined in the text and Figure 88, below. The CLK pin shall be pulled up to +3.3V_EDGE through a 1 kOhm resistor. |
| DATA_OUT    | OCP_B5 | Output    | Scan data output from the baseboard to the OCP NIC 3.0 card. This bit stream is used to shift configuration data out to the NIC.                                                                                                                                          |

Table 27: Pin Descriptions – Scan Chain

|         |        |        | For baseboard implementations, the DATA_OUT pin shall be connected to the Primary Connector. The DATA_OUT pin shall be pulled down to GND through a 1 kOhm resistor if the scan chain is not used.  For NIC implementations, the DATA_OUT pin shall be                                                      |
|---------|--------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|         |        |        | pulled down to GND on the OCP NIC 3.0 card through a 10 kOhm resistor.                                                                                                                                                                                                                                      |
| DATA_IN | OCP_B4 | Input  | Scan data input to the baseboard. This bit stream is used to shift out NIC status bits to the baseboard.                                                                                                                                                                                                    |
|         |        |        | For baseboard implementations, the DATA_IN pin shall be pulled up to +3.3V_EDGE through a 10 kOhm resistor to prevent the input signal from floating if a card is not installed. This pin may be left as a no connect if the scan chain is not used.                                                        |
|         |        |        | For NIC implementations, the DATA_IN scan chain is required. The DATA_IN pin shall be connected to Shift Register 0, as defined in the text and Figure 88.                                                                                                                                                  |
| LD#     | OCP_B3 | Output | Scan shift register load. Used to latch configuration data on the OCP NIC 3.0 card.  For baseboard implementations, the LD# pin shall be pulled up to +3.3V_EDGE through a 1 kOhm resistor if the scan chain is not used to prevent the OCP NIC 3.0 card from erroneous data latching.                      |
|         |        |        | For NIC implementations, the LD# pin implementation is required. The LD# pin shall be connected to Shift Registers 0 & 1, and optionally connected to Shift Registers 2 & 3 (if implemented) as defined in the text and Figure 88. The LD# pin shall be pulled up to +3.3V_EDGE through a 10 kOhm resistor. |

Figure 87: Example Scan Chain Timing Diagram



The scan chain provides sideband status indication between the OCP NIC 3.0 card and the baseboard. The scan chain bit definition is defined in the two tables below. The scan chain data stream is 32-bits in length for both the DATA\_OUT and the DATA\_IN streams. The scan chain implementation is optional on

the host, but its implementation is mandatory per Table 28 and Table 29 on all OCP NIC 3.0 cards. The scan chain components operates on the +3.3V\_EDGE power domain.

The DATA\_OUT bus is an output from the host. The DATA\_OUT bus provides initial configuration options to the OCP NIC 3.0 card. At the time of this writing, the DATA\_OUT bus is not used. All baseboard systems that implement the Scan Chain shall connect DATA\_OUT between the platform and the Primary Connector for subsequent revisions of this specification. The DATA\_OUT data stream shall shift out all 0's prior to AUX\_PWR\_EN assertion to prevent leakage paths into unpowered silicon.

| Byte.bit | DATA_OUT Field | Default | Description                     |
|----------|----------------|---------|---------------------------------|
|          | Name           | Value   |                                 |
| 0.[07]   | Reserved       | 0h00    | Reserved. Byte 0 value is 0h00. |
| 1.[07]   | Reserved       | 0h00    | Reserved. Byte 1 value is 0h00. |
| 2.[07]   | Reserved       | 0h00    | Reserved. Byte 2 value is 0h00. |
| 3.[07]   | Reserved       | 0h00    | Reserved. Byte 3 value is 0h00. |

Table 28: Pin Descriptions – Scan Chain DATA OUT Bit Definition

The DATA\_IN bus is an input to the host and provides NIC status indication. The default implementation is completed with two 8-bit 74LV165 parallel in to serial out shift registers in a cascaded implementation. Up to four shift registers may be implemented to provide additional NIC status indication to the host platform. Alternatively, an OCP NIC 3.0 card vendor may choose to implement this chain using an active device (such as a microcontroller or CPLD). For active device implementations, there is an associated device start-up time. Refer to Section 3.11 for details on the +3.3V\_EDGE stable to the first data valid read in ID Mode.

DATA\_IN shift register 0 shall be mandatory for scan chain implementations for the card present, WAKE\_N and thermal threshold features. DATA\_IN shift registers 1, 2 & 3 are optional depending on the line side I/O and LED fields being reported to the host. Dual port LED applications require shift register 1. Quad port LED applications require shift registers 1 & 2. Octal port applications require shift registers 1, 2 & 3.

The host should read the DATA\_IN bus multiple times to qualify the incoming data stream. The number of data qualification reads is dependent on the baseboard implementation.

On the OCP NIC 3.0 card, a 1 kOhm pull up resistor shall be connected to the SER input of the last DATA\_IN shift register. Doing so ensures the default bit value of 0b1 for implementations using less than four shift registers.

| Byte.bit | DATA_IN Field Name | Default<br>Value | Description                                                                                      |
|----------|--------------------|------------------|--------------------------------------------------------------------------------------------------|
| 0.0      | PRSNTB[0]_P#       | 0bX              | PRSNTB[3:0]# bits shall reflect the same state as                                                |
| 0.1      | PRSNTB[1]_P#       | 0bX              | the signals on the Primary Connector. Connect                                                    |
| 0.2      | PRSNTB[2]_P#       | 0bX              | these scan chain signals directly to the OCP NIC                                                 |
| 0.3      | PRSNTB[3]_P#       | 0bX              | 3.0 card edge PRSNTB[3:0]# pins. The OCP NIC 3.0 implementer may alternatively choose to locally |

Table 29: Pin Descriptions – Scan Chain DATA\_IN Bit Definition

|     |                               |                | populate pull up and pull down resistors to these scan chain inputs as long as the PRSNTB[3:0]# values are the same on the scan chain and card edge.                                                                                                     |
|-----|-------------------------------|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0.4 | WAKE_N /<br>PRSNTB[0]_S#      | ObX /<br>ObX   | PCIe WAKE_N signal shall reflect the same state as the signal on the Primary Connector.                                                                                                                                                                  |
|     |                               |                | For LFF designs, this bit shall also serve as the PRSNTB[0]# signal from the Secondary Connector when the card is in ID Mode (AUX_PWR_EN==0). Multiplexing between the two functions shall be controlled via AUX_PWR_EN. Refer to Figure 88 for details. |
| 0.5 | TEMP_WARN_N /<br>PRSNTB[1]_S# | 0b1 /<br>0bX / | Temperature monitoring pin from the on-card thermal solution. This pin shall be asserted low when the network silicon or transceiver module temperature sensors exceed the temperature warning threshold.                                                |
|     |                               |                | For cards that do not require temperature reporting, the TEMP_WARN_N value shall be statically set to 0b1. Refer to Section 4.4 for details on temperature reporting.                                                                                    |
|     |                               |                | For LFF designs, this bit shall also serve as the PRSNTB[1]# signal from the Secondary Connector when the card is in ID Mode (AUX_PWR_EN==0). Multiplexing between the two functions shall be controlled via AUX_PWR_EN. Refer to Figure 88 for details. |
| 0.6 | TEMP_CRIT_N /<br>PRSNTB[2]_S# | Ob1 /<br>ObX   | Temperature monitoring pin from the on-card thermal solution. This pin shall be asserted low when the network silicon or transceiver module temperature sensors exceed the temperature critical threshold.                                               |
|     |                               |                | For cards that do not require temperature reporting, the TEMP_CRIT_N value shall be statically set to 0b1. Refer to Section 4.4 for details on temperature reporting.                                                                                    |
|     |                               |                | For LFF designs, this bit shall also serve as the PRSNTB[2]# signal from the Secondary Connector when the card is in ID Mode (AUX_PWR_EN==0). Multiplexing between the two functions shall be controlled via AUX_PWR_EN. Refer to Figure 88 for details. |

| 0.7 | FAN_ON_AUX /<br>PRSNTB[3]_S# / | 0b0 /<br>0bX | When high, FAN_ON_AUX shall request the system fan to be enabled for extra cooling in the S5 state.                                                                                                                                                      |
|-----|--------------------------------|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|     |                                |              | The FAN_ON_AUX bit shall be asserted when the network silicon or transceiver module cooling requested threshold has been exceeded. The temperature at which this assertion occurs is device dependent.                                                   |
|     |                                |              | The FAN_ON_AUX bit shall deassert when the network silicon or transceiver module temperature is at least 5°C below the assertion threshold.                                                                                                              |
|     |                                |              | 0b0 – The system fan is not requested/off in S5.<br>0b1 – The system fan is requested/on in S5.                                                                                                                                                          |
|     |                                |              | For cards that do not require temperature reporting, the FAN_ON_AUX value shall be statically set to 0b0. Refer to Section 4.4 for details on temperature reporting.                                                                                     |
|     |                                | 18           | For LFF designs, this bit shall also serve as the PRSNTB[3]# signal from the Secondary Connector when the card is in ID Mode (AUX_PWR_EN==0). Multiplexing between the two functions shall be controlled via AUX_PWR_EN. Refer to Figure 88 for details. |
| 1.0 | LINK_SPDA_PO#                  | 0b1          | Port 0 link and speed A indication (max speed). Active low.                                                                                                                                                                                              |
|     |                                |              | 0b0 – Link LED is illuminated on the host platform.<br>0b1 – Link LED is not illuminated on the host<br>platform.                                                                                                                                        |
| (   |                                |              | <ul> <li>On = link is detected on the port and is at the maximum speed.</li> <li>Off = the physical link is down, the link is not operating at the maximum speed or the port is disabled.</li> </ul>                                                     |
|     |                                |              | Note: The link and speed A LED may also be blinked for use as port identification.                                                                                                                                                                       |
| 1.1 | LINK_SPDB_P0#                  | 0b1          | Port 0 link and speed B indication (not max speed). Active low.                                                                                                                                                                                          |
|     |                                |              | 0b0 – Link LED is illuminated on the host.                                                                                                                                                                                                               |

|     |                           |            | 0b1 – Link LED is not illuminated on the host.                                                 |
|-----|---------------------------|------------|------------------------------------------------------------------------------------------------|
|     |                           |            |                                                                                                |
|     |                           |            | On = link is detected on the port and is not at the                                            |
|     |                           |            | maximum speed.                                                                                 |
|     |                           |            | <b>Off</b> = the physical link is down, the link is                                            |
|     |                           |            | operating at the maximum speed, or the port is                                                 |
|     |                           |            | disabled.                                                                                      |
|     |                           |            | Note: The link and speed B LED may also be                                                     |
|     |                           |            | blinked for use as port identification.                                                        |
| 1.2 | ACT_P0#                   | 0b1        | Port 0 activity indication. Active low.                                                        |
|     |                           |            |                                                                                                |
|     |                           |            | 0b0 – ACT LED is illuminated on the host.                                                      |
|     |                           |            | 0b1 – ACT LED is not illuminated on the host.                                                  |
|     |                           |            | Disting a stilling and the second state of the second The LED                                  |
|     |                           |            | Blinking = activity is detected on the port. The LED should blink at the rate of ½ Hz to 5 Hz. |
|     |                           |            | Off = no activity is detected on the port.                                                     |
| 1.3 | LINK SPDA P1#             | 0b1        | Port 1 link and speed A indication (max speed).                                                |
| 1.5 | ENVICES DIVELLIN          | 001        | Active low.                                                                                    |
| 1.4 | LINK SPDB P1#             | 0b1        | Port 1 link and speed B indication (not max                                                    |
|     |                           |            | speed). Active low.                                                                            |
| 1.5 | ACT_P1#                   | 0b1        | Port 1 activity indication. Active low.                                                        |
| 1.6 | LINK_SPDA_P2#             | 0b1        | Port 2 link and speed A indication (max speed).                                                |
|     |                           |            | Active low.                                                                                    |
| 1.7 | LINK_SPDB_P2#             | 0b1        | Port 2 link and speed B indication (not max                                                    |
| 2.0 | ACT P2#                   | 0b1        | speed). Active low.  Port 2 activity indication. Active low.                                   |
| 2.0 | LINK SPDA P3#             | 0b1<br>0b1 | Port 3 link and speed A indication (max speed).                                                |
| 2.1 | LINK_SI DA_I S#           | ODI        | Active low.                                                                                    |
| 2.2 | LINK_SPDB_P3#             | 0b1        | Port 3 link and speed B indication (not max                                                    |
|     |                           |            | speed). Active low.                                                                            |
| 2.3 | ACT_P3#                   | 0b1        | Port 3 activity indication. Active low.                                                        |
| 2.4 | LINK_SPDA_P4#             | 0b1        | Port 4 link and speed A indication (max speed).                                                |
| 2.5 | LIANK COOR SAII           | Ol: 4      | Active low.                                                                                    |
| 2.5 | LINK_SPDB_P4#             | 0b1        | Port 4 link and speed B indication (not max speed). Active low.                                |
| 2.6 | ACT P4#                   | 0b1        | Port 4 activity indication. Active low.                                                        |
| 2.7 | LINK SPDA P5#             | 0b1<br>0b1 | Port 5 link and speed A indication (max speed).                                                |
| 2.7 | E. 11 5 5 7 1 5 7 1 5 7 1 | 001        | Active low.                                                                                    |
| 3.0 | LINK_SPDB_P5#             | 0b1        | Port 5 link and speed B indication (not max                                                    |
|     | _ <b>_</b>                |            | speed). Active low.                                                                            |
| 3.1 | ACT_P5#                   | 0b1        | Port 5 activity indication. Active low.                                                        |
| 3.2 | LINK_SPDA_P6#             | 0b1        | Port 6 link and speed A indication (max speed).                                                |
|     |                           |            | Active low.                                                                                    |
| 3.3 | LINK_SPDB_P6#             | 0b1        | Port 6 link and speed B indication (not max                                                    |
|     |                           |            | speed). Active low.                                                                            |

| 3.4 | ACT_P6#       | 0b1 | Port 6 activity indication. Active low.         |
|-----|---------------|-----|-------------------------------------------------|
| 3.5 | LINK_SPDA_P7# | 0b1 | Port 7 link and speed A indication (max speed). |
|     |               |     | Active low.                                     |
| 3.6 | LINK_SPDB_P7# | 0b1 | Port 7 link and speed B indication (not max     |
|     |               |     | speed). Active low.                             |
| 3.7 | ACT_P7#       | 0b1 | Port 7 activity indication. Active low.         |



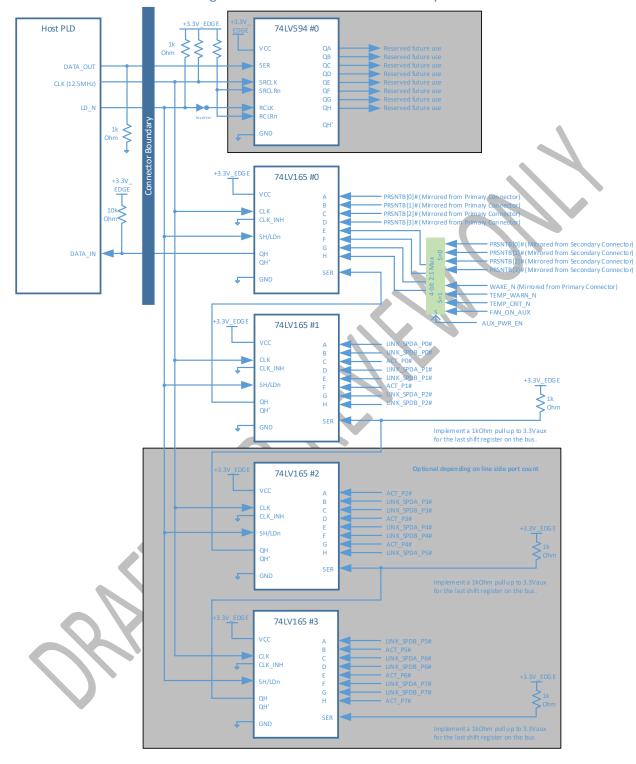


Figure 88: Scan Chain Connection Example

# 3.4.6 Power Supply Pins

This section provides the pin assignments for the power supply interface signals. The AC/DC specifications are defined in the PCIe CEM Specification, Rev 4.0 and amended in Section 3.9. An example connection diagram is shown in Figure 89.

Table 30: Pin Descriptions – Power

| Signal Name | Pin #   | Baseboard | Signal Description                                                                                        |
|-------------|---------|-----------|-----------------------------------------------------------------------------------------------------------|
|             |         | Direction |                                                                                                           |
| GND         | Various | GND       | Ground return; a total of 46 ground pins are on the                                                       |
|             |         |           | main 140-pin connector area. Additionally, a total of 4                                                   |
|             |         |           | ground pins are in the OCP bay area. Refer to Section                                                     |
|             |         |           | 3.3 for details.                                                                                          |
| +12V_EDGE   | B1, B2, | Power     | +12 V main or +12 V aux power; total of 6 pins per                                                        |
|             | B3, B4, |           | connector. The +12V_EDGE pins shall be rated to 1.1 A                                                     |
|             | B5, B6  |           | per pin with a maximum derated power delivery of 80                                                       |
|             |         |           | W.                                                                                                        |
|             |         |           | The +12V_EDGE power pins shall be within the rail                                                         |
|             |         |           | tolerances as defined in Section 3.9 when the PWR_EN                                                      |
|             |         |           | pin is driven high by the baseboard.                                                                      |
| l           |         |           | The OCD NIC 2 0 conditions until mally implement a func                                                   |
|             |         |           | The OCP NIC 3.0 card may optionally implement a fuse                                                      |
| +3.3V_EDGE  | B11     | Power     | on +12V_EDGE to protect against electrical faults.<br>+3.3 V main or +3.3 V aux power; total of 1 pin per |
| +3.3V_EDGE  | DII     | Power     | connector. The +3.3V EDGE pin shall be rated to 1.1 A                                                     |
|             |         |           | for a maximum derated power delivery of 3.63 W.                                                           |
|             |         |           | 101 a maximum derated power delivery of 5.05 w.                                                           |
|             |         |           | The +3.3V_EDGE power pin shall be within the rail                                                         |
|             |         |           | tolerances as defined in Section 3.9 when the PWR_EN                                                      |
|             |         |           | pin is driven high by the baseboard.                                                                      |
|             |         |           | The OCP NIC 3.0 card may optionally implement a fuse                                                      |
|             |         |           | on +3.3V_EDGE to protect against electrical faults.                                                       |
| AUX_PWR_EN  | B12     | Output    | Aux Power enable. Active high.                                                                            |
|             |         |           | This pin indicates that the baseboard +12V_EDGE and                                                       |
| $\wedge$    |         |           | +3.3V_EDGE power are supplied per the Aux Power                                                           |
|             |         |           | Mode requirements described in Section 3.9.                                                               |
|             | 1       |           | Additionally, this signal notifies the OCP NIC 3.0 card to                                                |
|             |         |           | enable any power supplies that run only in the Aux                                                        |
|             |         |           | Power Mode.                                                                                               |
|             |         |           | AUX_PWR_EN is pinned out on both the Primary and                                                          |
|             |         |           | Secondary Connector. For SFF and LFF OCP NIC 3.0                                                          |
|             |         |           | cards, the AUX_PWR_EN connection shall be                                                                 |
|             |         |           | implemented on the Primary Connector only. The                                                            |
|             |         |           | AUX_PWR_EN connection on the Secondary Connector                                                          |
| 1           |         |           | is reserved for a future use case.                                                                        |

|             | I      |        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|-------------|--------|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|             |        |        | This signal shall be pulled down to GND through a 10 kOhm resistor on the baseboard. This ensures the OCP NIC 3.0 card power is disabled until instructed to turn on by the baseboard.                                                                                                                                                                                                                                                                                            |
|             |        |        | When low, the OCP NIC 3.0 card supplies running on aux power shall be disabled.                                                                                                                                                                                                                                                                                                                                                                                                   |
|             |        |        | When high, the OCP NIC 3.0 card supplies running on aux power shall be enabled.                                                                                                                                                                                                                                                                                                                                                                                                   |
|             |        |        | For OCP NIC 3.0 cards that do not use a separate "main power" domain circuitry (or can operate in a single power domain), the AUX_PWR_EN signal serves as the primary method to enable all the card power supplies.                                                                                                                                                                                                                                                               |
|             |        |        | For OCP NIC 3.0 cards that support the Programming Mode power state, the condition AUX_PWR_EN==0 and MAIN_PWR_EN==1 shall prevent the aux power supplies from being enabled. An example of this logic is shown in Figure 89.                                                                                                                                                                                                                                                      |
|             |        |        | It is expected that a baseboard will not drive signals other than SMBus and the Scan Chain to the OCP NIC 3.0 card when this signal is low.                                                                                                                                                                                                                                                                                                                                       |
| MAIN_PWR_EN | OCP_B2 | Output | Main Power Enable. Active high.                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|             |        |        | This pin indicates that the baseboard +12V_EDGE and +3.3V_EDGE power are supplied per the Main Power Mode requirements described in Section 3.9. Additionally, this signal notifies the OCP NIC 3.0 card to enable any power supplies that run only in the Main Power Mode.                                                                                                                                                                                                       |
|             |        |        | The MAIN_PWR_EN pin is driven by the baseboard and may only be asserted when AUX_PWR_EN is already asserted. The MAIN_PWR_EN pin must be implemented on baseboard systems, but may optionally be used to control main power rail power supplies by the OCP NIC 3.0 card depending on the end point silicon implementation. Depending on the silicon vendor, end point devices may be able to operate in a single power domain, or may require separate power domains to function. |
|             |        |        | For OCP NIC 3.0 cards that support the Programming Mode power state, the condition AUX_PWR_EN == 0                                                                                                                                                                                                                                                                                                                                                                                |

|                   |        | 1             |                                   |                                                             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |                                                                                        |
|-------------------|--------|---------------|-----------------------------------|-------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------|
|                   |        |               |                                   | rom bein                                                    | g enabled. An ex                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | ent the main power<br>ample of this gating                                             |
|                   |        |               | pulled do<br>baseboar             | wn to GN<br>d. This er                                      | sures the OCP N                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | is signal shall be<br>Ohm resistor on the<br>IC 3.0 card power is<br>by the baseboard. |
|                   |        |               |                                   |                                                             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | pplies running on                                                                      |
|                   |        |               | main pow                          | er shall k                                                  | oe disabled.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                        |
|                   |        |               | _                                 |                                                             | CP NIC 3.0 card subsequently controls.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         | upplies running on                                                                     |
|                   |        |               | cards tha                         | t do not ι                                                  |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                | t for OCP NIC 3.0<br>nain power" domain                                                |
| NIC DIAID COOD    | OCD 54 | lin in it.    | SVR circu                         |                                                             | A State of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the state of the sta | demails and the U                                                                      |
| NIC_PWR_GOOD      | OCP_B1 | Input         | the OCP N                         |                                                             | •                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | ignal is driven by                                                                     |
|                   |        |               | The NIC                           | DWP CO                                                      | OD cianal is used                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | to indicate when                                                                       |
|                   |        |               | _                                 |                                                             | _                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | ower domain rails                                                                      |
|                   |        |               |                                   |                                                             | onal tolerances.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | ower domain rails                                                                      |
|                   |        |               |                                   |                                                             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |                                                                                        |
|                   |        |               | The truth                         | table sho                                                   | ows the expected                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               | NIC_PWR_GOOD                                                                           |
|                   |        |               |                                   |                                                             | sequencing dep                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | _                                                                                      |
|                   |        |               | values of                         | AUX_PW                                                      | R_EN and MAIN_                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | _PWR_EN.                                                                               |
|                   |        | <i>`</i> '''' | AUX_P<br>WR_EN                    | MAIN_<br>PWR_E                                              | NIC_PWR_GOOD<br>Nominal Steady                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | State Name                                                                             |
|                   |        |               |                                   | N                                                           | State Value                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |                                                                                        |
|                   |        |               | 0                                 | 0                                                           | 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | ID Mode                                                                                |
|                   |        |               | 1                                 | 0                                                           | 1                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Aux Power Mode                                                                         |
|                   |        |               | 0                                 | 1                                                           | 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Programming Mode                                                                       |
| $\bigcirc$ $\vee$ |        |               | 1                                 | 1                                                           | 1                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              | Main Power Mode                                                                        |
|                   |        |               | Where ap<br>Power do<br>good indi | (Figure 1<br>opropriate<br>main sho<br>cation to<br>the dom | e, designs that ha<br>ould also connect<br>the NIC_PWR_G<br>ains. Refer to Fig                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | 7) for timing details.  Ive a separate Main to the main power OOD signal via a FET     |
|                   |        |               |                                   |                                                             | nal shall indicate<br>oplies are not yet                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | that the OCP NIC within nominal                                                        |

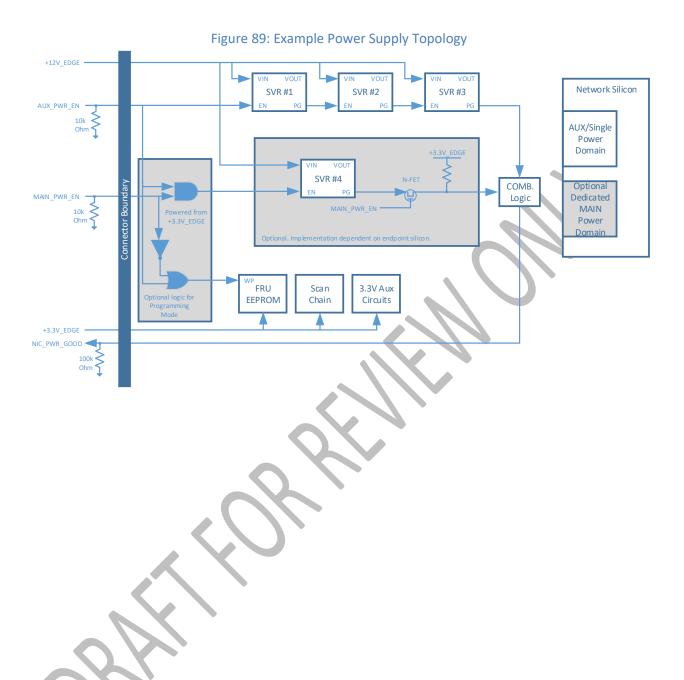
tolerances or are in a fault condition after the power ramp times ( $T_{APL}$  and  $T_{MPL}$ ) have expired.

For cards that support the Programming Mode power state, the NIC\_PWR\_GOOD signal shall remain low when the OCP NIC 3.0 card is in Programming Mode as both the Aux Power Mode and Main Power Mode power supplies are disabled. Programming Mode shall only be used on OCP NIC 3.0 cards that advertise that the Programming Mode power state is supported per Section 4.10.3.

For baseboards, this pin may be connected to the platform I/O hub as a NIC power health status indication. This signal shall be pulled down to ground with a 100 kOhm resistor on the baseboard to prevent a false power good indication if no OCP NIC 3.0 card is present.

For OCP NIC 3.0 cards this signal shall indicate the OCP NIC 3.0 card power is "good" for the given power mode. This signal may be implemented by combinatorial logic, a cascaded power good tree or a discrete power good monitor output.

When high, this signal should be treated as  $V_{\text{REF}}$  is available for NC-SI communications. Refer to timing parameter T4 in the DMTF DSP0222 specification for details.



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# 3.4.7 USB 2.0 (A68/A69) – Primary Connector Only

This section provides the pin assignments for the USB 2.0 interface signals. USB 2.0 is only defined for operation on the Primary Connector. USB 2.0 may be used for applications with end point silicon that requires a USB connection to the baseboard. Implementations may also allow for a USB-Serial or USB-JTAG translator for serial or JTAG applications. If multiple USB devices are required, an optional USB hub may be implemented on the OCP NIC 3.0 card. Downstream device discovery is completed as part of the bus enumeration per the USB 2.0 specification. A basic example connection diagram is shown in Figure 90. An example depicting USB-Serial and USB-JTAG connectivity with an USB hub is shown in Figure 91.

Table 31: Pin Descriptions – USB 2.0 – Primary Connector only

| Signal Name          | Pin #      | Baseboard          | Signal Description                                                                                                                                                                                                                            |
|----------------------|------------|--------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| -                    |            | Direction          |                                                                                                                                                                                                                                               |
| USB_DATn<br>USB_DATp | A68<br>A69 | Bi-<br>directional | USB 2.0 Differential Pair – Primary Connector Only.                                                                                                                                                                                           |
|                      |            |                    | A baseboard implementation shall provide a USB                                                                                                                                                                                                |
|                      |            |                    | connection to the OCP NIC 3.0 primary connector.                                                                                                                                                                                              |
|                      |            |                    | NIC implementations that require USB shall connect                                                                                                                                                                                            |
|                      |            |                    | the bus to the end point silicon. This pin shall be left                                                                                                                                                                                      |
|                      |            |                    | as a no connect if it is not used on the OCP NIC 3.0 card.                                                                                                                                                                                    |
|                      |            |                    |                                                                                                                                                                                                                                               |
|                      |            |                    | The USB pins shall be directly connected between the                                                                                                                                                                                          |
|                      |            |                    | end point silicon or USB device and the card gold fingers.                                                                                                                                                                                    |
|                      |            |                    |                                                                                                                                                                                                                                               |
|                      |            | 04                 | The USB interface shall be based on a $V_{BUS} = 5 \text{ V}$ per the USB specification. Both the baseboard and NIC device shall be capable of driving a differential signal using 3.3 V logic. Differential termination ( $V_{TERM}$ ) pull- |
|                      |            |                    | up values on the D+ line, if implemented, shall also be 3.3V compliant. The OCP NIC 3.0 card may                                                                                                                                              |
|                      |            |                    | implement protection diodes and is up to the adapter vendor for placement.                                                                                                                                                                    |
| OX                   |            |                    | To prevent leakage paths, a baseboard shall not use                                                                                                                                                                                           |
|                      |            |                    | USB pull up resistors on the USB_DATp/n lines to                                                                                                                                                                                              |
|                      |            |                    | indicate the bus data transmission rate. If used, pull up resistors shall only exist on the NIC side.                                                                                                                                         |
|                      |            |                    | The AUX_PWR_EN signal may be used for                                                                                                                                                                                                         |
|                      |            |                    | downstream USB devices that require a V <sub>BUS</sub>                                                                                                                                                                                        |
|                      |            |                    | detection indication. Designers would have to ensure                                                                                                                                                                                          |
|                      |            |                    | the V <sub>BUS</sub> detection threshold supports 3.3V signaling.                                                                                                                                                                             |
|                      |            |                    | Examples of this may include USB-serial converting devices.                                                                                                                                                                                   |

Figure 90: USB 2.0 Connection Example – Basic Connectivity

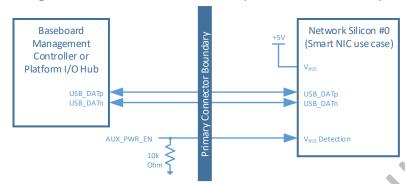
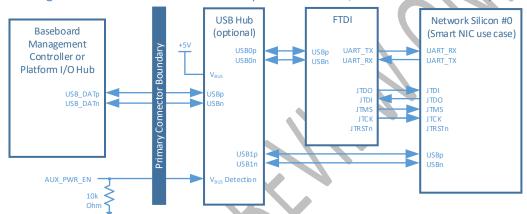


Figure 91: USB 2.0 Connection Example – USB-Serial / USB-JTAG Connectivity



# 3.4.8 UART (A68/A69) – Secondary Connector Only

This section provides the pin assignments for the UART interface signals. UART is only defined for operation on the Secondary Connector. The UART pins may be used with end point silicon that require console redirection over the baseboard – such as LFF SmartNICs. An example connection diagram is shown in Figure 92.

Table 32: Pin Descriptions – UART – Secondary Connector Only

| Signal Name | Pin # | Baseboard | Signal Description                                             |
|-------------|-------|-----------|----------------------------------------------------------------|
|             |       | Direction |                                                                |
| UART_RX     | A68   | Input     | UART Receive. +3.3 V signaling levels. Secondary               |
|             |       |           | Connector Only.                                                |
|             |       |           |                                                                |
|             |       |           | A baseboard implementation shall provide a UART                |
|             |       |           | receive connection from the OCP NIC 3.0 connector.             |
|             |       |           | The UART_RX pin shall be pulled up to +3.3 V <sub>AUX</sub> on |
|             |       |           | the baseboard to prevent erroneous data reception              |
|             |       |           | when the OCP NIC 3.0 card is powered off or not                |
|             |       |           | present.                                                       |
|             |       |           |                                                                |
|             |       |           | NIC implementations that require a UART shall                  |
|             |       |           | connect the network silicon UART_RX pin to the                 |
|             |       |           | UART_TX pin on the OCP NIC 3.0 connector. This pin             |
|             |       |           | shall be left as a no connect if it is not used on the         |
|             |       |           | OCP NIC 3.0 card.                                              |
|             |       |           |                                                                |
|             |       |           | The UART_RX pin shall be buffered on the NIC to                |
|             |       |           | prevent a leakage path into unpowered silicon when             |
|             |       |           | the card is in ID Mode. The buffer may be controlled           |
|             |       |           | via a local "Power Good" indicator.                            |
| UART_TX     | A69   | Output    | UART Transmit. +3.3 V signaling levels. Secondary              |
|             |       |           | Connector Only.                                                |
|             |       |           | A baseboard implementation shall provide a UART                |
|             |       |           | transmit connection to the OCP NIC 3.0 connector.              |
|             |       |           | transmit connection to the OCP NIC 3.0 connector.              |
|             |       |           | NIC implementations that require a UART shall                  |
|             |       |           | connect the UART_TX pin from the OCP NIC 3.0                   |
|             |       |           | connector to the target silicon UART_RX pin. This pin          |
|             |       |           | shall be left as a no connect if it is not used on the         |
|             |       |           | OCP NIC 3.0 card.                                              |
|             |       |           |                                                                |
|             |       |           | The UART_TX pin shall be buffered on the NIC to                |
|             |       |           | prevent a leakage path into unpowered silicon when             |
|             |       |           | the card is in ID Mode. The buffer may be controlled           |
|             |       |           | via a local "Power Good" indicator.                            |



Figure 92: UART Connection Example

# 3.4.9 RFU[1:4] Pins

This section provides the pin assignments for the RFU[1:4] interface signals.

Table 33: Pin Descriptions – RFU[1:4]

| Signal Name<br>(Primary /<br>Secondary) | Pin # | Baseboard<br>Direction | Signal Description                                                                                                                                                                                                                                                                                                                                                      |
|-----------------------------------------|-------|------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RFU1 / RFU3, N/C                        | B68   | Input /                | Reserved future use pins. These pins shall be left as                                                                                                                                                                                                                                                                                                                   |
| RFU2 / RFU4, N/C                        | B69   | Output                 | no connect. These pins may also be used as a differential pair for future implementations.  In this release of the OCP NIC 3.0 specification, the RFU[1:2] pins are defined on the Primary Connector. RFU[3:4] are defined on the Secondary Connector. A total of two reserved pins are available for the SFF; a total of four reserved pins are available for the LFF. |

#### 3.5 PCIe Bifurcation Mechanism

OCP NIC 3.0 baseboards and OCP NIC 3.0 cards support multiple bifurcation combinations. Single socket baseboards with a single or multiple root ports, as well as a multi-socket baseboards with a single or multiple root ports are supported. The bifurcation mechanism also supports OCP NIC 3.0 cards with a single or multiple end points. These features are accomplished via I/O pins on the Primary and Secondary Connector:

- PRSNTA#, PRSNTB[3:0]#. The PRSNTA# pin shall connect to the PRSNTB# pins as a hard coded value on the OCP NIC 3.0 card. The encoding of the PRSNTB[3:0]# pins allows the baseboard to determine the PCIe Links available on the OCP NIC 3.0 card. PRSNTA# and PRSNTB[3:0]# pins exist for each connector. For the SFF, a baseboard shall read the pins associated with the Primary Connector to determine the card type. For the LFF, a baseboard shall read the pins associated with both the Primary and Secondary Connector to determine the card type.
- BIF[3:0]#. The BIF# pin states shall be controlled by the baseboard to allow the baseboard to
  override the default end point bifurcation for silicon that support bifurcation. Additional
  combinatorial logic is required and is specific to the card silicon. The combinatorial logic is not
  covered in this specification. The BIF[3:0]# pins may optionally be hardcoded for baseboards
  that do not require a dynamic bifurcation override. BIF[2:0]# pins exist on each connector.

A high level bifurcation connection diagram is shown in Figure 82.

# 3.5.1 PCIe OCP NIC 3.0 Card to Baseboard Bifurcation Configuration (PRSNTA#, PRSNTB[3:0]#)

The OCP NIC 3.0 card to baseboard configuration mechanism consists of four dual use pins (PRSNTB[3:0]#) on the OCP NIC 3.0 card and a grounded PRSNTA# pin on the baseboard per connector. For the SFF, a baseboard shall read the pins associated with the Primary Connector to determine the card type. For the LFF, a baseboard shall read the pins associated with both the Primary and Secondary Connector to determine the card type. These pins provide card presence detection as well as mechanism to notify the baseboard of the pre-defined PCIe lane width capabilities. The PRSNTB[3:0]# pins are pulled up to +3.3V\_EDGE on the baseboard and are active low signals. A state of 0b1111 indicates that no card is present in the connector(s). Depending on the capabilities of the OCP NIC 3.0 card, a selection of PRSNTB[3:0]# signals may be strapped to the PRSNTA# signal and is pulled low by the baseboard. The encoding of the PRSTNB[3:0]# bits is shown in Table 34 for x32, x16 and x8 PCIe cards. While SFF and LFF cards are allowed in an LFF compliant slot, the condition where the Primary Connector PRSNTB[3:0]# equals 0b1111 and the Secondary Connector PRSNTB[3:0]# pins is not equal to 0b1111 is invalid.

## 3.5.2 PCIé Baseboard to OCP NIC 3.0 Card Bifurcation Configuration (BIF[2:0]#)

Three signals (BIF[2:0]#) are driven by the baseboard to notify requested bifurcation on the OCP NIC 3.0 card silicon. This allows the baseboard to set the lane configuration on the OCP NIC 3.0 card that supports multiple bifurcation options. BIF[2:0]# pins exist on each connector. For the SFF, the BIF[2:0]# pins associated with the Primary Connector are used. For the LFF, the BIF[2:0]# pins associated with both the Primary and Secondary Connector are used to determine the requested bifurcation.

For example, a baseboard that has four separate hosts that support a 4 x4 connection, should appropriately drive the BIF[2:0]# pins per Table 34 and indicate to the SFF OCP NIC 3.0 card silicon to setup a 4 x4 configuration.

As previously noted, the BIF[2:0]# signals require additional combinatorial logic to decode the BIF[2:0]# value and appropriately apply it to the end-point silicon. The combinatorial logic is not covered in the specification as its implementation is specific to the vendor silicon used.

#### 3.5.3 PCIe Bifurcation Decoder

The combination of the PRSNTB[3:0]# and BIF[2:0]# pins deterministically sets the PCIe lane width for a given combination of baseboard and OCP NIC 3.0 cards. Table 34 shows the resulting number of PCIe links and its width for known combinations of baseboards and OCP NIC 3.0 cards. A copy of this bifurcation decoder, along with a detailed PCIe lane, PERST# and REFCLCK assignments is available on the OCP NIC 3.0 Wiki site. Please refer to: <a href="https://www.opencompute.org/wiki/Server/Mezz">https://www.opencompute.org/wiki/Server/Mezz</a>.

**Note 1:** Baseboard vendors do not have to support the full complement of cases enumerated in the bifurcation table. Instead, baseboard vendors may choose to support only a subset of cases that is applicable to their hardware topology.

**Note 2:** The baseboard must disable PCIe lanes during the initialization phase if the number of detected PCIe links are greater than what is supported on the baseboard to prevent a nondeterministic solution. For example, if the baseboard only supports a 1 x16 connection, and the OCP NIC 3.0 card only supports a 2 x8 connection, the baseboard must disable PCIe lanes 8-15 to prevent any potential LTSSM issues during the discovery phase.

**Note 3:** Due to separate PCIe REFCLKs and power state timing differences in multi-host configurations, Table 34 shows the expected resulting links for a given baseboard and OCP NIC 3.0 card combination.



Table 34: PCIe Bifurcation Decoder for x32, x16, x8, x4, x2 and x1 Card Widths

|             |                                                              |                                                                             |                                              |                                         |                                                        |                                            | 1 1 10                                  |                                                                       |                                              |                                                                 | 1                                         |                                           | 1 1 1 1 1 1                                           |                                                                                           |
|-------------|--------------------------------------------------------------|-----------------------------------------------------------------------------|----------------------------------------------|-----------------------------------------|--------------------------------------------------------|--------------------------------------------|-----------------------------------------|-----------------------------------------------------------------------|----------------------------------------------|-----------------------------------------------------------------|-------------------------------------------|-------------------------------------------|-------------------------------------------------------|-------------------------------------------------------------------------------------------|
|             |                                                              |                                                                             | SFF (2C+/4C+): Host CPU Sockets>             | lockets>                                | 1 Upstream Socket                                      | 2 Upstream Sockets                         | 4 Upstream Sockets                      | 4 Sockets                                                             | This condition is not                        | 71.                                                             | Upstream Sockets (1                       | This                                      | 4                                                     | 4 Sockets                                                                                 |
|             |                                                              |                                                                             |                                              |                                         |                                                        |                                            |                                         |                                                                       | applicable for SFF. 32 lanes                 |                                                                 | (F)                                       | applicable for SFF. 32                    | 8                                                     | (1 Socket per Host)<br>First 8 PCle lanes                                                 |
|             |                                                              |                                                                             | SFF: Total PCIe Links (1 connector)>         | nector)>                                | 1, 2, or 4 Links                                       | 2 Links                                    | 4 Links                                 | 4 x2 links                                                            | is only available in the LFF implementation. | is only available in the LFF implementation.                    | 2 Links                                   | the LFF implementation.                   |                                                       | 4 x2 links                                                                                |
|             |                                                              |                                                                             | LFF: Host CPU Sockets>                       |                                         | 2 Upstream Sockets                                     | 4 Upstream Sockets<br>(2 sockets per host) | 8 Upstream Sockets<br>(Note 1)          | 8 Upstream Sockets<br>First 8 PCle lanes per<br>connector<br>(Note 1) | 1 Upstream Socket                            | 2 Upstresm Sockets<br>(1 Socket per host)                       | 4 Upstream Sockets<br>(2 Socket per Host) | 4 Upstresm Sockets (1<br>socket per Host) | 8 Upstresm Sockets<br>(2 Socket per Host)<br>(Note 1) | 8 Upstream Sockets<br>(2 Socket per Host)<br>First 8 PCIe lanes per<br>connector (Note 1) |
|             |                                                              |                                                                             | LFF: Total PCle Links (Across 2 connectors)> | ss 2 connectors)>                       | 1, 2, 4 or 8 Links                                     | 4 Links                                    | 8 Links                                 | 8 x2 links                                                            | 1Link<br>(No Bifurcation)                    | 1, 2, or 4 Links                                                | 4 Links                                   | 4 Links                                   | 8 Links                                               | 8 x2 links                                                                                |
|             |                                                              |                                                                             | System Link Width Support per Connector>     | per Connector>                          | 1x16,1x8,1x4,1x2,1x1<br>2x8,2x4,2x2,2x1<br>4x4,4x2,4x1 | 1x8,1x4,1x2,1x1<br>2x8,2x4,2x2,2x1         | 4 x4, 4 x2, 4x1                         | 4 x2, 4 x1                                                            | 1×15                                         | 1xf6, 1x8, 1x4, 1x2, 1x1<br>2x6, 2x4, 2x2, 2x1<br>4x4, 4x2, 4x1 | 2x8,2x4,2x2,2x1                           | 2 x8, 2 x4, 2 x2, 2 x1                    | 4x4,4x2,4x1                                           | 4 x2, 4 x1                                                                                |
|             | Metwork Card                                                 | d - b                                                                       | Primary Connector BIF[2:0]# (SFF & LFF)      | # (SFF & LFF) ->                        | 00000                                                  | 06001                                      | 06010                                   | 00011                                                                 |                                              | 00100                                                           |                                           | 0610                                      | 06110                                                 | 06#1                                                                                      |
| pue         | Card Short S                                                 | Card Short Supported Bifurcation                                            | Primary Connector                            | Secondary Connector                     |                                                        | 0000                                       | OIOGO .                                 | IIOGO                                                                 | 00000                                        | 00190                                                           |                                           | 000                                       | OII o                                                 |                                                                                           |
| ridth<br>15 | Not Present (                                                | Card Not Present                                                            | Obtiff (not used)                            |                                         |                                                        |                                            |                                         |                                                                       |                                              |                                                                 |                                           |                                           |                                                       |                                                                                           |
| OEE OU      | -0                                                           | 1x8,1x4,1x2,1x1                                                             | 061110                                       | 0bffff (not used)                       | 1x8                                                    | 1x8<br>(Sorbot Dodu)                       | 1x4<br>(Socker Ocele)                   | 1x2<br>(Socket 0 colu)                                                |                                              |                                                                 | 1x8<br>(Hort Doels)                       |                                           | 1x4<br>(Hoot 0 colu)                                  | 1x2<br>(Host Coole)                                                                       |
| 2           | -                                                            | 1x4,1x2,1x1                                                                 | 061110                                       | 0bffff (not used)                       | 1x4                                                    | 1x4<br>(Sector Conty)                      | 1x4                                     | 1x2                                                                   |                                              |                                                                 | 1x4                                       |                                           | 1x4<br>(Heat Creek)                                   | 1x2<br>Office O code)                                                                     |
| 23 25       | П                                                            | 1x2,1x1                                                                     | 0b1ff0                                       | Obititi (not used)                      | 1x2                                                    | 1x2                                        | 1x2                                     | 1x2                                                                   |                                              |                                                                 | 1x2                                       |                                           | 1x2                                                   | 1x2                                                                                       |
| 22.4        | T                                                            | 1x1                                                                         | 061110                                       | Obititi (not used)                      | 1x1                                                    | (Socket U only)                            | (Socket U only)                         | (Socket U only)                                                       |                                              |                                                                 | (Host U only)                             |                                           | (Host U only)                                         | (Host U only)                                                                             |
| SFF 2C+     | 2                                                            | 1x8,1x4,1x2,1x1                                                             | 061101                                       | 0bffff (not used)                       | 1x8                                                    | (Socket Donly) 1x8 (Socket Donly)          | (Socket 0 only) 2 x4 (Socket 0 & 1)     | (Socket 0 only) 2 x2 (Socket 0 & 2 colu)                              |                                              |                                                                 | (Host 0 only)<br>1x8<br>(Host 0 only)     |                                           | (Host Donly)<br>2 x4<br>(Host 0 & t)                  | (Host Conly)<br>2 x2<br>(Host 0 & 2 celu)                                                 |
| SFF 2C+     | 1x8 Option B                                                 | C X4, C XC, C X.                                                            | 00-4004                                      | 000000000000000000000000000000000000000 | 93                                                     | (Socret Collis)                            | (accueros)                              | (Note 4)                                                              |                                              |                                                                 | (fines a com)                             |                                           | (Lacascal)                                            | (Note 4)                                                                                  |
| SFF 4C+     | 2 x8 Option B                                                | 6 x0, 6 x4, 6 x6, 6 x1<br>4 x4, 4 x2, 4 x1                                  |                                              | ODIIII (not used)                       | e<br>v                                                 | ŝ.                                         | ***                                     | (Socket 0 & 2 only)                                                   |                                              |                                                                 | (Hox 0 & 1)                               |                                           | ž.                                                    | C XC<br>(Hozt 0 & 2 only)<br>(Note 4)                                                     |
| SFF 2C+     | 1x8 Option D                                                 | 1x8,1x4<br>2x4,<br>1x8 Option D 4x2 (First 8 lanes), 4x1                    | 061100                                       | Obfiff (not used)                       | 1x8                                                    | 1x8<br>(Socket 0 only)                     | 2 x4<br>(Socket 0 & 1)                  | 4 x2                                                                  |                                              |                                                                 | 1x8<br>(Host 0 only)                      |                                           | 2 x4<br>(Host 0 & 1)                                  | 4 x2                                                                                      |
|             | 1x16 Option D                                                | 1x16,1x8,1x4<br>2x8,2x4,<br>4x4,4x2 (First 8 lanes),4                       | 06/100                                       | 0bffff (not used)                       | 1x16                                                   | 2 x8                                       | 4 74                                    | 4 x2                                                                  |                                              |                                                                 | 2 x8<br>(Host 0 & 1)                      |                                           | 4 74                                                  | 4×2                                                                                       |
| BSVD        | RSVD                                                         | RSVD                                                                        | 0b10ff (not used)                            | Obtiff (not used)                       |                                                        |                                            |                                         |                                                                       |                                              |                                                                 |                                           |                                           |                                                       |                                                                                           |
| SFF 2C+     | 2 x4                                                         | 2x4, 2x2, 2x1<br>1x4, 1x2, 1x1                                              | 051010                                       | Obfiff (not used)                       | 2 x 4                                                  | 1x4<br>(Socket 0 only)                     | 2 x4<br>(Socket 0 & 1)                  | 2 x2<br>(Socket 0 & 2 only)<br>(Note 4)                               |                                              |                                                                 | 1x4<br>(Host 0 only)                      |                                           | 2 x4<br>(Host 0 & 1)                                  | 2 x2<br>(Host 0 & 2 only)<br>(Note 4)                                                     |
| SFF 2C+     | 4 x2                                                         | 4 x2 (First 8 lanes), 4 x1<br>2 x2, 2 x1<br>1 x2, 1 x1                      | 061001                                       | Obfiff (not used)                       | 2 x 2                                                  | 1x2<br>(Socket 0 only)                     | 2 x2<br>(Socket 0 & 1)                  | 4 x2                                                                  |                                              |                                                                 | 1x2<br>(Host 0 only)                      |                                           | 2 x2<br>(Host 0 & 1)                                  | 4 x2                                                                                      |
| RSVD        | RSVD                                                         | RSVD for future x8                                                          | Ob1000 (not used)                            | Obititi (not used)                      |                                                        |                                            |                                         |                                                                       |                                              |                                                                 |                                           |                                           |                                                       |                                                                                           |
| SFF 4C+     | 1x16 Option A                                                | 1x16,1x6,1x4,1x2,1x1                                                        | Upom                                         | Ubiliti (not used)                      | 1xIb                                                   | 1x6<br>(Socket 0 only)                     | 1x4<br>(Socket 0 only)                  | 1x2<br>(Socket 0 only)                                                |                                              |                                                                 | 1x6<br>(Hoct 0 only)                      |                                           | 1x4<br>(Host 0 only)                                  | 1 x2<br>(Host 0 only)                                                                     |
| SFF 4C+     | 2 x8 Option A                                                | 2 x8, 2 x4, 2 x2, 2 x1                                                      | 060110                                       | 0b1111 (not used)                       | eo<br>So                                               | S XS                                       | 2 x4<br>(Socket 0 & 2 only)<br>(Note 4) | 1x2<br>(Socket 0 only)                                                |                                              |                                                                 | 2x8<br>(Hoxt 0 & 1)                       |                                           | 2 x4<br>(Host 0 & 2 only)                             | 1x2<br>(Host 0 only)                                                                      |
|             |                                                              | 1x16,1x8,1x4,1x2,1x1<br>2x8,2x4,2x2,2x1                                     | 06.0101                                      | Obfiff (not used)                       | 1x16                                                   | 2 x 8                                      | 2 x4<br>(Socket 0 & 2 only)<br>(Note 4) | 1x2<br>(Socket 0 only)                                                |                                              |                                                                 | 2 x8<br>(Host 0 & 1)                      |                                           | 2 x4<br>(Host 0 & 2 only)                             | 1x2<br>(Host 0 only)                                                                      |
| SFF 4C+     | 1x16 Option C                                                | 1x16,1x8,1x4<br>2x8,2x4,2x2,2x1<br>4x4,4x2,4x1                              | 060100                                       | Obfiff (not used)                       | 1x16                                                   | 2×8                                        | 4 x 4                                   | 2 x2<br>(Socket 0 & 2 only)                                           |                                              |                                                                 | 2 x8<br>(Ho±10 % 1)                       |                                           | 4 x4                                                  | 2 x2<br>(Host 0 & 2 only)                                                                 |
| FF 4C+      | 4 x4                                                         | 4 x4, 4 x2, 4 x1                                                            | 050011                                       | 0bffff (not used)                       | \$x.\$                                                 | 2 x4<br>(EP 0 and 2 only)                  | 4 x 4                                   | 1x2<br>(Socket 0 only)                                                |                                              |                                                                 | 2 x4<br>(Hoạt 0 & 1)                      |                                           | \$X\$                                                 | 1x2<br>(Host 0 only)                                                                      |
| The second  | 2x16 Option A                                                | 2x 16, 2 x8, 2 x4, 2 x2, 2 x1                                               | 060111                                       | 050111                                  | 2 x16                                                  | 2 x8<br>(Socket 0 & 2 only)                | 2 x4<br>(Socket 0 & 4 only)             | 2 x2<br>(Sockets 0 & 4)                                               | 1x16                                         | 2 x16                                                           | 2 x8<br>(Host 0 & 2)                      | 2x8<br>(Hoxt 0 & 2)                       | 2 x4<br>(Socket 0 on each Host<br>0 & 2)              | 2 x2<br>(Socket 0 on each Host<br>0 & 2)                                                  |
|             |                                                              |                                                                             |                                              | 060110                                  | 4x8                                                    | 4x8                                        | 4 x4<br>(Sockets 0, 2, 4 & 6)           | 2 x 2<br>(Sockets 0 & 4)                                              | 1x8                                          | 4 x8                                                            | <b>4</b> x8                               | <b>4</b> x8                               | ch Hoot                                               | 2 x2<br>(Socket 0 on each Host<br>0 & 2)                                                  |
| LFF         | 2 x16 Option B                                               | 2 x16, 2 x8, 2 x4, 2 x2, 2 x1<br>4 x8, 4 x4, 4 x2, 4 x1                     | 06.0101                                      | 050101                                  | 2×16                                                   | 4 x8                                       | 4 x4<br>(Sockets 0, 2, 4 & 6)           | 2 x2<br>(Sockets 0 & 4)                                               | 1x16                                         | 2×16                                                            | 8x. <b>t</b>                              | \$x.\$                                    | 4 x4<br>(Socket 0 on each Host<br>0.1,2 & 3)          | 2 x2<br>(Host 0 & 2)                                                                      |
|             | 2 x16 Option C                                               | 2 x16, 2 x8, 2 x4, 2 x2, 2 x1<br>4 x8, 4 x4, 4 x2, 4 x1<br>8 x4, 8 x2, 8 x1 | 000100                                       | 050100                                  | 2 x16                                                  | 8x 4                                       | 8 x4<br>(Note 1)                        | 4 x2<br>(Sockets 0, 2, 4 & 6)                                         | 1x16                                         | 2 x16                                                           | 4.x6                                      | 8x 4                                      | 8 x4<br>(Note 1)                                      | 2 x 2<br>(Host 0 & 2)                                                                     |
| RSVD        | RSVD                                                         | RSVD                                                                        | 0b0010 (not used)                            |                                         |                                                        |                                            |                                         |                                                                       |                                              |                                                                 |                                           |                                           |                                                       |                                                                                           |
|             | 1x32 Option A 1x32<br>1x16, 1<br>2x16, 2<br>4x8, 4<br>8x4, 8 | x8,1x4,1x2,1x1<br>2x8,2x4,2x2,2x1<br>x4,4x2,4x1<br>x2,8x1                   | 00000                                        | 000090                                  | 2 x 16                                                 | . \$2 <b>*</b>                             | 8 x4<br>(Note 1)                        | 4 x2<br>(Sockets 0, 2, 4 % 6)                                         | 1x32                                         | 2 x 16                                                          | . \$x                                     | . \$x                                     | 8x4<br>(Note 1)                                       | 2 x 2<br>(Host 0 & 2)                                                                     |
|             | 1x32 Option B                                                | 1x32<br>1x16,1x8,1x4,1x2,1x1                                                | 000090                                       | 000001                                  | 1×16                                                   | 1x8<br>(Socket 0 only)                     | 1x4<br>(Socket 0 only)                  | 1x2<br>(Socket 0 only)                                                | 1x32                                         | 1x16<br>(Socket 0 only)                                         | 1x8<br>(Host 0 only)                      | 1x8<br>(Host 0 only)                      | 1x4<br>(Host 0 only)                                  | 1x2<br>(Host 0 only)                                                                      |
|             |                                                              |                                                                             |                                              |                                         |                                                        |                                            |                                         |                                                                       |                                              |                                                                 |                                           |                                           |                                                       |                                                                                           |

#### 3.5.4 Bifurcation Detection Flow

The following detection flow shall be used to determine the resulting link count and lane width based on the baseboard and OCP NIC 3.0 card configurations.

- 1. The baseboard shall read the state of the PRSNTB[3:0]# pins for the Primary Connector and Secondary Connector (if applicable). An OCP NIC 3.0 card is present in the system if the resulting value is not 0b1111 on the Primary Connector.
- 2. Firmware determines the OCP NIC 3.0 card PCIe lane width capabilities per Table 34 by reading the PRSNTB[3:0]# pins.
- 3. The baseboard reconfigures the PCIe bifurcation on its ports to match the highest common lane width and lowest common link count on the card.
- 4. For cases where the baseboard request a link count override (such as requesting a 4-host baseboard requesting 4 x4 operation on a supported card that would otherwise default to a 2 x8 case), the BIF[0:2]# pins shall be asserted as appropriate. Asserting the BIF[0:2]# pins assumes the OCP NIC 3.0 card supports the requested link override.
  - Note: For cards that are already powered up, BIF[0:2]# reconfiguration requires a transition back to ID Mode. During this transition, the card power rails are inactive and manageability links may be briefly lost due to the RBT isolation state.
- 5. The BIF[0:2]# pins must be in their valid states upon the assertion of AUX PWR EN.
- 6. AUX\_PWR\_EN is asserted. An OCP NIC 3.0 card is allowed a max ramp time T<sub>APL</sub> between AUX\_PWR\_EN assertion and NIC\_PWR\_GOOD assertion.
- 7. MAIN\_PWR\_EN is asserted. An OP NIC 3.0 card is allowed a max ramp time T<sub>MPL</sub> between MAIN\_PWR\_EN assertion and NIC\_PWR\_GOOD reassertion. For cards that do not have a separate AUX and MAIN power domain, this state is an unconditional transition to NIC\_PWR\_GOOD.
- 8. The PCIe REFCLK shall become valid a minimum of 100 μs before the deassertion of PERST#.
- 9. PERST# shall be deasserted >1 s after NIC\_PWR\_GOOD assertion as defined in Figure 106. Refer to Section 3.11 for timing details.

## 3.5.5 PCIe Bifurcation Examples

For illustrative purposes, the following figures show several common bifurcation permutations using a SFF.

# 3.5.5.1 Single Host (1 x16) Baseboard with a 1 x16 OCP NIC 3.0 Card (Single Controller)

Figure 93 illustrates a single host baseboard that supports x16 with a single controller OCP NIC 3.0 card that also supports x16. The PRSTNB[3:0]# state is 0b0111. The BIF[2:0]# state is 0b000 to set the card as a 1x16 for bifurcation capable controllers. For controllers without bifurcation support, the BIF[2:0] pin connections are not required on the card. The PRSNTB encoding notifies the baseboard that this card is only capable of 1 x16. The single host baseboard determines that it is also capable of supporting 1 x16. The resulting link width is 1 x16.

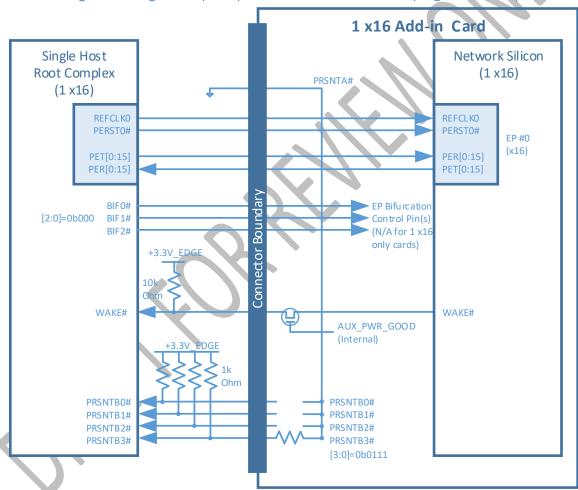


Figure 93: Single Host (1 x16) and 1 x16 OCP NIC 3.0 Card (Single Controller)

# 3.5.5.2 Single Host (2 x8) Baseboard with a 2 x8 OCP NIC 3.0 Card (Dual Controllers)

Figure 94 illustrates a single host baseboard that supports 2 x8 with a dual controller OCP NIC 3.0 card that also supports 2 x8. The PRSTNB[3:0]# state is 0b0110. The BIF[2:0]# state is 0b000 in this example because the network card only supports a 2x8. The PRSNTB encoding notifies the baseboard that this card is only capable of 2 x8. The single host baseboard determines that it is also capable of supporting 2 x8. The resulting link width is 2 x8.

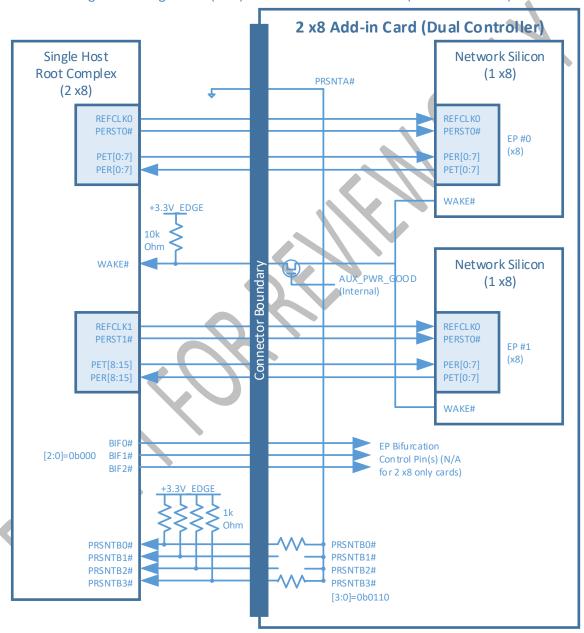


Figure 94: Single Host (2 x8) and 2 x8 OCP NIC 3.0 Card (Dual Controllers)

## 3.5.5.3 Quad Host (4 x4) Baseboard with a 4 x4 OCP NIC 3.0 Card (Single Controller)

Figure 95 illustrates a quad host baseboard that supports 4 x4 with a single controller OCP NIC 3.0 card that supports 1 x16, 2 x8 and 4 x4. The PRSTNB[3:0]# state is 0b0100. The BIF[2:0]# state in this example is 0b110 as the end point network controller is forced to bifurcate to 4 x4. The PRSNTB encoding notifies the baseboard that this card is only capable of 1 x16, 2 x8 and 4 x4. The quad host baseboard determines that it is also capable of supporting 4 x4. The resulting link width is 4 x4.

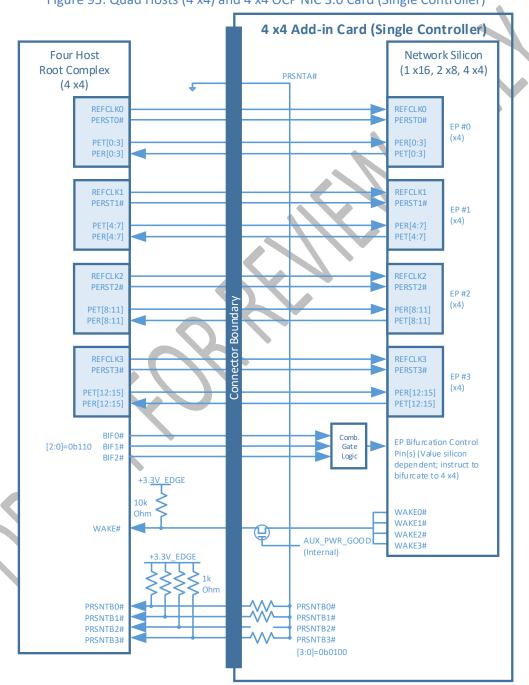
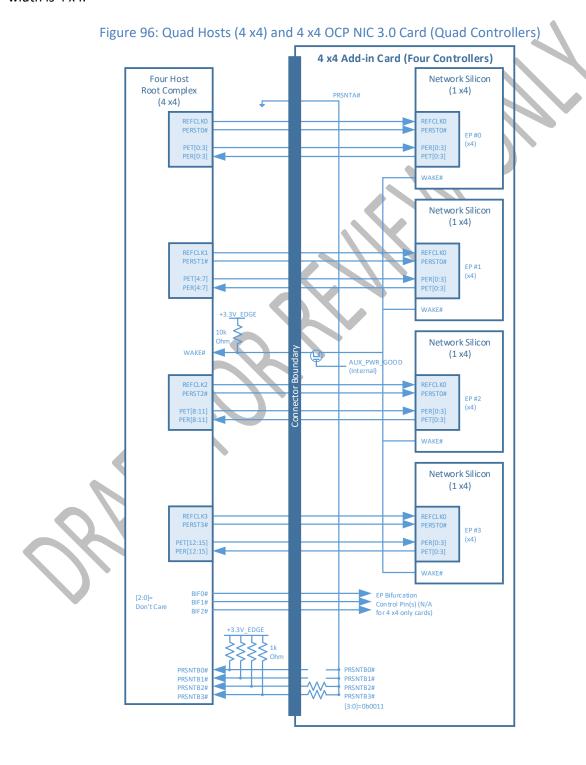


Figure 95: Quad Hosts (4 x4) and 4 x4 OCP NIC 3.0 Card (Single Controller)

## 3.5.5.4 Quad Host (4 x4) Baseboard with a 4 x4 OCP NIC 3.0 Card (Quad Controllers)

Figure 96 illustrates a quad host baseboard that supports 4 x4 with a quad controller OCP NIC 3.0 card that supports 4 x4. The PRSTNB[3:0]# state is 0b0011. The BIF[2:0]# state is a don't care value as there is no need to instruct the end-point network controllers to a specific bifurcation (each controller only supports 1x4 in this example). The PRSNTB encoding notifies the baseboard that this card is only capable of 4 x4. The quad host baseboard determines that it is also capable of supporting 4 x4. The resulting link width is 4 x4.



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# 3.5.5.5 Single Host (1 x16, no Bifurcation) Baseboard with a 2 x8 OCP NIC 3.0 Card (Dual Controller)

Figure 97 illustrates a single host baseboard that supports 1 x16 with a dual controller OCP NIC 3.0 card that supports 2 x8. The PRSTNB[3:0]# state is 0b0110. The BIF[2:0]# state is 0b000 as each silicon instance only supports 1x8. The PRSNTB encoding notifies the baseboard that this card is only capable of 2 x8. The quad host baseboard determines that it is capable of 1x 16, but down shifts to 1 x8. The resulting link width is 1 x8 and only on endpoint 0.

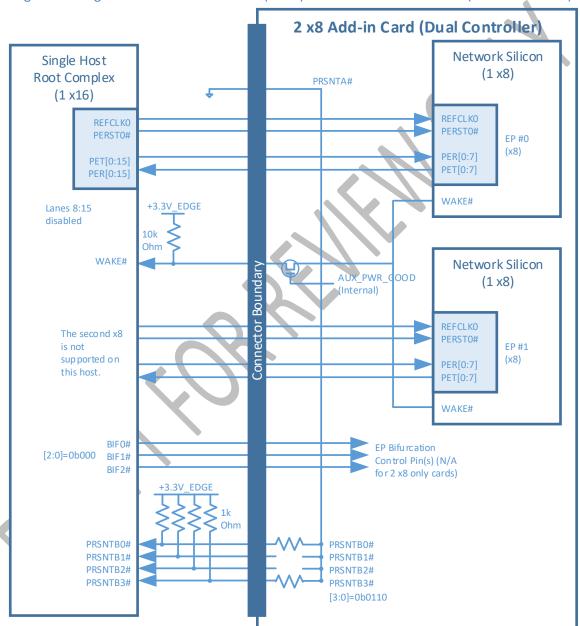


Figure 97: Single Host with no Bifurcation (1 x16) and 2 x8 OCP NIC 3.0 Card (Dual Controllers)

# 3.6 PCIe REFCLK and PERST# Mapping

The OCP NIC 3.0 specification allows for up to four PCIe REFCLKs and PERST# signals on the Primary Connector and up to two PCIe REFCLKs and PERST# signals on the Secondary Connector. The association of each REFCLK and PERST# is based on the card PCIe Link number and is shown in Table 35. Cards that implement both the Primary and Secondary Connectors have a total of up to 6 available REFCLKs and 6 PERST# signals.

REFCLK[0:3] and PERST[0:3]# are defined for use in this release of the specification. REFCLK[4:5] and PERST[4:5]# are not currently defined for use. The following tables enumerate the REFCLK and PERST# mapping for SFF cards for 1, 2 and 4 links; LFF cards for 1, 2, 4 and 8 links. For a LFF 8 link scenario, the lower x4 "link-a" and upper x4 "link-b" of each x8 lanes are expected to use the same REFCLK and PERST (see Table 37). A 1:2 clock driver circuit is expected on the OCP NIC 3.0 card in this case.

For multi-host use cases, the baseboard may require a multiplexer circuit to direct the Host 1, Host 2 PCIe reference clock to the connector REFCLK1 signal to maintain proper REFCLK associations for a card with two links. Refer to the diagrams in Sections 3.6.1 and 3.6.2.

| REFCLK # | PERST # | Description             | Availability (Connector)  |
|----------|---------|-------------------------|---------------------------|
| REFCLK0  | PERSTO# | Associated with Link 0. | Primary Connector only.   |
| REFCLK1  | PERST1# | Associated with Link 1. | Primary Connector only.   |
| REFCLK2  | PERST2# | Associated with Link 2. | Primary Connector only.   |
| REFCLK3  | PERST3# | Associated with Link 3. | Primary Connector only.   |
| REFCLK4  | PERST4# | Not used.               | Secondary Connector only. |
| REFCLK5  | PERST5# | Not used.               | Secondary Connector only. |

Table 35: PCIe REFCLK and PERST Associations

| Table 36: SFF PCIe Link | / REFCLKn | / PERSTn mapping for 1, 2 and 4 Links |
|-------------------------|-----------|---------------------------------------|
|-------------------------|-----------|---------------------------------------|

|                               |                                                             | 11 0 7                |                       |  |  |  |  |
|-------------------------------|-------------------------------------------------------------|-----------------------|-----------------------|--|--|--|--|
|                               | Primary C                                                   | Connector             |                       |  |  |  |  |
| Lanes [0:3]                   | Lanes [4:7]                                                 | Lanes [8:11]          | Lanes [12:15]         |  |  |  |  |
| Link 0 – x16, REFCLKO, PERSTO | #                                                           |                       |                       |  |  |  |  |
| Link 0 – x8, REFCLKO, PERSTO# | Link 0 – x8, REFCLK0, PERST0# Link 1 – x8, REFCLK1, PERST1# |                       |                       |  |  |  |  |
| Link 0 – x4, REFCLKO,         | Link 1 – x4, REFCLK1,                                       | Link 2 – x4, REFCLK2, | Link 3 – x4, REFCLK3, |  |  |  |  |
| PERSTO#                       | PERST1#                                                     | PERST2#               | PERST3#               |  |  |  |  |

Table 37: LFF PCIe Link / REFCLKn / PERSTn mapping for 1, 2, 4 and 8 Links

| Primary Connector              |                                |                 |                       | Secondary Connector            |                       |               |                      |  |  |
|--------------------------------|--------------------------------|-----------------|-----------------------|--------------------------------|-----------------------|---------------|----------------------|--|--|
| Lanes                          | anes Lanes Lanes Lanes         |                 | Lanes                 | Lanes                          | Lanes                 | Lanes         |                      |  |  |
| [0:3]                          | [4:7]                          | [8:11]          | [12:15]               | [16:19]                        | [20:23]               | [24:27]       | [28:31]              |  |  |
| Link 0 – x32, R                | Link 0 – x32, REFCLKO, PERSTO# |                 |                       |                                |                       |               |                      |  |  |
| Link 0 – x16, REFCLKO, PERSTO# |                                |                 |                       | Link 2 – x16, REFCLK2, PERST2# |                       |               |                      |  |  |
| Link 0 – x8, REFCLKO, Link 1 - |                                | Link 1 – x8, RE | Link 1 – x8, REFCLK1, |                                | Link 2 – x8, REFCLK2, |               | Link 3 – x8 REFCLK3, |  |  |
| PERSTO#                        |                                | PERST1#         |                       | PERST2#                        |                       | PERST3#       |                      |  |  |
| Link 0a – x4,                  | Link 0b – x4,                  | Link 1a – x4,   | Link 1b – x4,         | Link 2a – x4,                  | Link 2b – x4,         | Link 3a – x4, | Link 3b – x4,        |  |  |
| REFCLKO,                       | REFCLKO,                       | REFCLK1,        | REFCLK1,              | REFCLK2,                       | REFCLK2,              | REFCLK3,      | REFCLK3,             |  |  |
| PERSTO#                        | PERSTO#                        | PERST1#         | PERST1#               | PERST2#                        | PERST2#               | PERST3#       | PERST3#              |  |  |

# 3.6.1 SFF PCIe REFCLK and PERST# Mapping

The following figures show the Link n, REFCLKn, PERSTn mapping for the SFF with 1, 2 and 4 links as single, dual and quad host configurations. For clarity, the PCIe sideband signals are not illustrated in this section. Please refer to the signal descriptions and associated diagrams for connectivity requirements.

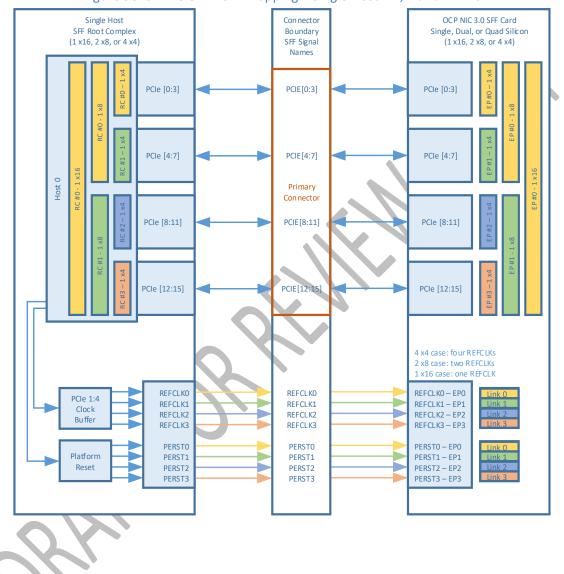


Figure 98: SFF PCIe REFCLK Mapping – Single Host – 1, 2 and 4 links

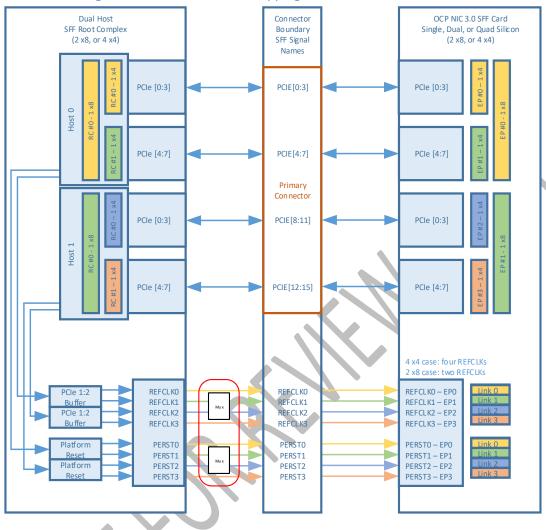


Figure 99: SFF PCIe REFCLK Mapping – Dual Host – 2 and 4 links

**Note:** For dual host applications that connect to a two link endpoint, the baseboard Host 1 REFCLKO and PERSTO signal needs to be multiplexed to the REFCLK1 and PERST1 pins of the OCP NIC 3.0 card edge. This ensures the mandated Link n, REFCLKn and PERSTn mappings are maintained.

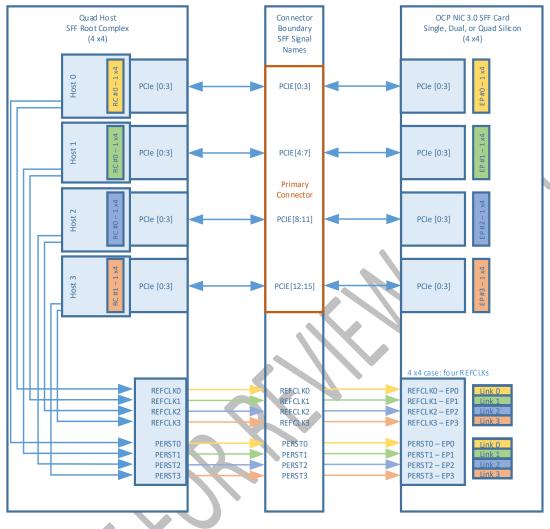


Figure 100: SFF PCIe REFCLK Mapping – Quad Host – 4 Links

**Note:** For quad host applications that connect to a two link endpoint, the baseboard Host 2 REFCLK and PERST signal needs to be multiplexed to the REFCLK1 and PERST1 pins of the OCP NIC 3.0 card edge. This ensures the mandated Link n, REFCLKn and PERSTn mappings are maintained.

## 3.6.2 LFF PCIe REFCLK and PERST# Mapping

The following figures show the Link n, REFCLKn, PERSTn mapping for the LFF with 1, 2 and 4 links as single, dual and quad host configurations. For clarity, the PCle sideband signals are not illustrated this section. Please refer to the signal descriptions and associated diagrams for connectivity requirements.

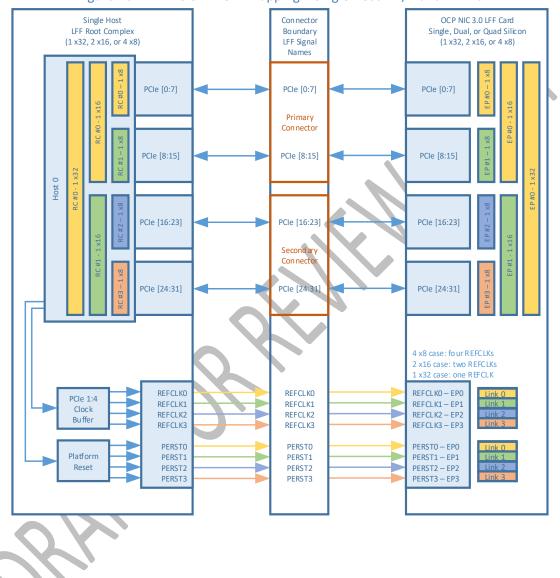


Figure 101: LFF PCIe REFCLK Mapping – Single Host – 1, 2 and 4 links

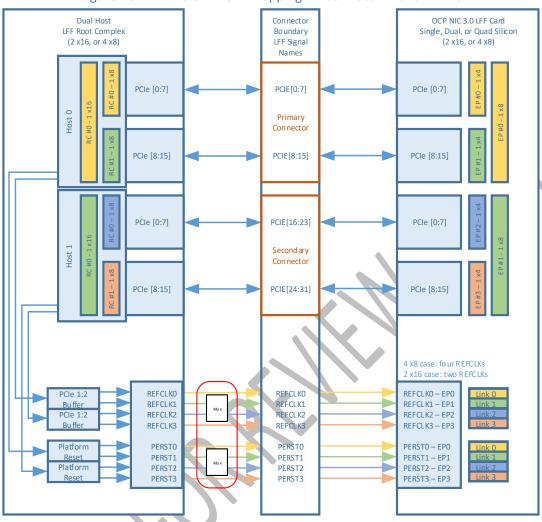


Figure 102: LFF PCIe REFCLK Mapping – Dual Host – 2 and 4 links

**Note:** For dual host applications that connect to a two link endpoint, the baseboard Host 1 REFCLKO and PERSTO signal needs to be multiplexed to the REFCLK1 and PERST1 pins of the OCP NIC 3.0 card edge. This ensures the mandated Link n, REFCLKn and PERSTn mappings are maintained.

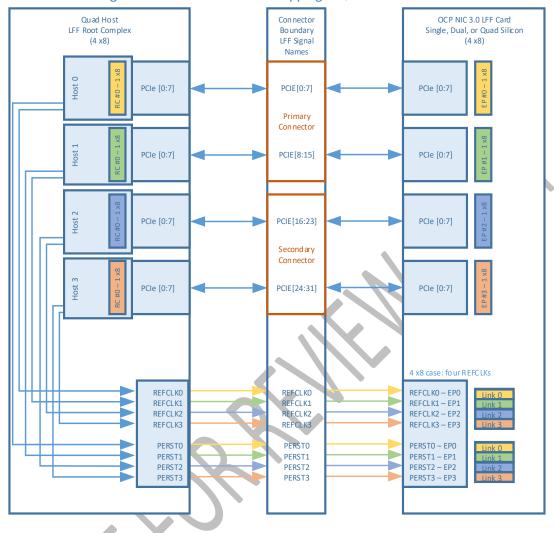


Figure 103: LFF PCIe REFCLK Mapping – Quad Host – 4 Links

**Note:** For quad host applications that connect to a two link endpoint, the baseboard Host 2 REFCLK and PERST signal needs to be multiplexed to the REFCLK1 and PERST1 pins of the OCP NIC 3.0 card edge. This ensures the mandated Link n, REFCLKn and PERSTn mappings are maintained.

# 3.6.3 REFCLK and PERST# Mapping Expansion

For cases where bifurcation are permissible on the baseboard and OCP NIC 3.0 card, an expanded PCIe Bifurcation spreadsheet is available on the OCP Wiki site: https://www.opencompute.org/wiki/Server/Mezz.

Implementers shall use the spreadsheet version that is aligned with this version of the OCP NIC 3.0 specification.

The spreadsheet enumerates all of the supported PCIe link, lane and REFCLK mappings for each supported configuration. The bifurcation decoder is shown in Section 3.5.3.

# 3.7 Port Numbering and LED Implementations

The OCP NIC 3.0 I/O bracket shall provide port labeling for user identification.

LEDs shall be implemented on the OCP NIC 3.0 I/O bracket when there is sufficient space for local indication. LEDs are typically placed on the primary side. LEDs may be optionally implemented on the secondary side of the card for space constrained implementations. LEDs may be remotely implemented on the card Scan Chain (as defined in Section 3.4.5) for link/activity indication on the baseboard. LED configurations for the local and remote cases are described in the sections below. In all cases, the actual link rate may be directly queried through the management interface.

#### 3.7.1 OCP NIC 3.0 Port Naming and Port Numbering

The numbering of all OCP NIC 3.0 external ports shall start from Port 1. When oriented with the primary side components facing up and viewing directly into the port, Port 1 shall be located on the left hand side. The port numbers shall sequentially increase to the right. Refer to Figure 104 as an example implementation.

# **3.7.2** OCP NIC **3.0** Card LED Configuration

For low I/O count SFF cards without built in light pipes (such as 1x QSFP, 2x QSFP, 2x SFP, or 2x RJ45), or LFF cards, where additional I/O bracket area is available, the card shall locally implement on-board link/activity indications. The card may additionally implement LEDs on the optional Scan Chain data stream.

For 4x SFP, a permissible LED implementation may include right angle SMT mount LEDs placed on the secondary side of the OCP NIC 3.0 card. The LEDs shall be located below the line side I/O cages.

A QSFP typically operates in a single port mode, but may be optionally configured to operate in dual or quad port modes. The LED definition extends to these modes to indicate the overall operating status of the cage.

Note: Depending on the end faceplate implementation (e.g., with an ejector latch), the secondary side LED implementation may be obstructed and biased to the left to prevent interference with the ejector cam mechanism.

The recommended local (on-card) LED implementation uses two physical LEDs (a bicolored Speed A/Speed B Link LED and a discrete Activity LED). Table 38 describes the OCP NIC 3.0 card LED implementations.

The LEDs shall be uniformly illuminated across the indicator surface. LED surfaces with a diffusion treatment are preferred. For ease of indication within the operating environment, all OCP NIC 3.0 cards shall implement measures to prevent bleed-through between LED indicators and their surrounding chassis components.

Table 38: OCP NIC 3.0 Card LED Configuration with Two Physical LEDs per Port

| Active low. The LED is illuminated when the signal is low. Bicolor multifunction LED.  Off  This LED shall be used to indicate link.  When the link is up, then this LED shall be lit and solid. This indicates that the link is established, there are no local or remote faults, and the link is ready for data packet transmission/reception.  For all single port cage implementations (SFP, QSFP and BASE-T), the LED indication shall operate as follows:  • The LED is Green when the port is linked at its maximum speed.  • The LED is Amber when the port is linked but not operating at the highest speed.  • The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:  • The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  • The LED is Green when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  • The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 mm and 537 mm while amber LEDs shall emit light at a wavelength between 580 nm and 589 nm.                                              | LED Pin | LED Color | Description                                                            |  |  |  |  |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----------|------------------------------------------------------------------------|--|--|--|--|
| multifunction LED.  This LED shall be used to indicate link.  When the link is up, then this LED shall be lit and solid. This indicates that the link is established, there are no local or remote faults, and the link is ready for data packet transmission/reception.  For all single port cage implementations (SFP, QSFP and BASE-T), the LED indication shall operate as follows:  • The LED is Green when the port is linked at its maximum speed.  • The LED is Amber when the port is linked but not operating at the highest speed.  • The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:  • The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  • The LED is Green when all ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  • The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength |         |           | •                                                                      |  |  |  |  |
| This LED shall be used to indicate link.  When the link is up, then this LED shall be lit and solid. This indicates that the link is established, there are no local or remote faults, and the link is ready for data packet transmission/reception.  For all single port cage implementations (SFP, OSFP and BASE-T), the LED indication shall operate as follows:  • The LED is Green when the port is linked at its maximum speed.  • The LED is Amber when the port is linked but not operating at the highest speed.  • The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., OSFP breakout), the LED indication shall operate as follows:  • The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  • The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  • The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                     |         | Amber     | _                                                                      |  |  |  |  |
| When the link is up, then this LED shall be lit and solid. This indicates that the link is established, there are no local or remote faults, and the link is ready for data packet transmission/reception.  For all single port cage implementations (SFP, QSFP and BASE-T), the LED indication shall operate as follows:  The LED is Green when the port is linked at its maximum speed.  The LED is Amber when the port is linked but not operating at the highest speed.  The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:  The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                           |         | Off       |                                                                        |  |  |  |  |
| that the link is established, there are no local or remote faults, and the link is ready for data packet transmission/reception.  For all single port cage implementations (SFP, QSFP and BASE-T), the LED indication shall operate as follows:  The LED is Green when the port is linked at its maximum speed.  The LED is Amber when the port is linked but not operating at the highest speed.  The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:  The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                     |         |           | This LED shall be used to indicate link.                               |  |  |  |  |
| that the link is established, there are no local or remote faults, and the link is ready for data packet transmission/reception.  For all single port cage implementations (SFP, QSFP and BASE-T), the LED indication shall operate as follows:  The LED is Green when the port is linked at its maximum speed.  The LED is Amber when the port is linked but not operating at the highest speed.  The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:  The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                     |         |           |                                                                        |  |  |  |  |
| link is ready for data packet transmission/reception.  For all single port cage implementations (SFP, QSFP and BASE-T), the LED indication shall operate as follows:  • The LED is Green when the port is linked at its maximum speed.  • The LED is Amber when the port is linked but not operating at the highest speed.  • The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:  • The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  • The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  • The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                    |         |           |                                                                        |  |  |  |  |
| LED indication shall operate as follows:  The LED is Green when the port is linked at its maximum speed.  The LED is Amber when the port is linked but not operating at the highest speed.  The LED is off when no link is present.  When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:  The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.  The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |         |           |                                                                        |  |  |  |  |
| <ul> <li>The LED is Amber when the port is linked but not operating at the highest speed.</li> <li>The LED is off when no link is present.</li> <li>When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows: <ul> <li>The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.</li> <li>The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.</li> <li>The LED is off when no link is present on all ports of the multi-lane cage.</li> </ul> </li> <li>For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.</li> <li>The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.</li> <li>The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.</li> <li>For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |         |           | LED indication shall operate as follows:                               |  |  |  |  |
| <ul> <li>The LED is off when no link is present.</li> <li>When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:</li> <li>The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.</li> <li>The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.</li> <li>The LED is off when no link is present on all ports of the multi-lane cage.</li> <li>For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.</li> <li>The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.</li> <li>The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.</li> <li>For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |         |           | The LED is Amber when the port is linked but not operating at the      |  |  |  |  |
| <ul> <li>When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:</li> <li>The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.</li> <li>The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.</li> <li>The LED is off when no link is present on all ports of the multi-lane cage.</li> <li>For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.</li> <li>The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.</li> <li>The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.</li> <li>For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |         |           |                                                                        |  |  |  |  |
| <ul> <li>operation (e.g., QSFP breakout), the LED indication shall operate as follows:</li> <li>The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.</li> <li>The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.</li> <li>The LED is off when no link is present on all ports of the multi-lane cage.</li> <li>For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.</li> <li>The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.</li> <li>The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.</li> <li>For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |         |           | The LED is off when no link is present.                                |  |  |  |  |
| <ul> <li>The LED is Green when all ports of the multi-lane cage are linked at its maximum speed.</li> <li>The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.</li> <li>The LED is off when no link is present on all ports of the multi-lane cage.</li> <li>For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.</li> <li>The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.</li> <li>The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.</li> <li>For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |         |           | operation (e.g., QSFP breakout), the LED indication shall operate as   |  |  |  |  |
| at its maximum speed.  The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.  The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |         |           |                                                                        |  |  |  |  |
| <ul> <li>The LED is Amber when one or more ports of the multi-lane cage are linked, but not operating at the highest speed, or one or more ports are down.</li> <li>The LED is off when no link is present on all ports of the multi-lane cage.</li> <li>For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.</li> <li>The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.</li> <li>The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.</li> <li>For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |         |           |                                                                        |  |  |  |  |
| are linked, but not operating at the highest speed, or one or more ports are down.  The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |         |           |                                                                        |  |  |  |  |
| The LED is off when no link is present on all ports of the multi-lane cage.  For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |         |           | are linked, but not operating at the highest speed, or one or more     |  |  |  |  |
| For silicon with limited I/O, the Amber LED may be omitted. In this case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |         |           |                                                                        |  |  |  |  |
| case, the Green LED shall simply indicate link is up at any configured speed.  The illuminated Link LED indicator may be blinked and used for port identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |         |           |                                                                        |  |  |  |  |
| identification through vendor specific link diagnostic software.  The Link LED shall be located on the left hand side or located on the top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |         |           | case, the Green LED shall simply indicate link is up at any configured |  |  |  |  |
| top for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.  For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |         |           | ,                                                                      |  |  |  |  |
| 513 nm and 537 nm while amber LEDs shall emit light at a wavelength                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |         |           | top for each port when the OCP NIC 3.0 card is viewed in the           |  |  |  |  |
|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |         |           | 513 nm and 537 nm while amber LEDs shall emit light at a wavelength    |  |  |  |  |

|          |       | For uniformity across OCP NIC 3.0 products, all link LEDs shall have their luminance across the total surface area measured in millicandelas (mcd) with an average value between 12 mcd to 18 mcd.                                     |
|----------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Activity | Green | Active low. The LED is illuminated when the signal is low.                                                                                                                                                                             |
|          | Off   |                                                                                                                                                                                                                                        |
|          |       | For all single port cage implementations (SFP, QSFP and BASE-T), the LED indication shall operate as follows:  • The LED is off when there is no activity.  • The LED should blink at the rate of ½ Hz to 5 Hz when there is activity. |
|          |       | When a multi-lane cage is configured for dual port or quad port operation (e.g., QSFP breakout), the LED indication shall operate as follows:                                                                                          |
|          |       | <ul> <li>The LED is off when there is no activity on all ports of the<br/>multi-lane cage.</li> </ul>                                                                                                                                  |
|          |       | <ul> <li>The LED should blink at the rate of ½ Hz to 5 Hz when there is<br/>activity on one or more ports of the multi-lane cage.</li> </ul>                                                                                           |
|          |       | The activity LED shall be located on the right hand side or located on the bottom for each port when the OCP NIC 3.0 card is viewed in the horizontal plane.                                                                           |
|          |       | For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm.                                                                                                                                             |
|          |       | For uniformity across OCP NIC 3.0 products, all activity LEDs shall have their luminance across the total surface area measured in millicandelas (mcd) with an average value between 12 mcd and 18 mcd.                                |

# 3.7.3 OCP NIC 3.0 Card LED Ordering

For all OCP NIC 3.0 card use cases, each port shall implement the green/amber Link LED and a green activity LED. For I/O limited silicon, the amber LED may be omitted.

When the OCP NIC 3.0 card is viewed from the horizontal position, and with the primary component side facing up, the Link LED shall be located on the left side and the activity LED shall be located on the right. The LED placement may also make use of a stacked LED assembly, or light pipe in the vertical axis. In this case, the Link Activity LED shall be on the top of the stack, and the Activity LED shall be on the bottom of the stack when viewed from the horizontal position. In all cases, the port ordering shall increase from left to right when viewed from the same horizontal position.

The actual placement of the Link and Activity LEDs on the faceplate may be left up to the discretion of the OCP NIC 3.0 card designer. The LED port association should be clearly labeled on the OCP NIC 3.0

card if the space allows. Similarly, the LED for link and the LED for Activity indication should also be marked on the faceplate. Vendors shall use the largest text permissible for increased readability.

For 4xSFP configurations, the LEDs may be placed on the secondary side of the card using right-angle SMT components. OCP NIC 3.0 designers may opt to use the scan chain LEDs instead or in addition to the on-card indicators.

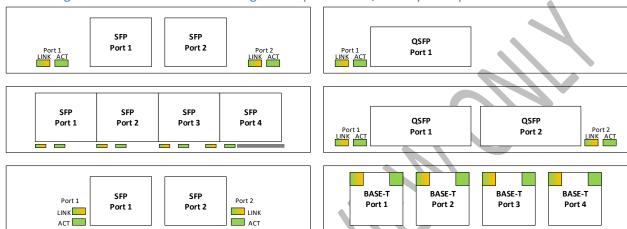


Figure 104: Port and LED Ordering - Example SFF Link/Activity and Speed LED Placement

Note 1: The example port and LED ordering diagrams shown in Figure 104 are viewed with the card in the horizontal position and the primary side is facing up.

Note 2: The 4xSFP LED implementation is biased to the left to allow clearance for the ejector latch cam.

## 3.7.4 Baseboard LEDs Configuration over the Scan Chain

A SFF OCP NIC 3.0 card with a fully populated I/O bracket (2x QSFP, 4x SFP or 4x RJ45) does not have sufficient space for primary-side discrete on-board (faceplate) LED indicators. Section 3.7.2 presents an implementation for placing LEDs on the secondary side.

In this scenario, the line side link and activity LED indicators are implemented on the baseboard system via the Scan Chain for remote indication. The Scan Chain bit stream is defined in Section 3.4.5.

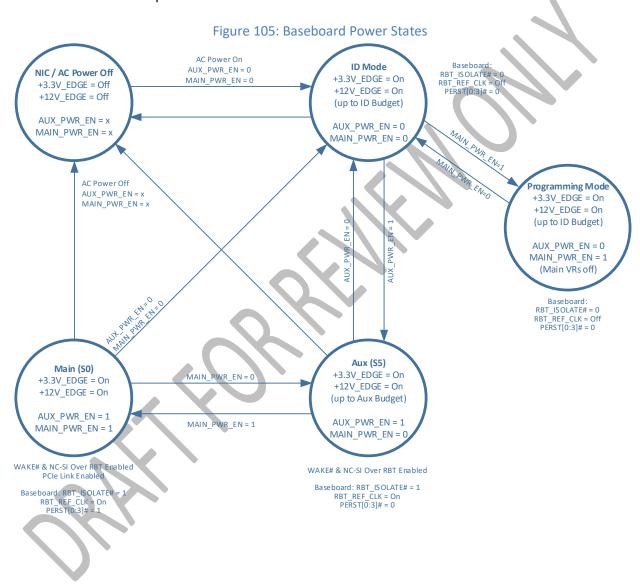
The baseboard LED implementation uses two discrete LEDs – a green/amber Link LED and a discrete green Activity. The physical baseboard LED implementation is left up to the baseboard vendor and is not defined in this specification. The LED implementation is optional for baseboards.

For serviceability, green LEDs shall emit light at a wavelength between 513 nm and 537 nm while amber LEDs shall emit light at a wavelength between 580 nm and 589 nm.

At the time of this writing, the Scan Chain definition allows for up to two link and one activity LED per port. A total of up to 8 ports are supported in the Scan Chain. The bit stream defines the LEDs to be active low (on). The Scan Chain LED implementation allows the NIC LED indicators to be remotely located on the OCP NIC 3.0 compliant chassis (e.g., front LED indicators with rear I/O cards).

# 3.8 Power State Machine

There are four permissible power states for normal operation of the card: NIC Power Off, ID Mode, Aux Power Mode (S5), and Main Power Mode (S0). These four power states are mandatory for each OCP NIC 3.0 card. An optional fifth power state is Programming Mode and allows the FRU EEPROM to be updated in the field under the baseboard control. The normal transition order for these states is shown in Figure 105 and described in detail in the sections below. For simplicity, only the signal transitions resulting in a state change are shown. The available functions per power state are defined in Table 39. The minimum transition time between power states is defined in Section 3.11.



| Power State             | AUX_PWR<br>_EN | MAIN_PW<br>R_EN | PERSTn | FRU            | Scan<br>Chain  | WAKEn | RBT<br>Link | PCle<br>Link | +3.3V<br>_EDGE | +12V<br>_EDGE  |
|-------------------------|----------------|-----------------|--------|----------------|----------------|-------|-------------|--------------|----------------|----------------|
| NIC Power Off           | Low            | Low             | Low    |                |                |       |             |              |                |                |
| ID Mode                 | Low            | Low             | Low    | Х              | X <sup>1</sup> |       |             |              | Х              | X <sup>2</sup> |
| Programming<br>Mode     | Low            | High            | Low    | X <sup>4</sup> |                |       |             |              | Х              | X <sup>2</sup> |
| Aux Power<br>Mode (S5)  | High           | Low             | Low    | Х              | Х              | Х     | Х           |              | Х              | X³             |
| Main Power<br>Mode (S0) | High           | High            | High   | Х              | Х              | Х     | Х           | X            | Х              | Х              |

Table 39: Available Card Functions per Power State

**Note 1:** Only the PRSNTB[0:3]# scan chain signals are valid in ID mode as the OCP NIC 3.0 card power rails have not yet been enabled via the AUX\_PWR\_EN/MAIN\_PWR\_EN signals.

**Note 2:** The +12V\_EDGE rail is on, but the max permissible current draw is up to the ID Mode / Programming Mode current limit defined in Section 3.9.

**Note 3:** The +12V\_EDGE rail is on, but the max permissible current draw is up to the Aux Power Mode current limit defined in Section 3.9.

**Note 4:** The FRU EEPROM WP pin is low (not write protected) to enable programming using any of the defined methods for controlling the EEPROM WP signal. Refer to the FRU Write Protection Mechanism field in Section 4.10.3.

#### 3.8.1 NIC Power Off

In NIC Power Off mode, all power delivery has been turned off or the card is not physically plugged into the baseboard. Transition to this state can be from any other state.

## 3.8.2 ID Mode

In the ID Mode, only +3.3V\_EDGE is available for powering up the FRU EEPROM and the Scan Chain devices. All OCP NIC 3.0 cards must enter the ID Mode state for FRU EEPROM and scan chain queries immediately following the NIC Power Off state. The baseboard queries the EEPROM and determines the OCP NIC 3.0 device capabilities. The FRU EEPROM content requirements are defined in Section 4.10.3. Only the card PRSNTB[0:3]# bits are valid on the scan chain in this mode as the OCP NIC 3.0 card power rails have not yet been enabled via the AUX\_PWR\_EN and MAIN\_PWR\_EN signals. The WAKE#, TEMP\_WARN#, TEMP\_CRIT#, Link and Activity bits are invalid and should be masked by the baseboard in ID Mode.

The +12V\_EDGE rail is not intended to be used in ID Mode, however leakage current may be present. The max leakage is defined in Section 3.9. An OCP NIC 3.0 card shall transition to this mode when AUX PWR EN=0 and MAIN PWR EN=0.

#### 3.8.3 Aux Power Mode (S5)

The Aux Power Mode provides both  $+3.3V\_EDGE$  as well as  $+12V\_EDGE$  is available.  $+12V\_EDGE$  in Aux mode may be used to deliver power to the OCP NIC 3.0 card, but only up to the Aux mode budget as defined in Table 40. An OCP NIC 3.0 card shall transition to this mode when AUX\_PWR\_EN=1, MAIN\_PWR\_EN=0, NIC\_PWR\_GOOD=1 and the duration  $(T_{APL})$  has passed for the ID-Aux Power Mode

ramp. This guarantees the ID mode to Aux Power Mode transition (as shown in Figure 106) has completed and all Aux Power Mode rails are within operating tolerances. The WAKE#, TEMP\_WARN#, and TEMP\_CRIT# bits shall not sampled until these conditions are met.

#### 3.8.4 Main Power Mode (S0)

The Main Power Mode provides both +3.3V\_EDGE and +12V\_EDGE across the OCP connector. The OCP NIC 3.0 card operates in full capacity. Up to 80 W may be delivered on +12V\_EDGE for a SFF Card and up to 150 W for a LFF Card. Additionally, up to 3.63 W is delivered on each +3.3V\_EDGE pin. An OCP NIC 3.0 card shall transition to this mode when AUX\_PWR\_EN=1, MAIN\_PWR\_EN=1, NIC\_PWR\_GOOD=1 and the duration (T<sub>MPL</sub>) has passed for the Aux-Main Power Mode ramp. This guarantees the Aux Power Mode to Main Power Mode transition (as shown in Figure 106) has completed and all Main Power Mode rails are within operating tolerances. The WAKE#, TEMP\_WARN#, and TEMP\_CRIT# bits shall not sampled until these conditions are met.

## 3.8.5 Programming Mode

The Programming Mode only provides +3.3V\_EDGE for powering up the FRU EEPROM. This is an optional state that disables the FRU EEPROM write protection mechanism via combinatorial logic and allows the baseboard to reprogram the FRU EEPROM. This state shall only be entered from ID mode if the FRU EEPROM advertises support for this power state as defined in Section 4.10.3.

Additionally, the Aux Power Mode and Main Power Mode SVRs need to remain disabled and NIC\_PWR\_GOOD shall remain low while the card is in this state. An example discrete logic circuit to accomplish this gating is shown in Figure 89. NIC vendors may implement their own gating circuitry as long as the same result is achieved.

Devices which use GPIO, NC-SI or PLDM for FRU EEPROM WP control may allow programming of the FRU EEPROM when in operating in the Aux Power or Main Power Modes. Usage of the GPIO signal, NC-SI or PLDM to control the WP mechanism are implementation specific and is outside the scope of this specification.

### 3.9 Power Supply Rail Requirements and Slot Power Envelopes

The baseboard provides +3.3V\_EDGE and +12V\_EDGE to both the Primary and Secondary Connectors. The rail requirements are leveraged from the PCIe CEM 4.0 specification. For OCP NIC 3.0 implementations, there are five total power envelopes. Four are defined for SFF, and one is defined for LFF. The max current draw is defined in Table 40 for each state and power envelope and is inclusive of the line side transceivers installed on the card.

| Power Rail                   | 15 W Slot      | 25 W Slot     | 35 W Slot     | 80 W Slot     | 150 W         |
|------------------------------|----------------|---------------|---------------|---------------|---------------|
|                              | SFF            | SFF           | SFF           | SFF           | LFF           |
|                              | Hot Aisle      | Hot Aisle     | Hot Aisle     | Cold Aisle    | Cold Aisle    |
| +3.3V_EDGE                   |                |               |               |               |               |
| Voltage Tolerance            | ±9% (max)      | ±9% (max)     | ±9% (max)     | ±9% (max)     | ±9% (max)     |
|                              |                |               |               |               |               |
| Supply Current               |                |               |               |               |               |
| ID Mode                      | 100 mA (max)   | 100 mA (max)  | 100 mA (max)  | 100 mA (max)  | 100 mA (max)  |
| Programming Mode             | 100 mA (max)   | 100 mA (max)  | 100 mA (max)  | 100 mA (max)  | 100 mA (max)  |
| Aux Mode                     | 1.1 A (max)    | 1.1 A (max)   | 1.1 A (max)   | 1.1 A (max)   | 2.2 A (max)   |
| Main Mode                    | 1.1 A (max)    | 1.1 A (max)   | 1.1 A (max)   | 1.1 A (max)   | 2.2 A (max)   |
| Capacitive Load              | 150 μF (max)   | 150 μF (max)  | 150 μF (max)  | 150 μF (max)  | 300 μF (max)  |
| +12V_EDGE                    |                |               |               |               |               |
| Voltage Tolerance            | +8%/-12% (max) | +8/-12% (max) | +8/-12% (max) | +8/-12% (max) | +8/-12% (max) |
|                              |                |               |               |               |               |
| Supply Current               |                |               |               |               |               |
| ID Mode                      | 50 mA (max)    | 50 mA (max)   | 50 mA (max)   | 50 mA (max)   | 50 mA (max)   |
| Programming Mode             | 50 mA (max)    | 50 mA (max)   | 50 mA (max)   | 50 mA (max)   | 50 mA (max)   |
| Aux Mode                     | 0.7 A (max)    | 1.1 A (max)   | 1.5 A (max)   | 3.3 A (max)   | 6.3 A (max)   |
| Main Mode                    | 1.25 A (max)   | 2.1 A (max)   | 2.9 A (max)   | 6.6 A (max)   | 12.5 A (max)  |
| Capacitive Load <sup>3</sup> | 500 μF (max)   | 500 μF (max)  | 500 μF (max)  | 500 μF (max)  | 1000 μF (max) |

Table 40: Baseboard Power Supply Rail Requirements – Slot Power Envelopes

**Note 1:** While cards may draw up to the published power ratings, the baseboard vendor shall evaluate its cooling capacity for each slot power envelope to determine if a transition to Aux Power Mode is allowed.

**Note 2:** The maximum slew rate for each OCP NIC 3.0 card shall be no more than 0.1 A/ $\mu$ s per the PCIe CEM specification.

**Note 3:** Each OCP NIC 3.0 card shall limit the bulk capacitance to the max values published (500  $\mu$ F for a SFF card, 1000  $\mu$ F for a LFF card).

**Note 4:** For systems that implement hot plug, the baseboard shall limit the voltage slew rate such that the instantaneous inrush current shall not exceed the specified max current. The equation is defined in the PCIe CEM specification and is dV/dt = I/C; where:

I = max allowed current (A)
C = max allowed bulk capacitance (F)
dV/dt = maximum allowed voltage slew rate (V/s)

The OCP NIC 3.0 FRU definition provides a record for the max power consumption of the card. This value shall be used to aid in determining if the card may be enabled in a given OCP slot. Refer to Section 4.10.3 for the available FRU records.

Additionally, the baseboard shall advertise its slot power limits to aid in the overall board power budget allocation to prevent a high power card from being enabled in a lower power class slot. This is implemented via the Slot Power Limit Control mechanism as defined in the PCIe Base Specification. The end point silicon will power up in a low power state until power is negotiated.

### 3.10 Hot Swap Considerations for +12V\_EDGE and +3.3V\_EDGE Rails

Hot plug and hot swap support is optional for baseboard implementers. However, the OCP NIC 3.0 form factor lends itself to potential hot plug and removal events while the baseboard is powered on. These events need to be carefully orchestrated with the operating system and system management entity to prevent a system hang. A surprise extraction may occur in some instances when resources have not been quiesced and the card is removed. Many aspects of the system are involved in processing such an event in both cases. The current scope of this specification does not define an overall hardware or software system architecture to support hot plug. Instead, this specification only highlights the hardware elements that can be utilized to support hot plug for implementations.

The system implementer shall consider the use of hot swap controllers on both the +12V\_EDGE and +3.3V\_EDGE pins to prevent damage to the baseboard or the OCP NIC 3.0 card. Hot swap controllers limit the in-rush current while also providing overcurrent, undervoltage and overvoltage protection capabilities.

The hot swap controller may gate the +12V\_EDGE and +3.3V\_EDGE based on the PRSNTB[3:0]# value. Per Section 3.5.3, a card is present in the system when the encoded value is not 0b1111. The PRSNTB[3:0]# may be AND'ed together and connected to the hot swap controller to accomplish this result. Per the OCP NIC 3.0 mechanical definition (Section 3.1.1), the present pins are short pins and engage only when the card is positively seated.

The PRSNTB[3:0]# pins are used to detect an OCP 3.0 NIC card insertion and removal event. The card type detection is described in Section 3.5. Using in-band signaling, the PCIe link may be enabled to periodically train when a card is plugged in. Similarly, the signals may be used to detect a card removal. The card type is determined by querying the FRU data over the SMBus.

At the time of this writing, the DSP0222 Network Controller Sideband Interface (NC-SI) Specification 1.1 and 1.2 does not define a mechanism to discover hot-plug support. Future work is needed for supporting this feature on NCSI over RBT interfaces.

Baseboards that do not support hot insertion, or hot extractions may opt to not implement these features.

### **3.11 Power Sequence Timing Requirements**

The following figure shows the power sequence of PRSNTB[3:0]#, +3.3V\_EDGE, +12V\_EDGE relative to AUX\_PWR\_EN, RBT\_ISOLATE#, BIF[2:0]#, MAIN\_PWR\_EN, PERSTn\*, and PCIe REFCLK stable on the baseboard. Additionally, the OCP NIC 3.0 card power ramp, and NIC\_PWR\_GOOD are shown. Please refer to Section 3.4.6 for the NIC\_PWR\_GOOD definition. Refer to DMTF DSP0222 for details on the NC-SI controller and clock startup requirements.

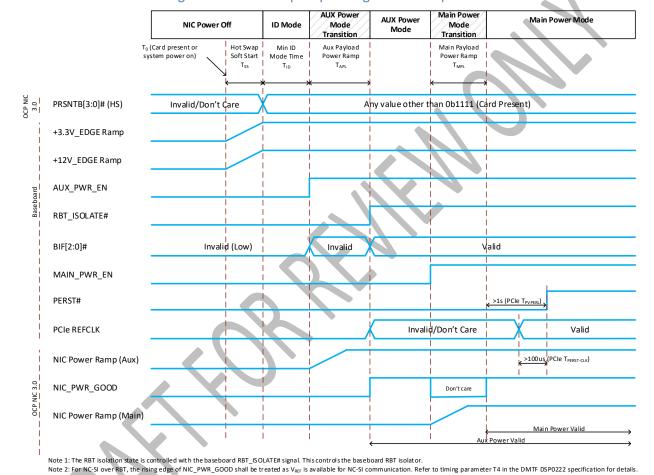


Figure 106: Power-Up Sequencing – Normal Operation

http://opencompute.org

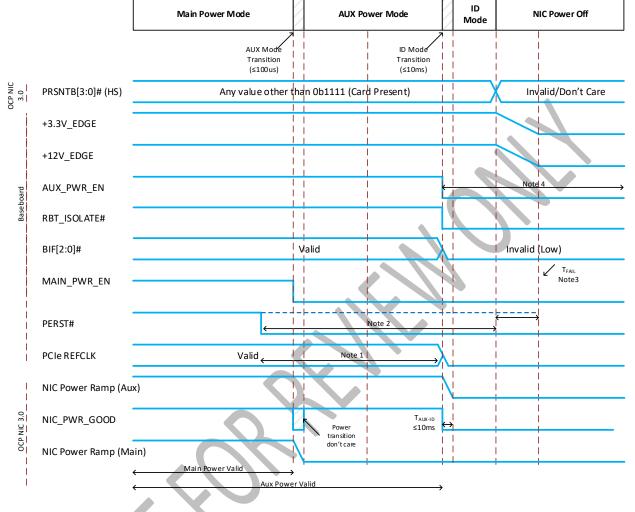


Figure 107: Power-Down Sequencing – Normal Operation

Note 1: REFCLK go inactive after PERST# goes active. (PCIe CEM Section 2.2.3)

Note 2: PERST# goes active before the power on the connector is removed. (PCIe CEM Section 2.2.3)

Note 3: In the case of a surprise power down, PERST# goes active  $T_{\text{FAIL}}$  after power is no longer stable.

Note 4: The baseboard shall have a minimum delay of T<sub>CYCLE\_SFF</sub> and T<sub>CYCLE\_LFF</sub> for the respective form-factors between AUX\_PWR\_EN deassertion (power off) and subsequent AUX\_PWR\_EN assertion (power on) to prevent powering up into a pre-biased condition.

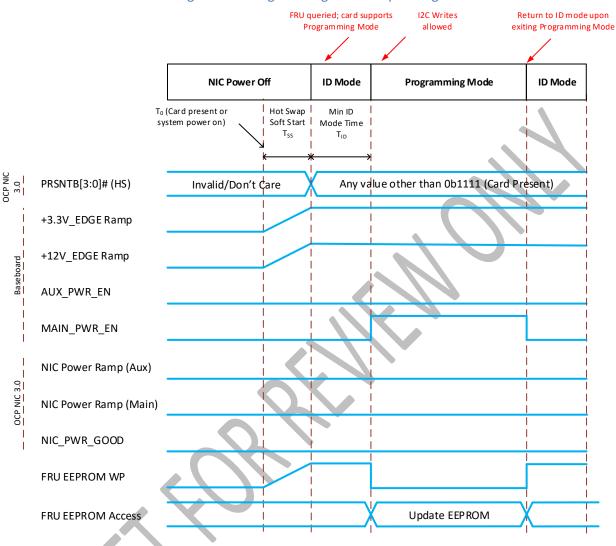


Figure 108: Programming Mode Sequencing

Note 1: All other signals are electrically low and are not shown.

Table 41: Power Sequencing Parameters

| Parameter             | Value | Units | Description                                                                                                                                                           |
|-----------------------|-------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| T <sub>ss</sub>       | 20    | ms    | Maximum time between system +3.3V_EDGE and +12V_EDGE ramp to power stable.                                                                                            |
|                       |       |       | This parameter is only applicable to hot swap controller-based implementations. For non-hot swap applications, the +3.3V_EDGE and +12V_EDGE ramp is system dependent. |
| T <sub>SCAN_RDY</sub> | 1     | ms    | Minimum time required between +3.3V_EDGE stable to the first scan chain data valid read.                                                                              |
| T <sub>ID</sub>       | 20    | ms    | Minimum guaranteed time per spec to spend in ID mode.                                                                                                                 |

| T <sub>APL</sub>       | 50  | ms | Maximum time between AUX_PWR_EN assertion and                               |
|------------------------|-----|----|-----------------------------------------------------------------------------|
|                        |     |    | NIC_PWR_GOOD assertion.                                                     |
| T <sub>MPL</sub>       | 50  | ms | Maximum time between MAIN_PWR_EN assertion and                              |
|                        |     |    | NIC_PWR_GOOD assertion.                                                     |
| T <sub>PVPERL</sub>    | 1   | S  | Minimum time between NIC_PWR_GOOD assertion in Main Power                   |
|                        |     |    | Mode and PERST# deassertion. For OCP NIC 3.0 applications, this             |
|                        |     |    | value is >1 second. This is longer than the minimum value specified         |
|                        |     |    | in the PCIe CEM Specification, Rev 4.0.                                     |
| T4                     | 2   | S  | Maximum time interval from when the network controller NC-SI                |
|                        |     |    | over RBT interface is able to respond to commands.                          |
|                        |     |    |                                                                             |
|                        |     |    | The parameter T4 is defined in the DSP0222 specification and is             |
|                        |     |    | measured from when V <sub>REF</sub> becomes available. For OCP NIC 3.0, the |
|                        |     |    | value T4 is measured from the deassertion of RBT_ISOLATE#.                  |
| T <sub>PERST-CLK</sub> | 100 | μs | Minimum Time PCIe REFCLK is stable before PERST# inactive.                  |
| T <sub>FAIL</sub>      | 500 | ns | In the case of a surprise power down, PERST# goes active at                 |
|                        |     |    | minimum T <sub>FAIL</sub> after power is no longer stable.                  |
| T <sub>AUX-ID</sub>    | 10  | ms | Maximum time from AUX_PWR_EN deassertion to NIC_PWR_GOOD                    |
|                        |     |    | deassertion.                                                                |
| T <sub>CYCLE SFF</sub> | 30  | ms | Minimum time between AUX_PWR_EN deassertion to AUX_PWR_EN                   |
| _                      |     |    | reassertion for SFF cards. Delay time allows for OCP NIC 3.0 card           |
|                        |     |    | capacitors to discharge and prevent reapplying power into a pre-            |
|                        |     |    | biased condition.                                                           |
| T <sub>CYCLE_LFF</sub> | 60  | ms | Minimum time between AUX_PWR_EN deassertion to AUX_PWR_EN                   |
| _                      |     |    | reassertion for LFF cards. Delay time allows for OCP NIC 3.0 card           |
|                        |     |    | capacitors to discharge and prevent reapplying power into a pre-            |
|                        |     |    | biased condition.                                                           |
|                        | •   | •  |                                                                             |

# 3.12 Digital I/O Specifications

All digital I/O pins on the connector boundary are +3.3 V signaling levels. Table 42 following tables provide the absolute max levels. Refer to the appropriate specifications for the RBT, PCIe and SMBus DC/AC specifications.

Table 42: Digital I/O DC specifications

| Symbol          | Parameter           | Min | Max | Units | Note |
|-----------------|---------------------|-----|-----|-------|------|
| V <sub>OH</sub> | Output voltage      |     | 3.6 | V     |      |
| V <sub>OL</sub> | Output low voltage  |     | 0.8 | V     |      |
| I <sub>OH</sub> | Output high current |     |     | mA    |      |
| I <sub>ОН</sub> | Output low current  |     |     | mA    |      |
| V <sub>IH</sub> | Input voltage       |     | 3.6 | V     |      |
| V <sub>IL</sub> | Input low voltage   |     | 0.8 | V     |      |
| I <sub>OH</sub> | Input current       |     |     | mA    |      |

Table 43: Digital I/O AC specifications

| Symbol          | Parameter        | Min | Max | Units | Note |
|-----------------|------------------|-----|-----|-------|------|
| T <sub>OR</sub> | Output rise time |     |     | ns    |      |
| T <sub>OF</sub> | Output fall time |     |     | ns    |      |

# 4 Management and Pre-OS Requirements

OCP NIC 3.0 card management is an important aspect to overall system management. This section specifies a common set of management requirements for OCP NIC 3.0 implementations. There are three types of implementations (RBT+MCTP Type, RBT Type, and MCTP Type) depending on the physical sideband management interfaces, transports, and traffic supported over different transports. An OCP NIC 3.0 implementation shall support at least one type of implementation for card management. For a given type of implementation, an OCP NIC 3.0 card shall support type specific requirements described in Sections 4.1 through 4.7.

| Management Type | Definition                                                                    |
|-----------------|-------------------------------------------------------------------------------|
| RBT Type        | The RBT Type management interface is exclusive to the Reduced Media           |
|                 | Independent Interface (RMII) Based Transport (RBT). The NIC card is required  |
|                 | to support the DSP0222 Network Controller Sideband Interface (NC-SI)          |
|                 | Specification for this management                                             |
| RBT+MCTP Type   | The RBT+MCTP management interface supports both the RBT and MCTP              |
|                 | standards, specifically the DSP0222 Network Controller Sideband Interface     |
|                 | (NC-SI) Specification, DSP0236 Management Component Transport Protocol        |
|                 | (MCTP) Base Specification, and the associated binding specifications. This is |
|                 | the preferred management implementation for baseboard NIC cards. See          |
|                 | MCTP Type below for more details                                              |
| MCTP Type       | The MCTP management interface supports MCTP standards specifically the        |
|                 | DSP0236 Management Component Transport Protocol (MCTP) Base                   |
|                 | Specification and the associated binding specifications.                      |

Table 44: OCP NIC 3.0 Management Implementation Definitions

### 4.1 Sideband Management Interface and Transport

OCP NIC 3.0 sideband management interfaces are used by a Management Controller (MC) or Baseboard Management Controller (BMC) to communicate with the OCP NIC 3.0 card. Table 45 summarizes the sideband management interface and transport requirements.

| Table 45. Sideband Management Interface and Transport Requirements |          |          |          |  |  |  |
|--------------------------------------------------------------------|----------|----------|----------|--|--|--|
| Requirement                                                        | RBT+MCTP | RBT Type | MCTP     |  |  |  |
|                                                                    | Type     |          | Type     |  |  |  |
| NC-SI compliant RMII Based Transport (RBT) including               | Required | Required | N/A      |  |  |  |
| physical interface defined in Section 10 of DMTF DSP0222           |          |          |          |  |  |  |
| I <sup>2</sup> C compliant physical interface for FRU EEPROM       | Required | Required | Required |  |  |  |
| SMBus 2.0 compliant physical interface                             | Required | N/A      | Required |  |  |  |
| Management Component Transport Protocol (MCTP) Base                | Required | N/A      | Required |  |  |  |
| (DSP0236 compliant) over MCTP/SMBus Binding (DSP0237               |          |          |          |  |  |  |
| compliant)                                                         |          |          |          |  |  |  |
| PCIe VDM compliant physical interface                              | Optional | Optional | Optional |  |  |  |
| Management Component Transport Protocol (MCTP) Base                | Optional | Optional | Optional |  |  |  |
| (DSP0236 compliant) over MCTP/PCIe VDM Binding                     |          |          |          |  |  |  |
| (DSP0238 compliant)                                                |          |          |          |  |  |  |

Table 45: Sideband Management Interface and Transport Requirements

### 4.2 NC-SI Traffic

DMTF DSP0222 defines two types of NC-SI traffic: Pass-Through and Control. Table 46 summarizes the NC-SI traffic requirements.

| Requirement                                           | RBT+MCTP | RBT Type | МСТР     |
|-------------------------------------------------------|----------|----------|----------|
|                                                       | Туре     |          | Type     |
| NC-SI Control over RBT (DMTF DSP0222 compliant)       | Required | Required | N/A      |
| NC-SI Control over MCTP (DMTF DSP0261 compliant)      | Required | N/A      | Required |
| NC-SI Pass-Through over RBT (DMTF DSP0222 compliant)  | Required | Required | N/A      |
| NC-SI Pass-Through over MCTP (DMTF DSP0261 compliant) | Optional | N/A      | Optional |

Table 46: NC-SI Traffic Requirements

Note: A Management Controller (MC) is allowed to use NC-SI Control traffic only without enabling NC-SI pass-through.

### 4.3 Management Controller (MC) MAC Address Provisioning

An OCP NIC 3.0 compliant card that supports NC-SI pass-through shall provision one or more MAC addresses per Package (refer to the Package definition as detailed in the DMTF DSP0222 specification) for Out-Of-Band (OOB) management traffic. The number of MC MAC addresses provisioned is implementation dependent. These MAC addresses are not exposed to the host(s) as available MAC addresses. The MC is not required to use these provisioned MAC addresses. Table 47 summarizes the MC MAC address provisioning requirements. A MAC address algorithm calculator is provided on the OCP NIC 3.0 wiki page and may be downloaded from: http://www.opencompute.org/wiki/Server/Mezz

Table 47: MC MAC Address Provisioning Requirements

| Requirement                                                                                                                                                                                                                                                                                              | RBT+MCTP | RBT Type | МСТР     |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|----------|----------|
|                                                                                                                                                                                                                                                                                                          | Type     |          | Туре     |
| One or more MAC Addresses per package shall be provisioned for the MC.                                                                                                                                                                                                                                   | Required | Required | Optional |
| The OCP NIC 3.0 platform may choose to use the NIC vendor allocated MAC addresses for the BMC.                                                                                                                                                                                                           |          |          |          |
| The usage of provisioned MAC addresses are BMC implementation specific and is outside the scope of this specification.                                                                                                                                                                                   |          |          |          |
| The recommended MAC address allocation scheme is stated below. This algorithm assumes all of the port MAC addresses are sequentially allocated first, followed by the BMC MAC addresses. For multi-host capable cards, the MAC addresses shall be provisioned for the maximum number of supported hosts. |          |          |          |
| Assumptions:                                                                                                                                                                                                                                                                                             |          |          |          |

| 1. TI        | he number of BMCs or virtual BMCs is the same as                                       |          |          |          |
|--------------|----------------------------------------------------------------------------------------|----------|----------|----------|
| th           | ne number of hosts (1:1 relationship between each ost and the BMC).                    |          |          |          |
| 2. TI        | he maximum number of partitions on each port is                                        |          |          |          |
| th           | ne same.                                                                               |          |          |          |
| Variables:   | :                                                                                      |          |          |          |
|              | um_ports - Number of Ports on the OCP NIC 3.0 ard                                      |          |          |          |
|              | <pre>ax_parts - Maximum number of partitions on a ort per host</pre>                   |          |          |          |
| • n          | um_hosts — Number of hosts supported by the                                            |          | -111     |          |
|              | irst addr – The MAC address of the first host                                          |          |          |          |
|              | or the first partition on the first port                                               |          |          |          |
|              | ost addr[i] - base MAC address of i <sup>th</sup> host (0                              |          |          |          |
|              | i ≤ num hosts-1)                                                                       |          |          |          |
| • b:         | mc_addr[i] - base MAC address of i <sup>th</sup> BMC (0                                |          |          |          |
| <b>S</b>     | i ≤ num_hosts-1)                                                                       |          |          |          |
| F 1.         |                                                                                        |          |          |          |
| Formula:     | ost_addr[i] = first_addr + i*num_ports*max_parts                                       |          |          |          |
|              | he assignment of MAC address used by ith host on                                       |          |          |          |
|              | ort j for the partition k is out of the scope of this                                  |          |          |          |
| -            | pecification.                                                                          |          |          |          |
| -            | mc_addr[i] = first_addr+                                                               |          |          |          |
|              | um_ports*max_parts*num_hosts + i*num_ports                                             |          |          |          |
|              | he MAC address used by i <sup>th</sup> BMC on port j, where 0                          |          |          |          |
| ≤            | $i \le num\_hosts-1$ and $0 \le j \le num\_ports-1$ is                                 |          |          |          |
| bı           | mc_addr[i] + j                                                                         |          |          |          |
| For manulati | boot coughly OCD NIC 2.0 courds the NAAC                                               | Doguinad | Doguinad | Doguinad |
|              | host capable OCP NIC 3.0 cards, the MAC shall be provisioned for the maximum number of | Required | Required | Required |
| supported    |                                                                                        |          |          |          |
|              |                                                                                        |          |          |          |
| _            | ithm assumes each host and port MAC address                                            |          |          |          |
|              | ion shall have a corresponding BMC MAC address in sequential order.                    |          |          |          |
| anocated     | sequential order.                                                                      |          |          |          |
| Variables:   | :                                                                                      |          |          |          |
| • n          | um_ports - Number of Ports on the OCP NIC 3.0                                          |          |          |          |
| Ca           | ard                                                                                    |          |          |          |

|                                                                                                                     |          | 7        |          |
|---------------------------------------------------------------------------------------------------------------------|----------|----------|----------|
| • max_parts - Maximum number of partitions on a                                                                     |          |          |          |
| port per host                                                                                                       |          |          |          |
| <ul> <li>num_hosts - Number of hosts supported by the</li> </ul>                                                    |          |          |          |
| NIC                                                                                                                 |          |          |          |
| <ul><li>first_addr - The MAC address of the first host</li></ul>                                                    |          |          |          |
| for the first partition on the first port                                                                           |          |          |          |
| <ul> <li>host_addr[i][j] - base MAC address of i<sup>th</sup> host</li> </ul>                                       |          |          |          |
| for the j <sup>th</sup> port                                                                                        |          |          |          |
| bmc_addr[i][j] - base MAC address of i <sup>th</sup> BMC                                                            |          |          |          |
| for the j <sup>th</sup> port                                                                                        |          |          |          |
| • i is the host number (0 ≤ i ≤ num_hosts-1)                                                                        |          |          |          |
| • j is the port number (0 ≤ j ≤ num_ports-1)                                                                        |          |          |          |
| • $k$ is the partition number (0 $\leq k \leq$                                                                      |          |          |          |
| max_parts-1)                                                                                                        |          |          |          |
|                                                                                                                     |          |          |          |
| Formula:                                                                                                            |          |          |          |
| <pre>host_addr[i][j] = first_addr + i*(max parts+1)*num ports + j</pre>                                             |          |          |          |
| <ul><li>bmc addr[i][j] = first addr +</li></ul>                                                                     |          |          |          |
| i*(max parts+1)*num ports +                                                                                         |          |          |          |
| max parts*num ports + j                                                                                             |          |          |          |
| The assignment of MAC address used by i <sup>th</sup> host on                                                       |          |          |          |
| port j for the partition k is out of the scope of this                                                              |          |          |          |
| specification.                                                                                                      |          |          |          |
|                                                                                                                     |          |          |          |
| Support at least one of the following mechanisms for                                                                | Required | Required | Optional |
| provisioned MC MAC Address retrieval:                                                                               |          |          |          |
| <ul> <li>NC-SI Control/RBT (DMTF DSP0222 compliant)</li> <li>NC-SI Control/MCTP (DMTF DSP0261 compliant)</li> </ul> |          |          |          |
| • NC-SI CONTROL/MCTP (DIMTE DSP0261 Compilant)                                                                      |          |          |          |
| <b>Note:</b> This capability is planned to be included in revision 1.2                                              |          |          |          |
| of the DSP0222 NC-SI specification.                                                                                 |          |          |          |
| For DIATE DEPOSABLE A complete of OCD NIC 2 O                                                                       |          |          |          |
| For DMTF DSP0222 1.1 compliant OCP NIC 3.0 implementations, MC MAC address retrieval shall be                       |          |          |          |
| supported using NC-SI OEM commands. An OCP NIC 3.0                                                                  |          |          |          |
| implementation, that is compliant with DMTF DSP0222 that                                                            |          |          |          |
| defines standard NC-SI commands for MC MAC address                                                                  |          |          |          |
| retrieval, shall support those NC-SI commands.                                                                      |          |          |          |

# 4.4 ASIC Die Temperature Reporting

An OCP NIC 3.0 implementation can have several silicon components including one or more ASICs implementing NIC functions. For the system management, it is important that the die temperatures of these ASIC components can be retrieved over sideband interfaces. The ASIC die temperature reporting

requirements of this section are independent of the transceiver module temperature reporting discussed in Section 4.6.

The temperature reporting interface shall be accessible in Aux Power Mode (S5), and Main Power Mode (S0). Table 48 summarizes temperature reporting requirements. These requirements improve the system thermal management and allow the baseboard management device to access key component temperatures on an OCP NIC 3.0 card. When the temperature reporting function is implemented, it is required that the temperature reporting accuracy is within ±3°C.

Table 48: Temperature Reporting Requirements

| Requirement                                                                                                                                                                                                                                                                                                                                                                      | RBT+MCTP    | RBT Type    | МСТР        |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-------------|-------------|
| nequirement                                                                                                                                                                                                                                                                                                                                                                      | Туре        | ПОЛУРС      | Туре        |
| ASIC die temperature reporting for a component with TDP ≥5 W                                                                                                                                                                                                                                                                                                                     | Required    | Required    | Required    |
| ASIC die temperature reporting for a component with TDP < 5 W                                                                                                                                                                                                                                                                                                                    | Recommended | Recommended | Recommended |
| When the temperature sensor reporting function is implemented, the OCP NIC 3.0 card shall support PLDM for Platform Monitoring and Control (DSP0248 compliant) for temperature reporting.                                                                                                                                                                                        | Required    | Required    | Required    |
| When the temperature sensor reporting function is implemented, the OCP NIC 3.0 card shall report upper warning, upper critical, and upper fatal thresholds for PLDM numeric sensors.  Note: Refer to DSP0248 for definitions of the upper warning, upper critical, and upper fatal thresholds.                                                                                   | Required    | Required    | Required    |
| When the temperature reporting function is implemented using PLDM numeric sensors, the temperature tolerance shall be reported as part of the sensor Platform Descriptor Record (PDR) format.                                                                                                                                                                                    | Required    | Required    | Required    |
| Support for self-shutdown.  The purpose of the self-shutdown feature is to "self-protect" the NIC ASIC from permanent damage due to high operating temperatures. The NIC may accomplish this by reducing the power consumed by the ASIC. A BMC may continuously monitor the NIC ASIC temperature and shutdown the NIC ASIC as soon as the temperature reaches a threshold value. | Optional    | Optional    | Optional    |
| There may be scenarios and implementations where the OCP NIC ASIC may be required to self-shutdown without depending on an external entity like the BMC. For those scenarios and implementations, the self-shutdown feature is a final effort in preventing permanent damage to the NIC ASIC at the expense of potential data loss.                                              |             |             |             |

If the self-shutdown feature is implemented, the NIC ASIC shall monitor its temperature and shut-down itself as soon as the self-shutdown threshold value is reached. The value of the self-shutdown threshold is implementation specific. It is recommended that the self-shutdown threshold value is higher than the maximum junction temperature of the ASIC implementing the NIC function. It is also recommended that the self-shutdown threshold value is between the critical and fatal temperature thresholds of the ASIC. If the self-shutdown feature is implemented, care shall be taken to ensure that the board power down state is latched and the board does not autonomously resume normal operation. The OCP NIC 3.0 card does not need to know the reason for the NIC ASIC self-shutdown threshold crossing (e.g., fan failure). After the NIC ASIC enters the self-shutdown state, the OCP NIC 3.0 card may not be operational. This might cause the system with the OCP NIC 3.0 card to become unreachable via the NIC. In order to recover the NIC ASIC from the self-shutdown state, the OCP NIC 3.0 card shall go through the NIC ID Mode state as described in Section 3.8.1. If the self-shutdown feature is implemented, the implementation shall provide a mechanism to enable/disable the feature. Note: It is assumed that a system management function will prevent a component from reaching its fatal threshold

### 4.5 Power Consumption Reporting

An OCP NIC 3.0 implementation may be able to report the power consumed at the board level. It is important for the system management that the information about the power consumption can be retrieved over sideband interfaces. Table 49 summarizes the power consumption reporting requirements.

Table 49: Power Consumption Reporting Requirements

| Requirement                                                  | RBT+MCTP | RBT Type | MCTP     |
|--------------------------------------------------------------|----------|----------|----------|
|                                                              | Type     |          | Type     |
| Board Only Estimated Power Consumption Reporting. The        | Required | Required | Required |
| value of this field is encoded into the FRU EEPROM contents. |          |          |          |

temperature.

| This field reports the board max power consumption value      |          |          |          |
|---------------------------------------------------------------|----------|----------|----------|
| without transceivers plugged into the line side receptacles.  |          |          |          |
| Pluggable Transceiver Module Power Reporting. The             | Required | Required | Required |
| pluggable transceivers plugged into the line side receptacles |          |          |          |
| shall be inventoried (via an EEPROM query) and the Power      |          |          |          |
| Class of the module shall be reported.                        |          |          |          |
| Board Runtime Power Consumption Reporting. This value         | Optional | Optional | Optional |
| shall be optionally reported over the management binding      |          |          |          |
| interface. The runtime power value shall report the card      |          |          |          |
| edge power.                                                   |          |          |          |
| PLDM for Platform Monitoring and Control (DSP0248             | Required | Required | Required |
| compliant) shall be used for transceiver and board power      |          |          |          |
| consumption reporting.                                        |          |          |          |

### 4.6 Pluggable Transceiver Module Status and Temperature Reporting

A pluggable transceiver module is a compact, hot-pluggable transceiver used to connect the OCP 3.0 NIC to an external physical medium. It is important for proper system operation to know the presence and temperature of pluggable transceiver modules. Table 50 summarizes pluggable module status reporting requirements. The transceiver temperature is always reported and is independent of the ASIC die temperature reporting requirements as discussed in Section 4.4. The temperature reporting interface shall be accessible in Aux Power Mode (S5), and Main Power Mode (S0).

| Requirement                                               | RBT+MCTP | RBT Type | MCTP     |
|-----------------------------------------------------------|----------|----------|----------|
|                                                           | Туре     |          | Туре     |
| Pluggable Transceiver modules Presence Status and         | Required | Required | Required |
| Temperature Reporting                                     |          |          |          |
| PLDM for Platform Monitoring and Control (DSP0248         | Required | Required | Required |
| compliant) for reporting the pluggable transceiver module |          |          |          |
| presence status and pluggable transceiver module          |          |          |          |
| temperature                                               |          |          |          |

Table 50: Pluggable Module Status Reporting Requirements

# 4.7 Management and Pre-OS Firmware Inventory and Update

An OCP NIC 3.0 implementation can have different types of firmware components for data path, control path, and management path operations. It is desirable that OCP NIC 3.0 implementations support an OS-independent mechanism for the management firmware update. It is desirable that the management firmware update does not require a system reboot for the new firmware image to become active. Table 51 summarizes the firmware inventory and update requirements.

| Table 51. Management and Pre-OS Firmware inventory and Opdate Requirements |          |             |          |  |  |
|----------------------------------------------------------------------------|----------|-------------|----------|--|--|
| Requirement                                                                | RBT+MCTP | RBT Type    | MCTP     |  |  |
|                                                                            | Type     |             | Type     |  |  |
| Network boot in UEFI driver (supporting both IPv4 and                      | Required | Required    | Required |  |  |
| IPv6 addressing for network boot)                                          |          |             |          |  |  |
| UEFI secure boot for UEFI drivers                                          | Required | Required    | Required |  |  |
| UEFI Firmware Management Protocol (FMP)                                    | Required | Required    | Required |  |  |
| PLDM for Firmware Update (DSP0267 compliant)                               | Required | Recommended | Required |  |  |

Table 51: Management and Pre-OS Firmware Inventory and Update Requirements

#### 4.7.1 Secure Firmware

It is highly recommended that an OCP NIC 3.0 card supports a secure firmware feature. In the future versions of the OCP NIC 3.0 specification, the secure firmware feature is intended to be required. When the secure firmware feature is enabled and where export compliance permits, the OCP NIC 3.0 card shall verify firmware components prior to the execution, execute only signed and verified firmware components, and only allow authenticated firmware updates. Where applicable, an OCP NIC 3.0 implementation shall use the guidelines provided in NIST SP 800-193 Platform Resiliency Guidelines for the following secure firmware functions:

- Signed Firmware Updates
- Ensure only valid/authenticated firmware updates can be applied. Refer to: NIST 800-193
   Section 3.5 Firmware Update Mechanisms, and 4.1.2 Root of Trust for Update (RTU) and Chain of Trust for Update (CTU)
- Ensure authentication mechanisms cannot be bypassed. Refer to NIST 800-193 Section 4.2 Protection.
- Secure Boot
- Only boot trusted/authenticated firmware: NIST 800-193 4.1.3 Root of Trust for Detection (RTD) and Chain of Trust for Detection (CTD), and Section 4.3 Detection
- Recovery mechanism in case of boot failure: NIST 800-193 Section 4.4 Recovery

#### 4.7.2 Firmware Inventory

The OCP NIC 3.0 card shall allow queries to obtain the firmware component versions, device model, and device ID via in-band and out-of-band interfaces without impacting NIC function and performance of said paths.

### 4.7.3 Firmware Inventory and Update in Multi-Host Environments

A multi-host capable OCP NIC 3.0 card shall gracefully handle concurrent in-band queries from multiple hosts and out-of-band access from the BMC for firmware component versions, device model, and device ID information.

A multi-host capable OCP NIC 3.0 card shall only permit one entity to perform write accesses to NIC firmware at a time, without creating contention.

A multi-host capable OCP NIC 3.0 card shall gracefully handle exceptions when more than one entity attempts to perform concurrent NIC firmware writes.

### 4.8 NC-SI Package Addressing and Hardware Arbitration Requirements

NC-SI over RBT is implemented via RMII pins between the MC and the OCP NIC 3.0 card. Protocol and implementation details of NC-SI over RBT can be found in the DMTF DSP0222 standard.

### 4.8.1 NC-SI over RBT Package Addressing

NC-SI over RBT capable OCP NIC 3.0 cards shall use a unique Package ID per ASIC when multiple ASICs share the single NC-SI physical interconnect to ensure there are no addressing conflicts.

Baseboards use the Slot\_ID[1:0] values on the Primary Connector for this identification. The value of Slot\_ID[1:0] is determined by the encoding shown in Table 52. SLOT\_ID[1:0] is statically set high or low on the baseboard and is available on the OCP Bay portion of the Primary Connector.

| Dhysical                | SLOT_I     | ID[1:0]    |               | Package ID[2:0] |               |
|-------------------------|------------|------------|---------------|-----------------|---------------|
| Physical<br>Slot (Dec.) | Pin OCP_A6 | Pin OCP_B7 | Package ID[2] | Package ID[1]   | Package ID[0] |
| Slot (Dec.)             | SLOT_ID1   | SLOT_ID0   | PhysDev#      | SLOT_ID1        | SLOT_ID0      |
| Slot 0                  | 0          | 0          | 0/1           | 0               | 0             |
| Slot 1                  | 0          | 1          | 0/1           | 0               | 1             |
| Slot 2                  | 1          | 0          | 0/1           | 1               | 0             |
| Slot 3                  | 1          | 1          | 0/1           | 1               | 1             |

Table 52: Slot\_ID[1:0] to Package ID[2:0] Mapping

Package ID[2:0] is a 3-bit field and is encoded in the NC-SI Channel ID as bits [7:5]. SLOT\_ID1 is associated with Package ID[1]. SLOT\_ID0 is associated with Package ID[0]. The Package ID[2] value is based on the silicon instance on the same physical OCP NIC 3.0 card. Package ID[2]==0b0 is assigned for physical controller #0. Package ID[2]==0b1 is assigned for physical controller #1. In this case, physical controller #1 on the same card is at an address offset of +0x4. Refer to the specific endpoint device datasheet for details on the Package ID configuration options.

Note: The Package ID[2] field is optionally configurable in the NC-SI specification. If the target silicon hard codes this bit to 0b0, then a card must only implement a single silicon instance to prevent addressing conflicts.

Refer to the DMTF DSP0222 standard for more information on package addressing and Package ID.

### 4.8.2 Arbitration Ring Connections

For baseboards that implement two or more Primary Connectors, the NC-SI over RBT arbitration ring shall be connected to each other. The arbitration ring shall support operation with one card, or multiple cards installed. Figure 86 shows an example connection with dual Primary Connectors.

### 4.9 SMBus 2.0 Addressing Requirements

The SMBus provides a low speed management bus for the OCP NIC 3.0 card. The FRU EEPROM is directly connected to the OCP NIC 3.0 card edge on this bus and can be read by the baseboard in the ID Mode, Aux Power Mode and Main Power Mode. Network controllers may utilize the SMBus 2.0 interface for MCTP communications. OCP NIC 3.0 does not support MCTP over I<sup>2</sup>C due to the use of specific SMBus 2.0 addressing. Proper power domain isolation shall be implemented on the NIC.

#### 4.9.1 SMBus Address Map

OCP NIC 3.0 cards shall support the SMBus Address Resolution Protocol (ARP). This allows for dynamic assignment of slave device addresses. This method automatically resolves address conflicts and eliminates the need for manual address configuration. The SMBus address type can be either a Dynamic and Persistent Address or a Dynamic and Volatile Address. Refer to the SMBus 2.0 specification and Section 6.11 of DSP0237 for details on SMBus address assignment. Due to the prevalent use of SMBus muxes in many baseboard designs, the OCP NIC 3.0 card is discouraged from sending unsolicited messages, which includes the optional "Notify ARP Master" command.

A baseboard implementation may choose to only use fixed addresses for OCP NIC 3.0 cards. The assignment of these fixed addresses is system dependent and is outside the scope of this specification. When fixed addresses are used, then the OCP NIC 3.0 card shall be a "Fixed and Discoverable" SMBus device. Refer to the SMBus 2.0 specification for more details.

All predefined SMBus addresses for OCP NIC 3.0 are shown in Table 53. Baseboard and OCP NIC 3.0 card designers must ensure additional devices do not conflict. The addresses shown are in 8-bit format and represent the read/write address pair.

| Dhysical                   | SLOT_ID[1:0] |            | FRU EEPROM Address |          |       |                   |                |
|----------------------------|--------------|------------|--------------------|----------|-------|-------------------|----------------|
| Physical<br>Slot<br>(Dec.) | Pin OCP_A6   | Pin OCP_B7 | A2                 | A1       | A0    | Binary<br>Address | Hex<br>Address |
| (Dec.)                     | SLOT_ID1     | SLOT_ID0   | SLOT_ID1           | SLOT_ID0 | Fixed |                   |                |
| Slot 0                     | 0            | 0          | 0                  | 0        | 0     | 0b1010_000X       | 0xA0/0xA1      |
| Slot 1                     | 0            | 1          | 0                  | 1        | 0     | 0b1010_010X       | 0xA4/0xA5      |
| Slot 2                     | 1            | 0          | 1                  | 0        | 0     | 0b1010_100X       | 0xA8/0xA9      |
| Slot 3                     | 1            | 1          | 1                  | 1        | 0     | 0b1010_110X       | 0xAC/0xAD      |

Table 53: FRU EEPROM Address Mar

#### 4.10 FRU EEPROM

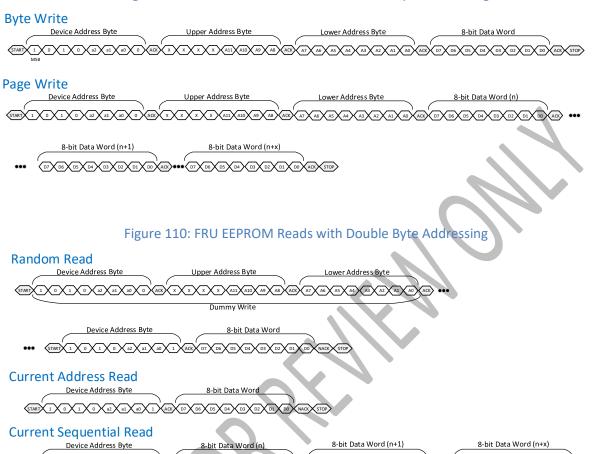
### 4.10.1 FRU EEPROM Addressing and Size

A FRU EEPROM is implemented on the OCP NIC 3.0 cards and is used by the baseboard to determine the card type and capabilities. The FRU EEPROM is directly connected to the SMBus on the card edge. Only one EEPROM is required for a single physical OCP NIC 3.0 card regardless of the PCIe width or number of physical card edge connectors it occupies. The FRU EEPROM is mandatory and shall be connected to the Primary Connector SMBus.

The FRU EEPROM is readable in all four power states: ID mode, Programming mode, Aux Power mode (S5), and Main Power mode (S0).

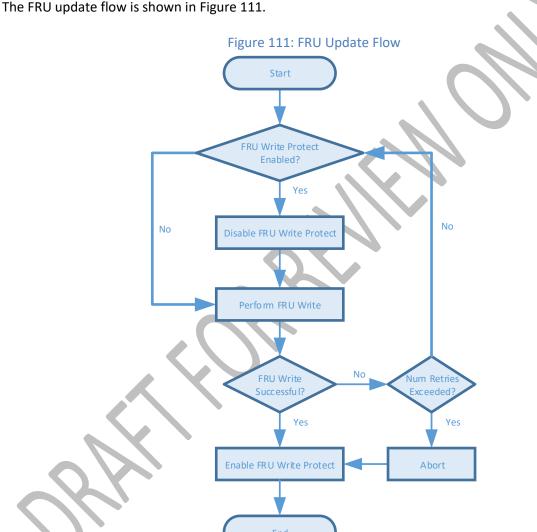
The permissible EEPROM addresses are indicated in Table 53. The write/read pair is presented in 8-bit format. The EEPROM shall use double byte addressing and, at minimum, shall be of sufficient size to hold the base FRU contents and any vendor specific information. The double byte write and read accesses are shown in 109 and Figure 110. Refer to the I<sup>2</sup>C specification for timing details.

Figure 109: FRU EEPROM Writes with Double Byte Addressing



#### 4.10.2 FRU EEPROM Write Protection

The FRU EEPROM should be write protected for production cards. The FRU write protection may optionally be overridden for field updates via the use of a mechanical jumper or switch, a GPIO, controlled via a NC-SI or PLDM based mechanism, or the Programming Mode Power state. An OCP NIC 3.0 card may implement one or more of these write protection implementations. The definitions of these mechanisms are outside the scope of this specification. The NIC vendor write protection mechanism(s) shall be noted in the OEM Record. The FRU shall be writable for Programming mode power state, manufacturing test and during the card development cycle.



#### **4.10.3 FRU EEPROM Content Requirements**

The FRU EEPROM shall follow the data format specified in Section 1 of the IPMI Platform Management FRU Information Storage Definition specification. For OCP NIC 3.0, the FRU Information Device shall, at a minimum, contain the Common Header, Board Info Area, Product Info Area and a MultiRecord Area for storing the OEM record. These fields shall be populated in the FRU EEPROM. Where applicable, fields

common to the Board Info and Product Info records shall be populated with the same values so they are consistent.

The OEM record 0xC0 is used to store specific records for the OCP NIC 3.0 and is stored in the MultiRecord area of the FRU layout. For an OCP NIC 3.0 card, the FRU EEPROM OEM record content based on the format defined in Table 54 shall be populated.

Note: Table 54 only shows a portion of the OEM record. The complete record includes a Common Header and valid record checksum as defined in the IPMI Platform Management FRU Information Storage Definition specification.

Table 54: FRU EEPROM Record – OEM Record 0xC0, Offset 0x00

| Offset | Length | Description                                                                                                                                                                                                                                                                                                                                                                                                          |
|--------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0      | 3      | Manufacturer ID.                                                                                                                                                                                                                                                                                                                                                                                                     |
|        |        | For OCP NIC 3.0 compliant cards, the value of this field shall be set to the OCP IANA assigned number. This value is 42623 in decimal or 0x00A67F in hexadecimal. The least significant byte (0x7F) is first at offset 0 and the most significant byte (0x00) is at offset 2.                                                                                                                                        |
| 3      | 1      | OCP NIC 3.0 FRU OEM Record Version.                                                                                                                                                                                                                                                                                                                                                                                  |
|        |        | This field indicates the card OEM Record Version. Baseboards shall read this field to determine the OEM Record format. OCP NIC 3.0 cards compliant to this version of the specification shall be set the field to 0x01. Future changes to the OEM Record format will result in an additional record version value added to this list.  0x00 – Reserved 0x01 – OCP NIC 3.0 card FRU record released with version 0.90 |
|        |        | 0x02 – 0xFF – Reserved                                                                                                                                                                                                                                                                                                                                                                                               |
| 4      | 1      | Card Max power (in Watts) in MAIN (S0) mode.                                                                                                                                                                                                                                                                                                                                                                         |
|        |        | The encoded value is the calculated max power of the OCP NIC 3.0 card in the Main Power (S0) mode only and does not include the consumed power by transceivers plugged into the line side receptacle(s).                                                                                                                                                                                                             |
|        |        | 0x00 – 0xFE – Card power rounded up to the nearest Watt for fractional values.  0xFF – Unknown                                                                                                                                                                                                                                                                                                                       |
| 5      | 1      | Card Max power (in Watts) in AUX (S5) mode.                                                                                                                                                                                                                                                                                                                                                                          |
| S      |        | The encoded value is the calculated max power of the OCP NIC 3.0 card in the Aux Power (S5) mode only and does not include the consumed power by transceivers plugged into the line side receptacle(s).                                                                                                                                                                                                              |
|        |        | 0x00 – 0xFE – Card power rounded up to the nearest Watt for fractional values. 0xFF – Unknown                                                                                                                                                                                                                                                                                                                        |
| 6      | 1      | Hot Aisle Card Cooling Tier with Passive Cables or RJ45.                                                                                                                                                                                                                                                                                                                                                             |
|        |        | The encoded value reports the OCP NIC 3.0 Card Hot Card Cooling Tier as defined in Section 6.6 for cards with passive pluggable cables or with RJ45 for the line side I/O.                                                                                                                                                                                                                                           |
|        |        | 0x00 – Reserved<br>0x01 – Hot Aisle Cooling Tier 1                                                                                                                                                                                                                                                                                                                                                                   |

|    |   | 0v02 Hot Aido Cooling Tior 2                                                       |
|----|---|------------------------------------------------------------------------------------|
|    |   | 0x02 – Hot Aisle Cooling Tier 2                                                    |
|    |   | 0x03 – Hot Aisle Cooling Tier 3                                                    |
|    |   | 0x04 – Hot Aisle Cooling Tier 4                                                    |
|    |   | 0x05 – Hot Aisle Cooling Tier 5                                                    |
|    |   | 0x06 – Hot Aisle Cooling Tier 6                                                    |
|    |   | 0x07 – Hot Aisle Cooling Tier 7                                                    |
|    |   | 0x08 – Hot Aisle Cooling Tier 8                                                    |
|    |   | 0x09 – Hot Aisle Cooling Tier 9                                                    |
|    |   | 0x0A – Hot Aisle Cooling Tier 10                                                   |
|    |   | 0x0B – Hot Aisle Cooling Tier 11                                                   |
|    |   | 0x0C – Hot Aisle Cooling Tier 12                                                   |
|    |   | 0x0D – 0xFE – Reserved                                                             |
|    |   | 0xFF – Unknown                                                                     |
| 7  | 1 | Cold Aisle Card Cooling Tier with Passive Cables or RJ45.                          |
|    |   | The encoded value reports the OCP NIC 3.0 Card Cold Aisle Cooling Tier as          |
|    |   | defined in Section 6.6 for cards with passive pluggable cables or with RJ45 for    |
|    |   | the line side I/O.                                                                 |
|    |   | 0x00 – Reserved                                                                    |
|    |   | 0x01 – Cold Aisle Cooling Tier 1                                                   |
|    |   | 0x02 – Cold Aisle Cooling Tier 2                                                   |
|    |   | 0x03 – Cold Aisle Cooling Tier 3                                                   |
|    |   | 0x04 – Cold Aisle Cooling Tier 4                                                   |
|    |   | 0x05 – Cold Aisle Cooling Tier 5                                                   |
|    |   | 0x06 – Cold Aisle Cooling Tier 6                                                   |
|    |   | 0x07 – Cold Aisle Cooling Tier 7                                                   |
|    |   | 0x08 – Cold Aisle Cooling Tier 8                                                   |
|    |   | 0x09 – Cold Aisle Cooling Tier 9                                                   |
|    |   | 0x0A – Cold Aisle Cooling Tier 10                                                  |
|    |   | 0x0B – Cold Aisle Cooling Tier 11                                                  |
|    |   | 0x0C – Cold Aisle Cooling Tier 12                                                  |
|    |   | 0x0D – 0xFE – Reserved                                                             |
|    |   | 0xFF – Unknown                                                                     |
| 8  | 1 | Card active/passive cooling.                                                       |
|    |   | This byte defines if the card has passive cooling (there is no fan on the card) or |
|    |   | active cooling (a fan is located on the card).                                     |
|    |   | - '                                                                                |
|    |   | 0x00 – Passive Cooling                                                             |
|    |   | 0x01 – Active Cooling                                                              |
|    |   | 0x02 – 0xFE – Reserved                                                             |
|    |   | 0xFF – Unknown                                                                     |
| 9  | 2 | Hot aisle standby airflow requirement.                                             |
|    |   | The encoded value represents the amount of airflow, in LFM, required to cool       |
|    |   | the card in AUX (S5) mode while operating in a hot aisle environment with an       |
| •  |   | approach air temperature of 45°C. Refer to Section 6 for more information          |
|    |   | about the thermal and environmental requirements.                                  |
|    |   | Byte 9 is the least significant byte, byte 10 is the most significant byte.        |
|    |   | 0x0000-0xFFFE – LFM required for cooling card in Hot Aisle Operation.              |
|    |   | 0xFFFF – Unknown.                                                                  |
|    |   | LONILLE CHANGENIA                                                                  |
| 11 | 2 | Cold aisle standby airflow requirement.                                            |

|     |   | The encoded value represents the amount of airflow, in LFM, required to cool the card in AUX (S5) mode while operating in a cold aisle environment with an approach air temperature of 35°C. Refer to Section 6 for more information about the thermal and environmental requirements.  Byte 11 is the least significant byte, byte 12 is the most significant byte.  0x0000-0xFFFE – LFM required for cooling card in Cold Aisle Operation.  0xFFFF – Unknown.                                                                                                                                                                                               |
|-----|---|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 13  | 1 | UART Configuration 1 – Secondary Connector.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|     |   | This byte denotes the UART configuration 1. A value 0x00 means no serial connection is implemented on the Secondary Connector card edge.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|     |   | Bits [2:0] denotes the UART baud rate per the encoding table below. If implemented, the encoded field value defines the default baud rate of the OCP NIC 3.0 card serial port.  0b000 – No serial connection 0b001 – 115200 baud 0b010 – 57600 baud 0b010 – 19200 baud 0b100 – 19200 baud 0b101 – 9600 baud 0b110 – 4800 baud 0b111 – 2400 baud Bits [4:3] denotes the number of data bits. 0b00 – No serial connection 0b01 – 7 data bits 0b10 – 8 data bits 0b11 – Reserved Bits [7:5] denotes the parity bit character. 0b000 – No serial connection 0b001 – None (N) 0b010 – Odd (O) 0b011 – Even (E) 0b100 – Mark (M) 0b101 – Space (S) 0b110 – Reserved |
|     |   | 0b111 – Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 14  | 1 | UART Configuration 2 – Secondary Connector.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| _0  |   | This byte denotes the UART configuration 2. A value 0x00 means no serial connection is implemented on the Secondary Connector card edge.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| Oll |   | Bits [1:0] denotes the number of stop bits.  0b00 – No serial connection  0b01 – 1 stop bit  0b10 – 1.5 stop bits  0b11 – 2 stop bits                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|     |   | Bits [3:2] denotes the flow control method.  0b00 – No serial connection  0b01 – Software handshaking  0b10 – No handshaking  0b11 – Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|     |   | Bits [7:4] are reserved and shall be encoded to a value of 0b0000.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |

| 15 | 1 | USB Present – Primary Connector.                                                                                                                                                                                                 |
|----|---|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|    |   | This byte denotes a USB 2.0 connection is implemented on the Primary Connector card edge.                                                                                                                                        |
|    |   | 0x00 – No USB 2.0 is present or is not implemented on the card edge.<br>0x01 – A USB 2.0 connection is implemented on the card edge.                                                                                             |
| 16 | 1 | Manageability Type.                                                                                                                                                                                                              |
|    |   | This byte denotes the card manageability type and interface used.                                                                                                                                                                |
|    |   | 0x00 – No manageability 0x01 – RBT Type 0x02 – MCTP Type 0x03 – RBT + MCTP Type 0x04-0x0FF – Reserved for future use                                                                                                             |
| 17 | 1 | FRU Write Protection Mechanism.                                                                                                                                                                                                  |
|    |   | This byte defines the FRU write protection mechanism implemented on the OCP NIC 3.0 card. Multiple FRU write projection mechanisms may be simultaneously supported on the OCP NIC 3.0 card. Refer to Section 4.10.2 for details. |
|    |   | Bit 0 – FRU EEPROM is not write protected.                                                                                                                                                                                       |
|    |   | Bit 1 – FRU EEPROM is statically write protected. No field updates permissible.  Bit 2 – FRU EEPROM is write protected via a mechanical jumper or switch.                                                                        |
|    |   | Bit 3 – FRU EEPROM write protection is controlled via network silicon GPIO.                                                                                                                                                      |
|    |   | Bit 4 – FRU EEPROM write protection is controlled via an NC-SI or PLDM based                                                                                                                                                     |
|    |   | mechanism.                                                                                                                                                                                                                       |
|    |   | Bit 5 – FRU EEPROM write protection is controlled by the Programming Mode power state.                                                                                                                                           |
|    |   | Bits [6:7] – Reserved for future use.                                                                                                                                                                                            |
|    |   | 0xFF – Reserved.                                                                                                                                                                                                                 |
| 18 | 1 | Programming Mode Power State supported.                                                                                                                                                                                          |
|    |   | This byte defines support for the Programming Mode power state. If supported, the FRU EEPROM write protect mechanism is disabled for field updates. Refer to Section 3.8 for details on the Programming Mode power state.        |
|    |   | 0x00 – Programming Mode power state not supported.                                                                                                                                                                               |
|    |   | 0x01 – Programming Mode power state supported.                                                                                                                                                                                   |
|    |   | 0x02 – 0xFE – Reserved for future use.                                                                                                                                                                                           |
| 10 |   | 0xFF – Reserved.                                                                                                                                                                                                                 |
| 19 | 1 | Hot Aisle Card Cooling Tier with Active Cables.                                                                                                                                                                                  |
|    |   | The encoded value reports the OCP NIC 3.0 Card Hot Aisle Card Cooling Tier as defined in Section 6.6 for cards with active pluggable cables for the line side I/O.                                                               |
|    |   | 0x00 – Card only supports passive cables (e.g., RJ45)                                                                                                                                                                            |
|    |   | 0x01 – Hot Aisle Cooling Tier 1                                                                                                                                                                                                  |
|    |   | 0x02 – Hot Aisle Cooling Tier 2<br>0x03 – Hot Aisle Cooling Tier 3                                                                                                                                                               |
|    |   | 0x04 – Hot Aisle Cooling Tier 4                                                                                                                                                                                                  |
|    |   | 0x05 – Hot Aisle Cooling Tier 5                                                                                                                                                                                                  |
|    |   | 0x06 – Hot Aisle Cooling Tier 6                                                                                                                                                                                                  |
|    |   | 0x07 – Hot Aisle Cooling Tier 7                                                                                                                                                                                                  |
|    |   | 0x08 – Hot Aisle Cooling Tier 8                                                                                                                                                                                                  |

|    |   | 0x09 – Hot Aisle Cooling Tier 9                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|----|---|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|    |   | 0x0A – Hot Aisle Cooling Tier 10                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x0B – Hot Aisle Cooling Tier 11                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x0C – Hot Aisle Cooling Tier 12                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x0D – 0xFE – Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|    |   | 0xFF – Unknown                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 20 | 1 | Cold Aisle Card Cooling Tier with Active Cables.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | The encoded value reports the OCP NIC 3.0 Card Cold Aisle Card Cooling Tier as                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|    |   | defined in Section 6.6 for cards with active pluggable cables for the line side                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|    |   | 1/0.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|    |   | 0x00 – Card only supports passive cables (e.g., RJ45)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|    |   | 0x01 – Cold Aisle Cooling Tier 1                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x02 – Cold Aisle Cooling Tier 2                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x03 – Cold Aisle Cooling Tier 3                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x04 – Cold Aisle Cooling Tier 4                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x05 – Cold Aisle Cooling Tier 5                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x06 – Cold Aisle Cooling Tier 6                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x07 – Cold Aisle Cooling Tier 7                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x08 – Cold Aisle Cooling Tier 8                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x09 – Cold Aisle Cooling Tier 9                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|    |   | 0x0A – Cold Aisle Cooling Tier 10                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|    |   | 0x0B – Cold Aisle Cooling Tier 11                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|    |   | 0x0C – Cold Aisle Cooling Tier 12                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|    |   | 0x0D – 0xFE – Reserved                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|    |   | 0xFF – Unknown                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| 21 | 1 | Transceiver Reference Power Level.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|    |   | i Transceiver Rejerence Power Level.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|    | 1 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|    |   | The encoded value denotes the reference power envelope for active                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable 0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)                                                                                                                                                                                                                                                                                                                                                                                                           |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 5 (4.0 W max)  0x05 – QSFP Active cable Power Class 6 (4.5 W max)                                                                                                                                                                                                                                                                                                                                                                                                           |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)                                                                                                                                                                                                                                                                                                   |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  Ox00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)                                                                                                                                                                                                                                                                                                   |
| 22 | 1 | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)  0x08 – 0xFF – Reserved  Transceiver Reference Temperature Level.                                                                                                                                                                                                                                 |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)  0x08 – 0xFF – Reserved  Transceiver Reference Temperature Level.  The encoded value denotes the reference active transceiver temperature limit,                                                                                                                                                  |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)  0x08 – 0xFF – Reserved  Transceiver Reference Temperature Level.                                                                                                                                                                                                                                 |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)  0x08 – 0xFF – Reserved  Transceiver Reference Temperature Level.  The encoded value denotes the reference active transceiver temperature limit,                                                                                                                                                  |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)  0x08 – 0xFF – Reserved  Transceiver Reference Temperature Level.  The encoded value denotes the reference active transceiver temperature limit, in degrees Celsius, that was used to determine the card thermal tier.                                                                            |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  0x00 – Passive Cable  0x01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  0x02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  0x03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  0x04 – QSFP Active cable Power Class 4 (3.5 W max)  0x05 – QSFP Active cable Power Class 5 (4.0 W max)  0x06 – QSFP Active cable Power Class 6 (4.5 W max)  0x07 – QSFP Active cable Power Class 7 (5.0 W max)  0x08 – 0xFF – Reserved  Transceiver Reference Temperature Level.  The encoded value denotes the reference active transceiver temperature limit, in degrees Celsius, that was used to determine the card thermal tier.  0x00 – Passive Cable                                                      |
|    |   | The encoded value denotes the reference power envelope for active transceivers that was used to determine the card thermal tier. The active cable power class is defined in the respective module management interface specifications:  SFF-8472 for SFP modules – Power level 1 through 3  SFF-8636 for QSFP modules – Power Classes 1 through 7.  Ox00 – Passive Cable  Ox01 – QSFP Active cable Power Class 1 (1.5 W max) / SFP Level 1 (1.0 W max)  Ox02 – QSFP Active cable Power Class 2 (2.0 W max) / SFP Level 2 (1.5 W max)  Ox03 – QSFP Active cable Power Class 3 (2.5 W max) / SFP Level 3 (2.0 W max)  Ox04 – QSFP Active cable Power Class 4 (3.5 W max)  Ox05 – QSFP Active cable Power Class 5 (4.0 W max)  Ox06 – QSFP Active cable Power Class 6 (4.5 W max)  Ox07 – QSFP Active cable Power Class 7 (5.0 W max)  Ox08 – OxFF – Reserved  Transceiver Reference Temperature Level.  The encoded value denotes the reference active transceiver temperature limit, in degrees Celsius, that was used to determine the card thermal tier.  Ox00 – Passive Cable  Ox01 – OxFE – Transceiver max operating temperature |

|                | ı        |                                                                                                                                                                                                                                                                                                                                                                                                                |
|----------------|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                |          | The encoded value denotes the required thermal tier when the OCP NIC 3.0 active cooling fails.                                                                                                                                                                                                                                                                                                                 |
|                |          | 0x00 – Card requires the same thermal tier when the active cooling fan fails or                                                                                                                                                                                                                                                                                                                                |
|                |          | the OCP NIC 3.0 card uses passive cooling.                                                                                                                                                                                                                                                                                                                                                                     |
|                |          | 0x01 – Card requires Cooling Tier 1 with card fan failure                                                                                                                                                                                                                                                                                                                                                      |
|                |          | 0x02 – Card requires Cooling Tier 2 with card fan failure                                                                                                                                                                                                                                                                                                                                                      |
|                |          | 0x03 – Card requires Cooling Tier 3 with card fan failure                                                                                                                                                                                                                                                                                                                                                      |
|                |          | 0x04 – Card requires Cooling Tier 4 with card fan failure                                                                                                                                                                                                                                                                                                                                                      |
|                |          | 0x05 – Card requires Cooling Tier 5 with card fan failure                                                                                                                                                                                                                                                                                                                                                      |
|                |          | 0x06 – Card requires Cooling Tier 6 with card fan failure 0x07 – Card requires Cooling Tier 7 with card fan failure                                                                                                                                                                                                                                                                                            |
|                |          | 0x08 – Card requires Cooling Tier 7 with card fan failure                                                                                                                                                                                                                                                                                                                                                      |
|                |          | 0x09 – Card requires Cooling Tier 8 with card fan failure                                                                                                                                                                                                                                                                                                                                                      |
|                |          | 0x0A – Card requires Cooling Tier 10 with card fan failure                                                                                                                                                                                                                                                                                                                                                     |
|                |          | 0x0B – Card requires Cooling Tier 11 with card fan failure                                                                                                                                                                                                                                                                                                                                                     |
|                |          | 0x0C – Card requires Cooling Tier 12 with card fan failure                                                                                                                                                                                                                                                                                                                                                     |
|                |          | 0x0D – FF – Reserved                                                                                                                                                                                                                                                                                                                                                                                           |
| 24:30          | 7        | Reserved for future use.                                                                                                                                                                                                                                                                                                                                                                                       |
|                |          | Set each byte to 0xFF for this version of the specification.                                                                                                                                                                                                                                                                                                                                                   |
| 31             | 1        | Number of Physical Controllers (N).                                                                                                                                                                                                                                                                                                                                                                            |
|                |          | This byte denotes the number of SMBus connected physical controllers on the OCP NIC 3.0 card. If N=0, no controllers exist on this OCP NIC 3.0 card and this                                                                                                                                                                                                                                                   |
|                |          | is the last byte in the FRU OEM Record.                                                                                                                                                                                                                                                                                                                                                                        |
|                |          | If N≥1, then the controller UDID records below shall be included for each                                                                                                                                                                                                                                                                                                                                      |
|                |          | controller N.                                                                                                                                                                                                                                                                                                                                                                                                  |
| 32:47          | 16       | Controller 1 UDID (if applicable).                                                                                                                                                                                                                                                                                                                                                                             |
|                |          | This field reports the Controller 1 Unique Device Identifier (UDID) and is used                                                                                                                                                                                                                                                                                                                                |
|                |          | to aid in the dynamic slave address assignment over the SMBus Address                                                                                                                                                                                                                                                                                                                                          |
|                |          | Resolution Protocol. The format of the UDID string is defined in the SMBus 2.0                                                                                                                                                                                                                                                                                                                                 |
|                |          | specification.                                                                                                                                                                                                                                                                                                                                                                                                 |
|                |          | This field shall list the second significant buts first (to alien the FDH and such the                                                                                                                                                                                                                                                                                                                         |
|                |          | This field shall list the most significant byte first (to align the FRU order to the                                                                                                                                                                                                                                                                                                                           |
|                |          | reported UDID order on the SMBus). This field is populated with the UDID for                                                                                                                                                                                                                                                                                                                                   |
|                |          | reported UDID order on the SMBus). This field is populated with the UDID for Controller 1.                                                                                                                                                                                                                                                                                                                     |
| 48:63          | 16       | reported UDID order on the SMBus). This field is populated with the UDID for Controller 1.  This field is omitted and is of zero length if controller 1 is not present.                                                                                                                                                                                                                                        |
| 48:63          | 16       | reported UDID order on the SMBus). This field is populated with the UDID for Controller 1.  This field is omitted and is of zero length if controller 1 is not present.  Controller 2 UDID (if applicable). See Controller 1 UDID description above.                                                                                                                                                           |
| 64:79          | 16       | reported UDID order on the SMBus). This field is populated with the UDID for Controller 1.  This field is omitted and is of zero length if controller 1 is not present.  Controller 2 UDID (if applicable). See Controller 1 UDID description above.  Controller 3 UDID (if applicable). See Controller 1 UDID description above.                                                                              |
| 64:79<br>80:95 | 16<br>16 | reported UDID order on the SMBus). This field is populated with the UDID for Controller 1.  This field is omitted and is of zero length if controller 1 is not present.  Controller 2 UDID (if applicable). See Controller 1 UDID description above.  Controller 3 UDID (if applicable). See Controller 1 UDID description above.  Controller 4 UDID (if applicable). See Controller 1 UDID description above. |
| 64:79          | 16       | reported UDID order on the SMBus). This field is populated with the UDID for Controller 1.  This field is omitted and is of zero length if controller 1 is not present.  Controller 2 UDID (if applicable). See Controller 1 UDID description above.  Controller 3 UDID (if applicable). See Controller 1 UDID description above.                                                                              |

### 4.10.4 FRU Template

A FRU template is provided as a baseline implementation example. This FRU template contains the IPMI Platform Management FRU Information Storage Definition Product Info, Board Info records as well as the OEM record for OCP NIC 3.0.

The FRU template file may be downloaded from the OCP NIC 3.0 Wiki site: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>.

# 5 Routing Guidelines and Signal Integrity Considerations

### 5.1 NC-SI over RBT

The NC-SI over RBT requirements in this section apply to both the SFF and LFF OCP NIC 3.0 cards. Designers shall use the appropriate SFF or LFF timing parameters for the design calculations.

The overall end-to-end timing budget is computed by the formula below. The values of each parameter are shown in Table 55 and in DSP0222. The overall BMC pad to ASIC pad timing budget is 3 ns assuming the values shown. This value is inclusive of the RBT isolation buffer on the baseboard, propagation delay through the OCP connector, clock jitter or any clock buffers that may be implemented on the OCP NIC 3.0 card. The addition of these components subtract from the total available budget.

Total timing budget 
$$= T_{CLK} - T_{CO(max)} - T_{SU(min)} - T_{SKEW(max)}$$

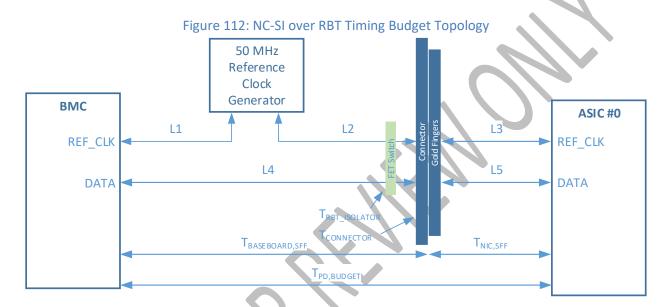
$$= 20 \text{ ns} - 12.5 \text{ ns} - 3 \text{ ns} - 1.5 \text{ ns}$$

$$= 3 \text{ ns}$$

Table 55: NC-SI over RBT Timing Parameters

| Parameter                       | Value   | Description                                                 |  |  |
|---------------------------------|---------|-------------------------------------------------------------|--|--|
| $T_{PD,BUDGET}$                 | 3000 ps | Total propagation delay budget between BMC and the targe    |  |  |
|                                 |         | ASIC.                                                       |  |  |
| T <sub>BASEBOARD,SFF</sub>      | 2100 ps | Max permissible propagation delay on a SFF baseboard.       |  |  |
| $T_{BASEBOARD,LFF}$             | 1650 ps | Max permissible propagation delay on a LFF baseboard.       |  |  |
| $T_{NIC,SFF}$                   | 900 ps  | Max permissible propagation delay for a SFF OCP NIC 3.0     |  |  |
|                                 |         | card.                                                       |  |  |
| $T_{NIC,LFF}$                   | 1350 ps | Max permissible propagation delay for a LFF OCP NIC 3.0     |  |  |
|                                 |         | card.                                                       |  |  |
| T <sub>CLK</sub>                | 20 ns   | 50 MHz REF_CLK frequency period.                            |  |  |
| T <sub>CO(max)</sub>            | 12.5 ns | Clock-to-out value per DSP0222                              |  |  |
| T <sub>SU(min)</sub>            | 3 ns    | RBT single ended signal data setup to REF_CLK rising edge   |  |  |
| T <sub>SKEW(max)</sub>          | 1.5 ns  | Max permissible clock REF_CLK skew between any two          |  |  |
| $\wedge$                        |         | devices in the system – BMC and target NIC ASIC(s).         |  |  |
| $T_{RBT\_ISOLATOR(max)}$        | -       | Baseboard RBT isolator propagation delay. Value is          |  |  |
|                                 |         | dependent on device selection. Baseboard implementers       |  |  |
|                                 |         | shall include this value in the timing budget calculations. |  |  |
| T <sub>CONNECTOR,STRADDLE</sub> | 110 ps  | OCP NIC 3.0 straddle mount connector propagation delay.     |  |  |
|                                 |         | This value is the assumed worst case value for all straddle |  |  |
|                                 |         | mount connector configurations.                             |  |  |
| $T_{CONNECTOR,RA}$              | 130 ps  | OCP NIC 3.0 right angle connector propagation delay. This   |  |  |
|                                 |         | value is the assumed worst case value for all right angle   |  |  |
|                                 |         | connector configurations.                                   |  |  |
| $T_{CLK\_BUF(max)}$             | -       | OCP NIC 3.0 clock buffer propagation delay. Value is        |  |  |
|                                 |         | dependent on device selection. OCP NIC 3.0 implementers     |  |  |
|                                 |         | shall include this value in the timing budget calculations. |  |  |

| T <sub>JITTER_REF</sub> | - | Baseboard reference clock generator cycle-to-cycle clock     |
|-------------------------|---|--------------------------------------------------------------|
|                         |   | jitter. Value is dependent on device selection. Baseboard    |
|                         |   | implementers shall include this value in the timing budget   |
|                         |   | calculations.                                                |
| T <sub>JITTER_NIC</sub> | - | OCP NIC 3.0 clock buffer cycle-to-cycle clock jitter (if     |
|                         |   | implemented on the NIC). Value is dependent on device        |
|                         |   | selection. OCP NIC 3.0 implementers shall include this value |
|                         |   | in the timing budget calculations.                           |



The following sections define the portion of the overall propagation delay budget allocated to the baseboard and to the OCP NIC 3.0 card, as well as additional requirements for each. Baseboard and NIC implementers shall analyze their design to ensure the timing budget is not violated.

The traces shall be implemented as 50 Ohm ±15% impedance controlled nets. Baseboard and NIC designers are encouraged to follow the guidelines defined in the RMII and NC-SI specifications for physical routing. Refer to Section 3.4.4 and the DSP0222 specification for example interconnect topologies.

### **5.1.1 SFF** Baseboard Requirements

The SFF baseboard is allocated a maximum propagation time of 2100 ps between the BMC and the connector edge. NC-SI over RBT isolation buffers are required on the baseboard. The requirements for additional add-in card loading are reduced. The available timing budget for the SFF baseboard is computed by the formula below.

$$T_{BASEBOARD,SFF} = 2100 \text{ ps} - T_{RBT\_ISOLATOR} - T_{CONNECTOR}$$

The skew requirement defines the max permissible clock skew ( $T_{SKEW}$ ) between any two system devices. The  $T_{SKEW}$  calculation is computed by the formula below. This applies to both the devices on the baseboard and the NIC. L1 is the REF\_CLK segment from the baseboard 50 MHz reference clock generator to the BMC. L2 is the REF\_CLK segment between the baseboard clock generator to the OCP

NIC 3.0 connector and L3 is the segment between the SFF OCP NIC 3.0 card gold fingers and the target ASIC. Refer to Figure 112 for details. The max permissible value of L3 is  $T_{\text{NIC,SFF}}$  = 900 ps as discussed in Section 5.1.3. Baseboard vendors shall take this value into consideration when analyzing the available timing budget.

$$T_{SKEW(max)} \le | L1 - (L2 + T_{CONNECTOR} + L3) |$$

#### **5.1.2** LFF Baseboard Requirements

The LFF baseboard is allocated a maximum propagation time of 1650 ps between the BMC and the connector edge. NC-SI over RBT isolation buffers are required on the baseboard. The requirements for additional add-in card loading are reduced. The available timing budget for the LFF baseboard is computed by the formula below.

$$T_{BASEBOARD,LFF}$$
 = 1650 ps -  $T_{RBT ISOLATOR}$  -  $T_{CONNECTOR}$ 

Similar to SFF, the LFF clock skew parameter  $T_{SKEW(max)}$  must not be exceeded. The max permissible value of L3 is  $T_{NIC,LFF}$  = 1350 ps. Refer to Section 5.1.1 for the skew computation requirements.

#### **5.1.3 SFF OCP NIC 3.0 Card Requirements**

The SFF OCP NIC 3.0 card is allocated a maximum propagation time of  $T_{NIC,SFF}$  = 900 ps between the card gold finger and the ASIC pad for both the clock and data signals. The total card propagation delay from the RBT clock input towards the card to the RBT outputs from the card shall be less than 14.3 ns ( $T_{CO(max)}$  + 2 x  $T_{NIC,SFF}$ ) when measured at the corresponding SFF OCP NIC 3.0 gold fingers. This can be achieved by using an ASIC with the worst case Clock-to-Out ( $T_{CO,MAX}$ ) value of 12.5 ns specified by DSP0222, and each SFF OCP NIC 3.0 card-side RBT signal not exceeding a max propagation time of 900 ps.

This propagation delay is equivalent to a max length of 5.1 inches assuming standard FR4 material with a propagation delay of 175 ps/in. Additional trace length may be achieved with the use of a higher propagation velocity material (e.g., material with a lower dielectric constant) on the baseboard and OCP NIC 3.0 card or simultaneously using both BMC and ASIC devices with an improved timing from Clock-to-Out ( $T_{CO,MAX}$ ) value compared to the published value of 12.5 ns in DSP0222. For NIC implementations with clock buffers, the propagation delay of the buffer needs to be included in this timing budget (i.e., L3 +  $T_{CLK_BUF}$  + L3' +  $T_{CO,MAX}$  + L5 shall be less than 14.3 ns) as shown in Figure 114.

If multiple ASICs are utilized, the RBT\_CLK\_IN signal may be routed with a T-topology as shown in Figure 113. The trace length would be calculated as the delay summation of segment L3 + L3' for ASIC #0 and L3 + L3' for ASIC #1. The data path delay to the ASIC is L5.

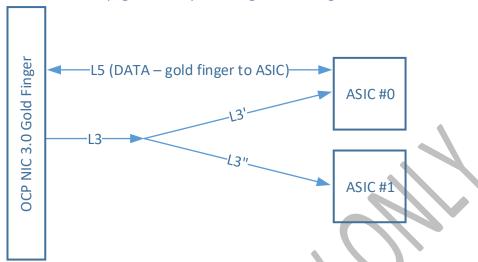


Figure 113: NC-SI over RBT Propagation Delay Matching for Two Target ASICs - No Clock Buffer

A clock buffer is optionally permitted if the NIC timing budget is not violated. This is shown in Figure 114. In this case, the trace length would be calculated as the delay summation of trace segment L3 +  $T_{CLK\_BUF}$  + L3' for ASIC #0, and L3 +  $T_{CLK\_BUF}$  + L3' for ASIC #1.

L3 DOO 1:2 Clock Buffer T<sub>CLK\_BUF</sub>

ASIC #0

ASIC #1

Figure 114: NC-SI over RBT Propagation Delay Matching for Two Target ASICs – Clock Buffer

# 5.1.4 LFF OCP NIC 3.0 Card Requirements

Similar to the SFF, a LFF OCP NIC 3.0 Card is allocated a maximum propagation time of  $T_{\text{NIC,LFF}}$  = 1350 ps between the card gold finger and the ASIC pad for both the clock and data signals. The segment L3 between the LFF OCP NIC 3.0 card gold fingers and the ASIC shall not exceed this propagation delay for a single and multi-ASIC target implementations. Refer to Section 5.1.3 for computation and topology considerations.

#### 5.2 SMBus 2.0

For the SMBus 2.0 interface, both the baseboard and OCP NIC 3.0 designers shall follow the applicable requirements found in the SMBus, PCIe CEM specifications. This applies to the routing guidelines, SI

considerations, bus operational speed range, capacitive loading, and range of pull up resistance values. Doing so allows the baseboard suppliers to design a SMBus interface that is compatible with OCP NIC 3.0 products.

#### **5.3** PCle

OCP NIC 3.0 card suppliers shall follow the PCIe routing specifications. Refer to the PCIe CEM and PCIe Base specifications for end-to-end channel signal integrity considerations.

#### **5.3.1** Channel Requirements

The OCP NIC 3.0 PCIe channel requirements align with the electrical budget and constraints as detailed in the PCI Express® CEM 4.0 Rev 1.0 and PCI Express Base Specification Rev 4.0. Exceptions or clarifications to the referenced specifications are noted in the sections below.

#### **5.3.1.1** REFCLK requirements

REFCLK requirements are detailed in the PCI Express CEM 4.0 Rev 1.0 Section 2.1.

### **5.3.1.2** Add-in Card Electrical Budgets

This section defines the OCP NIC 3.0 card channel budget from the gold finger edge to the end point silicon. The values listed below are shown for reference and mirrors that of the PCIe CEM 4.0 specification.

| Parameter                                            | PCIe CEM 4.0 Rev 1.0 Specification Section |
|------------------------------------------------------|--------------------------------------------|
| AC coupling capacitors                               | Section 4.7.1                              |
| Insertion Loss Values (Voltage Transfer              | Section 4.7.2 and Appendix A.              |
| Function)                                            | Section 4.7.10 for 16 GT/s                 |
| Jitter Values                                        | Section 4.7.3 for 8 GT/s and 16 GT/s.      |
|                                                      | Also refer to the PCIe Base Specification  |
|                                                      | Section 8.3.5                              |
| Crosstalk                                            | Section 4.7.4                              |
| Lane-to-lane skew (S <sub>A</sub> ) for Add-in cards | Section 4.7.5                              |
| Transmitter Equalization                             | Section 4.7.6 and PCIe Base Spec Chapter 9 |
| Skew within a differential pair                      | Section 4.7.7                              |
| Differential data trace impedance                    | Section 4.7.8                              |
| Differential data trace propagation delay            | Section 4.7.9                              |

Table 56: PCIe Electrical Budgets

### 5.3.1.3 Baseboard Channel Budget

The baseboard channel budget directly follows the PCI Express CEM 4.0 Rev 1.0 specification. Details of the budget are outside of the scope of this specification.

### 5.3.1.4 SFF-TA-1002 Connector Channel Budget

Reference the SFF-TA-1002 Revision 1.1 or later.

### **5.3.1.5** Differential Impedance (Informative)

For PCIe transmit and receive differential pairs, the target impedance is 85 Ohms ±10%.

For the PCIe REFCLKs, the target impedance is 100 Ohms ±10%.

#### 5.3.2 Test Fixtures

Test Fixtures are designed using the PCIe CEM 4.0 CLB and CBB. The fixtures host interface has been modified to the OCP connector standard and there are two version of the fixtures, one for Gen 3 PCIe and one for Gen 4 PCIe. Careful attention has been placed on these fixtures to help insure that standard test equipment automation should work without significant modification.

| Table 5711 ele reser meares for ele rive sie |                 |                   |  |  |  |
|----------------------------------------------|-----------------|-------------------|--|--|--|
| Test Fixture                                 | PCIe Generation | PCB Material      |  |  |  |
| Load Board                                   | Gen 3           | TU863             |  |  |  |
|                                              | Gen 4           | TU883             |  |  |  |
| Base Board                                   | Gen 3           | TU863             |  |  |  |
|                                              | Gen 4           | TBD (+vISI board) |  |  |  |

Table 57: PCIe Test Fixtures for OCP NIC 3.0

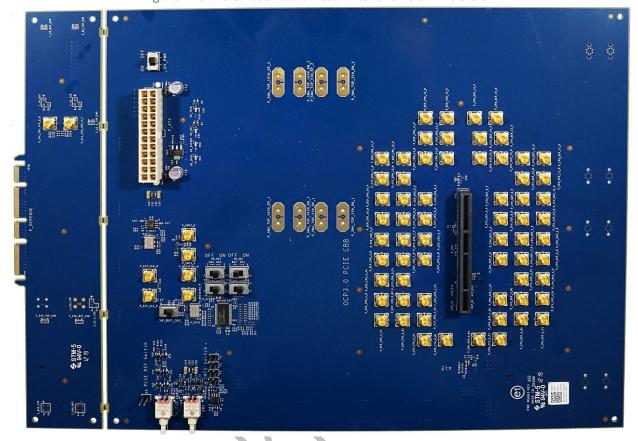
### **5.3.2.1** Compliance Load Board (CLB)

Figure 115: PCIe Load Board Test Fixture for QCP NIC 3.0 SFF



#### **5.3.2.2** Compliance Baseboard (CBB)

Figure 116: PCle Base Board Test Fixture for OCP NIC 3.0 SFF



### 5.3.3 Test Methodology

OCP NIC 3.0 is compliant to the applicable PCIe specifications. The electrical interface may be tested against the PCI Express® Architecture PHY Test Specification Revision 4.0, providing that the appropriate test fixtures from Section 5.3.2 are used.

### **5.3.3.1** Test Setup

This section is a work-in-progress by the OCP NIC 3.0 SI Subgroup. The following information will be added in a future document release:

- Description of the OCP NIC 3.0 CLB and CBB test figure for use in the PCle Architecture PHY Test Specifications.
- A user guide is in development through UNH at the time of publication.
- The test procedure is based on the PCIe procedures. The differences between the procedures for PCIe Adapters and OCP NIC 3.0 cards will be documented in the user guide.

### 6 Thermal and Environmental

### 6.1 Airflow Direction

The OCP NIC 3.0 card is designed to operate in either of two different airflow directions which are referred to as Hot Aisle and Cold Aisle. In both Hot Aisle and Cold Aisle configurations all airflow is directed over the topside of the card. Component placement must assume that there will be no airflow on the bottom side of the card. The local approach air temperature and velocity to the card is dependent on the capability of the system adopting OCP NIC 3.0 card. These parameters may be impacted by the operational altitude and relative humidity in Hot Aisle or Cold Aisle configurations. Design boundary conditions for Hot Aisle and Cold Aisle cooling are included below in Sections 6.1.1 and 6.1.2 respectively.

The two airflow directions of the Hot and Cold Aisle cases should not result in multiple thermal solutions to separately satisfy the varying thermal boundary conditions. Ideally, any specific OCP NIC 3.0 card design should function in systems with either Hot Aisle or Cold Aisle cooling. Thermal analysis in support of this specification have shown the Hot Aisle configuration to be more challenging than Cold Aisle but card vendors should make that determination for each card that is developed.

#### 6.1.1 Hot Aisle Cooling

The airflow in typical server systems will approach from the card edge or heatsink side of the card. This airflow direction is referred to as Hot Aisle cooling and is illustrated below in Figure 117. The term Hot Aisle refers to the card being located at the rear of the system where the local inlet airflow is preheated by the upstream system components (e.g., HDD, CPU, DIMM, etc.).

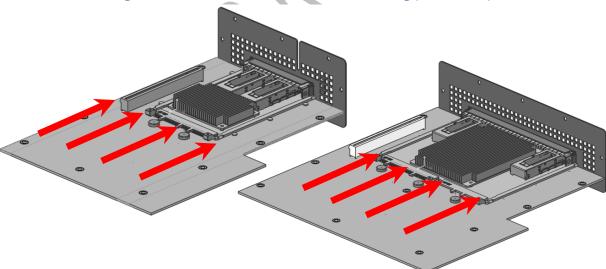


Figure 117: Airflow Direction for Hot Aisle Cooling (SFF and LFF)

The boundary conditions for Hot Aisle cooling are shown below in Table 58 and Table 59. The low temperature is listed at 5°C and assumes fresh air could be ducted to the back of the system from the front. More typically the inlet temperature to the OCP NIC 3.0 card will be in the same range as PCIe cards located at the back of the system (55°C local inlet temperature). Depending on the system design, power density, and airflow the inlet temperature to the OCP NIC 3.0 card may be as high as 60°C or 65°C. The airflow velocities listed in Table 59 represent the airflow velocities typical in mainstream

servers. Higher airflow velocities are available within the Hot Aisle cooling tiers listed in Table 64 but card designers must be sure to understand the system level implications of such high card LFM requirements.

Table 58: Hot Aisle Air Temperature Boundary Conditions

|                 | Low            | Typical | High | Max  |
|-----------------|----------------|---------|------|------|
| Local Inlet air | 5°C            | 55°C    | 60°C | 65°C |
| temperature     | (system inlet) | 33 C    | 60 C | 65 C |

Table 59: Hot Aisle Airflow Boundary Conditions

|                          | Low    | Typical     | High    | Max                 |
|--------------------------|--------|-------------|---------|---------------------|
| Local inlet air velocity | 50 LFM | 100-200 LFM | 300 LFM | System<br>Dependent |

#### 6.1.2 Cold Aisle Cooling

When installed in the front of a server the airflow will approach from the I/O connector (e.g., SFP, QSFP or RJ45) side of the card. This airflow direction is referred to as Cold Aisle cooling and is illustrated below in Figure 118. The term Cold Aisle refers to the card being located at the front of the system where the local inlet airflow is assumed to be the same temperature as the system inlet airflow.

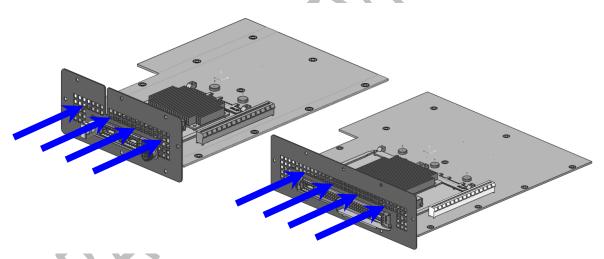


Figure 118: Airflow Direction for Cold Aisle Cooling (SFF and LFF)

The boundary conditions for Cold Aisle cooling are shown below in Table 60 and Table 61. The temperature values listed in Table 60 assume the inlet temperature to the OCP NIC 3.0 card to be the same as the system inlet. The low, typical, high, and max temperatures listed align with the ASHRAE A1, A2, A3, and A4 environmental classes. Depending on the system, the supported ASHRAE class may limit the maximum temperature to the OCP 3.0 NIC card. However, for more broad industry support, cards should be designed to the upper end of the ASHRAE classes (e.g., class A4).

Table 60: Cold Aisle Air Temperature Boundary Conditions

|                 | Low | Typical      | High      | Max       |
|-----------------|-----|--------------|-----------|-----------|
| Local Inlet Air | 5°C | 25-35°C      | 40°C      | 45°C      |
| Temperature     |     | ASHRAE A1/A2 | ASHRAE A3 | ASHRAE A4 |

|                 | •      |         |         |           |
|-----------------|--------|---------|---------|-----------|
|                 | Low    | Typical | High    | Max       |
| Local Inlet Air | 50 LFM | 100 LFM | 200 LFM | System    |
| Velocity        |        |         |         | Dependent |

Table 61: Cold Aisle Airflow Boundary Conditions

#### 6.2 Thermal Design Guidelines

The information in this section is intended to serve as a quick reference guide for OCP NIC 3.0 designers early in the design process. The information should be used as a reference for upfront thermal design and feasibility and should not replace detailed card thermal design analysis. The actual cooling capability of the card shall be defined based on the testing with the OCP NIC 3.0 thermal test fixture as defined in Section 6.4.

#### 6.2.1 SFF Card ASIC Cooling – Hot Aisle

The ASIC or controller chip is typically the highest power component on the card. Thus, as OCP NIC 3.0 cards are developed it is important to understand the ASIC cooling capability. Figure 119 below provides an estimate of the maximum ASIC power that can be supported as a function of the local inlet velocity for the SFF card in a hot aisle cooling configuration. Each curve in Figure 119 represents a different local inlet air temperature from 45°C to 65°C.

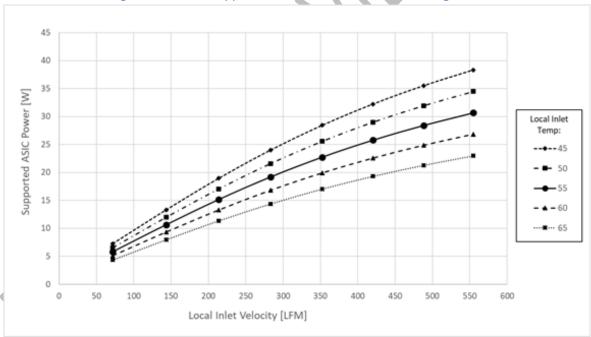


Figure 119: ASIC Supportable Power for Hot Aisle Cooling – SFF

The curves shown in Figure 119 were obtained using CFD analysis of a reference OCP NIC 3.0 SFF card. The reference card has a 20 mm x 20 mm ASIC with two QSFP connectors. Figure 120 shows a comparison of the 3D CAD and CFD model geometry for the reference OCP NIC 3.0 card. Additional card geometry parameters and boundary conditions used in the reference CFD analysis are summarized in Table 62. The OCP NIC 3.0 simulation was conducted within a virtual version of the test fixture defined in Section 6.4.

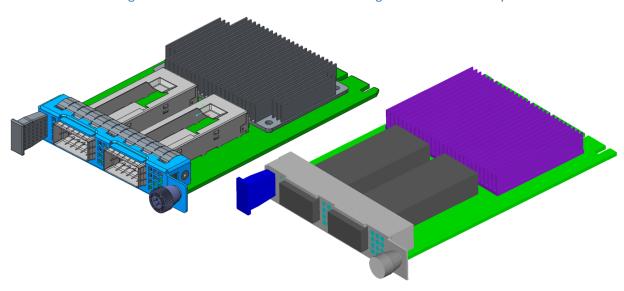


Figure 120: OCP NIC 3.0 SFF Reference Design and CFD Geometry

Table 62: Reference OCP NIC 3.0 SFF Card Geometry

| rd         |  |
|------------|--|
|            |  |
| m          |  |
| m          |  |
| 9.24 mm    |  |
| m          |  |
| mm         |  |
| uminum     |  |
|            |  |
|            |  |
|            |  |
| /W         |  |
| W          |  |
| пK         |  |
| ′mK        |  |
|            |  |
| 3.5 W each |  |
|            |  |

An increase in the supported ASIC power or a decrease in the required airflow velocity may be achieved through heatsink size and material changes. For example, a larger heatsink or a heatsink made out of copper could improve ASIC cooling and effectively shift up the supportable power curves shown in Figure 119.

It is important to point out that the curves shown in Figure 119 represent only the maximum ASIC power that can be supported vs. the supplied inlet velocity. Other heat loads on the card may require airflow velocities above and beyond that required to cool the ASIC. SFP or QSFP optical transceivers located downstream of the AISC will in many cases pose a greater cooling challenge than the ASIC cooling.

Cooling the optical transceivers becomes even more difficult as the ASIC power is increased due to additional preheating of the air as it moves through the ASIC heatsink. OCP NIC 3.0 designers must consider all heat sources early in the design process to ensure the card thermal solution is sufficient for the feature set. In addition, OCP NIC 3.0 designers must consider all power modes in the design process – including SO (Main Power Mode) and S5 (Aux Power Mode). For both modes, the card designer must provide the airflow requirements in the OEM FRU record as described in Section 4.10.3.

Card designers must also consider the airflow capability of the server systems that the cards are targeted for use within. Figure 121 below shows the SFF ASIC supportable power curves with an overlay of three server airflow capability ranges. Designers must ensure that their thermal solutions and resulting card airflow requirements fall within the range of supportable system airflow velocity. Cards that are under-designed (e.g., require airflow greater than the system capability) will have thermal issues when deployed into the server system. Card designers are advised to work closely with system vendors to ensure they target the appropriate airflow and temperature boundary conditions.

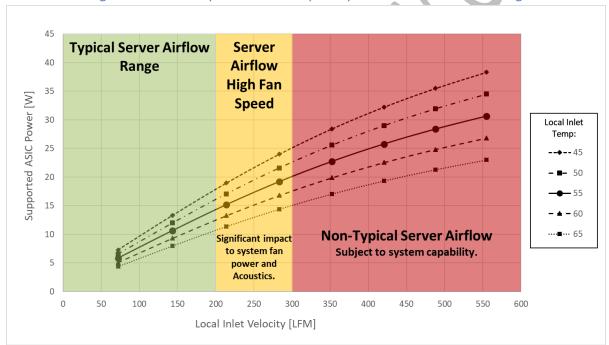


Figure 121: Server System Airflow Capability – SFF Card Hot Aisle Cooling

The server airflow capability is typically more restrictive when the OCP card is operating in standby mode (S5). The airflow available from the system cooling solution is often more restrictive due to limited power budget available in an S5 state. The graph below emphasizes that though the local OCP NIC 3.0 air temperature is typically lower than in S0 (since preheating from upstream components should be greatly reduced while in standby), the upper bound of local air velocity is a fraction of what can be generated when the system is in main power mode (S0). Card vendors must test for these conditions, making sure that the provided cooling is sufficient for both the ASIC and any installed transceivers (which will still be receiving preheat from the ASIC in S5 mode).

The NIC vendor shall provide the required LFM during S5 state in the FRU EEPROM (see Section 4.10.3). The cold aisle should be tested at 35°C; the hot aisle should be tested at 45°C.

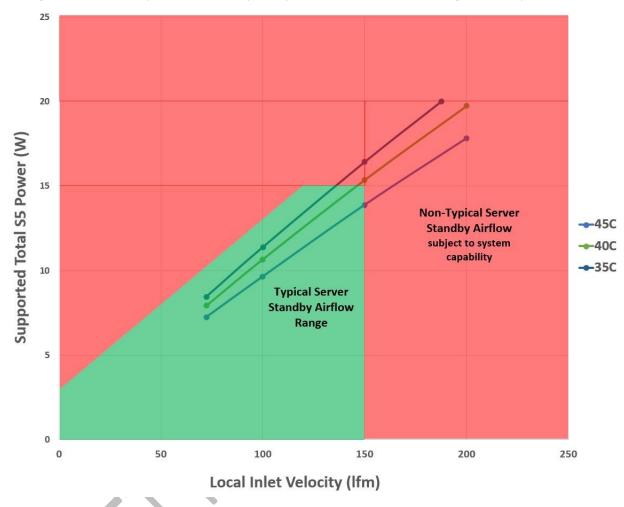


Figure 122: Server System Airflow Capability – SFF Card Hot Aisle Cooling in standby (S5) mode

#### 6.2.2 LFF Card ASIC Cooling – Hot Aisle

Figure 123 below provides an estimate of the maximum ASIC power that can be supported as a function of the local inlet velocity for the LFF card in a hot aisle cooling configuration. Each curve in Figure 123 represents a different local inlet air temperature from 45°C to 65°C.

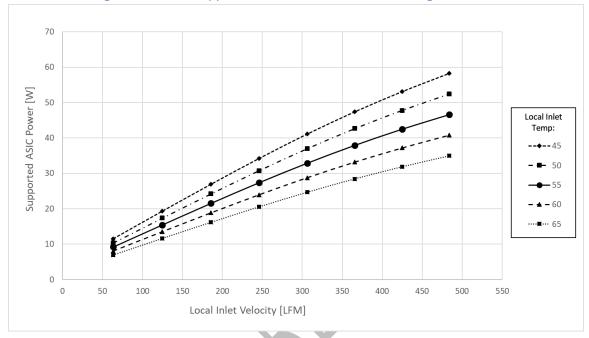


Figure 123: ASIC Supportable Power for Hot Aisle Cooling – LFF Card

The curves shown in Figure 123 were obtained using CFD analysis of the reference OCP NIC 3.0 LFF card. The reference card has a 45 mm x 45 mm ASIC with two QSFP connectors. Additional card geometry parameters and boundary conditions used in the reference CFD analysis are summarized in Table 63. Figure 124 shows a comparison of the 3D CAD and CFD model geometry for the reference OCP NIC 3.0 card.

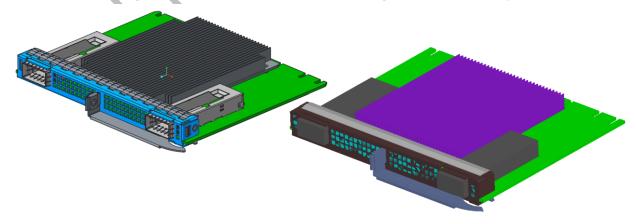


Figure 124: OCP NIC 3.0 LFF Reference Design and CFD Geometry

Table 63: Reference OCP NIC 3.0 LFF Card Geometry

| OCP NIC 3.0 Form Factor                        | LFF Card          |
|------------------------------------------------|-------------------|
| Heatsink Width                                 | 75 mm             |
| Heatsink Length                                | 85 mm             |
| Heatsink Height                                | 9.3 mm            |
| Heatsink Base Thickness                        | 1.5 mm            |
| Fin Count/Thickness                            | 33/0.5 mm         |
| Heatsink Material                              | Extruded Aluminum |
| ASIC Width                                     | 45                |
| ASIC Length                                    | 45                |
| ASIC Height                                    | 2.13              |
| ASIC Theta-JC                                  | 0.17 C/W          |
| ASIC Theta-JB                                  | 10 C/W            |
| OCP PCB In-Plane Conductivity                  | 34 W/mK           |
| OCP PCB Normal Conductivity                    | 0.33 W/mK         |
| ASIC T-case Max                                | 95°C              |
| OCP NIC 3.0 I/O Connectors Two QSFP @ 3.5 W ea |                   |

It is important to note that the supportable power for the LFF card is considerably higher than for the SFF card due to the increased size of the ASIC heatsink. In addition, optics module cooling on the LFF card will also be considerably improved due to the arrangement of the optics in parallel to the ASIC heatsink rather than in series. These thermal advantages are key drivers for the LFF card geometry. The OCP NIC 3.0 simulation was conducted within a virtual version of the LFF card test fixture defined in Section 6.4. In addition, OCP NIC 3.0 designers must consider all power modes in the design process – including SO (Main Power Mode) and S5 (Aux Power Mode). For both modes, the card designer must provide the airflow requirements in the OEM FRU record as described in Section 4.10.3.

Figure 125 below shows the LFF ASIC supportable power curves with an overlay of three server airflow capability ranges. Designers must ensure that their thermal solutions and resulting card airflow requirements fall within the range of supportable system airflow velocity. Cards that are under-designed (e.g., require airflow greater than the system capability) will have thermal issues when deployed into the server system. Card designers are advised to work closely with system vendors to ensure they target the appropriate airflow and temperature boundary conditions.

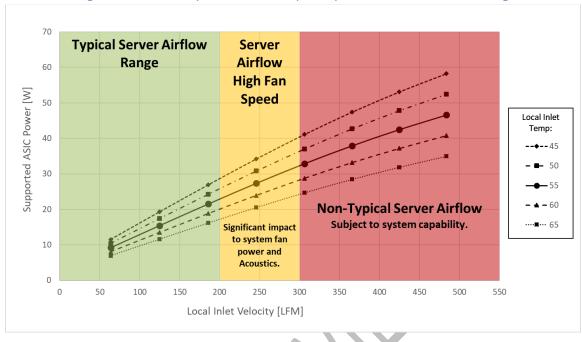


Figure 125: Server System Airflow Capability – LFF Card Hot Aisle Cooling

#### 6.2.3 SFF Card ASIC Cooling – Cold Aisle

Compared to the Hot Aisle cooling configuration, there are several key differences for Cold Aisle ASIC cooling. With Cold Aisle cooling the airflow is pulled from the I/O connector side of the card. The I/O connectors and faceplate venting may affect the airflow through the ASIC heatsink. The I/O connectors may also preheat the airflow by some amount. In a Cold Aisle cooling configuration, other parallel airflow paths may result in less airflow passing over and through the OCP NIC 3.0 card compared to the Hot Aisle.

The ASIC cooling analysis for the SFF Card in the Cold Aisle configuration was conducted utilizing the same geometry and boundary conditions described in Figure 120 and Table 62 with airflow moving from I/O connector to ASIC (opposite to the Hot Aisle analysis). Figure 126 below shows the results of this analysis for the Cold Aisle cooling configuration. Each curve in Figure 126 represents a different system inlet air temperature from 25°C to 45°C.

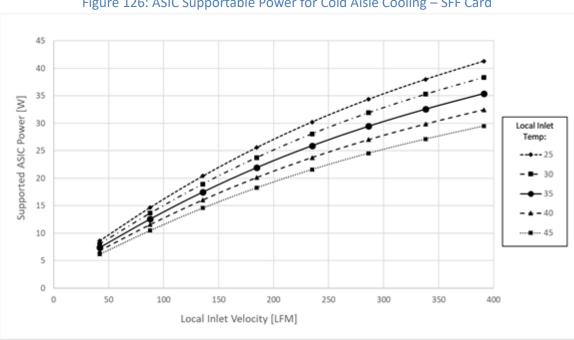


Figure 126: ASIC Supportable Power for Cold Aisle Cooling – SFF Card

Similar to Figure 121 for Hot Aisle cooling, Figure 127 below shows the ASIC supportable power curves with an overlay of three Cold Aisle server airflow capability ranges. Designers must ensure that their thermal solutions and resulting card airflow requirements fall within the range of supportable Cold Aisle system airflow velocity. Cards that are under-designed (e.g., require airflow greater than the system capability) will have thermal issues when deployed into the server system. Similar to the Hot Aisle cases, cooling of the optical transceivers need to be taken into consideration even though they are not preheated by the ASIC in the Cold Aisle case. OCP NIC 3.0 designers must consider all power modes in the design process – including SO (Main Power Mode) and S5 (Aux Power Mode). For both modes, the card designer must provide the airflow requirements in the OEM FRU record as described in Section 4.10.3. Card designers are advised to work closely with system vendors to ensure they target the appropriate airflow and temperature boundary conditions for both Hot and Cold Aisle cooling.

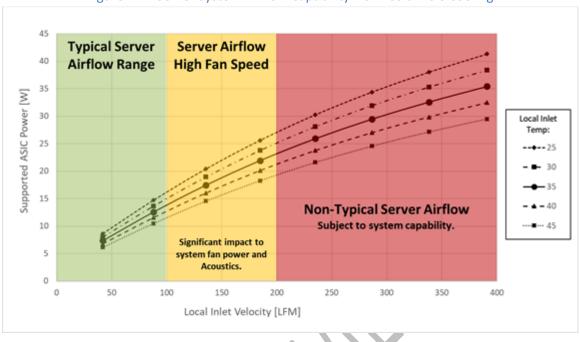


Figure 127: Server System Airflow Capability – SFF Cold Aisle Cooling

A comparison of Hot Aisle (55°C) and Cold Aisle (35°C) SFF ASIC cooling capability curves is shown below in Figure 128. The comparison shows the Hot Aisle ASIC cooling capability at 12 W at 150 LFM while the cold Aisle cooling capability shows support for 19 W at 150 LFM. In general, based on the reference geometry, the Cold Aisle cooling configuration allows for higher supported ASIC power at lower velocities due primarily to the lower inlet temperatures local to the OCP NIC 3.0 card when in the Cold Aisle cooling configuration.

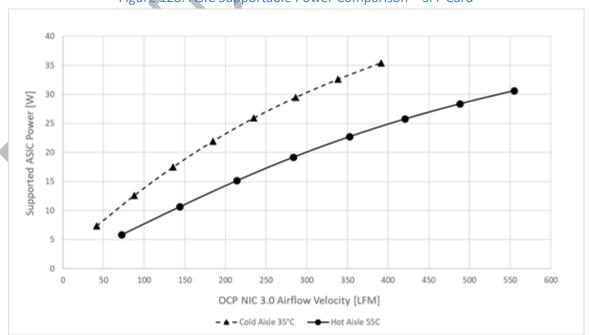


Figure 128: ASIC Supportable Power Comparison – SFF Card

#### 6.2.4 LFF Card ASIC Cooling – Cold Aisle

The ASIC cooling analysis for the LFF card in Cold Aisle configuration was conducted utilizing the same geometry and boundary conditions described in Figure 124 and Table 63 with airflow moving from I/O connector to ASIC (opposite to the Hot Aisle analysis). Figure 129 below shows the results of this analysis for the Cold Aisle cooling configuration. Each curve in Figure 129 represents a different system inlet air temperature from 25°C to 45°C.

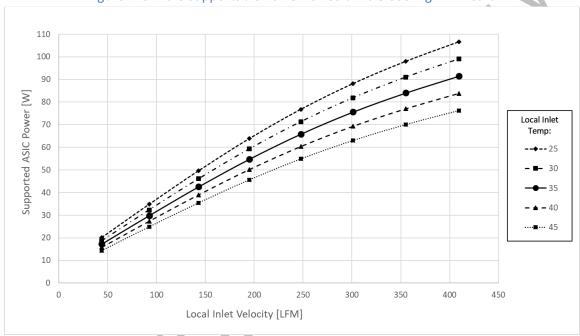


Figure 129: ASIC Supportable Power for Cold Aisle Cooling – LFF Card

Similar to Figure 127 for LFF Hot Aisle cooling, Figure 130 below shows the LFF ASIC supportable power curves with an overlay of three Cold Aisle server airflow capability ranges. Designers must ensure that their thermal solutions and resulting card airflow requirements fall within the range of supportable Cold Aisle system airflow velocity. Cards that are under-designed (e.g., require airflow greater than the system capability) will have thermal issues when deployed into the server system. Similar to the Hot Aisle cases, cooling of the optical transceivers need to be taken into consideration even though they are not preheated by the ASIC in the Cold Aisle case. OCP NIC 3.0 designers must consider all power modes in the design process – including SO (Main Power Mode) and S5 (Aux Power Mode). For both modes, the card designer must provide the airflow requirements in the OEM FRU record as described in Section 4.10.3. Card designers are advised to work closely with system vendors to ensure they target the appropriate airflow and temperature boundary conditions for both Hot and Cold Aisle cooling.

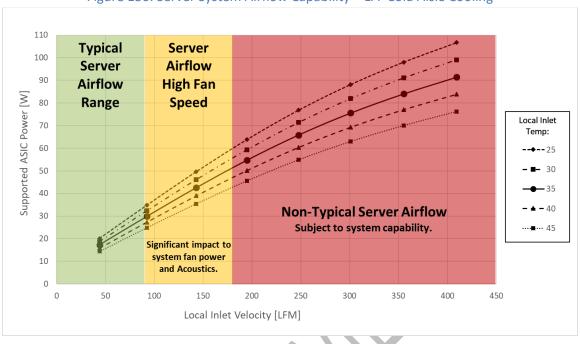


Figure 130: Server System Airflow Capability - LFF Cold Aisle Cooling

A comparison of Hot Aisle (55°C) and Cold Aisle (35°C) LFF ASIC cooling capability curves is shown below in Figure 131. The comparison shows the Hot Aisle ASIC cooling capability at 19 W at 150 LFM while the cold Aisle cooling capability shows support for 42 W at 150 LFM. In general, based on the reference geometry, the Cold Aisle cooling configuration allows for higher supported ASIC power at lower velocities due primarily to the lower inlet temperatures local to the OCP NIC 3.0 card when in the Cold Aisle cooling configuration.

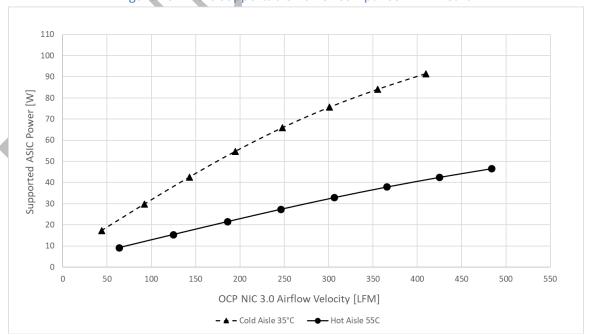


Figure 131: ASIC Supportable Power Comparison – LFF Card

## 6.3 Thermal Simulation (CFD) Modeling

CFD models of the SFF and LFF cards developed for the analysis detailed in Section 6.2 are available for download on the OCP NIC 3.0 Wiki: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>

The thermal models available on the wiki site are in Icepak format. CAD step file exports from those models are also available to aid in re-creation of the models in other CFD software tools. Note that the geometry utilized in the CFD models is based on the OCP NIC 3.0 thermal test fixture detailed in Section 6.4.

Thermal simulation of OCP NIC 3.0 cards using the provided CFD models is recommended. Ideally, vendors developing OCP NIC 3.0 cards would perform CFD analysis to validate card thermal solutions using the provided CFD models prior to building card prototypes. Once prototypes are available, vendors would then perform thermal testing on the functional cards using the thermal test fixtures detailed in Section 6.4.

#### **6.4** Thermal Test Fixture

Thermal test fixtures have been developed for SFF and LFF OCP NIC 3.0 cards. The test fixtures are intended to provide a common thermal test platform for card vendors, server vendors, and other industry groups planning to develop or utilize the OCP NIC 3.0 card form factors. Details of the thermal test fixtures are as follows:

- Sheet metal side walls, base, faceplate, and top cover
- Thumbscrew top cover access
- PCB sandwiched between base and side walls
- Intended for attachment to wind tunnel or flow bench such as those available at: http://www.fantester.com/
- Allows for thermal testing of functional OCP NIC 3.0 cards in a metered airflow environment
- Input power from external power supplies allows for OCP NIC 3.0 card power measurement
- SFF fixture power connections for 3.3 V, GND, GND, 12 V
- LFF fixture power connections for 3.3 V, GND, GND, GND, 12 V, 12 V
- RJ45 connector for NC-SI pass-through
- USB Type-C connector for microprocessor connectivity and Micro-B to the USB pins on the primary connector
- Functions as a remote PCIe extension with intent to position host server under the fixture for connection to system PCIe slot
- Single x16 connection to server host on bottom side of the fixture PCB (SFF)
- Dual x16 connection to server host on bottom side of the fixture PCB (LFF)
- Predefined locations for fixture airflow/temperature sensors on fixture PCB silkscreen. Quantity
   3x per SFF board and quantity 4x for LFF see Figure 137

- Candlestick style sensors are available at:
   <a href="https://www.qats.com/Products/Instruments/Temperature-and-Velocity-Measurement/Sensors/Candlestick-Sensor">https://www.qats.com/Products/Instruments/Temperature-and-Velocity-Measurement/Sensors/Candlestick-Sensor</a>
- Candlestick sensors must be procured separately, not integrated with fixture PCB
- Low profile PCIe card serves as blockage above OCP NIC 3.0 card to mimic system geometry and prevent airflow bypass
- LFF fixture uses a sheet metal obstruction built into the top cover

CAD Files for the current revision of the test fixture are available for download on the OCP NIC 3.0 Wiki: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>.

#### 6.4.1 Test Fixture for SFF Card

Images of the SFF thermal test fixture are shown in Figure 132 and Figure 133. The SFF fixture PCB is shown in Figure 134. Note the three candlestick sensor locations directly next to the OCP NIC 3.0 connectors.

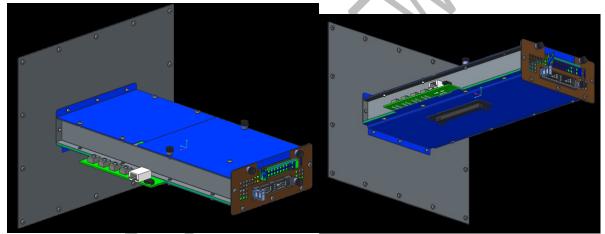


Figure 132: SFF Thermal Test Fixture Preliminary Design

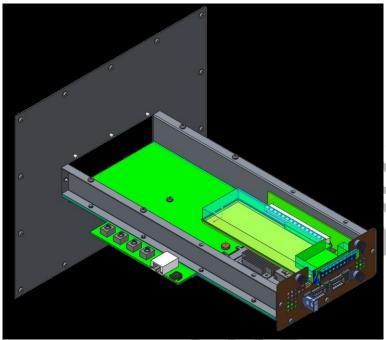
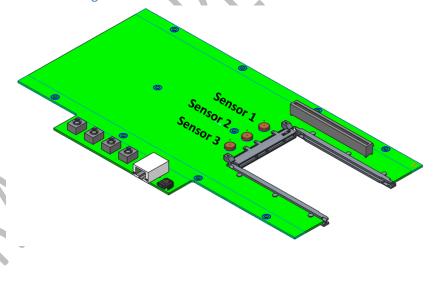


Figure 133: SFF Thermal Test Fixture Preliminary Design – Cover Removed





#### **6.4.2** Test Fixture for LFF Card

Images of the LFF thermal test fixture are shown in Figure 135 and Figure 136. The LFF fixture PCB is shown in Figure 137. Note the three candlestick sensor locations directly next to the OCP NIC 3.0 connectors.

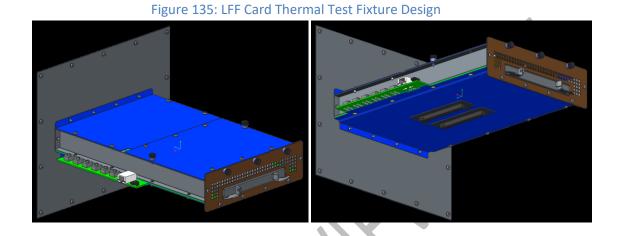
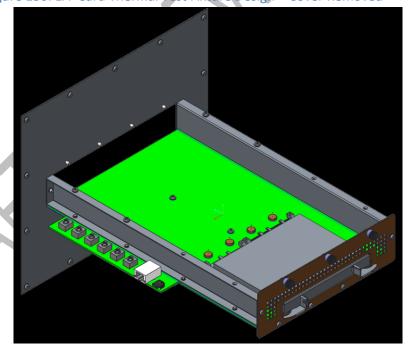


Figure 136: LFF Card Thermal Test Fixture Design – Cover Removed



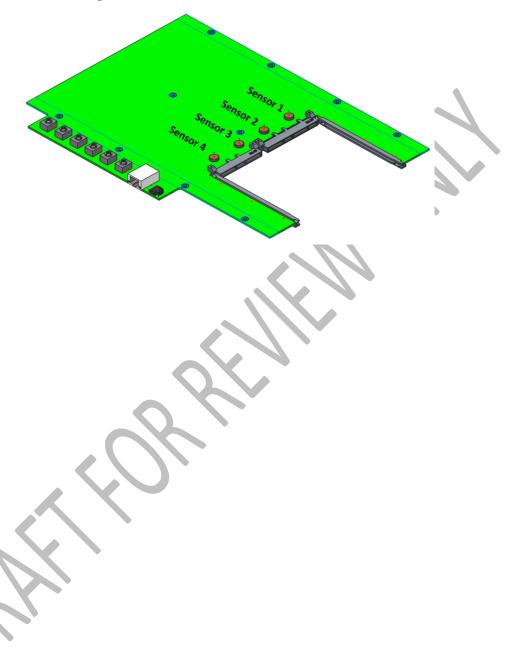


Figure 137: LFF Card Thermal Test Fixture PCB

#### 6.4.3 Test Fixture Airflow Direction

When utilizing the OCP NIC 3.0 thermal test fixture, the wind tunnel or flow bench must be configured to push airflow for Hot Aisle cooling or to pull airflow for Cold Aisle cooling as shown in Figure 138.

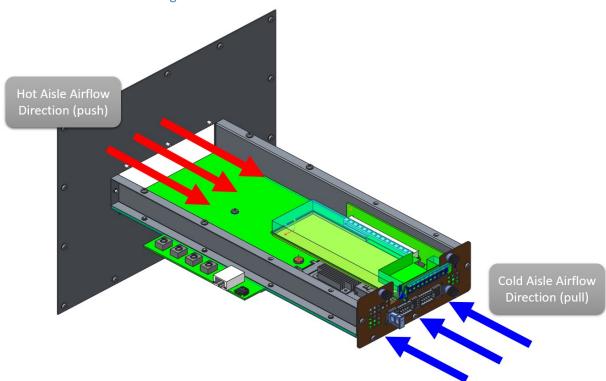


Figure 138: Thermal Test Fixture Airflow Direction

#### 6.4.4 Thermal Test Fixture Candlestick Sensors

As noted previously, candlestick sensor locations are included on the fixture PCB silkscreen. These candlestick sensors provide point measurements for both airflow velocity (LFM) and air temperature. The airflow at the inlet to the OCP NIC 3.0 will differ from the fixture mean velocity due to the obstructions above the OCP NIC 3.0 cards within the fixture. Thus, the fixture flow rate and cross-sectional area should not be used to determine the local velocity at the OCP NIC 3.0 card. Instead, the candlestick velocity/temperature sensors should be utilized to directly measure the local inlet velocity to the cards for hot aisle cooling.

Figure 139 and Figure 140 below show the air velocity at each sensor location vs. the total fixture flow rate in CFM. The curves shown in these figures are based on the data collected from the CFD models discussed in Section 6.3. Note the error between the velocities obtained from the sensor locations vs. the velocity based on the duct cross-sectional area.

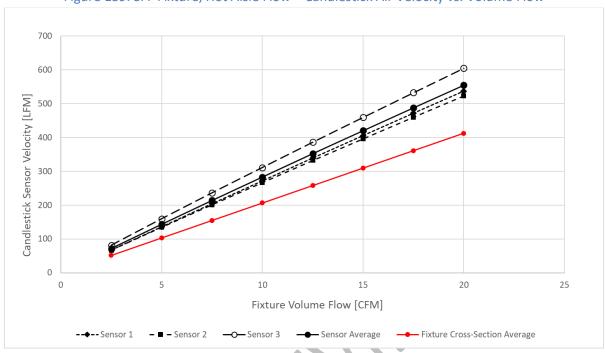
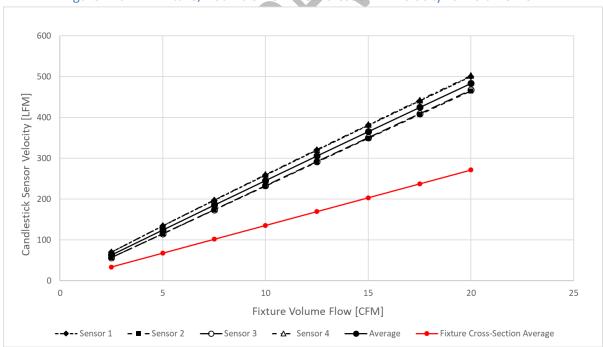


Figure 139: SFF Fixture, Hot Aisle Flow – Candlestick Air Velocity vs. Volume Flow





#### **6.5 Card Sensor Requirements**

See Sections 4.4 to 4.6 for information relating to temperature sensor and reporting requirements.

#### **6.6 Card Cooling Tiers**

Section 4.10.3 defines a number of FRU fields that may be read by the baseboard management controller (BMC). Two of these fields provide the Hot Aisle and Cold Aisle Card Cooling Tiers that may be used for open loop fan speed control. The Card Cooling Tiers relate the card local inlet temperature to the required local inlet velocity in linear feet per minute (LFM) which allows the system to set fan speeds according to the cooling requirements of the card.

The Card Cooling Tier FRU fields are particularly useful for systems that do not implement temperature sensor monitoring (open loop fan control). The FRU fields may also be used as a backup for systems that implement fan control based on temperature sensor monitoring (closed loop control).

Card Cooling Tiers for Hot and Cold Aisle Cooling configurations are defined in Table 64. The values in the table are listed with units shown in LFM. Future releases of this specification will provide more detail to the Card Cooling Tier curve definition.

|                                                | Та     | Target Operating Region  Server Airflo  High Fan Spe |        |        |        | Non-Typical Server Airflow - Subject to System Capabilit |        |        |        | pability |         |         |
|------------------------------------------------|--------|------------------------------------------------------|--------|--------|--------|----------------------------------------------------------|--------|--------|--------|----------|---------|---------|
| OCP NIC 3.0 Local<br>Inlet Temperature<br>[°C] | Tier 1 | Tier 2                                               | Tier 3 | Tier 4 | Tier 5 | Tier 6                                                   | Tier 7 | Tier 8 | Tier 9 | Tier 10  | Tier 11 | Tier 12 |
| 5                                              | 0      | 100                                                  | 100    | 100    | 100    | 100                                                      | 110    | 150    | 200    | 255      | 320     | 395     |
| 10                                             | 0      | 100                                                  | 100    | 100    | 100    | 100                                                      | 118    | 159    | 211    | 271      | 341     | 426     |
| 15                                             | 0      | 100                                                  | 100    | 100    | 100    | 105                                                      | 128    | 170    | 226    | 291      | 366     | 461     |
| 20                                             | 0      | 100                                                  | 100    | 100    | 100    | 109                                                      | 137    | 181    | 241    | 311      | 391     | 496     |
| 25                                             | 0      | 100                                                  | 100    | 100    | 100    | 114                                                      | 147    | 198    | 260    | 337      | 420     | 532     |
| 30                                             | 0      | 100                                                  | 100    | 100    | 110    | 130                                                      | 167    | 215    | 283    | 363      | 453     | 578     |
| 35                                             | 0      | 100                                                  | 100    | 100    | 120    | 146                                                      | 186    | 236    | 308    | 393      | 488     | 623     |
| 40                                             | 0      | 100                                                  | 100    | 111    | 139    | 172                                                      | 212    | 260    | 335    | 430      | 525     | 673     |
| 45                                             | 0      | 100                                                  | 100    | 125    | 161    | 200                                                      | 242    | 290    | 370    | 472      | 575     | 736     |
| 50                                             | 0      | 100                                                  | 110    | 155    | 198    | 243                                                      | 288    | 335    | 425    | 530      | 645     | 838     |
| 55                                             | 0      | 100                                                  | 150    | 200    | 250    | 300                                                      | 350    | 400    | 500    | 625      | 750     | 1000    |
| 60                                             | 0      | 150                                                  | 200    | 255    | 315    | 380                                                      | 450    | 525    | 643    | 796      | 936     | 1241    |
| 65                                             | 0      | 200                                                  | 260    | 330    | 410    | 500                                                      | 600    | 710    | 850    | 1025     | 1200    | 1550    |

Table 64: Card Cooling Tier Definitions (LFM)

A graphical view of the Card Cooling Tiers is shown in Figure 141. The Tiers range from 0 LFM to as high as 1000 LFM at 55°C local inlet temperature. It is important to understand that the cooling tiers extend well beyond the airflow range of most server systems. As noted in Section 6.2, card designers must consider the airflow capability of the systems that the cards are to be used in when designing the card thermal solution and component placement. Figure 142 and Figure 143 below show the range of typical system capability for Hot Aisle and Cold Aisle configurations. Cards designed to these typical ranges (Tiers 1-6) will be low risk to support in most if not all server systems. Alternatively, cards that require Tier 7 or greater may still work in many server systems but may require extra validation testing, specific system slot location requirements, and potentially ambient temperature and hardware restrictions.

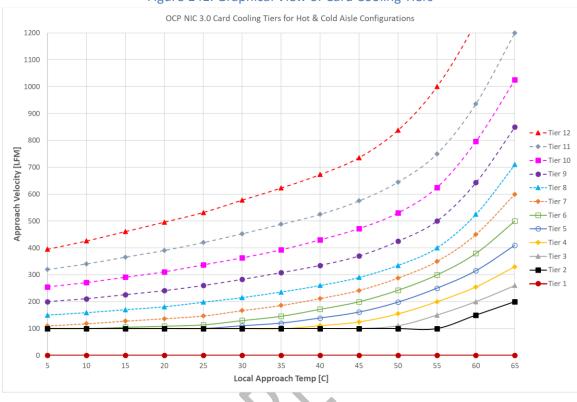
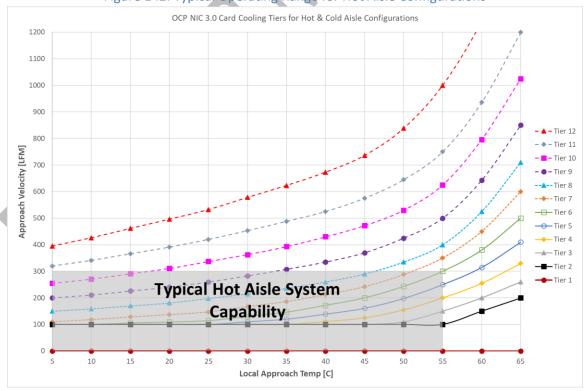


Figure 141: Graphical View of Card Cooling Tiers





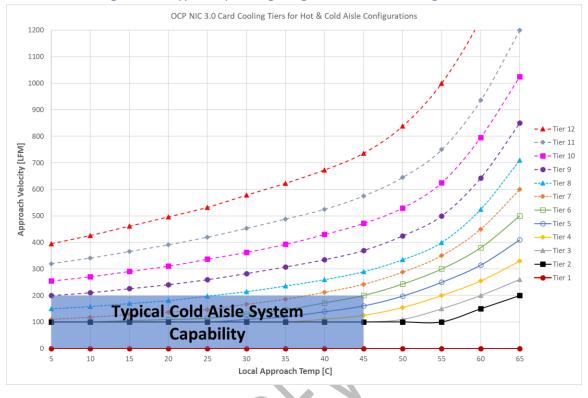


Figure 143: Typical Operating Range for Cold Aisle Configurations

## 6.7 Non-Operational Shock & Vibration Testing

OCP NIC 3.0 components are deployed in various environments. As such, all OCP NIC 3.0 cards shall be subjected to shock and vibration testing to ensure products do not sustain damage during normal operational or transportation conditions. While end customer deployments may require an additional final system level test, this section sets the minimum shock and vibration requirements for an OCP NIC 3.0 card that must also be considered.

Shock and vibration testing shall be done in accordance with the procedures listed below. The tests shall be conducted using a vertical shock table. The OCP NIC 3.0 card shall be secured in the standard test fixture as described in Section 6.7.1.

## 6.7.1 Shock & Vibe Test Fixture

The OCP NIC 3.0 shock and vibe fixture supports simultaneous testing of up to four SFF, or four LFF cards. The SFF fixture accepts card configurations that utilize the pull tab, ejector lever and internal lock mechanisms. The LFF fixture only accepts the single latch faceplate.

The fixture is comprised of a universal baseplate that allows for attaching SFF or LFF rail guides and simulated chassis faceplates. The baseplate includes an industry standard vibration table hole pattern for securing the UUT for test. Figure 144 and Figure 145 show the SFF and LFF fixtures, respectively.

CAD files for the current revision of the text fixture are available for download from the OCP NIC 3.0 wiki: <a href="http://www.opencompute.org/wiki/Server/Mezz">http://www.opencompute.org/wiki/Server/Mezz</a>.

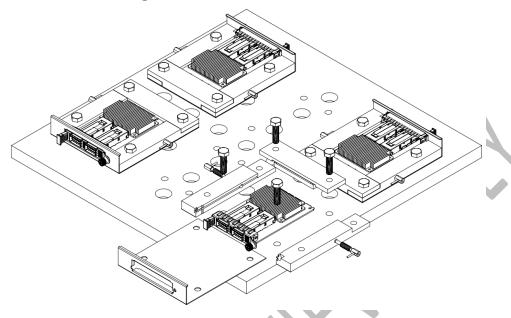
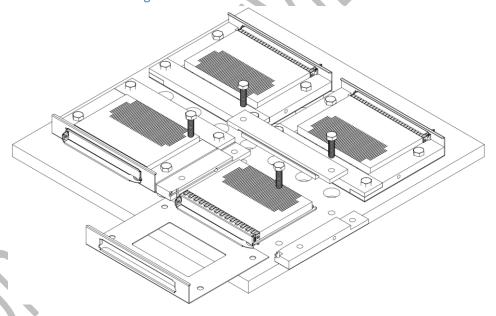


Figure 144: SFF Shock and Vibe Fixture

Figure 145: LFF Shock and Vibe Fixture



#### **6.7.2** Test Procedure

The following procedures shall be followed for the shock and vibration testing:

- A minimum sample size of three OCP NIC 3.0 cards shall be subjected to shock and vibration.
   Each sample shall be subjected to testing in the order listed below.
- All samples shall be verified for functionality prior to test.

- The OCP NIC 3.0 card shall be fixtured to simulate how the card will be mounted within a system. For example, the OCP NIC 3.0 card may be fixtured in the horizontal plane with the primary component side facing up for certain chassis configurations.
- The fixture shall be tested on all 6 sides. Each side shall be clearly labeled as 1-6 for test identification purposes. Testing shall be performed in the vertical axis only. The fixture shall be rotated until all six sides have been tested as the product may be dropped from any orientation during handling. Testing shall not be conducted on a three axis slip table.
- Non-operational vibration testing is performed at 1.88 G<sub>RMS</sub> for a duration of 15 minutes per side per Table 65.

| e ob. Nandom vibratio | on resume 1.00 GRMS FI |
|-----------------------|------------------------|
| Frequency (Hz)        | G²/Hz                  |
| 10                    | 0.13                   |
| 20                    | 0.13                   |
| 70                    | 0.004                  |
| 130                   | 0.004                  |
| 165                   | 0.0018                 |
| 500                   | 0.0018                 |

Table 65: Random Vibration Testing 1.88 G<sub>RMS</sub> Profile

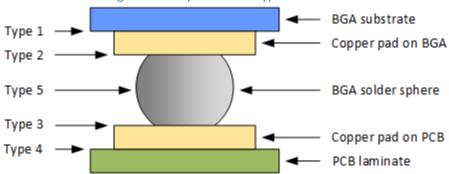
- Non-operational half-sine shock test at 71 G  $\pm$ 10% with a 2 ms duration per surface.
- Non-operational trapezoidal wave shock test at 50 G ±10% at a rate of 170 inches/sec per surface.
- All cards shall be checked for proper operation after the shock and vibration tests have been conducted. All three samples must be in full operating order to consider the product as a pass.

## 6.8 Dye and Pull Test Method

All Dye and Pull test methods shall be implemented per the IPC-TM-650 method 2.4.53 (Dye and Pull Test Method – formerly known as Dye and Pry). The Dye and Pull test uses a colored dye penetrant to visually indicate cracked solder joints on BGA devices. The test shall only be conducted after the Shock and Vibration testing has been conducted on the test samples. The Dye and Pull Test Method is a destructive test.

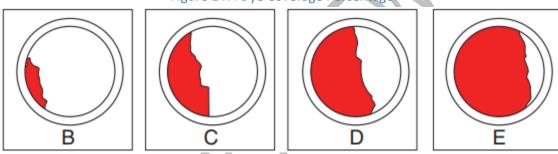
- A minimum sample size of three OCP NIC 3.0 cards shall be subjected to the Dye and Pull Test Method.
- All samples shall be first subjected to the Shock and Vibration testing outlined in Section 6.7.
- All samples shall be subjected to the preparation and test procedures of IPC-TM-650 method 2.4.53.
- Following the pull-test operation, the board sample shall be examined for dye indication at the target BGA area. Separation locations are categorized in to the following five areas:
  - Type 1 Separation between the BGA copper pad and the BGA substrate.
  - Type 2 Separation between the BGA copper pad and the BGA solder sphere.
  - Type 3 Separation between the BGA solder sphere and the copper pad on the PCB.
  - Type 4 Separation between the copper pad on the PCB and the PCB laminate.
  - Type 5 Separation of the BGA solder sphere.

Figure 146: Dye and Pull Type Locations



- Samples shall be subjected to the following failure criteria:
  - Dye coverage of >50% ("D" and "E" in Figure 147) of any Type 2 or Type 3 BGA cracks are present in the test sample.
  - One or more Type 1 or Type 4 BGA cracks are present in the test sample.

Figure 147: Dye Coverage Percentage



The following exceptions are allowed:

- For "via-in-pad" designs, dye is allowed on the laminate surface (under the pad), as long as the dye has not entered the inner-via laminate area, or is found on the separated via-barrel wall.
- Allowances for dye indications on mechanical (non-electrical) BGA corner locations or multiple use locations (grounds, powers) may be determined by the appropriate Engineering Team.

## **6.9 Gold Finger Plating Requirements**

This section defines the minimum plating/quality requirements for the OCP NIC 3.0 gold fingers.

#### **6.9.1** Host Side Gold Finger Plating Requirements

Per Section 6.4 (Environmental Requirements) of the PCIe CEM specification, the minimum host side gold finger plating is 30 microinches of gold over 50 microinches of nickel. OCP NIC 3.0 card vendors shall individually evaluate the minimum plating required.

The recommendation for OCP NIC 3.0 is to 30 microinches of gold over 150 microinches of nickel.

## **6.9.2** Line Side Gold Finger Durability Requirements

The line side connectors must be designed to support a minimum of 250 error free insertion cycles. In order to accomplish this, it is required that the minimum contact plating be as follows:

- SFP and QSFP connectors: 30 microinches of gold over 50 microinches of nickel
- RJ45 connectors have a minimum of 50 microinches of gold over 50 microinches of nickel

# 7 Regulatory

## 7.1 Required Compliance

An OCP NIC 3.0 card shall meet the following Environmental, EMC and safety requirements.

Note: Emissions and immunity tests in Section 7.1.4 are to be completed at the system level. The OCP NIC 3.0 vendors should work with the system vendors to achieve the applicable requirements listed in this section.

#### 7.1.1 Required Environmental Compliance

- China RoHS Directive
- **EU RoHS 2 Directive (2011/65/EU)** aims to reduce the environmental impact of electronic and electrical equipment (EEE) by restricting the use of certain hazardous materials. The substances banned under RoHS are lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls, polybrominated diphenyl ether, and four phthalates.
- **EU REACH Regulation (EC) No 1907/2006** addresses the production and use of chemical substances and their potential impact on human health and the environment.
- **EU Waste Electrical and Electronic Equipment ("WEEE")** Directive (2012/19/EU) mandates the treatment, recovery and recycling of EEE.
- The Persistent Organic Pollutants Regulation (EC) No. 850/2004 bans production, placing on the market and use of certain persistent organic pollutants.
- The California Safe Drinking Water and Toxic Enforcement Act of 1986 ("Proposition 65") sets forth a list of regulated chemicals that require warnings in the State of California.
- The Packaging and Packaging Waste Directive 94/62/EC limits certain hazardous substances in the packaging materials
- Batteries Directive 2006/66/EC regulates the manufacture and disposal of all batteries and accumulators, including those included in appliances.

## 7.1.2 Required EMC Compliance

Radiated and Conducted Emissions requirements are based on deployed geographical locations.
 Refer to Table 66 for details.

Table 66: FCC Class A Radiated and Conducted Emissions Requirements Based on Geographical Location

| Targeted Geography | Applicable Specifications                                                                                                                                                                                                                                            |
|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| USA                | FCC, 47 CFR Part 15, Class A digital device (USA)                                                                                                                                                                                                                    |
| Canada             | ICES-003, class A (CAN)                                                                                                                                                                                                                                              |
| EU                 | EN 55032: 2015+AC:2016 Class A Radiated and Conducted Emissions requirements for European Union EN 55035: 2017 Immunity requirements for the European Union (EU) EN 55024: 2010+A1:2015 Immunity requirements for European Union (EU) may alternatively be reported. |

|                       | Note: EN55024 is scheduled to be superseded by EN55035. OCP NIC 3.0 implementors are encouraged to test to EN55035 to avoid recertifying their product when EN55024 is withdrawn. |
|-----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Australia/New Zealand | AS/NZS CISPR 32:2015 Class A                                                                                                                                                      |
|                       | CISPR 32:2015 for Radiated and Conducted Emissions requirements                                                                                                                   |
| Japan                 | VCCI 32-1 Class A Radiated and Conducted Emissions requirements                                                                                                                   |
| Korea                 | KN32 – Radiated and Conducted Emissions                                                                                                                                           |
|                       | KN35- Immunity                                                                                                                                                                    |
| Taiwan                | BSMI CNS13438: 2006 (complete) Class A Radiated and Conducted Emissions requirements                                                                                              |

- **CE** Equipment must pass the CE specification
- All technical requirements covered under EMC Directive (2014/30/EU)

## 7.1.3 Required Product Safety Compliance

• Safety – requirements are listed in Table 67.

Table 67: Safety Requirements

| Targeted Category | Applicable Specifications                                                                                                  |
|-------------------|----------------------------------------------------------------------------------------------------------------------------|
| Safety            | UL 60950-1/CSA C22.2 No. 60950-1-07, 2 <sup>nd</sup> Edition + Amendment 1 + Amendment 2, dated 2011/12/19.                |
|                   | The Bi-National Standard for Safety of Information Technology Equipment, EN60950-1: 2006+A11:2009+A1:2010+A12:2010+A2:2013 |
|                   | IEC 60950-1 (Ed 2) + A1 + A2.                                                                                              |
|                   | IEC 62368-1 may also be co-reported depending on region                                                                    |

# 7.1.4 Required Immunity (ESD) Compliance

The OCP NIC 3.0 card shall meet or exceed the following ESD immunity requirements listed in Table 68.

Table 68: Immunity (ESD) Requirements

| Targeted Category       | Applicable Specifications                                                                                                                                                         |
|-------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Immunity (ESD)          | EN 55035 2017, and IEC 61000-4-2 2008 for ESD.                                                                                                                                    |
|                         | EN 55024 may alternatively be reported.<br>Required ±4 kV contact charge and ±8 kV air discharge.                                                                                 |
| Uki                     | Note: EN55024 is scheduled to be superseded by EN55035. OCP NIC 3.0 implementors are encouraged to test to EN55035 to avoid recertifying their product when EN55024 is withdrawn. |
| NEBS Level 3 (optional) | Optionally test devices to NEBS Level 3 –                                                                                                                                         |
|                         | Required ±8 kV contact charge and ±15 kV air discharge with interruptions not greater than 2 seconds. The device shall self-recover without operator intervention.                |
|                         | Note: NEBS compliance is part of the system level testing. The OCP NIC 3.0 specification is providing a baseline minimum recommendation for ESD immunity.                         |

## 7.2 Recommended Compliance

All OCP NIC 3.0 cards are required to meet the requirements specified in Section 7.1. Card vendors should also consider meeting the requirements below.

## 7.2.1 Recommended Environmental Compliance

- Halogen Free: IEC 61249-2-21 Definition of halogen free: 900ppm for Bromine or Chlorine, or 1500ppm combined total halogens.
- Arsenic: 1000 ppm (or 0.1% by weight)
- Emerging: US Conflict Minerals law: section 1502 of the Dodd-Frank Act requires companies using tin, tantalum, tungsten, and gold ("3TG") in their products to verify and disclose the mineral source. While this does not apply to products that are used to provide services, such as Infrastructure hardware products, the OCP NIC Subgroup is considering voluntarily reporting of this information.

#### 7.2.2 Recommended EMC Compliance

• FCC, 47 CFR Part 15, Subpart B Class A digital device (USA) with 10dB margin. Refer to the baseline requirements shown in Section 7.1.2 for details.



# 8 Revision History

# **8.1** Document Revision History

| Author               | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | Revision | Date       |
|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|------------|
| OCP NIC 3.0 Subgroup | Initial public review.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | 0.70     | 01/25/2018 |
| OCP NIC 3.0 Subgroup | <ul> <li>Implemented comments from 0.70 review.</li> <li>LED implementation updated.</li> <li>Gold finger lengths updated. All pins are full length except for PCIe TX/RX, REFCLKS and PRSNT pins.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 | 0.71     | 02/06/2018 |
| OCP NIC 3.0 Subgroup | - Updates to Section 4.x per the working group session.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | 0.72     | 02/21/2018 |
| OCP NIC 3.0 Subgroup | <ul> <li>Change NC-SI over RBT RXD/TXD pins to a pull-up instead of a pull down.</li> <li>Update power sequencing diagram. REFCLK is disabled before silicon transitions to AUX Power Mode.</li> <li>Merge pinout sections 3.4 and 3.5 together for structural clarity.</li> <li>Add text to gate WAKE# signal on AUX_PWR_GOOD (internal) assertion; updated diagrams with WAKE# signals to reflect implementation.</li> <li>Add initial signal integrity outline to document (WIP)</li> <li>Add Initial draft of the Shock and Vibration, and Dye and Pull test requirements.</li> <li>Rearrange Section 2 for structure; changed section name to Mechanical Card Form Factor</li> <li>Move non-NIC use cases to Section 1.5.</li> <li>Moved Port numbering and LED definitions to Section 3.8.</li> <li>Add secondary side LED placement for 4x SFP and 2x QSFP implementations in Section 3.8.</li> <li>Revised labeling section (Section 2.9).</li> <li>Optimize the scan chain LED bit stream for dual port applications.</li> <li>Add SLOT_ID[1]. Updated text and diagrams for mapping SLOT_ID[1:0] to Package ID[2:0] and FRU EEPROM A[2:0] fields.</li> <li>Reduce ID Mode power consumption on +12V_EDGE</li> </ul> | 0.73     | 05/01/2018 |
| OCP NIC 3.0 Subgroup | <ul> <li>Text clean up. All minor / generally agreed upon items within the OCP NIC 3.0 Workgroup have been accepted.</li> <li>Clarify PCle bifurcation is on a per-slot basis. Add 1x32 and 2x16 implementation examples for a Large Form Factor card.</li> <li>Removed reference to a x24 PCle width LFF card from Table 5 – OCP NIC 3.0 Card Definitions.</li> <li>Move SLOT_ID[1] to OCP_A6 for immediate power on indication of the card physical location for RBT and FRU EEPROM addressing. Updated RBT addressing and Scan Chain definition to match.</li> <li>Updated diagrams and text in Section 6.x based on feedback from the OCP NIC 3.0 Thermal Workgroup.</li> <li>Updated diagrams and text in Section 2.0 based on feedback received from the OCP NIC 3.0 Mechanical Workgroup.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                   | 0.74     | 06/04/2018 |
| OCP NIC 3.0 Subgroup | 0v80 public release                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           | 0.80     | 06/04/2018 |
| OCP NIC 3.0 Subgroup | Ov81 public release. Changes are as follows:  - Section 1.3 – Update Figure 1 with latest thumbscrew design Section 2.4.2 – Mechanical corrections to BOM items 5, 6A/B, 8 & 11 Section 3.4.3 – Add statement to isolate SMRST# if target device voltage is not powered from +3.3V_EDGE.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | 0.81     | 07/06/2018 |

|                      | - Section 3.4.4 – Clarified the RBT_ARB_IN and RBT_ARB_OUT pin                                                                         |      |            |
|----------------------|----------------------------------------------------------------------------------------------------------------------------------------|------|------------|
|                      | descriptions.                                                                                                                          |      |            |
|                      | - Section 3.4.4 – Clarified SLOT_ID[1:0] description and example                                                                       |      |            |
|                      | diagrams; move SLOT_ID[1:0] isolation to NIC and use direct                                                                            |      |            |
|                      | connection to FRU EEPROM.                                                                                                              |      |            |
|                      | - Section 3.4.5 – DATA_IN bit PRSNTB[3:0] definition to optionally use                                                                 |      |            |
|                      | pull up/down to match PRSNTB[3:0]# card edge connections.                                                                              |      |            |
|                      | - Section 3.4.7 – Add USB 2.0 definition to the Primary Connector.                                                                     |      |            |
|                      | - Section 3.4.8 – Add UART definition to the Secondary Connector.                                                                      |      |            |
|                      | - Section 3.4.9 – Changed Miscellaneous pins to RFU[1:2] pins.                                                                         |      |            |
|                      | - Section 3.8 – Clarified LED placement.                                                                                               |      |            |
|                      | - Section 3.9.x – Clarified ID-Aux and Aux-Main Power Mode transition                                                                  |      |            |
|                      | requirements to prevent sampling health status pins until cards have                                                                   |      |            |
|                      | fully entered into Aux and Main modes to prevent false indication.                                                                     |      |            |
|                      | - Section 3.11 – Updated hot swap consideration text to highlight                                                                      |      |            |
|                      | available hot swap mechanisms. Actual hot swap design is outside the                                                                   |      |            |
|                      | scope of this specification.                                                                                                           |      |            |
|                      | - Section 4 – Update MCTP Type management description.                                                                                 |      |            |
|                      | - Section 4.9 – Clarified the FRU EEPROM is directly connected to the                                                                  |      |            |
| OCD NIC 2 O Cubaraua | card edge. No isolation is used for the FRU EEPROM.                                                                                    | 0.02 | 09/02/2019 |
| OCP NIC 3.0 Subgroup | <ul><li>- Minor editorial changes.</li><li>- Changed names to "SFF" and "LFF" when referencing the two board</li></ul>                 | 0.82 | 08/03/2018 |
|                      | form factors for uniformity.                                                                                                           |      |            |
|                      | - Section 3.4.1 – Changed PERST[3:0]# to be asserted low until the                                                                     |      |            |
|                      | platform is ready to bring cards out of reset.                                                                                         |      |            |
|                      | - Section 3.5.3 – Corrected typos in the PCle Bifurcation Decoder                                                                      |      |            |
|                      | (Table 31) for hosts that implement 4 x2 links on the first 8 lanes when                                                               |      |            |
|                      | using a 4 x4 OCP NIC 3.0 card.                                                                                                         |      |            |
|                      | - Section 3.5.5.3 & 3.5.5.4 – Corrected the BIF[2:0] values in the                                                                     |      |            |
|                      | diagrams.                                                                                                                              |      |            |
|                      | - Section 3.7 – Corrected typos in the PCIe Bifurcation result and                                                                     |      |            |
|                      | REFCLK mapping (Table 38 and Table 41) for single host/quad host                                                                       |      |            |
|                      | cases with PCIe on the first 8 lanes. This change was due to                                                                           |      |            |
|                      | propagating corrections from Table 31 from Section 3.5.3.                                                                              |      |            |
|                      | - Section 3.8.3 – Changed faceplate LED placement for 2xQSFP to                                                                        |      |            |
|                      | primary side.                                                                                                                          |      |            |
|                      | - Section 4.10.2 – Added FRU field to identify the card manageability                                                                  |      |            |
|                      | type.                                                                                                                                  |      |            |
|                      |                                                                                                                                        |      |            |
| OCP NIC 3.0 Subgroup | - Section 5.3.4 – Removed subheadings for the PCIe test methodology.                                                                   | 0.83 | 08/29/2018 |
|                      | Replaced with reference text to the PCIe test specifications.                                                                          |      |            |
| OCP NIC 3.0 Subgroup | - Editorial changes.                                                                                                                   | 0.84 | 11/13/2018 |
|                      | - Add appropriate trademarks per entity usage guidelines                                                                               |      |            |
|                      | - Section 1.x – Reorganized section, added list of acronyms.                                                                           |      |            |
|                      | - Section 1.5, 2.x – Mechanical updates from ME team. Updates to                                                                       |      |            |
|                      | Vendor PN, pull tab/thumbscrew color.                                                                                                  |      |            |
|                      | - Section 3.1.x – Add card edge gold finger Detail D and profile                                                                       |      |            |
|                      | dimensions.                                                                                                                            |      |            |
|                      | - Section 3.1.1 – Change gold finger lengths to align with SFF-TA-1002                                                                 |      |            |
|                      | and SFF-TA-1009. All ground pins mate first; power, single ended and differential pairs mate second.                                   |      |            |
|                      | ·                                                                                                                                      |      |            |
|                      | - Section 3.4.1, Section 3.5.x – Updated for LFF and applications with 32 lanes of PCIe. Included TX/RX lane indices for lanes[16:31], |      |            |
|                      | REFCLK[4:5], PERST[4:5]# and PWRBRK1 on the Secondary Connector.                                                                       |      |            |
|                      | - Section 3.4.2 – Clarified BIF[0:2]# assertion timing.                                                                                |      |            |
|                      | - Section 3.4.4 – Clarified BBT isolation state with respect to                                                                        |      |            |
|                      | AUX_PWR_EN and NIC_PWR_GOOD assertion.                                                                                                 |      |            |
|                      |                                                                                                                                        |      |            |

- Section 3.4.5 Clarified that the scan chain shift registers may also be implemented with a CPLD as long as the logic is equivalent. Clarified the FAN ON AUX bit.
- Section 3.4.9 Changed RFU[1:2] to RFU[3:4] for the Secondary Connector.
- Section 3.7 Removed bifurcation expansion tables. Redirected readers to the pinout/bifurcation spreadsheet on the OCP Mezz Wiki site instead.
- Section 3.6 and Section 3.7 Merged together as they both discuss PCIE REFCLK mapping. Add new diagrams depicting single, dual and quad host implementations with 1, 2, and 4 links. Diagrams show association of the link to the REFCLK and PERST signals. Update bifurcation table color codes to differentiate SFF (2C+ / 4C+) implementations from LFF implementations.
- Section 3.11 Add RBT\_ISOLATE# to the power up/down sequencing diagrams. Changed BIF[2:0]# pins to 'low' state when AUX\_PWR\_EN is deasserted. Add timing value "T4" from DSP0222 to power up diagram and sequencing parameters table. Add TCYCLE\_SFF / TCYCLE\_LFF parameters to power down sequencing to prevent a pre-biased output condition when power cycling cards.
- Section 4.4 Clarified requirements for self-shutdown if the optional feature is implemented on the card.
- Section 4.9 Cleaned up SMBus 2.0 Address Map text. Add text to discourage the use of unsolicited SMBus messages including the optional 'Notify ARP Master' command.
- Section 4.10.2 Clarified FRU data format requirements per the IPMI Platform Management FRU Information Storage Definition. List minimum FRU content requirements.
- Section 5.1.x Clarified NC-SI over RBT physical routing and length matching requirements.
- Section 7.1.4 Corrected typo on NEBS air discharge value for ESD testing. Changed from 16 kV to 15 kV.

|                      | testing, changes not 15 kg to 15 kg.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |       |            |
|----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------------|
| OCP NIC 3.0 Subgroup | November release with all 0.84 subgroup changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     | 0.85  | 11/20/2018 |
| OCP NIC 3.0 Subgroup | <ul> <li>December Hot fix release. Minor text corrections and clarifications.</li> <li>Section 2.4.2 – Update faceplate and ejector handle drawing filenames</li> <li>Sections 2.4.3, 2.4.4, and 2.7.x – Mechanical drawing updates. Fixed typos and updated critical dimension text.</li> <li>Section 2.8.x – Mechanical drawing updates. Changed bottom of PCB datum from H to J.</li> <li>Section 3.4.5 – Clarified the default scan chain pin states for TEMP_WARN_N, TEMP_CRIT_N and FAN_ON_AUX when temperature reporting is not required.</li> <li>Section 3.4.7 – Clarified USB text on differential signaling voltage, termination voltage and V<sub>BUS</sub> detection indication. Updated USB figures to include V<sub>BUS</sub> and V<sub>BUS</sub> detection inputs.</li> <li>Section 3.8 – Updated power state machine. +12V_EDGE clarified as being "on, but limited up to the ID Mode budget." This clarification aligns with the existing text. Added clarification notes to Table 37 for permissible +12V_EDGE current draw in the ID Mode and Aux Power Mode states.</li> </ul> | 0.85b | 12/14/2018 |
| OCP NIC 3.0 Subgroup | <ul> <li>Section 1.2 – Change Cavium entity name to Marvell Semiconductor, Inc.</li> <li>Section 1.3 – Added DSP0267 reference</li> <li>Sections 1.5, 2.1.x – All 3D renderings have been updated</li> <li>Section 2.4.2 – Mechanical BOM updated. Added notes for Phillips + Torx screw heads.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          | 0.86  | 04/02/2019 |

- Sections 2.4.3, 2.4.4, 2.5.x, 2.7.x, 2.8.2 Mechanical 2D drawings updated.
- Section 2.7 Added insulator note regarding the use of 0.127 mm material for constrained regions; 4x 4mm diameter holes permitted for non-metallic mechanical retention pin cutouts
- Section 3.1 Gold finger figure updated to clarify dimension from center of pad.
- Section 3.4.4 Add note that RBT clock buffers are permitted so long as the card timing budget is not violated. Clarify permitted baseboard and OCP NIC 3.0 side pull up/pull down implementations on SLOT ID[1:0].
- Sections 3.4.5, 3.7.2 Scan Chain LED definition updated. Activity LED is OFF when "idle"
- Section 3.4.7 USB figures now shown as a BMC or Platform I/O hub connectivity instead of just the BMC.
- Section 3.4.8 UART figures now shown as a BMC or Platform I/O hub connectivity instead of just the BMC.
- Section 3.6 Clarify REFCLK/PERST mapping for LFF (Table 35).
- Section 4.4 Temperature Reporting clarified as ASIC die temp reporting. Also clarified die temp reporting is independent of the transceiver temp reporting.
- Section 4.6 Transceiver module temperature reporting is always required and is independent of the network ASIC TDP 5W threshold.
- Section 4.10.1 Add double byte FRU EEPROM access diagrams for clarity. FRU EEPROM WP mechanism may optionally be over written in the field to allow for field updates.
- Section 5.1 Re-wrote NC-SI over RBT SI recommendations. Broke up into three sections: common, baseboard, and OCP NIC 3.0 requirements.
- Section 5.2 Reference SMBus and PCIe CEM specifications for SI, routing and signal requirements.
- Sections 6.2.x Add notes to consider airflow requirements in Aux and Main power modes for SFF & LFF in Hot & Cold Aisle implementations.
- Section 6.7 Non-operational shock fixture CAD files on wiki. Updated test procedure requirements.

OCP NIC 3.0 Subgroup

- Section 1.1 Update OCPHL-P license link due to opencompute.org site restructuring.
- Section 1.3 Update NIST Special Publication 800-193 to May 2018
- Section 1.3.1 Add I<sup>2</sup>C as a trademark of NXP Semiconductor.
- Section 2.1 Add safety requirement text and cross reference Section 7.1.3.
- Section 2.1.1 Add requirement regarding maximum extraction force on heatsink for internal lock implementations.
- Section 2.x Update Mechanical 2D drawings from WG notes
- Section 2.7 Clarify insulator access hole requirements.
- Section 3.4.1 Clarify PWRBRK[0:1]# card pull up resistor value as 95kOhm or larger and must meet the  $T_{\text{PWRBRK}}$  timing parameter per PCIe CEM. Provided recommended Baseboard value between 4.7 kOhm and 10 kOhm.
- Section 3.4.4 Updated NC-SI over RBT signal list pull down requirements. TX\_EN and TXD[1:0] pull downs moved between RBT isolation circuit and OCP NIC 3.0 connector to prevent NIC side signals from floating when RBT\_ISOLATE# is asserted. Updated NC-SI diagrams to depict this change. Clarify HW ARB\_IN / ARB\_OUT ring integrity requirements for baseboards with multiple OCP NIC 3.0 slots.

0.90

06/20/2019

|                      | when AUX_PWR_EN and MAIN_PWR_EN are asserted.  - Section 3.4.6, 3.8.x, 3.9, 4.10.1 – Add optional Programming Mode power state. Add state of NIC_PWR_GOOD when in Programming Mode.  - Section 3.5.3 – Bifurcation decoder table updated to align with bifurcation spreadsheet.  - Section 3.8 – Rename section from "Power Capacity and Power Delivery" to "Power State Machine." Add text about Programming Power State. Clarify normal power state flow.  - Section 3.11 – Add Programming Mode sequencing diagram detailing transition from ID Mode to Programming Mode and back to ID Mode.  - Section 4.10.2 – Move FRU write protection mechanism to a dedicated section heading.  - Section 4.10.3 – Modify OEM Record Offsets for supporting FRU write protection, Programming Mode power state, and thermal requirements.  Offset 06/07 – Changed Hot/Cold Aisle tier for use with passive cables. Offset 17 – advertise FRU write protection mechanism.  Offset 18 – advertise if the Programming Mode Power State is supported.  Offset 19/20 – Add Hot/Cold Aisle tier for use with active cables.  Offset 31 – Defined "controller" as a SMBus connected device in the context of the FRU UDID.  - Section 5.1, 5.1.2, 5.1.4 – Add NC-SI over RBT requirements for LFF - Section 6.4 – Update thermal test fixture feature list.  - Section 6.6 – Update card cooling tiers. Combined Hot Aisle and Cold Aisle airflow definition. |      |            |
|----------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------------|
| OCP NIC 3.0 Subgroup | <ul> <li>Section 6.7.2 – Clarified Shock and Vibe testing shall be tested in the order noted in the specification.</li> <li>Section 2.2 – Clarified line side implementations may be a subset of I/O listed in Table 7.</li> <li>Section 2.x – Update ejector lever and faceplate to support a clinch nut implementation.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             | 0.91 | 07/24/2019 |
|                      | Updated Figure 13 & Figure 14 with new ejector lever diagrams Updated Table 9 with updated drawing & clinch nut. Removed bushing and wave washer from BOM. Updated Figures 16, 18 generic I/O plate for ejector clinch nut Updated Figures 19, 20 with Ejector Lever clinch nut updates. Updated Figure 21 with Ejector lock design. Renamed Section 2.4.8 (was Ejector Bushing, now Clinch Nut), Removed Section 2.4.9 (was Ejector Wave washer)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |      |            |
|                      | - Section 3.4.1, 3.4.3 and 3.4.6 — Clarified the PWRBRK[0:1]#, SMBus and AUX_PWR_EN of SFF and LFF. These pins are defined on both the Primary and Secondary Connectors. SFF and LFF cards shall use the Primary Connector pin. The Secondary Connector pin is reserved for a future use case.  - Section 4.3 - Clarified MC MAC address provisioning requirements for multi-host capable cards as the maximum number of supported hosts.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |      |            |
| OCP NIC 3.0 Subgroup | <ul> <li>Section 3.2.4 – Figure 77 was inadvertently changed to include an<br/>"Option D" straddle mount connector for a host PCB thickness of<br/>0.105". This was an error and has been removed.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    | 0.92 | 11/22/2019 |
|                      |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |      |            |

- Section 3.4.6 – Clarify +12V\_EDGE and +3.3V\_EDGE requirements

|                      | - Section 3.4.3 – Add "AUX Power Good (local signal)" to the isolator              |      |            |
|----------------------|------------------------------------------------------------------------------------|------|------------|
|                      | figure.                                                                            |      |            |
|                      | - Section 3.5.3 – Add implementation note to state baseboard vendors               |      |            |
|                      | only need to implement PCIe bifurcation options applicable to their                |      |            |
|                      | topology.                                                                          |      |            |
|                      | - Section 3.10 – Clarified that RBT hot-plug is not supported in                   |      |            |
|                      | DSP0222 version 1.1 and 1.2. This is feature would be dependent on                 |      |            |
|                      | future revisions of the DSP0222 specification.                                     |      |            |
|                      | - Section 3.11 - Change the max T <sub>APL</sub> / T <sub>MPL</sub> (AUX PWR EN to |      |            |
|                      | NIC PWR GOOD and MAIN PWR EN to NIC PWR GOOD)                                      |      |            |
|                      | parameters from 25ms to 50ms.                                                      |      |            |
|                      | - Section 4.10.3 – Changed offset three to state "OCP NIC 3.0 card FRU             |      |            |
|                      | record released with version 0.90". The same FRU Record field may be               |      |            |
|                      | used with incremental revisions of the specification.                              |      |            |
|                      | ·                                                                                  |      |            |
|                      | - Section 7.1.2, 7.1.4 – Add text for co-reporting testing for EN 55024            |      |            |
| 007.140.000.1        | and EN 55035.                                                                      | 0.00 | 10/05/0010 |
| OCP NIC 3.0 Subgroup | - Section 2.2.1 – Update max permissible heatsink force applied for                | 0.99 | 12/05/2019 |
|                      | internal lock variant.                                                             |      |            |
|                      | - Section 2.4.3 – Update SFF Generic I/O faceplate – Figures 15-17                 |      |            |
|                      | - Section 2.4.4 – Update LFF Generic I/O faceplate – Figure 18                     |      |            |
|                      | - Section 2.4.8 – Update Clinch nut drawings – Figures 22 and 23                   |      |            |
|                      | - Section 2.5.x – Update Keep Out zone drawings – Figures 24-33                    |      |            |
|                      | - Section 2.7.1 – Update SFF insulator drawings – Figures 35 and 36                |      |            |
|                      | - Section 2.7.2 – Update LFF insulator drawings – Figures 38 and 39                |      |            |
|                      | - Section 2.8.2 – Update SFF Pull Tab CTF dimensions – Figures 40-42               |      |            |
|                      | - Section 2.8.3 – Update SFF Ejector latch CTF dimensions – Figs 43-45             |      |            |
|                      | - Section 2.8.4 – Update SFF Internal latch CTF dimensions – Figs 46-48            |      |            |
|                      | - Section 2.8.5 – Update SFF Baseboard CTF dimensions – Figs 50-53                 |      |            |
|                      | - Section 2.8.6 – Update LFF Ejector latch CTF dimensions – Figs 54-56             |      |            |
|                      | - Section 2.8.7 – Update LFF Baseboard CTF dimensions – Figs 58-60                 |      |            |
|                      | - Section 3.1 – Update SFF-TA-1002 card edge drawings – Figs 67-69                 |      |            |
|                      | - Section 3.4.5 – For LFF, multiplex scan chain thermal pins                       |      |            |
|                      | (TEMP WARN, TEMP CRIT, FAN ON AUX) and WAKEn for                                   |      |            |
|                      | PRSNTB[3:0] from the secondary connector.                                          |      |            |
|                      | - Section 4.3 – Add second Management Controller MAC Address                       |      |            |
|                      | Algorithm. Add link to OCP NIC 3.0 wiki to download MAC Address                    |      |            |
|                      | algorithm calculator spreadsheet.                                                  |      |            |
|                      | - Section 4.10.3 – Offset 3 – Rearranged sentences for the OEM Record              |      |            |
|                      | Format description. Technical content remains the same.                            |      |            |
|                      | i offilat description. Technical content femalis the same.                         |      |            |
|                      |                                                                                    |      |            |

# 8.2 FRU Content Revision History

The following table summarizes the FRU content revision history and maps it against specification releases.

| Date       | Change Description                                                                                                                                                                                                                                                                                                                                                                                   | Released with |
|------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|
|            |                                                                                                                                                                                                                                                                                                                                                                                                      | Spec Version  |
| 01/25/2018 | - Initial FRU contents.                                                                                                                                                                                                                                                                                                                                                                              | 0.70          |
| 06/04/2018 | <ul> <li>Offset 4, 5 – Clarified that the Card Max Power in Main mode and the Card Max Power in Aux Mode do not include the power consumed by transceivers plugged into the line side receptacle(s).</li> <li>Offset 8 – Corrected Card active/passive cooling) as a byte value (not bitwise).</li> <li>Offset 13, 14 – Removed ASIC temperature target; replaced with UART Configuration</li> </ul> | 0.80          |
|            | 1 and UART Configuration 2.                                                                                                                                                                                                                                                                                                                                                                          |               |

|            | - Offset 15 – Added USB Present.                                                                                                                                        |      |
|------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
|            | - Offset 32-127 – Explicitly called out UDID offset ranges for controllers 1 through 6.                                                                                 |      |
| 07/06/2018 | - Offset 13, 14 – Clarified these offsets are only applicable to the Secondary Connector (LFF designs)                                                                  | 0.81 |
|            | <ul> <li>Offset 15 – Clarified this offset is only applicable to the Primary Connector (SFF designs)</li> </ul>                                                         |      |
| 11/20/2018 | - Offset 3 – Corrected Manufacturer ID as 0x00A67F.                                                                                                                     | 0.85 |
|            | - Offset 9, 10 – Clarified hot aisle standby airflow LSB, MSB byte order.                                                                                               |      |
|            | - Offset 11, 12 – Clarified cold aisle standby airflow LSB, MSB byte order.                                                                                             |      |
|            | - Offset 16 – Add card manageability type.                                                                                                                              |      |
| 04/02/2019 | - Offset 32-127 – Add note declaring the controller UDID fields may be omitted and left as zero length if no corresponding controller is present on the card.           | 0.86 |
| 06/20/2019 | <ul> <li>Offset 3 – Updated FRU OEM Record Version compliance. Cards complaint to spec<br/>version 0v90 shall use the value 0x01. All other values reserved.</li> </ul> | 0.90 |
|            | - Offset 6 – Clarified Hot Aisle Card Cooling Tier offset is applicable to passive cable or                                                                             |      |
|            | RJ-45 implementations.                                                                                                                                                  |      |
|            | - Offset 7 – Clarified Cold Aisle Card Cooling Tier offset is applicable to passive cable or                                                                            |      |
|            | RJ-45 implementations.                                                                                                                                                  |      |
|            | - Offset 9, 10 – Clarified hot aisle standby airflow requirement with an approach air temperature of 45°C.                                                              |      |
|            | <ul> <li>Offset 11, 12 – Clarified cold aisle standby airflow requirement with an approach air<br/>temperature of 35°C.</li> </ul>                                      |      |
|            | - Offset 17 – Add FRU Write Protection Mechanism indication.                                                                                                            |      |
|            | - Offset 18 – Add Programming Mode Power State indication.                                                                                                              |      |
|            | - Offset 19 – Add Hot Aisle Cooling Tier with Active Cables indication.                                                                                                 |      |
|            | - Offset 20 – Add Cold Aisle Card Cooling Tier with Active Cables indication.                                                                                           |      |
|            | - Offset 21 – Add Transceiver Reference Power Level indication.                                                                                                         |      |
|            | - Offset 22 – Add Transceiver Reference Temperature Level indication.                                                                                                   |      |
|            | - Offset 23 – Add Card Thermal Tier with local Fan Fail indication.                                                                                                     |      |
|            | - Offset 31 – Clarify Number of Physical Controllers as the number of SMBus                                                                                             |      |
|            | connected controllers on the OCP NIC 3.0 card.                                                                                                                          |      |
| 11/08/2019 | - Offset 3 – Changed FRU OEM Record Version definition to declare "this FRU record is                                                                                   | 0.92 |
|            | released with version x.xx" of the specification. This prevents revising the field to                                                                                   |      |
|            | match future specification releases when no FRU changes have been made.                                                                                                 |      |